查询PIC16C67供应商



PIC16C6X

,24小时加急出货

8-Bit CMOS Microcontrollers

Devices included in this data sheet:

- PIC16C61
- PIC16CR64
- PIC16C62PIC16C62A
- PIC16C65

PIC16C64A

- PIC16CR62
 PIC16C63
- PIC16C65APIC16CR65
- PIC16CR63
- PIC16C66
- PIC16C64
- PIC16C67

PIC16C6X Microcontroller Core Features:

- · High performance RISC CPU
- Only 35 single word instructions to learn
- All single cycle instructions except for program branches which are two-cycle
- Operating speed: DC 20 MHz clock input DC - 200 ns instruction cycle
- Interrupt capability
- Eight level deep hardware stack
- · Direct, indirect, and relative addressing modes
- Power-on Reset (POR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- Programmable code-protection
- Power saving SLEEP mode
- Selectable oscillator options

- Low-power, high-speed CMOS EPROM/ROM
 technology
- · Fully static design
- Wide operating voltage range: 2.5V to 6.0V
- Commercial, Industrial, and Extended temperature ranges

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- Low-power consumption:
 - < 2 mA @ 5V, 4 MHz
 - 15 μA typical @ 3V, 32 kHz
 - < 1 μA typical standby current

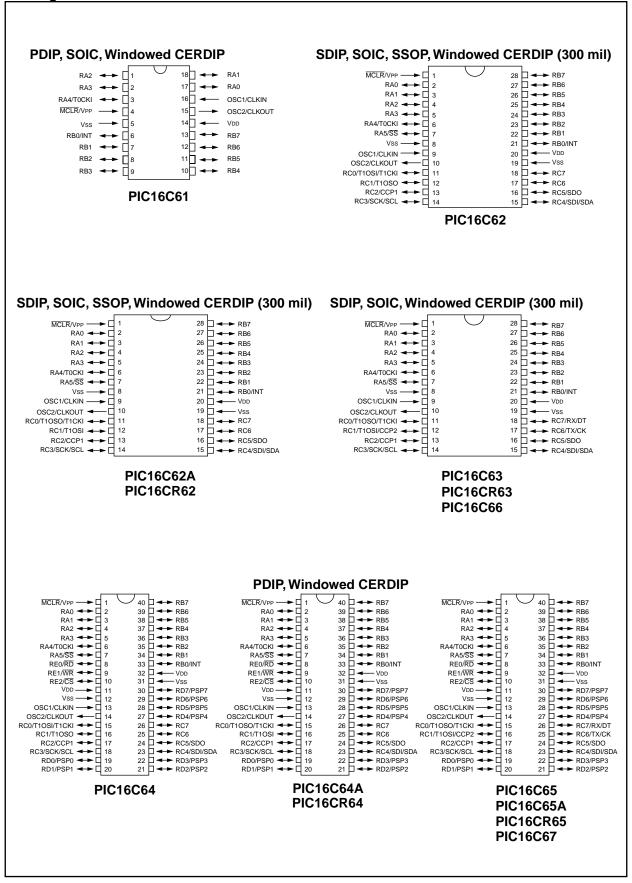
PIC16C6X Peripheral Features:

- Timer0: 8-bit timer/counter with 8-bit prescaler
- Timer1: 16-bit timer/counter with prescaler, can be incremented during sleep via external crystal/clock
- Timer2: 8-bit timer/counter with 8-bit period register, prescaler and postscaler
- Capture/Compare/PWM (CCP) module(s)
- Capture is 16-bit, max resolution is 12.5 ns, Compare is 16-bit, max resolution is 200 ns, PWM max resolution is 10-bit.
- Synchronous Serial Port (SSP) with SPI[™] and I²C[™]
- Universal Synchronous Asynchronous Receiver Transmitter (USART/SCI)
- Parallel Slave Port (PSP) 8-bits wide, with external RD, WR and CS controls
- Brown-out detection circuitry for Brown-out Reset (BOR)

PIC16C6X Features	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67
Program Memory (EPROM) x 14	1K	2K	2K	_	4K	—	2K	2K	-	4K	4K	-77	8K	8K
(ROM) x 14	_	_	_	2K		4K	_	-	2K	11000	ALC: NO	4K		_
Data Memory (Bytes) x 8	36	128	128	128	192	192	128	128	128	192	192	192	368	368
I/O Pins	13	22	22	22	22	22	33	33	33	33	33	33	22	33
Parallel Slave Port	_	-	-	-	-	_	Yes	Yes	Yes	Yes	Yes	Yes		Yes
Capture/Compare/PWM Module(s)	Ð	1	029	G1.C	2	2	1	1	1	2	2	2	2	2
Timer Modules	1	3	3	3	3	3	3	3	3	3	3	3	3	3
Serial Communication	_	SPI/ I ² C	SPI/ I ² C	SPI/ I ² C	SPI/I ² C, USART	SPI/I ² C, USART	SPI/ I ² C	SPI/ I ² C	SPI/ I ² C	SPI/I ² C, USART	SPI/I ² C, USART		SPI/I ² C, USART	SPI/I ² C, USART
In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Brown-out Reset	—	—	Yes	Yes	Yes	Yes		Yes	Yes		Yes	Yes	Yes	Yes
Interrupt Sources	3	7	7	7	10	10	8	8	8	11	11	11	10	11
Sink/Source Current (mA)	25/20	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25



Pin Diagrams



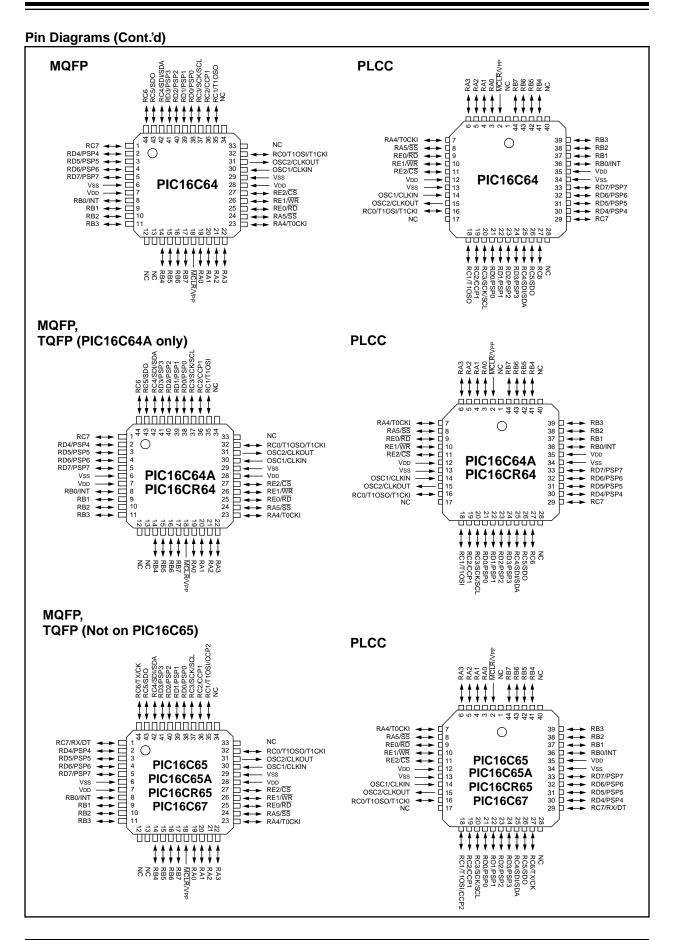


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For register and module descriptions in this data sheet, device legends show which devices apply to those sections. For example, the legend below shows that some features of only the PIC16C62A, PIC16CR62, PIC16C63, PIC16C64A, PIC16CR64, and PIC16C65A are described in this section.

 Applicable Devices

 61
 62
 62
 63
 R63
 64
 64
 R64
 65
 65A
 R65
 66
 67

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1.0 GENERAL DESCRIPTION

The PIC16CXX is a family of low-cost, high-performance, CMOS, fully-static, 8-bit microcontrollers.

All PIC16/17 microcontrollers employ an advanced RISC architecture. The PIC16CXX microcontroller family has enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with separate 8-bit wide data. The two stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16CXX microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

The **PIC16C61** device has 36 bytes of RAM and 13 I/O pins. In addition a timer/counter is available.

The **PIC16C62/62A/R62** devices have 128 bytes of RAM and 22 I/O pins. In addition, several peripheral features are available, including: three timer/counters, one Capture/Compare/PWM module and one serial port. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPITM) or the two-wire Inter-Integrated Circuit (I^2 C) bus.

The **PIC16C63/R63** devices have 192 bytes of RAM, while the **PIC16C66** has 368 bytes. All three devices have 22 I/O pins. In addition, several peripheral features are available, including: three timer/counters, two Capture/Compare/PWM modules and two serial ports. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI) or the two-wire Inter-Integrated Circuit (I²C) bus. The Universal Synchronous Asynchronous Receiver Transmitter (USART) is also know as a Serial Communications Interface or SCI.

The **PIC16C64/64A/R64** devices have 128 bytes of RAM and 33 I/O pins. In addition, several peripheral features are available, including: three timer/counters, one Capture/Compare/PWM module and one serial port. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI) or the two-wire Inter-Integrated Circuit (I²C) bus. An 8-bit Parallel Slave Port is also provided.

The **PIC16C65/65A/R65** devices have 192 bytes of RAM, while the **PIC16C67** has 368 bytes. All four devices have 33 I/O pins. In addition, several peripheral features are available, including: three timer/counters, two Capture/Compare/PWM modules and two serial ports. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI) or the two-wire Inter-Integrated Circuit (I²C) bus. The Universal Synchronous Asynchronous Receiver Transmit-

ter (USART) is also known as a Serial Communications Interface or SCI. An 8-bit Parallel Slave Port is also provided.

The PIC16C6X device family has special features to reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low-cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for High Speed crystals. The SLEEP (power-down) mode offers a power saving mode. The user can wake the chip from SLEEP through several external and internal interrupts, and resets.

A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software lock-up.

A UV erasable CERDIP packaged version is ideal for code development, while the cost-effective One-Time-Programmable (OTP) version is suitable for production in any volume.

The PIC16C6X family fits perfectly in applications ranging from high-speed automotive and appliance control to low-power remote sensors, keyboards and telecom processors. The EPROM technology makes customization of application programs (transmitter codes, motor speeds, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series perfect for all applications with space limitations. Low-cost, low-power, high performance, ease-of-use, and I/O flexibility make the PIC16C6X very versatile even in areas where no microcontroller use has been considered before (e.g. timer functions, serial communication, capture and compare, PWM functions, and co-processor applications).

1.1 Family and Upward Compatibility

Those users familiar with the PIC16C5X family of microcontrollers will realize that this is an enhanced version of the PIC16C5X architecture. Please refer to Appendix A for a detailed list of enhancements. Code written for PIC16C5X can be easily ported to PIC16CXX family of devices (Appendix B).

1.2 Development Support

PIC16C6X devices are supported by the complete line of Microchip Development tools.

Please refer to Section 15.0 for more details about Microchip's development tools.

		PIC16C61	PIC16C62A	PIC16CR62	PIC16C63	PIC16CR63
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20
	EPROM Program Memory (x14 words)	1K	2К	—	4K	_
Memory	ROM Program Memory (x14 words)	—	_	2К	—	4K
	Data Memory (bytes)	36	128	128	192	192
	Timer Module(s)	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/ PWM Module(s)	—	1	1	2	2
	Serial Port(s) (SPI/I ² C, USART)	-	SPI/I ² C	SPI/I ² C	SPI/I ² C, USART	SPI/I ² C USART
	Parallel Slave Port	_	<u> </u>	<u> </u>	—	_
	Interrupt Sources	3	7	7	10	10
	I/O Pins	13	22	22	22	22
	Voltage Range (Volts)	3.0-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	—	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SO	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC	28-pin SDIP, SOIC

TABLE 1-1: PIC16C6X FAMILY OF DEVICES

		PIC16C64A	PIC16CR64	PIC16C65A	PIC16CR65	PIC16C66	PIC16C67
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x14 words)	2К	_	4K		8K	8K
Memory	ROM Program Memory (x14 words)		2К		4K	_	_
	Data Memory (bytes)	128	128	192	192	368	368
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Mod- ule(s)	1	1	2	2	2	2
	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C	SPI/I ² C	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	Yes	Yes	Yes	Yes	_	Yes
	Interrupt Sources	8	8	11	11	10	11
	I/O Pins	33	33	33	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
Features	Brown-out Reset	Yes	Yes	Yes	Yes	Yes	Yes
	Packages	44-pin PLCC,	44-pin PLCC,	40-pin DIP; 44-pin PLCC, MQFP, TQFP	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C6X Family devices use serial programming with clock pin RB6 and data pin RB7.

2.0 PIC16C6X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC16C6X Product Identification System section at the end of this data sheet. When placing orders, please use that page of the data sheet to specify the correct part number.

For the PIC16C6X family of devices, there are four device "types" as indicated in the device number:

- 1. **C**, as in PIC16**C**64. These devices have EPROM type memory and operate over the standard voltage range.
- 2. **LC**, as in PIC16**LC**64. These devices have EPROM type memory and operate over an extended voltage range.
- 3. **CR**, as in PIC16**CR**64. These devices have ROM program memory and operate over the standard voltage range.
- 4. **LCR**, as in PIC16**LCR**64. These devices have ROM program memory and operate over an extended voltage range.

2.1 UV Erasable Devices

The UV erasable version, offered in CERDIP package is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the oscillator modes.

Microchip's PICSTART[®] Plus and PRO MATE[®] II programmers both support programming of the PIC16C6X.

2.2 <u>One-Time-Programmable (OTP)</u> <u>Devices</u>

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must also be programmed.

2.3 <u>Quick-Turnaround-Production (QTP)</u> <u>Devices</u>

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

2.4 <u>Serialized Quick-Turnaround</u> <u>Production (SQTPSM) Devices</u>

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random, or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password, or ID number.

ROM devices do not allow serialization information in the program memory space. The user may have this information programmed in the data memory space.

For information on submitting ROM code, please contact your regional sales office.

2.5 Read Only Memory (ROM) Devices

Microchip offers masked ROM versions of several of the highest volume parts, thus giving customers a low cost option for high volume, mature products.

For information on submitting ROM code, please contact your regional sales office.

NOTES:

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXX uses a Harvard architecture, in which, program and data are accessed from separate memories using separate buses. This improves bandwidth over traditional von Neumann architecture where program and data may be fetched from the same memory using the same bus. Separating program and data busses further allows instructions to be sized differently than 8-bit wide data words. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A twostage pipeline overlaps fetch and execution of instructions (Example 3-1). Consequently, all instructions execute in a single cycle (200 ns @ 20 MHz) except for program branches.

The PIC16C61 addresses 1K x 14 of program memory. The PIC16C62/62A/R62/64/64A/R64 address 2K x 14 of program memory, and the PIC16C63/R63/65/65A/R65 devices address 4K x 14 of program memory. The PIC16C66/67 address 8K x 14 program memory. All program memory is internal.

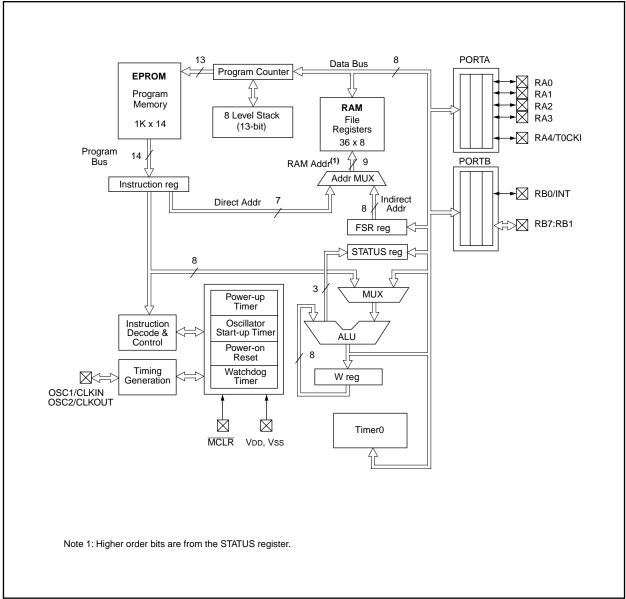
The PIC16CXX can directly or indirectly address its register files or data memory. All special function registers including the program counter are mapped in the data memory. The PIC16CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of "special optimal situations" makes programming with the PIC16CXX simple yet efficient, thus significantly reducing the learning curve. The PIC16CXX device contains an 8-bit ALU and working register (W). The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

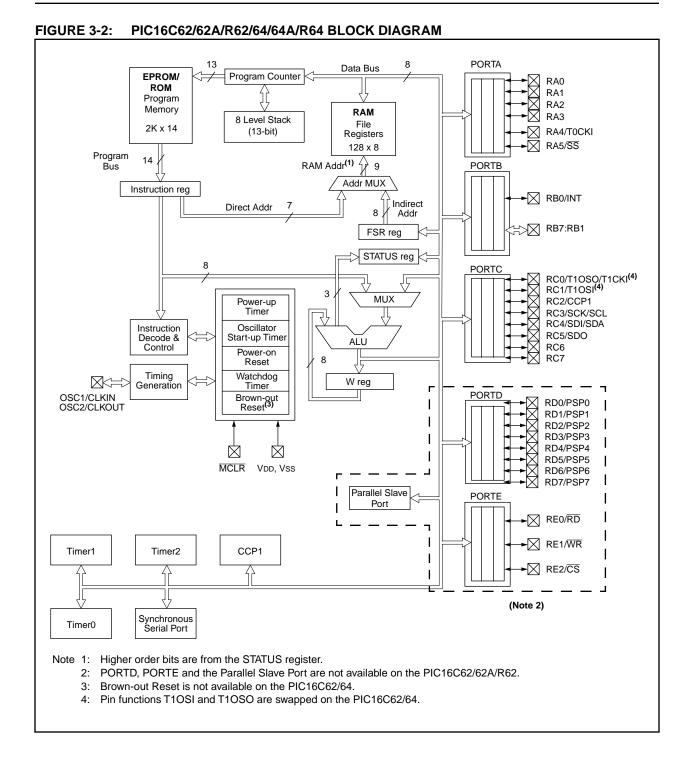
The ALU is 8-bits wide and capable of addition, subtraction, shift, and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register), the other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

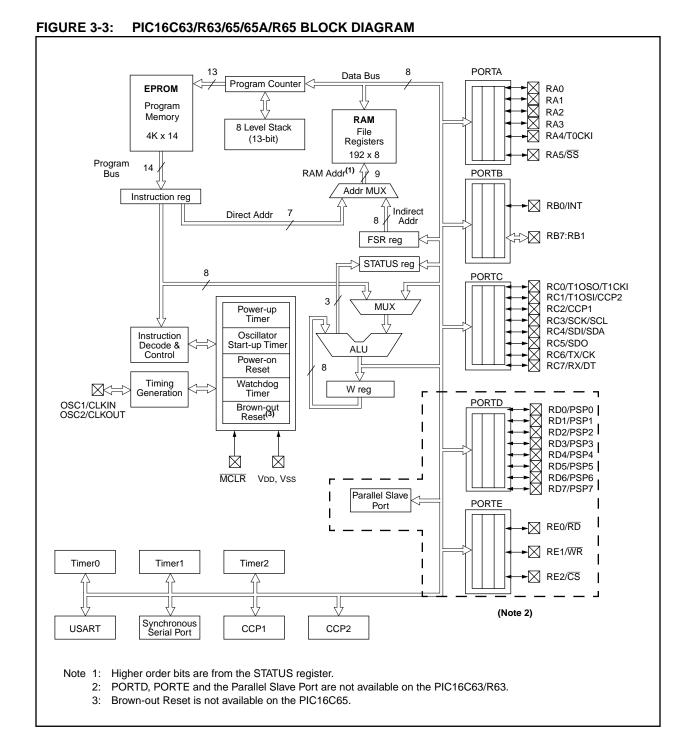
The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

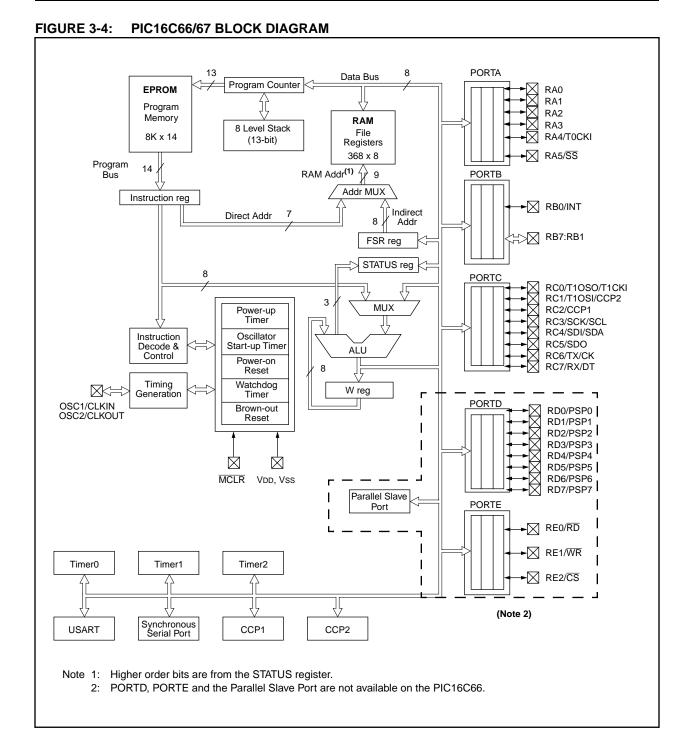
Depending upon the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. Bits C and DC operate as a borrow and digit borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.











Pin Name	DIP Pin#	SOIC Pin#	Pin Type	Buffer Type	Description
OSC1/CLKIN	16	16	I	ST/CMOS ⁽¹⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	15	15	0		Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/Vpp	4	4	I/P	ST	Master clear reset input or programming voltage input. This pin is an active low reset to the device.
					PORTA is a bi-directional I/O port.
RA0	17	17	I/O	TTL	
RA1	18	18	I/O	TTL	
RA2	1	1	I/O	TTL	
RA3	2	2	I/O	TTL	
RA4/T0CKI	3	3	I/O	ST	RA4 can also be the clock input to the Timer0 timer/counter. Output is open drain type.
					PORTB is a bi-directional I/O port. PORTB can be software pro- grammed for internal weak pull-up on all inputs.
RB0/INT	6	6	I/O	TTL/ST ⁽²⁾	RB0 can also be the external interrupt pin.
RB1	7	7	I/O	TTL	
RB2	8	8	I/O	TTL	
RB3	9	9	I/O	TTL	
RB4	10	10	I/O	TTL	Interrupt on change pin.
RB5	11	11	I/O	TTL	Interrupt on change pin.
RB6	12	12	I/O	TTL/ST ⁽³⁾	Interrupt on change pin. Serial programming clock.
RB7	13	13	I/O	TTL/ST ⁽³⁾	Interrupt on change pin. Serial programming data.
Vss	5	5	Р	_	Ground reference for logic and I/O pins.
Vdd	14	14	Р	_	Positive supply for logic and I/O pins.
Legend: I = input	Ο = οι	utput) = input/outpu	

TABLE 3-1: PIC16C61 PINOUT DESCRIPTION

— = Not used TTL = TTL input ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.
 2: This buffer is a Schmitt Trigger input when configured as the external interrupt.
 3: This buffer is a Schmitt Trigger input when used in serial programming mode.

Pin Name	Pin#	Pin Type	Buffer Type	Description
OSC1/CLKIN	9	I	ST/CMOS ⁽³⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	10	0	_	Oscillator crystal output. Connects to crystal or resonator in crys- tal oscillator mode. In RC mode, the pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/VPP	1	I/P	ST	Master clear reset input or programming voltage input. This pin is an active low reset to the device.
				PORTA is a bi-directional I/O port.
RA0	2	I/O	TTL	
RA1	3	I/O	TTL	
RA2	4	I/O	TTL	
RA3	5	I/O	TTL	
RA4/T0CKI	6	I/O	ST	RA4 can also be the clock input to the Timer0 timer/counter Output is open drain type.
RA5/SS	7	I/O	TTL	RA5 can also be the slave select for the synchronous seria port.
				PORTB is a bi-directional I/O port. PORTB can be software pro- grammed for internal weak pull-up on all inputs.
RB0/INT	21	I/O	TTL/ST ⁽⁴⁾	RB0 can also be the external interrupt pin.
RB1	22	I/O	TTL	
RB2	23	I/O	TTL	
RB3	24	I/O	TTL	
RB4	25	I/O	TTL	Interrupt on change pin.
RB5	26	I/O	TTL	Interrupt on change pin.
RB6	27	I/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming clock.
RB7	28	1/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming data.
	20	1/0	112/01	PORTC is a bi-directional I/O port.
RC0/T1OSO ⁽¹⁾ /T1CKI	11	I/O	ST	RC0 can also be the Timer1 oscillator output ⁽¹⁾ or Timer1 clock input.
RC1/T1OSI ⁽¹⁾ /CCP2 ⁽²⁾	12	I/O	ST	RC1 can also be the Timer1 oscillator input ⁽¹⁾ or Capture2 input/Compare2 output/PWM2 output ⁽²⁾ .
RC2/CCP1	13	I/O	ST	RC2 can also be the Capture1 input/Compare1 out- put/PWM1 output.
RC3/SCK/SCL	14	I/O	ST	RC3 can also be the synchronous serial clock input/output for both SPI and I ² C modes.
RC4/SDI/SDA	15	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I^2C mode).
RC5/SDO	16	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK ⁽²⁾	17	I/O	ST	RC6 can also be the USART Asynchronous Transmit ⁽²⁾ of Synchronous Clock ⁽²⁾ .
RC7/RX/DT ⁽²⁾	18	I/O	ST	RC7 can also be the USART Asynchronous Receive ⁽²⁾ of Synchronous Data ⁽²⁾ .
Vss	8,19	P	_	Ground reference for logic and I/O pins.
Vdd	20	P		Positive supply for logic and I/O pins.
Legend: I = input O =	output	/	O = input/outpu	t P = power

TABLE 3-2: PIC16C62/62A/R62/63/R63/66 PINOUT DESCRIPTION

Note 1: Pin functions T1OSO and T1OSI are reversed on the PIC16C62.

2: The USART and CCP2 are not available on the PIC16C62/62A/R62.

3: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.
4: This buffer is a Schmitt Trigger input when configured as the external interrupt.

5: This buffer is a Schmitt Trigger input when used in serial programming mode.

Pin Name	DIP Pin#	PLCC Pin#	TQFP MQFP Pin#	Pin Type	Buffer Type	Description
OSC1/CLKIN	13	14	30	I	ST/CMOS ⁽³⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	14	15	31	0	_	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the pin outputs CLK-OUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/Vpp	1	2	18	I/P	ST	Master clear reset input or programming voltage input. This pin is an active low reset to the device.
						PORTA is a bi-directional I/O port.
RA0	2	3	19	I/O	TTL	
RA1	3	4	20	I/O	TTL	
RA2	4	5	21	I/O	TTL	
RA3	5	6	22	I/O	TTL	
RA4/T0CKI	6	7	23	I/O	ST	RA4 can also be the clock input to the TimerC timer/counter. Output is open drain type.
RA5/SS	7	8	24	I/O	TTL	RA5 can also be the slave select for the synchronous serial port.
						PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT	33	36	8	I/O	TTL/ST ⁽⁴⁾	RB0 can also be the external interrupt pin.
RB1	34	37	9	I/O	TTL	
RB2	35	38	10	I/O	TTL	
RB3	36	39	11	I/O	TTL	
RB4	37	41	14	I/O	TTL	Interrupt on change pin.
RB5	38	42	15	I/O	TTL	Interrupt on change pin.
RB6	39	43	16	I/O	TTL/ST(5)	Interrupt on change pin. Serial programming clock.
RB7	40	44	17	I/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming data.
						PORTC is a bi-directional I/O port.
RC0/T1OSO ⁽¹⁾ /T1CKI	15	16	32	I/O	ST	RC0 can also be the Timer1 oscillator output ⁽¹⁾ or Timer1 clock input.
RC1/T1OSI ⁽¹⁾ /CCP2 ⁽²⁾	16	18	35	I/O	ST	RC1 can also be the Timer1 oscillator input ⁽¹⁾ or Capture2 input/Compare2 output/PWM2 output ⁽²⁾ .
RC2/CCP1	17	19	36	I/O	ST	RC2 can also be the Capture1 input/Compare1 out- put/PWM1 output.
RC3/SCK/SCL	18	20	37	I/O	ST	RC3 can also be the synchronous serial clock input/out- put for both SPI and I ² C modes.
RC4/SDI/SDA	23	25	42	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	24	26	43	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK ⁽²⁾	25	27	44	I/O	ST	RC6 can also be the USART Asynchronous Transmit ⁽²⁾ or Synchronous Clock ⁽²⁾ .
RC7/RX/DT ⁽²⁾	26	29	1	I/O	ST	RC7 can also be the USART Asynchronous Receive ⁽²⁾ or Synchronous Data ⁽²⁾ .
Legend: I = input C) = outp	ut	I/C) D = input	/output	P = power

TABLE 3-3: PIC16C64/64A/R64/65/65A/R65/67 PINOUT DESCRIPTION

Note 1: Pin functions T1OSO and T1OSI are reversed on the PIC16C64.

2: CCP2 and the USART are not available on the PIC16C64/64A/R64.

3: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.

4: This buffer is a Schmitt Trigger input when configured as the external interrupt.

5: This buffer is a Schmitt Trigger input when used in serial programming mode.

6: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

Pin Name	DIP Pin#	PLCC Pin#	TQFP MQFP Pin#	Pin Type	Buffer Type	Description
						PORTD can be a bi-directional I/O port or parallel slave port for interfacing to a microprocessor bus.
RD0/PSP0	19	21	38	I/O	ST/TTL ⁽⁶⁾	
RD1/PSP1	20	22	39	I/O	ST/TTL ⁽⁶⁾	
RD2/PSP2	21	23	40	I/O	ST/TTL ⁽⁶⁾	
RD3/PSP3	22	24	41	I/O	ST/TTL ⁽⁶⁾	
RD4/PSP4	27	30	2	I/O	ST/TTL ⁽⁶⁾	
RD5/PSP5	28	31	3	I/O	ST/TTL ⁽⁶⁾	
RD6/PSP6	29	32	4	I/O	ST/TTL ⁽⁶⁾	
RD7/PSP7	30	33	5	I/O	ST/TTL ⁽⁶⁾	
						PORTE is a bi-directional I/O port.
RE0/RD	8	9	25	I/O	ST/TTL ⁽⁶⁾	RE0 can also be read control for the parallel slave port.
RE1/WR	9	10	26	I/O	ST/TTL ⁽⁶⁾	RE1 can also be write control for the parallel slave port.
RE2/CS	10	11	27	I/O	ST/TTL ⁽⁶⁾	RE2 can also be select control for the parallel slave port.
Vss	12,31	13,34	6,29	Р	_	Ground reference for logic and I/O pins.
Vdd	11,32	12,35	7,28	Р	_	Positive supply for logic and I/O pins.
NC	-	1,17, 28,40	12,13, 33,34			These pins are not internally connected. These pins should be left unconnected.
Legend: I = input	O = outpu — = Not			D = input/ FL = TTL		P = power ST = Schmitt Trigger input

TABLE 3-3: PIC16C64/64A/R64/65/65A/R65/67 PINOUT DESCRIPTION (Cont.'d)

Note 1: Pin functions T1OSO and T1OSI are reversed on the PIC16C64.

2: CCP2 and the USART are not available on the PIC16C64/64A/R64.

Construction of the restoration of the

6: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

3.1 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3, and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clock and instruction execution flow is shown in Figure 3-5.

3.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3, and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g. GOTO) then two cycles are required to complete the instruction (Example 3-1).

A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register (IR)" in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

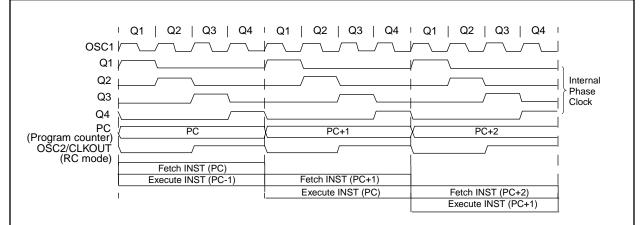
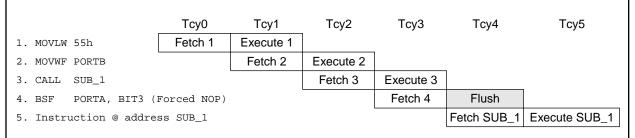


FIGURE 3-5: CLOCK/INSTRUCTION CYCLE

EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

4.0 MEMORY ORGANIZATION

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

4.1 Program Memory Organization

The PIC16C6X family has a 13-bit program counter capable of addressing an 8K x 14 program memory space. The amount of program memory available to each device is listed below:

Device	Program Memory	Address Range
PIC16C61	1K x 14	0000h-03FFh
PIC16C62	2K x 14	0000h-07FFh
PIC16C62A	2K x 14	0000h-07FFh
PIC16CR62	2K x 14	0000h-07FFh
PIC16C63	4K x 14	0000h-0FFFh
PIC16CR63	4K x 14	0000h-0FFFh
PIC16C64	2K x 14	0000h-07FFh
PIC16C64A	2K x 14	0000h-07FFh
PIC16CR64	2K x 14	0000h-07FFh
PIC16C65	4K x 14	0000h-0FFFh
PIC16C65A	4K x 14	0000h-0FFFh
PIC16CR65	4K x 14	0000h-0FFFh
PIC16C66	8K x 14	0000h-1FFFh
PIC16C67	8K x 14	0000h-1FFFh

For those devices with less than 8K program memory, accessing a location above the physically implemented address will cause a wraparound.

The reset vector is at 0000h and the interrupt vector is at 0004h.

FIGURE 4-1: PIC16C61 PROGRAM MEMORY MAP AND STACK

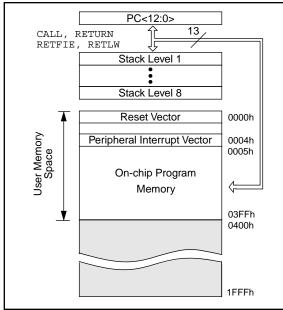


FIGURE 4-2: PIC16C62/62A/R62/64/64A/ R64 PROGRAM MEMORY MAP AND STACK

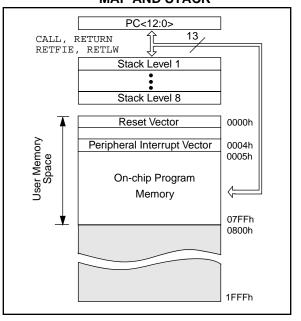


FIGURE 4-3: PIC16C63/R63/65/65A/R65 PROGRAM MEMORY MAP AND STACK

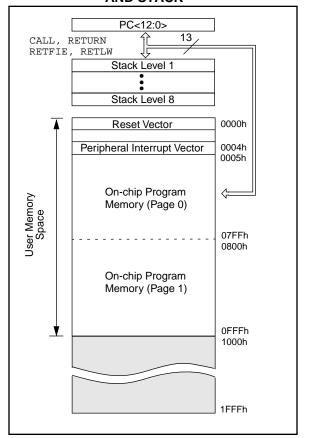
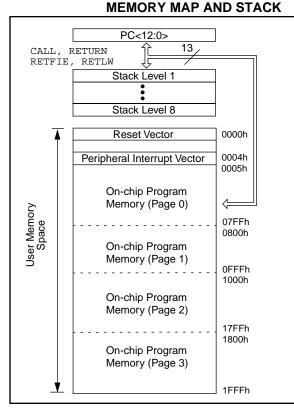


FIGURE 4-4:



PIC16C66/67 PROGRAM

4.2 Data Memory Organization

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The data memory is partitioned into multiple banks which contain the General Purpose Registers and the Special Function Registers. Bits RP1 and RP0 are the bank select bits.

RP1:RP0 (STATUS<6:5>)

- = 00 \rightarrow Bank0
- = 01 \rightarrow Bank1
- = 10 \rightarrow Bank2
- = 11 \rightarrow Bank3

Each bank extends up to 7Fh (128 bytes). The lower locations of each bank are reserved for the Special Function Registers. Above the Special Function Registers are General Purpose Registers, implemented as static RAM. All implemented banks contain special function registers. Some "high use" special function registers from one bank may be mirrored in another bank for code reduction and quicker access.

4.2.1 GENERAL PURPOSE REGISTERS

These registers are accessed either directly or indirectly through the File Select Register (FSR) (Section 4.5).

For the PIC16C61, general purpose register locations 8Ch-AFh of Bank 1 are not physically implemented. These locations are mapped into 0Ch-2Fh of Bank 0.

FIGURE 4-5:	PIC16C61 REGISTER FILE
	MAP

F

ile Addres	5	File	Address				
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h				
01h	TMR0	OPTION	81h				
02h	PCL	PCL	82h				
03h	STATUS	STATUS	83h				
04h	FSR	FSR	84h				
05h	PORTA	TRISA	85h				
06h	PORTB	TRISB	86h				
07h			87h				
08h			88h				
09h			89h				
0Ah	PCLATH	PCLATH	8Ah				
0Bh	INTCON	INTCON	8Bh				
0Ch			8Ch				
	General Purpose Register	Mapped in Bank 0 (2)					
2Fh			AFh				
30h			B0h				
7Fh			FFh				
	Bank 0	Bank 1	J				
 Unimplemented data memory location; read as '0'. Note 1: Not a physical register. 2: These locations are unimplemented in Bank 1. Any access to these locations will 							
	access the corresponding Bank 0 register.						

FIGURE 4-6: PIC16C62/62A/R62/64/64A/ R64 REGISTER FILE MAP

File Addre	ess		File Address					
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h					
01h	TMR0	OPTION	81h					
02h	PCL	PCL	82h					
03h	STATUS	STATUS	83h					
04h	FSR	FSR	84h					
05h	PORTA	TRISA	85h					
06h	PORTB	TRISB	86h					
07h	PORTC	TRISC	87h					
08h	PORTD ⁽²⁾ PORTE ⁽²⁾	TRISD ⁽²⁾ TRISE ⁽²⁾	88h					
09h	PCLATH	PCLATH	89h 8Ah					
0Ah 0Ph	INTCON	INTCON	8Bh					
0Bh 0Ch	PIR1	PIE1						
			8Dh					
0Dh			-					
0Eh	TMR1L	PCON	8Eh					
0Fh	TMR1H		8Fh					
10h	T1CON		90h					
11h	TMR2		91h					
12h	T2CON	PR2	92h					
13h	SSPBUF	SSPADD	93h					
14h	SSPCON	SSPSTAT	94h					
15h	CCPR1L		95h					
16h	CCPR1H		96h					
17h	CCP1CON		97h					
18h			98h					
1Fh			9Fh					
20h		General	A0h					
		Purpose						
	General Purpose	Register	BFh					
	Register		C0h					
7Fh			FFh					
	Bank 0	Bank 1						
	nplemented data m		ad as '0'.					
Note	e 1: Not a physica 2: PORTD and	ll register. PORTE are not av	ailable on					
	the PIC16C6							

FIGURE 4-7:

7: PIC16C63/R63/65/65A/R65 REGISTER FILE MAP

File Addre	ess	F	ile Address										
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h										
01h	TMR0	OPTION	81h										
02h	PCL	PCL	82h										
03h	STATUS	STATUS	83h										
04h	FSR	FSR	84h										
05h	PORTA	TRISA	85h										
06h	PORTB	TRISB	86h										
07h	PORTC	TRISC	87h										
08h	PORTD ⁽²⁾ PORTE ⁽²⁾	TRISD ⁽²⁾ TRISE ⁽²⁾	88h										
09h	PORTE	PCLATH	89h										
0Ah	INTCON	INTCON	8Ah										
0Bh			- 8Bh										
0Ch	PIR1	PIE1	8Ch										
0Dh	PIR2	PIE2	8Dh										
0Eh	TMR1L	PCON	8Eh										
0Fh	TMR1H		8Fh										
10h	T1CON		90h										
11h	TMR2		91h										
12h	T2CON	PR2	92h										
13h	SSPBUF	SSPADD	93h										
14h	SSPCON	SSPSTAT	94h										
15h	CCPR1L		95h										
16h	CCPR1H		96h										
17h	CCP1CON		97h										
18h	RCSTA	TXSTA	98h										
19h	TXREG	SPBRG	99h										
1Ah	RCREG		9Ah										
1Bh	CCPR2L		9Bh										
1Ch	CCPR2H		9Ch										
1Dh	CCP2CON		9Dh										
1Eh			9Eh										
1Fh			9Fh										
20h	General	General	A0h										
7Fh	Purpose Register	Purpose Register	FFh										
<u> </u>	Bank 0	Bank 1	1 10										
	nplemented data m e 1: Not a physica 2: PORTD and the PIC16C6	al register PORTE are not av											

FIGURE 4-8:	PIC16C66/67 DA	TA MEMORY MAP
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						A	File ddre
Indirect addr.(*)	00h	Indirect addr.(*)	80h	Indirect addr.(*)	100h	Indirect addr.(*)	18
TMR0	01h	OPTION	81h	TMR0	101h	OPTION	18
PCL	02h	PCL	82h	PCL	102h	PCL	18
STATUS	03h	STATUS	83h	STATUS	103h	STATUS	18
FSR	04h	FSR	84h	FSR	104h	FSR	18
PORTA	05h	TRISA	85h		105h		18
PORTB	06h	TRISB	86h	PORTB	106h	TRISB	18
PORTC	07h	TRISC	87h		107h		18
PORTD (1)	08h	TRISD (1)	88h		108h		18
PORTE (1)	09h	TRISE (1)	89h		109h		18
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH	18
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON	18
PIR1	0Ch	PIE1	8Ch		10Ch		18
PIR2	0Dh	PIE2	8Dh		10Dh		18
TMR1L	0Eh	PCON	8Eh		10Eh		18
TMR1H	0Fh		8Fh		10Fh		18
T1CON	10h		90h		110h		19
TMR2	11h		91h		111h		19
T2CON	12h	PR2	92h		112h		19
SSPBUF	13h	SSPADD	93h		113h		19
SSPCON	14h	SSPSTAT	94h		114h		19
CCPR1L	15h		95h		115h		19
CCPR1H	16h		96h		116h		19
CCP1CON	17h		97h	General	117h	General	19
RCSTA	18h	TXSTA	98h	Purpose Register	118h	Purpose Register	19
TXREG	19h	SPBRG	99h	16 Bytes	119h	16 Bytes	19
RCREG	1Ah	OF BILLO	9Ah	,	11Ah		19
CCPR2L	1Bh		9Bh		11Bh		19
CCPR2H	1Ch		9Ch		11Ch		19
CCP2CON	1Dh		9Dh		11Dh		19
00120011	1Eh		9Eh		11Eh		19
	1Fh		9Fh		11Fh		19
	20h		A0h		120h		1A
General Purpose Register 96 Bytes		General Purpose Register 80 Bytes	EFh	General Purpose Register 80 Bytes	16Fh	General Purpose Register 80 Bytes	1E
	7Fh	accesses 70h-7Fh in Bank 0	F0h	accesses 70h-7Fh in Bank 0	170h 17Fh	accesses 70h-7Fh in Bank 0	1F(
Bank 0		Bank 1	r FU	Bank 2	171-11	Bank 3	1171

Unimplemented data memory locations, read as '0'.

* Not a physical register.

These registers are not implemented on the PIC16C66.

Note: The upper 16 bytes of data memory in banks 1, 2, and 3 are mapped in Bank 0. This may require relocation of data memory usage in the user application code if upgrading to the PIC16C66/67.

4.2.2 SPECIAL FUNCTION REGISTERS:

The Special Function Registers are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. The special function registers can be classified into two sets (core and peripheral). The registers associated with the "core" functions are described in this section and those related to the operation of the peripheral features are described in the section of that peripheral feature.

TABLE 4-1: SPECIAL FUNCTION REGISTERS FOR THE PIC16C61

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR	Value on all other resets ⁽³⁾
Bank 0								•			
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	ts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	lule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signif	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	z	DC	с	0001 1xxx	000q quuu
04h (1)	FSR	Indirect data	a memory ad	dress pointe	er					xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	—	PORTA Dat	a Latch whe	n written: PC	RTA pins wh	en read	x xxxx	u uuuu
06h	PORTB	PORTB Dat	a Latch whe		xxxx xxxx	uuuu uuuu					
07h	—	Unimpleme	nted		_	—					
08h	-	Unimpleme	nted		_	—					
09h	—	Unimpleme	nted		_	—					
0Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	er 5 bits of th	e Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	_	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0-00 000x	0-00 000u
Bank 1											
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	ts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signif	ficant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	a memory ad	dress pointe	er		•	•	•	xxxx xxxx	uuuu uuuu
85h	TRISA	—	—	—	PORTA Dat	a Direction F	Register			1 1111	1 1111
86h	TRISB	PORTB Dat	a Direction C	Control Regis	ster					1111 1111	1111 1111
87h	-	Unimpleme	nimplemented								—
88h	-	Unimpleme	nted		_	—					
89h	-	Unimpleme	nted								—
8Ah ^(1,2)	PCLATH	—	—	_	Write Buffer	for the uppe	er 5 bits of th	e Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	—	TOIE	RBIF	0-00 000x	0-00 000u				

Legend: x = unknown, u = unchanged, q = value depends on condition, – = unimplemented locations read as '0'. Shaded locations are unimplemented and read as '0'

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer Reset.

4: The IRP and RP1 bits are reserved on the PIC16C61, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0	•	•	•		•	•	•	•	•	•	
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	dule's registe	r						xxxx xxxx	uuuu uuuu
02h (1)	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
_{04h} (1)	FSR	Indirect dat	a memory ac	ldress pointe	er	1	I	I	1	xxxx xxxx	uuuu uuuu
05h	PORTA	—	—		xx xxxx	uu uuuu					
06h	PORTB	PORTB Da	ta Latch whe		xxxx xxxx	uuuu uuuu					
07h	PORTC	PORTC Da	ta Latch whe		xxxx xxxx	uuuu uuuu					
08h	_	Unimpleme	nted		_	_					
09h	—	Unimpleme	nted		—	—					
0Ah (1,2)	PCLATH	_	—	_	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	(6)	(6)	_		SSPIF	CCP1IF	TMR2IF	TMR1IF	00 0000	00 0000
0Dh	—	Unimpleme	nted							_	—
0Eh	TMR1L	Holding reg	ister for the l	east Signific	cant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	e 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	dule's registe	r						0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	us Serial Por	Receive Bu	Iffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						xxxx xxxx	uuuu uuuu
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h-1Fh	—	Unimpleme	nted			_	_				

TABLE 4-2: SPECIAL FUNCTION REGISTERS FOR THE PIC16C62/62A/R62

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The BOR bit is reserved on the PIC16C62, always maintain this bit set.

5: The IRP and RP1 bits are reserved on the PIC16C62/62A/R62, always maintain these bits clear.

6: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C62/62A/R62, always maintain these bits clear.

4-Z.	SPECIAL FUNCTION REGISTERS FOR THE FIC 10C02/02A								som.u)	
Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
							•			
INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
PCL	Program Co	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	z	DC	С	0001 1xxx	000q quuu
FSR	Indirect data	a memory ac	dress pointe	er					xxxx xxxx	uuuu uuuu
TRISA	—	PORTA Data Direction Register								11 1111
TRISB	PORTB Dat	ORTB Data Direction Register								1111 1111
TRISC	PORTC Dat	PORTC Data Direction Register								1111 1111
_	Unimpleme	nted		—	_					
_	Unimpleme	nted							—	—
PCLATH	—	—	—	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
PIE1	(6)	(6)	_	_	SSPIE	CCP1IE	TMR2IE	TMR1IE	00 0000	00 0000
—	Unimpleme	nted		•					—	—
PCON	—	_	-	_	—	—	POR	BOR ⁽⁴⁾	dd	uu
_	Unimpleme	nted							—	_
—	Unimpleme	nted							_	_
_	Unimpleme	Inimplemented								_
PR2	Timer2 Peri	ïmer2 Period Register							1111 1111	1111 1111
SSPADD	Synchronou	is Serial Port	t (I ² C mode)	Address Reg	gister				0000 0000	0000 0000
SSPSTAT	—	_	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
_	Unimpleme	nted							-	_
	Name INDF OPTION PCL STATUS FSR TRISA TRISB TRISC TRISC INTCON PIE1 INTCON PIE1 PCON PCON INTCON PE2 SSPADD	NameBit 7INDFAddressingOPTIONRBPUPCLProgram CoSTATUSIRP(5)FSRIndirect dataTRISA—TRISBPORTB DataTRISCPORTC DataTRISCPORTC DataPCLATH—PIE1(6)PCON—PCONInimplemePCONInimplemePCONInimplemePCONInimplemePCONSpretroRR2SynchronouSSPSTAT—	NameBit 7Bit 6INDFAddressingINTEDGOPTIONRBPUINTEDGPCLProgram C	NameBit 7Bit 6Bit 5INDFAddressing till location uses contendOPTIONRBPUINTEDGTOCSPCLProgram Culter's (PC)Least SignSTATUSIRP ⁽⁵⁾ RP1 ⁽⁵⁾ RP0FSRIndirect datamemory astress pointsTRISA——PORTA DataTRISBPORTB DataDirection registerTRISBPORTC DataDirection registerTRISCPORTC DataDirection registerMinimplemetedIntel of 0Intel of 0PCLATH———PCLATHImage: Contended of 0Image: Contended of 0PIE1(6)(6)—INTCONGIEPEIEPIE1Image: Contended of 0Image: Contended of 0InimplemetedImage: Contended of 0Image: Contended of 0PCON—Image: Contended of 0Image: Contended of 0Image: Contended of 0Image: Contended of 0Image: Contended of 0PCONImage: Contended of 0Image: Contende of 0Image: Contended of 0Image: Contended of 0Image: Contende of 0Image: Contended of 0Image: Contended of 0Image: Contende of 0Image: Contended of 0Image: Contended of 0Image: Contende of 0Image: Contende of 0Image: Contended of 0Imag	NameBit 7Bit 6Bit 5Bit 4INDFAddressing this location uses contents of FSR to OPTIONINTEDGTOCSTOSEPCLProgram Councer's (PC)Least Significant ByteSTATUSIRP(5)RP1(5)RP0TOFSRIndirect data memory address pointerTOFSRIndirect data memory address pointerTOTRISA——PORTA Data Direction RTRISBPORTB Data Direction registerTOTRISCPORTC Data Direction registerTOMiniplemented———Unimplemented—PCLATH——(6)(6)—PIE1(6)(6)—UnimplementedPCON———Unimplemeted—Unimplemeted—Unimplemeted—Unimplemeted—UnimplemetedPR2Timer2 Pertor RegisterSSPADDSynchronous Serial Port (I ² C mode) Address RegisterSSPSTAT———D/ĀP	NameBit 7Bit 6Bit 5Bit 4Bit 3INDFAddressing this location uses contents of FSR to address dataOPTIONRBPUINTEDGTOCSTOSEPSAPCLProgram Counter's (PC)Least Significant BytePSAPCLIRP(5)RP1(5)RP0TOPDSTATUSIRP(5)RP1(5)RP0TOPDFSRIndirect dataPORTA Data Direction RegisterPORTA DataPORTATRISAPORTA DataPORTAPOTRISBPORTC DataDirection RegisterPORTAPOTRISCPORTC DataDirection RegisterPOPDTRISCPORTC DataDirection RegisterPOPDPCLATHPORDRBIEPCLATHINTERBIERBIEPIE1(6)(6)SSPIEPCONSSPIEUnimplementedUnimplementedUnimplementedUnimplementedUnimplementedUnimplementedPR2Timer2 Perior RegisterSPIADAddress Register-SSPADDSynchronox Serial Port (I ² C mode)PSS </td <td>NameBit 7Bit 6Bit 5Bit 4Bit 3Bit 2INDFAddressing this locationTOCSFSR to address data memory (normal constraints)OPTIONRBPUINTEDGTOCSTOSEPSAPS2PCLProgram Counter's (PC)Least Significant BytePSAPS2STATUSIRP(9)RP1(9)RP0TOPDZSTATUSIRP(9)RP1(5)RP0TOPDZSTATUSIRP(9)RP1(5)RP0TOPDZSTATUSIndirect dataPORTA Data Direction RegisterTTRISA——PORTA Data Direction RegisterTRISBPORTE Data Direction RegisterFTOPDPCLATHPORTC Data Direction RegisterTOFPCLATH———Vrite Buffer the upper 5 bits of the interper for the upper 5 bits of the interper for</td> <td>NameBit 7Bit 6Bit 5Bit 4Bit 3Bit 2Bit 1INDFAddressing this location uses contents of FSR to address data memory (not a physical OPTIONRBPUINTEDGTOCSTOSEPSAPS2PS1OPTIONRBPUINTEDGTOCSTOSEPSAPS2PS1PCLProgram Counter's (PC)Least Significant ByteSTATUSIRP(9)RP1(9)RP0TOPDZDCFSRIndirect data memory address pointerTRISA——PORTA Data Direction RegisterTRISA——PORTA Data Direction RegisterTRISAPORTB Data Direction RegisterTRISAPORTC Data Direction Register—Unimplementer—UnimplementerPCLATH——Mrite Buffer for the upper 5 bits of the Program CINTCONGIEPEIETOIEINTERBIETOIFINTERBIETOIFINTCONGIEPEIETOIEINTEPCIATH————Unimplementer———PCON————Muineplementer————Unimplementer———Unimplementer———Unimplementer——Unimplementer——Unimplementer—Unimplementer—Synchroous Serial Port (I²C mode) Address Register<</td> <td>NameBit 7Bit 6Bit 5Bit 4Bit 3Bit 2Bit 1Bit 0INDFAddressing Hills location with a location w</td> <td>Name Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Value on: POR, BOR INDF Addressing to call t</td>	NameBit 7Bit 6Bit 5Bit 4Bit 3Bit 2INDFAddressing this locationTOCSFSR to address data memory (normal constraints)OPTIONRBPUINTEDGTOCSTOSEPSAPS2PCLProgram Counter's (PC)Least Significant BytePSAPS2STATUSIRP(9)RP1(9)RP0TOPDZSTATUSIRP(9)RP1(5)RP0TOPDZSTATUSIRP(9)RP1(5)RP0TOPDZSTATUSIndirect dataPORTA Data Direction RegisterTTRISA——PORTA Data Direction RegisterTRISBPORTE Data Direction RegisterFTOPDPCLATHPORTC Data Direction RegisterTOFPCLATH———Vrite Buffer the upper 5 bits of the interper for	NameBit 7Bit 6Bit 5Bit 4Bit 3Bit 2Bit 1INDFAddressing this location uses contents of FSR to address data memory (not a physical OPTIONRBPUINTEDGTOCSTOSEPSAPS2PS1OPTIONRBPUINTEDGTOCSTOSEPSAPS2PS1PCLProgram Counter's (PC)Least Significant ByteSTATUSIRP(9)RP1(9)RP0TOPDZDCFSRIndirect data memory address pointerTRISA——PORTA Data Direction RegisterTRISA——PORTA Data Direction RegisterTRISAPORTB Data Direction RegisterTRISAPORTC Data Direction Register—Unimplementer—UnimplementerPCLATH——Mrite Buffer for the upper 5 bits of the Program CINTCONGIEPEIETOIEINTERBIETOIFINTERBIETOIFINTCONGIEPEIETOIEINTEPCIATH————Unimplementer———PCON————Muineplementer————Unimplementer———Unimplementer———Unimplementer——Unimplementer——Unimplementer—Unimplementer—Synchroous Serial Port (I ² C mode) Address Register<	NameBit 7Bit 6Bit 5Bit 4Bit 3Bit 2Bit 1Bit 0INDFAddressing Hills location with a location w	Name Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Value on: POR, BOR INDF Addressing to call t

TABLE 4-2: SPECIAL FUNCTION REGISTERS FOR THE PIC16C62/62A/R62 (Cont.'d)

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The BOR bit is reserved on the PIC16C62, always maintain this bit set.

5: The IRP and RP1 bits are reserved on the PIC16C62/62A/R62, always maintain these bits clear.

6: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C62/62A/R62, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physica	l register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	dule's registe	r						XXXX XXXX	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	то	PD	z	DC	с	0001 1xxx	000g guuu
04h (1)	FSR	Indirect data	a memory ac	dress pointe	ər	1				xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	PORTA Dat	a Latch wher	n written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Dat	ta Latch whe	n written: PC	ORTB pins wl	nen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Dat	ta Latch whe	n written: PO	ORTC pins w	hen read				xxxx xxxx	uuuu uuuu
08h	_	Unimpleme	nted		_	_					
09h	_	Unimpleme	nted		_	_					
0Ah (1,2)	PCLATH	_	_	ounter	0 0000	0 0000					
0Bh ⁽¹⁾	INTCON	GIE	- - Write Buffer for the upper 5 bits of the Program Counter GIE PEIE TOIE INTE RBIE TOIF INTF RBIF								0000 000u
0Ch	PIR1	(5)	(5)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	_	_	_		—	—	—	CCP2IF	0	0
0Eh	TMR1L	Holding reg	ister for the l	_east Signifi	cant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	ne 16-bit TMI	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	dule's registe	r	•		•	•	•	0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	us Serial Por	t Receive Bu	uffer/Transmit	Register			•	xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						XXXX XXXX	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						XXXX XXXX	uuuu uuuu
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Trai	SART Transmit Data Register							0000 0000	0000 0000
1Ah	RCREG	USART Red	ceive Data R	egister						0000 0000	0000 0000
1Bh	CCPR2L	Capture/Co	mpare/PWM	2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Co	mpare/PWM	2 (MSB)						xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	_	—	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
1Eh-1Fh	—	Unimpleme	nted					ł	ł	_	—

TABLE 4-3: SPECIAL FUNCTION REGISTERS FOR THE PIC16C63/R63

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The IRP and RP1 bits are reserved on the PIC16C63/R63, always maintain these bits clear.

5: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C63/R63, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1	•					•			•		
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address dat	a memory (n	ot a physica	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sig	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect dat	a memory ac	dress point	er					xxxx xxxx	uuuu uuuu
85h	TRISA	_	—	PORTA Dat	ta Direction R	Register				11 1111	11 1111
86h	TRISB	PORTB Da	ta Direction F	Register						1111 1111	1111 1111
87h	TRISC	PORTC Da	ta Direction I	Register						1111 1111	1111 1111
88h	_	Unimpleme	nted		_	_					
89h	—	Unimpleme	nted		_	_					
8Ah (1,2)	PCLATH	_	_	ounter	0 0000	0 0000					
8Bh ⁽¹⁾	INTCON	GIE	PEIE	RBIF	0000 000x	0000 000u					
8Ch	PIE1	(5)	(5) (5) RCIE TXIE SSPIE CCP1IE TMR2IE TMR1IE							0000 0000	0000 0000
8Dh	PIE2	_	—		_	_	_	_	CCP2IE	0	0
8Eh	PCON	_	—	-	_	-	_	POR	BOR	dd	uu
8Fh	_	Unimpleme	nted							_	_
90h	_	Unimpleme	nted							_	—
91h	_	Unimpleme	nted							_	_
92h	PR2	Timer2 Peri	iod Register							1111 1111	1111 1111
93h	SSPADD	Synchronou	us Serial Por	t (I ² C mode)	Address Reg	gister				0000 0000	0000 0000
94h	SSPSTAT	_	_	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
95h	—	Unimpleme	nted							—	—
96h	—	Unimpleme	nted							-	—
97h	—	Unimpleme	nted							—	—
98h ⁽²⁾	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h (2)	SPBRG	Baud Rate	aud Rate Generator Register								0000 0000
9Ah	_	Unimpleme	nted							_	_
9Bh	_	Unimpleme	nted							_	_
9Ch	_	Unimpleme	nted							_	_
9Dh	—	Unimpleme	nted							_	_
9Eh	_	Unimpleme	nted							_	_
9Fh	—	Unimpleme	nted							_	—

TABLE 4-3: SPECIAL FUNCTION REGISTERS FOR THE PIC16C63/R63 (Cont.'d)

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The IRP and RP1 bits are reserved on the PIC16C63/R63, always maintain these bits clear.

5: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C63/R63, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0						•	•			•	
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	ts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	dule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signif	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
_{04h} (1)	FSR	Indirect data	a memory ac	ldress pointe	er	1	I	I	I	xxxx xxxx	uuuu uuuu
05h	PORTA	_	PORTA Data Latch when written: PORTA pins when read								uu uuuu
06h	PORTB	PORTB Dat	RTB Data Latch when written: PORTB pins when read								uuuu uuuu
07h	PORTC	PORTC Da	TC Data Latch when written: PORTC pins when read								uuuu uuuu
08h	PORTD	PORTD Da	ta Latch whe		xxxx xxxx	uuuu uuuu					
09h	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	uuu
0Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF	(6)	_	_	SSPIF	CCP1IF	TMR2IF	TMR1IF	00 0000	00 0000
0Dh	_	Unimpleme	nted							_	—
0Eh	TMR1L	Holding reg	ister for the L	east Signific	cant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the N	Most Signific	ant Byte of th	e 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	dule's registe	r			•	•	•	0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	us Serial Port	Receive Bu	ffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	apture/Compare/PWM1 (LSB)							xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						XXXX XXXX	uuuu uuuu
17h	CCP1CON	—	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h-1Fh	_	Unimpleme	nted			—	—				

TABLE 4-4: SPECIAL FUNCTION REGISTERS FOR THE PIC16C64/64A/R64

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The BOR bit is reserved on the PIC16C64, always maintain this bit set.

5: The IRP and RP1 bits are reserved on the PIC16C64/64A/R64, always maintain these bits clear.

6: PIE1<6> and PIR1<6> are reserved on the PIC16C64/64A/R64, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1			•			•		•			
80h ⁽¹⁾	INDF	Addressing	this location	uses conte	nts of FSR to	address dat	a memory (n	ot a physica	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sig	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	z	DC	с	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect dat	a memory ac	Idress point	er			•	•	xxxx xxxx	uuuu uuuu
85h	TRISA	_	_		11 1111	11 1111					
86h	TRISB	PORTB Da	ta Direction I		1111 1111	1111 1111					
87h	TRISC	PORTC Da	PORTC Data Direction Register								1111 1111
88h	TRISD	PORTD Da	PORTD Data Direction Register								1111 1111
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Da	ta Direction I	Bits	0000 -111	0000 -111
8Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	PSPIE	(6)	_	-	SSPIE	CCP1IE	TMR2IE	TMR1IE	00 0000	00 0000
8Dh	_	Unimpleme	nted					1		_	_
8Eh	PCON	_	_	_	-	_	_	POR	BOR ⁽⁴⁾	dd	uu
8Fh	_	Unimpleme	nted					•		_	—
90h	_	Unimpleme	nted							_	_
91h	_	Unimpleme	Jnimplemented								_
92h	PR2	Timer2 Peri	iod Register							1111 1111	1111 1111
93h	SSPADD	Synchronou	us Serial Por	t (I ² C mode)	Address Reg	gister				0000 0000	0000 0000
94h	SSPSTAT	—		D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
95h-9Fh	_	Unimpleme	nted				_	_			

TABLE 4-4: SPECIAL FUNCTION REGISTERS FOR THE PIC16C64/64A/R64 (Cont.'d)

Legend: x = unknown, u = unchanged, q = value depends on condition, – = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The BOR bit is reserved on the PIC16C64, always maintain this bit set.

5: The IRP and RP1 bits are reserved on the PIC16C64/64A/R64, always maintain these bits clear.

6: PIE1<6> and PIR1<6> are reserved on the PIC16C64/64A/R64, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physica	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	dule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
03h (1)	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	z	DC	с	0001 1xxx	000g guuu
04h ⁽¹⁾	FSR	Indirect data	a memory ac	dress pointe	er	1				xxxx xxxx	uuuu uuuu
05h	PORTA	_	—	PORTA Dat	ta Latch wher	n written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Dat	ta Latch whe	n written: PO	ORTB pins wl	hen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Da	ta Latch whe	en written: PO	ORTC pins w	hen read				XXXX XXXX	uuuu uuuu
08h	PORTD	PORTD Da	ta Latch whe	en written: PO	ORTD pins w	hen read				xxxx xxxx	uuuu uuuu
09h	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	uuu
0Ah ^(1,2)	PCLATH	_									0 0000
0Bh ⁽¹⁾	INTCON	GIE									0000 000u
0Ch	PIR1	PSPIF	(6)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	_	_	—		_	—	—	CCP2IF	0	0
0Eh	TMR1L	Holding reg	ister for the I	Least Signifi	cant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	ne 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	dule's registe	r						0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	us Serial Por	t Receive Bu	uffer/Transmit	Register				XXXX XXXX	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						xxxx xxxx	uuuu uuuu
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	JSART Transmit Data Register							0000 0000	0000 0000
1Ah	RCREG	USART Red	SART Receive Data Register							0000 0000	0000 0000
1Bh	CCPR2L	Capture/Co	mpare/PWM	2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Co	mpare/PWM	2 (MSB)						xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	_	_	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
1Eh-1Fh	—	Unimpleme	nplemented								_

TABLE 4-5: SPECIAL FUNCTION REGISTERS FOR THE PIC16C65/65A/R65

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The BOR bit is reserved on the PIC16C65, always maintain this bit set.

5: The IRP and RP1 bits are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

6: PIE1<6> and PIR1<6> are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1	•							•	•		
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address dat	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program C	ounter's (PC)	Least Sig	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect dat	a memory ac	dress pointe	er					xxxx xxxx	uuuu uuuu
85h	TRISA	_	_	PORTA Dat	ta Direction R	egister				11 1111	11 1111
86h	TRISB	PORTB Da	ta Direction I	Register						1111 1111	1111 1111
87h	TRISC	PORTC Da	ta Direction I	Register						1111 1111	1111 1111
88h	TRISD	PORTD Da	ta Direction I	Register						1111 1111	1111 1111
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Da	ta Direction I	Bits	0000 -111	0000 -111
8Ah (1,2)	PCLATH	_	—	_	Write Buffer	for the uppe	er 5 bits of the	e Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	PSPIE	(6)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
8Dh	PIE2	_	_	_	_	_	_	_	CCP2IE	0	0
8Eh	PCON	_	_	_	_	_	_	POR	BOR ⁽⁴⁾	dd	uu
8Fh	_	Unimpleme	ented	<u></u>						_	—
90h	_	Unimpleme	ented							-	_
91h	—	Unimpleme	ented							-	—
92h	PR2	Timer2 Per	iod Register							1111 1111	1111 1111
93h	SSPADD	Synchrono	us Serial Por	t (I ² C mode)	Address Reg	jister				0000 0000	0000 0000
94h	SSPSTAT	—	—	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
95h	_	Unimpleme	ented	•	•			•		-	—
96h	—	Unimpleme	ented							-	—
97h	_	Unimpleme	ented				-			_	—
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generator R	egister						0000 0000	0000 0000
9Ah	_	Unimpleme	ented							_	—
9Bh	_	Unimpleme	ented							-	_
9Ch	_	Unimpleme	ented							-	_
9Dh	_	Unimpleme	ented							-	_
9Eh	_	Unimpleme	ented							—	—
9Fh	-	Unimpleme	ented							-	_

TABLE 4-5: SPECIAL FUNCTION REGISTERS FOR THE PIC16C65/65A/R65 (Cont.'d)

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: The BOR bit is reserved on the PIC16C65, always maintain this bit set.

5: The IRP and RP1 bits are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

6: PIE1<6> and PIR1<6> are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)									0000 0000
01h	TMR0	Timer0 mod	dule's registe	r						XXXX XXXX	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP	RP1	RP0	TO	PD	z	DC	с	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect data	a memory ac	dress pointe	er	1				xxxx xxxx	uuuu uuuu
05h	PORTA	—	—	PORTA Dat	ta Latch wher	n written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Dat	ta Latch whe	n written: PC	ORTB pins wi	nen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Dat	ta Latch whe	n written: P	ORTC pins w	hen read				XXXX XXXX	uuuu uuuu
08h (5)	PORTD	PORTD Dat	ta Latch whe	n written: PO	ORTD pins w	hen read				XXXX XXXX	uuuu uuuu
09h ⁽⁵⁾	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	uuu
0Ah (1,2)	PCLATH	_	_		Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
0Bh (1)	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽⁶⁾	(4)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	—	—			_	—	—	CCP2IF	0	0
0Eh	TMR1L	Holding reg	ister for the l	_east Signifi	cant Byte of t	he 16-bit TM	R1 register	ļ		xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	ne 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	dule's registe	r						0000 0000	0000 0000
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	us Serial Por	t Receive Bu	uffer/Transmit	Register				XXXX XXXX	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	СКР	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						XXXX XXXX	uuuu uuuu
17h	CCP1CON	—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Trai	nsmit Data R	egister						0000 0000	0000 0000
1Ah	RCREG	USART Red	ceive Data R	egister						0000 0000	0000 0000
1Bh	CCPR2L	Capture/Co	mpare/PWM	2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Co	mpare/PWM	2 (MSB)						xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	—	—	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
1Eh-1Fh	—	Unimpleme	nted							_	
											1

TABLE 4-6:SPECIAL FUNCTION REGISTERS FOR THE PIC16C66/67

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: PIE1<6> and PIR1<6> are reserved on the PIC16C66/67, always maintain these bits clear.

5: PORTD, PORTE, TRISD, and TRISE are not implemented on the PIC16C66, read as '0'.

6: PSPIF (PIR1<7>) and PSPIE (PIE1<7>) are reserved on the PIC16C66, maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1											
80h ⁽¹⁾	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	TOCS	TOSE PSA PS2 PS1 PS0 1						1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sig	nificant Byte		•			0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	a memory ac	dress pointe	er			1		xxxx xxxx	uuuu uuuu
85h	TRISA	_	—	PORTA Dat	ta Direction R	egister				11 1111	11 1111
86h	TRISB	PORTB Dat	ta Direction I	Register						1111 1111	1111 1111
87h	TRISC	PORTC Da	ta Direction I	Register						1111 1111	1111 1111
88h ⁽⁵⁾	TRISD	PORTD Da	ta Direction I	Register						1111 1111	1111 1111
89h (5)	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Da	ta Direction I	Bits	0000 -111	0000 -111
8Ah (1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	er 5 bits of the	e Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	PSPIE ⁽⁶⁾	(4)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
8Dh	PIE2	_	_	_	_	_	_	_	CCP2IE	0	0
8Eh	PCON	_	_	_	_	_	_	POR	BOR	dd	uu
8Fh	_	Unimplemented							-	_	
90h	_	Unimpleme	nted							_	_
91h	—	Unimplemented							-	—	
92h	PR2	Timer2 Period Register								1111 1111	1111 1111
93h	SSPADD	Synchronou	us Serial Por	t (I ² C mode)	Address Reg	ister				0000 0000	0000 0000
94h	SSPSTAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000 0000	0000 0000
95h	—	Unimpleme	nted	-						-	—
96h	—	Unimpleme	nted							-	—
97h	—	Unimpleme	nted	-						—	—
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generator R	egister						0000 0000	0000 0000
9Ah	_	Unimpleme	nted							_	_
9Bh	_	Unimpleme	nted							-	_
9Ch	_	Unimpleme	nted							_	_
9Dh	_	Unimpleme	nted							-	—
9Eh	_	Unimpleme	nted							—	_
9Fh	_	Unimpleme	nted							-	—

TABLE 4-6: SPECIAL FUNCTION REGISTERS FOR THE PIC16C66/67 (Cont.'d)

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: PIE1<6> and PIR1<6> are reserved on the PIC16C66/67, always maintain these bits clear.

5: PORTD, PORTE, TRISD, and TRISE are not implemented on the PIC16C66, read as '0'.

6: PSPIF (PIR1<7>) and PSPIE (PIE1<7>) are reserved on the PIC16C66, maintain these bits clear.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 2											
100h ⁽¹⁾	INDF	Addressing	0000 0000	0000 0000							
101h	TMR0	Timer0 mod	Timer0 module's register								
102h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
103h (1)	STATUS	IRP RP1 RP0 TO PD Z DC C								0001 1xxx	000q quuu
104h (1)	FSR	Indirect dat	a memory ac	dress pointe	er					xxxx xxxx	uuuu uuuu
105h	_	Unimpleme	nted							_	_
106h	PORTB	PORTB Da	ta Latch whe	n written: PO	ORTB pins wh	nen read				xxxx xxxx	uuuu uuuu
107h	—	Unimpleme	nted							—	—
108h	—	Unimpleme	nted							—	—
109h	_	Unimplemented								-	—
10Ah (1,2)	PCLATH	-								0 0000	0 0000
10Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 0000
10Ch- 10Fh	_	- Unimplemented									_
Bank 3											
180h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address dat	a memory (n	ot a physica	l register)	0000 0000	0000 0000
181h	OPTION	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
182h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
183h ⁽¹⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
184h ⁽¹⁾	FSR	Indirect dat	a memory ac	dress pointe	er					xxxx xxxx	uuuu uuuu
185h	—	Unimpleme	nted							_	—
186h	TRISB	PORTB Da	ta Direction I	Register						1111 1111	1111 1111
187h	—	Unimplemented								_	—
188h	—	Unimplemented								—	—
189h	—	Unimplemented								_	_
18Ah ^(1,2)	PCLATH	—	—	—	Write Buffer	for the uppe	r 5 bits of th	e Program C	ounter	0 0000	0 0000
18Bh (1)	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 0000
18Ch- 19Fh	_	Unimpleme	nted							-	_

TABLE 4-6: SPECIAL FUNCTION REGISTERS FOR THE PIC16C66/67 (Cont.'d)

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.

2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

4: PIE1<6> and PIR1<6> are reserved on the PIC16C66/67, always maintain these bits clear.

5: PORTD, PORTE, TRISD, and TRISE are not implemented on the PIC16C66, read as '0'.

6: PSPIF (PIR1<7>) and PSPIE (PIE1<7>) are reserved on the PIC16C66, maintain these bits clear.

4.2.2.1 STATUS REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The STATUS register, shown in Figure 4-9, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the TO and PD bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000u uluu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect the Z, C or DC bits from the STATUS register. For other instructions, not affecting any status bits, see the "Instruction Set Summary."

- Note 1: For those devices that do not use bits IRP and RP1 (STATUS<7:6>), maintain these bits clear to ensure upward compatibility with future products.
- Note 2: The C and DC bits operate as a borrow and digit borrow bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

FIGURE 4-9: STATUS REGISTER (ADDRESS 03h, 83h, 103h, 183h)

R/W-0	R/W-0 R/W-0 R-1 R-1 R/W-x R/W-x R/W-x	
IRP	RP1 RP0 TO PD Z DC C	R = Readable bit
bit7	bitO	W = Writable bit - n = Value at POR reset x = unknown
bit 7:	IRP: RegIster Bank Select bit (used for indirect addressing) 1 = Bank 2, 3 (100h - 1FFh) 0 = Bank 0, 1 (00h - FFh)	
bit 6-5:	RP1:RP0 : Register Bank Select bits (used for direct addressing) 11 = Bank 3 (180h - 1FFh) 10 = Bank 2 (100h - 17Fh) 01 = Bank 1 (80h - FFh) 00 = Bank 0 (00h - 7Fh) Each bank is 128 bytes.	
bit 4:	TO: Time-out bit 1 = After power-up, CLRWDT instruction, or SLEEP instruction 0 = A WDT time-out occurred	
bit 3:	PD : Power-down bit 1 = After power-up or by the CLRWDT instruction 0 = By execution of the SLEEP instruction	
bit 2:	 Z: Zero bit 1 = The result of an arithmetic or logic operation is zero 0 = The result of an arithmetic or logic operation is not zero 	
bit 1:	DC : Digit carry/borrow bit (for ADDWF, ADDLW, SUBLW, and SUBWF instructions) 1 = A carry-out from the 4th low order bit of the result occurred 0 = No carry-out from the 4th low order bit of the result	(For borrow the polarity is reversed).
bit 0:	 C: Carry/borrow bit (for ADDWF, ADDLW, SUBLW, and SUBWF instructions)(For b 1 = A carry-out from the most significant bit of the result occurred 0 = No carry-out from the most significant bit of the result Note: a subtraction is executed by adding the two's complement of the second of For rotate (RRF, RLF) instructions, this bit is loaded with either the high or b 	perand.

4.2.2.2 OPTION REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The OPTION register is a readable and writable register which contains various control bits to configure the TMR0/WDT prescaler, the external INT interrupt, TMR0, and the weak pull-ups on PORTB. Note: To achieve a 1:1 prescaler assignment for TMR0 register, assign the prescaler to the Watchdog Timer.

FIGURE 4-10: OPTION REGISTER (ADDRESS 81h, 181h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1					
RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0 bit0	R = Readable bit W = Writable bit				
							DILU	U = Unimplemented bit,				
								read as '0'				
								- n = Value at POR reset				
bit 7:	RBPU: POF											
	1 = PORTB				al port latch v							
				-	a port lator v	alues						
bit 6:	INTEDG: In 1 = Interrup											
	0 = Interrup											
bit 5:	TOCS: TMR	-	-									
DIC 5.	1 = Transition											
	0 = Internal			(CLKOUT)							
bit 4:	TOSE: TMR	0 Source E										
	1 = Increme											
	0 = Increme	ent on low-te	o-high tran	sition on RA	A4/T0CKI pir	Ì						
bit 3:	PSA: Prescaler Assignment bit											
	1 = Prescal											
	0 = Prescal	er is assign	ed to the T	imer0 mod	ule							
bit 2-0:	PS2:PS0: Prescaler Rate Select bits											
	Bit Value	TMR0 Ra	ate WDT	Rate								
	000	1:2	1:	1								
	001	1:4	1:									
	010	1:8	1:									
	011 100	1:16		8 16								
	100	1:32		32								
	110	1:12		64								
	111	1:25		128								

4.2.2.3 INTCON REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The INTCON Register is a readable and writable register which contains the various enable and flag bits for the TMR0 register overflow, RB port change and external RB0/INT pin interrupts. **Note:** Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

FIGURE 4-11: INTCON REGISTER (ADDRESS 0Bh, 8Bh, 10Bh 18Bh)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x		
GIE bit7	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF bit0	 R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset x = unknown 	
bit 7:	GIE: ⁽¹⁾ Global Interrupt Enable bit 1 = Enables all un-masked interrupts 0 = Disables all interrupts								
bit 6:	PEIE: ⁽²⁾ Peripheral Interrupt Enable bit 1 = Enables all un-masked peripheral interrupts 0 = Disables all peripheral interrupts								
bit 5:	1 = Enables t	TolE: TMR0 Overflow Interrupt Enable bit 1 = Enables the TMR0 overflow interrupt 0 = Disables the TMR0 overflow interrupt							
bit 4:	INTE: RB0/INT External Interrupt Enable bit 1 = Enables the RB0/INT external interrupt 0 = Disables the RB0/INT external interrupt								
bit 3:	RBIE: RB Port Change Interrupt Enable bit 1 = Enables the RB port change interrupt 0 = Disables the RB port change interrupt								
bit 2:	T0IF: TMR0 (1 = TMR0 reg 0 = TMR0 reg	gister ove	rflowed (mu	ust be clear	ed in softwa	re)			
bit 1:	INTF: RB0/IN 1 = The RB0/ 0 = The RB0/	/INT exter	nal interrup	ot occurred		ared in soft	ware)		
bit 0:	RBIF: RB Port Change Interrupt Flag bit 1 = At least one of the RB7:RB4 pins changed state (see Section 5.2 to clear the interrupt) 0 = None of the RB7:RB4 pins have changed state								
	For the PIC16C61/62/64/65, if an interrupt occurs while the GIE bit is being cleared, the GIE bit may unintentionally be re-enabled by the RETFIE instruction in the user's Interrupt Service Routine. Refer to Section 13.5 for a detailed description.								
2:	The PEIE bit	(bit6) is u	inimplemer	ited on the	PIC16C61, 1	ead as '0'.			
global		IE (INTCO						corresponding enable bit or the rupt flag bits are clear prior to	

4.2.2.4 PIE1 REGISTER

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the individual enable bits for the peripheral interrupts.

Bit PEIE (INTCON<6>) must be set to Note: enable any peripheral interrupt.

FIGURE 4-12: PIE1 REGISTER FOR PIC16C62/62A/R62 (ADDRESS 8Ch)

RW-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0				
_	—	_	—	SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit			
bit7 bit 7-6:	Deserved		intoin theor	hite close			bit0	 W = Writable bit U = Unimplemented bit, read as '0' n = Value at POR reset 			
	Reserved: Always maintain these bits clear.										
bit 5-4:	Unimpleme	Unimplemented: Read as '0'									
bit 3:	SSPIE : Synchronous Serial Port Interrupt Enable bit 1 = Enables the SSP interrupt 0 = Disables the SSP interrupt										
bit 2:	CCP1IE : Co 1 = Enables 0 = Disable	s the CCP1	interrupt	oit							
bit 1:	TMR2IE : TMR2 to PR2 Match Interrupt Enable bit 1 = Enables the TMR2 to PR2 match interrupt 0 = Disables the TMR2 to PR2 match interrupt										
bit 0:	TMR1IE : TM 1 = Enables 0 = Disable	s the TMR1	overflow in	nterrupt	t						

FIGURE 4-13: PIE1 REGISTER FOR PIC16C63/R63/66 (ADDRESS 8Ch)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
—	_	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit		
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset									
bit 7-6:	Reserved:	Always ma	aintain thes	e bits clear.						
bit 5:	RCIE: USART Receive Interrupt Enable bit 1 = Enables the USART receive interrupt 0 = Disables the USART receive interrupt									
bit 4:	TXIE: USART Transmit Interrupt Enable bit 1 = Enables the USART transmit interrupt 0 = Disables the USART transmit interrupt									
bit 3:	SSPIE : Syr 1 = Enable 0 = Disable	s the SSP i	nterrupt	Interrupt Er	able bit					
bit 2:	CCP1IE : C 1 = Enable 0 = Disable	s the CCP1	I interrupt	bit						
bit 1:	TMR2IE : TMR2 to PR2 Match Interrupt Enable bit 1 = Enables the TMR2 to PR2 match interrupt 0 = Disables the TMR2 to PR2 match interrupt									
bit 0:	TMR1IE: TMR1 Overflow Interrupt Enable bit 1 = Enables the TMR1 overflow interrupt 0 = Disables the TMR1 overflow interrupt									

FIGURE 4-14: PIE1 REGISTER FOR PIC16C64/64A/R64 (ADDRESS 8Ch)

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
PSPIE	—	—		SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit		
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset									
bit 7:	PSPIE: Parallel Slave Port Read/Write Interrupt Enable bit 1 = Enables the PSP read/write interrupt 0 = Disables the PSP read/write interrupt									
bit 6:	Reserved:	Reserved: Always maintain this bit clear.								
bit 5-4:	Unimplem	Unimplemented: Read as '0'								
bit 3:	SSPIE: Synchronous Serial Port Interrupt Enable bit 1 = Enables the SSP interrupt 0 = Disables the SSP interrupt									
bit 2:	1 = Enable	CCP1IE: CCP1 Interrupt Enable bit 1 = Enables the CCP1 interrupt 0 = Disables the CCP1 interrupt								
bit 1:	TMR2IE: TMR2 to PR2 Match Interrupt Enable bit 1 = Enables the TMR2 to PR2 match interrupt 0 = Disables the TMR2 to PR2 match interrupt									
bit 0:	TMR1IE : T 1 = Enable 0 = Disable	s the TMR1	overflow i	nterrupt	t					

FIGURE 4-15: PIE1 REGISTER FOR PIC16C65/65A/R65/67 (ADDRESS 8Ch)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
PSPIE bit7	—	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE bit0	R = Readable bit W = Writable bit U = Unimplemented bit,			
		read as '0' - n = Value at POR reset									
bit 7:	 PSPIE: Parallel Slave Port Read/Write Interrupt Enable bit 1 = Enables the PSP read/write interrupt 0 = Disables the PSP read/write interrupt 										
bit 6:	Reserved:	Always ma	intain this l	oit clear.							
bit 5:	1 = Enables	RCIE: USART Receive Interrupt Enable bit 1 = Enables the USART receive interrupt 0 = Disables the USART receive interrupt									
bit 4:	TXIE: USART Transmit Interrupt Enable bit 1 = Enables the USART transmit interrupt 0 = Disables the USART transmit interrupt										
bit 3:	SSPIE : Syr 1 = Enables 0 = Disable	s the SSP i	nterrupt	Interrupt Er	able bit						
bit 2:	CCP1IE: CCP1 Interrupt Enable bit 1 = Enables the CCP1 interrupt 0 = Disables the CCP1 interrupt										
bit 1:	TMR2IE : TMR2 to PR2 Match Interrupt Enable bit 1 = Enables the TMR2 to PR2 match interrupt 0 = Disables the TMR2 to PR2 match interrupt										
bit 0:	TMR1IE : TI 1 = Enables 0 = Disable	s the TMR1	overflow in	nterrupt	t						

4.2.2.5 PIR1 REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the individual flag bits for the peripheral interrupts.

Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-16: PIR1 REGISTER FOR PIC16C62/62A/R62 (ADDRESS 0Ch)

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0				
_	_	_	—	SSPIF	CCP1IF	TMR2IF	TMR1IF	R = Readable bit			
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset										
bit 7-6:	Reserved: Always maintain these bits clear.										
bit 5-4:	Unimplem	Unimplemented: Read as '0'									
bit 3:	SSPIF : Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive										
bit 2:	CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode										
bit 1:		to PR2 mat	ch occurre	· ·	bit cleared in so	ftware)					
bit 0:	TMR1IF : TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software) 0 = No TMR1 register overflow occurred										
globa	Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.										

FIGURE 4-17: PIR1 REGISTER FOR PIC16C63/R63/66 (ADDRESS 0Ch)

R/W-0	R/W-0	R-0 RCIF	R-0 TXIF	R/W-0 SSPIF	R/W-0 CCP1IF	R/W-0 TMR2IF	R/W-0 TMR1IF	R = Readable bit		
 pit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset									
bit 7-6:	Reserved: Always maintain these bits clear.									
bit 5:	RCIF: USART Receive Interrupt Flag bit 1 = The USART receive buffer is full (cleared by reading RCREG) 0 = The USART receive buffer is empty									
bit 4:	TXIF: USART Transmit Interrupt Flag bit 1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full									
bit 3:	SSPIF : Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive									
bit 2:	CCP1IF : CCP1 Interrupt Flag bit <u>Capture Mode</u> 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred <u>Compare Mode</u> 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred <u>PWM Mode</u> Unused in this mode									
bit 1:	TMR2IF : TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred									
bit 0:	TMR1IF : TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software) 0 = No TMR1 register overflow occurred									

R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 U-0 U-0 R/W-0 PSPIF CCP1IF TMR2IF TMR1IF = Readable bit SSPIF R W = Writable bit bit7 bit0 U = Unimplemented bit,read as '0' - n = Value at POR reset bit 7: PSPIF: Parallel Slave Port Interrupt Flag bit 1 = A read or a write operation has taken place (must be cleared in software) 0 = No read or write operation has taken place bit 6: Reserved: Always maintain this bit clear. Unimplemented: Read as '0' bit 5-4: SSPIF: Synchronous Serial Port Interrupt Flag bit bit 3: 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive CCP1IF: CCP1 Interrupt Flag bit bit 2: Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode bit 1: TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred bit 0: TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software) 0 = No TMR1 register occurred Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-18: PIR1 REGISTER FOR PIC16C64/64A/R64 (ADDRESS 0Ch)

FIGURE 4-19: PIR1 REGISTER FOR PIC16C65/65A/R65/67 (ADDRESS 0Ch)

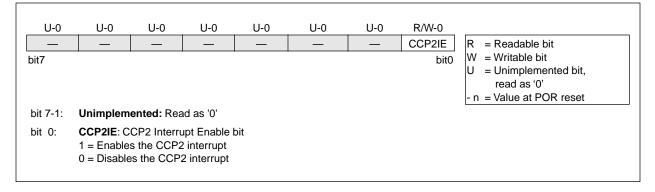
R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0			
PSPIF		RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	R = Readable bit		
bit7		bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset								
bit 7:	 PSPIF: Parallel Slave Port Interrupt Flag bit 1 = A read or a write operation has taken place (must be cleared in software) 0 = No read or write operation has taken place 									
bit 6:	Reserved:	Always ma	aintain this I	oit clear.						
bit 5:	RCIF: USA 1 = The US 0 = The US	SART receiv	/e buffer is	full (cleared	l by reading	RCREG)				
bit 4:	TXIF: USART Transmit Interrupt Flag bit 1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full									
bit 3:	 SSPIF: Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive 									
bit 2:	CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode									
bit 1:	1 = TMR2 1	TMR2IF : TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred								
bit 0:	TMR1IF : TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software) 0 = No TMR1 register overflow occurred									
globa		GIE (INTC						corresponding enable bit or the rupt flag bits are clear prior to		

4.2.2.6 **PIE2 REGISTER**

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the CCP2 interrupt enable bit.

FIGURE 4-20: PIE2 REGISTER (ADDRESS 8Dh)



4.2.2.7 PIR2 REGISTER

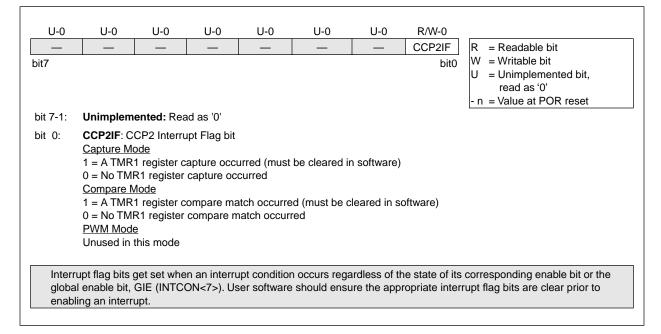
Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the CCP2 interrupt flag bit.

Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-21: PIR2 REGISTER (ADDRESS 0Dh)



4.2.2.8 PCON REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Power Control register (PCON) contains a flag bit to allow differentiation between a Power-on Reset to an external MCLR reset or WDT reset. Those devices with brown-out detection circuitry contain an additional bit to differentiate a Brown-out Reset condition from a Power-on Reset condition. Note: BOR is unknown on Power-on Reset. It must then be set by the user and checked on subsequent resets to see if BOR is clear, indicating a brown-out has occurred. The BOR status bit is a "don't care" and is not necessarily predictable if the brown-out circuit is disabled (by clearing the BODEN bit in the Configuration word).

FIGURE 4-22: PCON REGISTER FOR PIC16C62/64/65 (ADDRESS 8Eh)

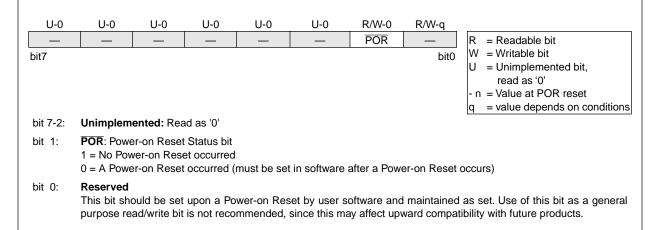
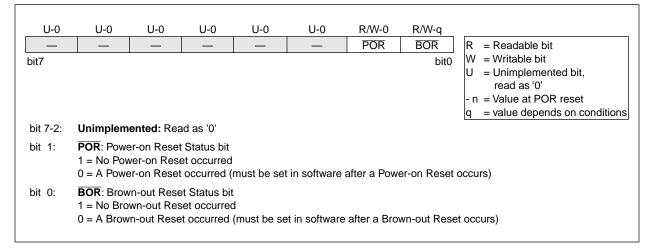


FIGURE 4-23: PCON REGISTER FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67 (ADDRESS 8Eh)



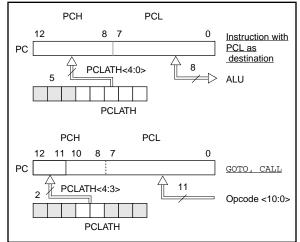
4.3 PCL and PCLATH

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The upper bits (PC<12:8>) are not readable, but are indirectly writable through the PCLATH register. On any reset, the upper bits of the PC will be cleared. Figure 4-24 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 4-24: LOADING OF PC IN DIFFERENT SITUATIONS



4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 word block). Refer to the application note *"Implementing a Table Read"* (AN556).

4.3.2 STACK

The PIC16CXX family has an 8 deep x 13-bit wide hardware stack. The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or a POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

- Note 1: There are no status bits to indicate stack overflows or stack underflow conditions.
- Note 2: There are no instructions mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW, and RETFIE instructions, or the vectoring to an interrupt address

4.4 Program Memory Paging

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PIC16C6X devices are capable of addressing a continuous 8K word block of program memory. The CALL and GOTO instructions provide only 11 bits of address to allow branching within any 2K program memory page. When doing a CALL or GOTO instruction the upper two bits of the address are provided by PCLATH<4:3>. When doing a CALL or GOTO instruction, the user must ensure that the page select bits are programmed so that the desired program memory page is addressed. If a return from a CALL instruction (or interrupt) is executed, the entire 13-bit PC is pushed onto the stack. Therefore, manipulation of the PCLATH<4:3> bits are not required for the return instructions (which POPs the address from the stack).

Note: PIC16C6X devices with 4K or less of program memory ignore paging bit PCLATH<4>. The use of PCLATH<4> as a general purpose read/write bit is not recommended since this may affect upward compatibility with future products. Example 4-1 shows the calling of a subroutine in page 1 of the program memory. This example assumes that the PCLATH is saved and restored by the interrupt service routine (if interrupts are used).

EXAM	PLE 4-1:	CALL OF A SUBROUTINE IN PAGE 1 FROM PAGE 0				
ORG 0x	500					
BSF	pclath,3	;Select page 1 (800h-FFFh)				
BCF	pclath,4	;Only on >4K devices				
CALL	SUB1_P1	;Call subroutine in				
	:	;page 1 (800h-FFFh)				
	:					
	:					
ORG 0x	900					
SUB1_P	1:	;called subroutine				
	:	;page 1 (800h-FFFh)				
	:					
RETURN		<pre>;return to Call subroutine ;in page 0 (000h-7FFh)</pre>				

4.5 Indirect Addressing, INDF and FSR Registers

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

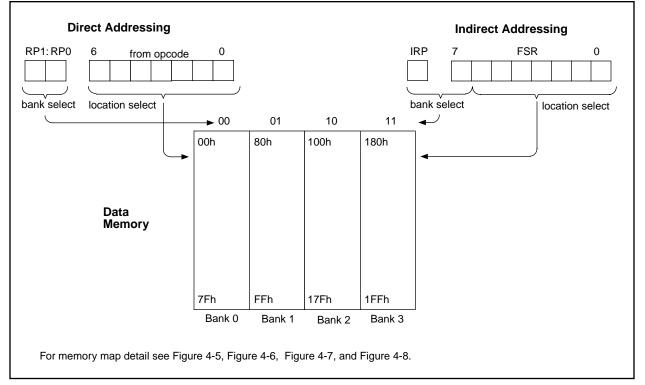
Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses the register pointed to by the File Select Register, FSR. Reading the INDF register itself indirectly (FSR = '0') will produce 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-25.

A simple program to clear RAM location 20h-2Fh using indirect addressing is shown in Example 4-2.

EXAMPLE 4-2: INDIRECT ADDRESSING

NEXT	movlw movwf clrf incf	FSR INDF	;initialize pointer ; to RAM ;clear INDF register ;inc pointer
	btfss	FSR,4	;all done?
	goto	NEXT	;NO, clear next
CONTINUE			
	:		;YES, continue

FIGURE 4-25: DIRECT/INDIRECT ADDRESSING



NOTES:

5.0 I/O PORTS

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Some pins for these I/O ports are multiplexed with an alternate function(s) for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

All devices have a 6-bit wide PORTA, except for the PIC16C61 which has a 5-bit wide PORTA.

Pin RA4/T0CKI is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as output or input.

Setting a bit in the TRISA register puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISA register puts the contents of the output latch on the selected pin.

Reading PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified, and then written to the port data latch.

Pin RA4 is multiplexed with Timer0 module clock input to become the RA4/T0CKI pin.

EXAMPLE 5-1: INITIALIZING PORTA

BCF	STATUS,	RPO ;	
BCF	STATUS,	RP1 ;	PIC16C66/67 only
CLRF	PORTA	;	Initialize PORTA by
		;	clearing output
		;	data latches
BSF	STATUS,	RPO ;	Select Bank 1
MOVLW	0xCF	;	Value used to
		;	initialize data
		;	direction
MOVWF	TRISA	;	Set RA<3:0> as inputs
		;	RA<5:4> as outputs
		;	TRISA<7:6> are always
		;	read as '0'.

FIGURE 5-1: BLOCK DIAGRAM OF THE RA3:RA0 PINS AND THE RA5

PIN

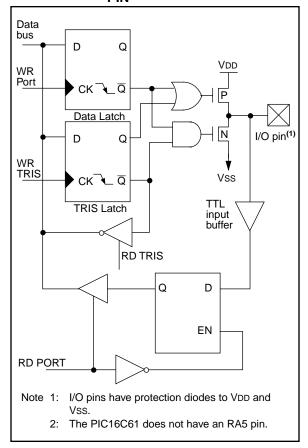


FIGURE 5-2: BLOCK DIAGRAM OF THE RA4/T0CKI PIN

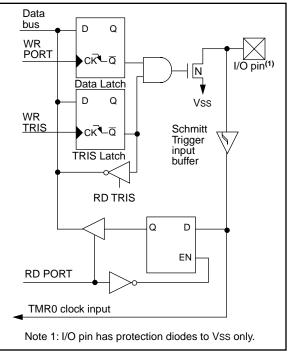


TABLE 5-1: PORTA FUNCTIONS

Name	Bit#	Buffer Type	Function
RA0	bit0	TTL	Input/output
RA1	bit1	TTL	Input/output
RA2	bit2	TTL	Input/output
RA3	bit3	TTL	Input/output
RA4/T0CKI	bit4	ST	Input/output or external clock input for Timer0. Output is open drain type.
RA5/ <u>SS</u> (1)	bit5	TTL	Input/output or slave select input for synchronous serial port.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: The PIC16C61 does not have PORTA<5> or TRISA<5>, read as '0'.

TABLE 5-2: REGISTERS/BITS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
05h	PORTA		_	RA5 ⁽¹⁾	RA4	RA3	RA2	RA1	RA0	xx xxxx	uu uuuu
85h	TRISA	_	_	PORTA Data	Direction Re	11 1111	11 1111				

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA. Note 1: PORTA<5> and TRISA<5> are not implemented on the PIC16C61, read as '0'.

5.2 PORTB and TRISB Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is TRISB. Setting a bit in the TRISB register puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISB register puts the contents of the output latch on the selected pin(s).

EXAMPLE 5-2: INITIALIZING PORTB

BCF	STATUS, RPO	;
CLRF	PORTB	; Initialize PORTB by
		; clearing output
		; data latches
BSF	STATUS, RPO	; Select Bank 1
MOVLW	0xCF	; Value used to
		; initialize data
		; direction
MOVWF	TRISB	; Set RB<3:0> as inputs
		; RB<5:4> as outputs
		; RB<7:6> as inputs

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit $\overline{\text{RBPU}}$ (OPTION<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are also disabled on a Power-on Reset.

Four of PORTB's pins, RB7:RB4, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are OR'ed together to generate the RB port change interrupt with flag bit RBIF (INTCON<0>).

This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB. This will end the mismatch condition.
- b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition, and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a keypad and make it possible for wake-up on key-depression. Refer to the Embedded Control Handbook, Application Note, *"Implementing Wake-up on Key Stroke" (AN552).*

Note:	For PIC16C61/62/64/65, if a change on the
	I/O pin should occur when a read operation
	is being executed (start of the Q2 cycle),
	then interrupt flag bit RBIF may not get set.

The interrupt on change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt on change feature.

FIGURE 5-3: BLOCK DIAGRAM OF THE RB7:RB4 PINS FOR PIC16C61/62/64/65

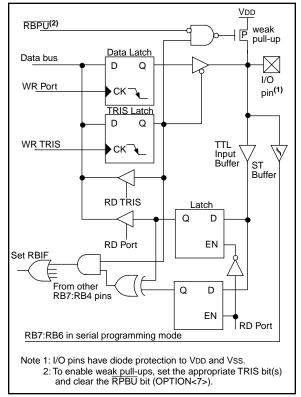


FIGURE 5-4: BLOCK DIAGRAM OF THE RB7:RB4 PINS FOR PIC16C62A/63/R63/64A/65A/ R65/66/67

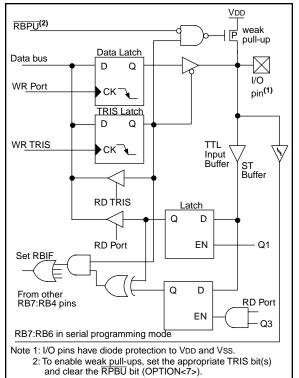
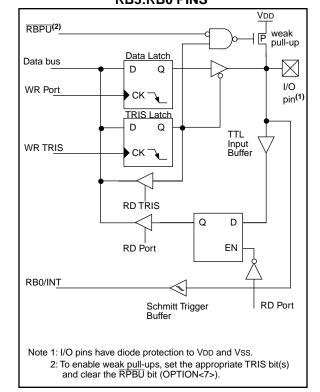


TABLE 5-3: PORTB FUNCTIONS

FIGURE 5-5: BLOCK DIAGRAM OF THE RB3:RB0 PINS



Name	Bit#	Buffer Type	Function
RB0/INT	bit0	TTL/ST ⁽¹⁾	Input/output pin or external interrupt input. Internal software programmable weak pull-up.
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up.
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up.
RB3	bit3	TTL	Input/output pin. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB6	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming clock.
RB7	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming data.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

2: This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 5-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
06h, 106h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX XXXX	uuuu uuuuu
86h, 186h	TRISB	PORTB D	ata Directior		1111 1111	1111 1111					
81h, 181h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTB.

5.3 PORTC and TRISC Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTC is an 8-bit wide bi-directional port. Each pin is individually configurable as an input or output through the TRISC register. PORTC is multiplexed with several peripheral functions (Table 5-5). PORTC pins have Schmitt Trigger input buffers.

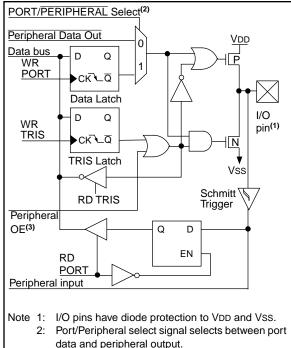
When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. Since the TRIS bit override is in effect while the peripheral is enabled, read-modify-write instructions (BSF, BCF, XORWF) with TRISC as destination should be avoided. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

EXAMPLE 5-3: INITIALIZING PORTC

BCF	STATUS, F	RPO ;	
BCF	STATUS, F	RP1 ;	PIC16C66/67 only
CLRF	PORTC	;	Initialize PORTC by
		;	clearing output
		;	data latches
BSF	STATUS, F	RPO ;	Select Bank 1
MOVLW	0xCF	;	Value used to
		;	initialize data
		;	direction
MOVWF	TRISC	;	Set RC<3:0> as inputs
		;	RC<5:4> as outputs
		;	RC<7:6> as inputs

PORTC FUNCTIONS FOR PIC16C62/64

FIGURE 5-6: PORTC BLOCK DIAGRAM



3: Peripheral OE (output enable) is only activated if peripheral select is active.

Name Bit# **Buffer Type** Function RC0/T1OSI/T1CKI ST bit0 Input/output port pin or Timer1 oscillator input or Timer1 clock input RC1/T1OSO ST Input/output port pin or Timer1 oscillator output bit1 RC2/CCP1 bit2 ST Input/output port pin or Capture1 input/Compare1 output/PWM1 output RC3 can also be the synchronous serial clock for both SPI and ^{2}C modes. RC3/SCK/SCL bit3 ST RC4 can also be the SPI Data In (SPI mode) or data I/O (²C mode). RC4/SDI/SDA ST bit4 RC5/SDO Input/output port pin or synchronous serial port data output ST bit5 RC6 bit6 ST Input/output port pin RC7 ST Input/output port pin bit7

Legend: ST = Schmitt Trigger input

TABLE 5-5:

News	D://	D	For a time
Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output or Timer1 clock input
RC1/T1OSI	bit1	ST	Input/output port pin or Timer1 oscillator input
RC2/CCP1	bit2	ST	Input/output port pin or Capture input/Compare output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and f^2C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (2 C mode).
RC5/SDO	bit5	ST	Input/output port pin or synchronous serial port data output
RC6	bit6	ST	Input/output port pin
RC7	bit7	ST	Input/output port pin

TABLE 5-6:PORTC FUNCTIONS FOR PIC16C62A/R62/64A/R64

Legend: ST = Schmitt Trigger input

TABLE 5-7: PORTC FUNCTIONS FOR PIC16C63/R63/65/65A/R65/66/67

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output or Timer1 clock input
RC1/T1OSI/CCP2	bit1	ST	Input/output port pin or Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and 2 C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O ($^{ m fC}$ mode).
RC5/SDO	bit5	ST	Input/output port pin or synchronous serial port data output
RC6/TX/CK	bit6	ST	Input/output port pin or USART Asynchronous Transmit, or USART Syn- chronous Clock
RC7/RX/DT	bit7	ST	Input/output port pin or USART Asynchronous Receive, or USART Syn- chronous Data

Legend: ST = Schmitt Trigger input

TABLE 5-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
07h	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
87h	TRISC	PORTC D	Data Direct	1111 1111	1111 1111						

Legend: x = unknown, u = unchanged.

5.4 PORTD and TRISD Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTD is an 8-bit port with Schmitt Trigger input buffers. Each pin is individually configurable as input or output.

PORTD can be configured as an 8-bit wide microprocessor port (parallel slave port) by setting control bit PSPMODE (TRISE<4>). In this mode, the input buffers are TTL.

FIGURE 5-7: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)

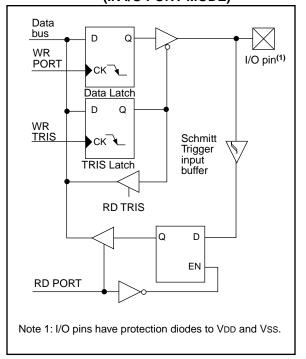


TABLE 5-9: PORTD FUNCTIONS

Name	Bit#	Buffer Type	Function
RD0/PSP0	bit0	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit0
RD1/PSP1	bit1	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit1
RD2/PSP2	bit2	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit2
RD3/PSP3	bit3	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit3
RD4/PSP4	bit4	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit4
RD5/PSP5	bit5	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit5
RD6/PSP6	bit6	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit6
RD7/PSP7	bit7	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit7

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Buffer is a Schmitt Trigger when in I/O mode, and a TTL buffer when in Parallel Slave Port mode.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	uuuu uuuu
88h	TRISD	PORTD I	Data Direc		1111 1111	1111 1111					
89h	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Da	ata Directio	n Bits	0000 -111	0000 -111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTD.

5.5 PORTE and TRISE Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTE has three pins, RE2/CS, RE1/WR, and RE0/RD which are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers.

I/O PORTE becomes control inputs for the microprocessor port when bit PSPMODE (TRISE<4>) is set. In this mode, the user must make sure that the TRISE<2:0> bits are set (pins are configured as digital inputs). In this mode the input buffers are TTL.

Figure 5-9 shows the TRISE register, which controls the parallel slave port operation and also controls the direction of the PORTE pins.

FIGURE 5-8: PORTE BLOCK DIAGRAM

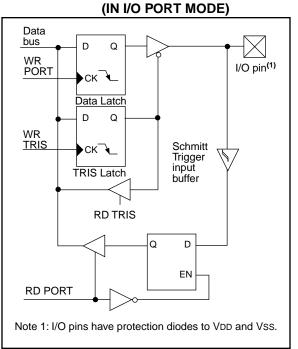


FIGURE 5-9: TRISE REGISTER (ADDRESS 89h)

R-0	R-0	R/W-0	R/W-0	U-0	R/W-1	R/W-1	R/W-1	
IBF bit7	OBF	IBOV	PSPMODE	_	bit2	bit1	bit0 bit0	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset
bit 7 :	IBF: Input 1 = A word 0 = No wor	l has been	received and	s waiting t	o be read by	the CPU		
bit 6:	1 = The ou	tput buffer	full Status bit still holds a pr has been read		ritten word			
bit 5:		occurred	•				(must be cle	ared in software)
bit 4:	PSPMODE 1 = Paralle 0 = Genera	I slave por		le Select t	bit			
bit 3:	Unimplem	ented: Re	ad as '0'					
bit 2:		tion Contro	ction Bits ol bit for pin RE	2/ CS				
bit 1:	Bit1 : Direc 1 = Input 0 = Output		ol bit for pin RE	1/WR				
bit 0:	Bit0 : Direc 1 = Input 0 = Output		ol bit for pin RE	0/RD				

Name	Bit#	Buffer Type	Function
RE0/RD	bit0	ST/TTL ⁽¹⁾	Input/output port pin or Read control input in parallel slave port mode.
			1 = Not a read operation
			0 = Read operation. The system reads the PORTD register (if chip selected)
RE1/WR	bit1	ST/TTL ⁽¹⁾	Input/output port pin or Write control input in parallel slave port mode. WR 1 = Not a write operation 0 = Write operation. The system writes to the PORTD register (if chip selected)
RE2/CS	bit2	ST/TTL ⁽¹⁾	Input/output port pin or Chip select control input in parallel slave port mode. CS 1 = Device is not selected 0 = Device is selected

TABLE 5-11: PORTE FUNCTIONS

Legend: ST = Schmitt Trigger input, TTL = TTL input Note 1: Buffer is a Schmitt Trigger when in I/O mode, and a TTL buffer when in Parallel Slave Port (PSP) mode.

TABLE 5-12: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
09h	PORTE	_	—	_	—	_	RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Da	ta Direction	Bits	0000 -111	0000 -111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells not used by PORTE.

5.6 I/O Programming Considerations

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

5.6.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (e.g., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (ex. BCF, BSF, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-4 shows the effect of two sequential read-modify-write instructions on an I/O port.

EXAMPLE 5-4: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

;Initial PORT settings: PORTB<7:4> Inputs ; PORTB<3:0> Outputs ;PORTB<7:6> have external pull-ups and are ;not connected to other circuitry

:

;

;

;					PORT	latch	PORT	pins
;								
	BCF	PORTB,	7	;	01pp	pppp	11pp	pppp
	BCF	PORTB,	б	;	10pp	pppp	11pp	pppp
	BSF	STATUS,	RP0	;				
	BCF	TRISB,	7	;	10pp	pppp	11pp	pppp
	BCF	TRISB,	б	;	10pp	pppp	10pp	pppp

;Note that the user may have expected the ;pin values to be 00pp pppp. The 2nd BCF ;caused RB7 to be latched as the pin value ;(high).

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

5.6.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-10). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

Q1| Q2| Q3| Q4' Q1| Q2| Q3| Q4' Q1' Q2| Q3| Q4' Q1| Q2| Q3| Q4' Note: This example shows a write to PORTB PC PC PC + 1 PC + 2 PC + 3 Instruction followed by a read from PORTB. MOVWF PORTB MOVF PORTB.W fetched NOP NOP write to PORTB Note that: data setup time = (0.25TCY - TPD) RB7:RB0 where TCY = instruction cycle Port pin TPD = propagation delay sampled here Therefore, at higher clock frequencies, Instruction NOP executed a write followed by a read may be prob-MOVWF PORTB MOVF PORTB.W lematic. write to PORTB

FIGURE 5-10: SUCCESSIVE I/O OPERATION

5.7 Parallel Slave Port

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTD operates as an 8-bit wide parallel slave port (microprocessor port) when control bit PSPMODE (TRISE<4>) is set. In slave mode it is asynchronously readable and writable by the external world through $\overline{\text{RD}}$ control input (RE0/ $\overline{\text{RD}}$) and $\overline{\text{WR}}$ control input pin (RE1/ $\overline{\text{WR}}$).

It can directly interface to an 8-bit microprocessor data bus. The external microprocessor can read or write the PORTD latch as an 8-bit latch. Setting PSPMODE enables port pin RE0/RD to be the RD input, RE1/WR to be the WR input and RE2/CS to be the CS (chip select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (set).

There are actually two 8-bit latches, one for data-out (from the PIC16/17) and one for data input. The user writes 8-bit data to PORTD data latch and reads data from the port pin latch (note that they have the same address). In this mode, the TRISD register is ignored since the microprocessor is controlling the direction of data flow.

A write to the PSP occurs when both the \overline{CS} and \overline{WR} lines are first detected low. When either the \overline{CS} or \overline{WR} lines become high (level triggered), then the Input Buffer Full status flag bit IBF (TRISE<7>) is set on the Q4 clock cycle, following the next Q2 cycle, to signal the write is complete (Figure 5-12). The interrupt flag bit PSPIF (PIR1<7>) is also set on the same Q4 clock cycle. IBF can only be cleared by reading the PORTD input latch. The input Buffer Overflow status flag bit IBOV (TRISE<5>) is set if a second write to the Parallel Slave Port is attempted when the previous byte has not been read out of the buffer.

A read from the PSP occurs when both the \overline{CS} and \overline{RD} lines are first detected low. The Output Buffer Full status flag bit OBF (TRISE<6>) is cleared immediately (Figure 5-13) indicating that the PORTD latch is waiting to be read by the external bus. When either the \overline{CS} or \overline{RD} pin becomes high (level triggered), the interrupt flag bit PSPIF is set on the Q4 clock cycle, following the next Q2 cycle, indicating that the read is complete. OBF remains low until data is written to PORTD by the user firmware.

When not in Parallel Slave Port mode, the IBF and OBF bits are held clear. However, if flag bit IBOV was previously set, it must be cleared in firmware.

An interrupt is generated and latched into flag bit PSPIF when a read or write operation is completed. PSPIF must be cleared by the user in firmware and the interrupt can be disabled by clearing the interrupt enable bit PSPIE (PIE1<7>).

FIGURE 5-11: PORTD AND PORTE AS A PARALLEL SLAVE PORT

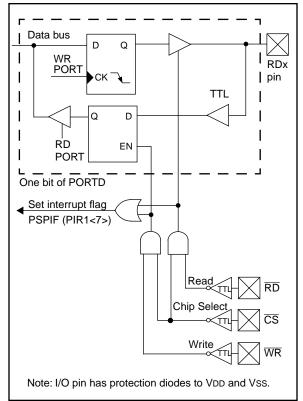
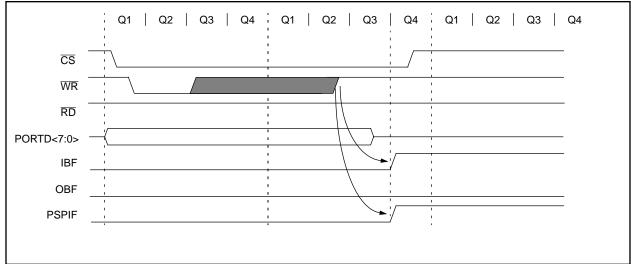


FIGURE 5-12: PARALLEL SLAVE PORT WRITE WAVEFORMS





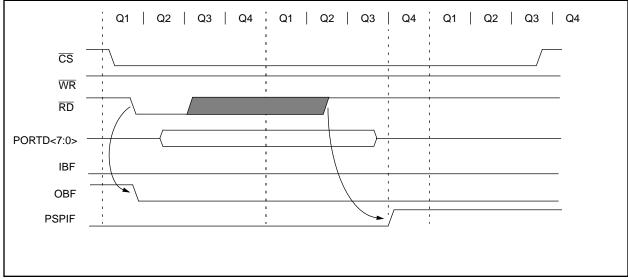


TABLE 5-13: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	PSP7	PSP6	PSP5	PSP4	PSP3	PSP2	PSP1	PSP0	xxxx xxxx	uuuu uuuu
09h	PORTE	_	_	—	_	_	RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE D	ata Directior	Bits	0000 -111	0000 -111
0Ch	PIR1	PSPIF	(1)	RCIF ⁽²⁾	TXIF ⁽²⁾	SSPIF	CCP1IF	TMR2IF	TRM1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE	(1)	RCIE ⁽²⁾	TXIE ⁽²⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by the PSP.

Note 1: These bits are reserved, always maintain these bits clear.

2: These bits are implemented on the PIC16C65/65A/R65/67 only.

6.0 OVERVIEW OF TIMER MODULES

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

All PIC16C6X devices have three timer modules except for the PIC16C61, which has one timer module. Each module can generate an interrupt to indicate that an event has occurred (i.e., timer overflow). Each of these modules are detailed in the following sections. The timer modules are:

- Timer0 module (Section 7.0)
- Timer1 module (Section 8.0)
- Timer2 module (Section 9.0)

6.1 <u>Timer0 Overview</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Timer0 module is a simple 8-bit overflow counter. The clock source can be either the internal system clock (Fosc/4) or an external clock. When the clock source is an external clock, the Timer0 module can be selected to increment on either the rising or falling edge.

The Timer0 module also has a programmable prescaler option. This prescaler can be assigned to either the Timer0 module or the Watchdog Timer. Bit PSA (OPTION<3>) assigns the prescaler, and bits PS2:PS0 (OPTION<2:0>) determine the prescaler value. TMR0 can increment at the following rates: 1:1 when the prescaler is assigned to Watchdog Timer, 1:2, 1:4, 1:8, 1:16, 1:32, 1:64, 1:128, and 1:256.

Synchronization of the external clock occurs after the prescaler. When the prescaler is used, the external clock frequency may be higher then the device's frequency. The maximum frequency is 50 MHz, given the high and low time requirements of the clock.

6.2 <u>Timer1 Overview</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer1 is a 16-bit timer/counter. The clock source can be either the internal system clock (Fosc/4), an external clock, or an external crystal. Timer1 can operate as either a timer or a counter. When operating as a counter (external clock source), the counter can either operate synchronized to the device or asynchronously to the device. Asynchronous operation allows Timer1 to operate during sleep, which is useful for applications that require a real-time clock as well as the power savings of SLEEP mode.

TImer1 also has a prescaler option which allows TMR1 to increment at the following rates: 1:1, 1:2, 1:4, and 1:8. TMR1 can be used in conjunction with the Capture/Compare/PWM module. When used with a CCP module, Timer1 is the time-base for 16-bit capture or 16-bit compare and must be synchronized to the device.

6.3 <u>Timer2 Overview</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer2 is an 8-bit timer with a programmable prescaler and a programmable postscaler, as well as an 8-bit Period Register (PR2). Timer2 can be used with the CCP module (in PWM mode) as well as the Baud Rate Generator for the Synchronous Serial Port (SSP). The prescaler option allows Timer2 to increment at the following rates: 1:1, 1:4, and 1:16.

The postscaler allows TMR2 register to match the period register (PR2) a programmable number of times before generating an interrupt. The postscaler can be programmed from 1:1 to 1:16 (inclusive).

6.4 <u>CCP Overview</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The CCP module(s) can operate in one of three modes: 16-bit capture, 16-bit compare, or up to 10-bit Pulse Width Modulation (PWM).

Capture mode captures the 16-bit value of TMR1 into the CCPRxH:CCPRxL register pair. The capture event can be programmed for either the falling edge, rising edge, fourth rising edge, or sixteenth rising edge of the CCPx pin.

Compare mode compares the TMR1H:TMR1L register pair to the CCPRxH:CCPRxL register pair. When a match occurs, an interrupt can be generated and the output pin CCPx can be forced to a given state (High or Low) and Timer1 can be reset. This depends on control bits CCPxM3:CCPxM0.

PWM mode compares the TMR2 register to a 10-bit duty cycle register (CCPRxH:CCPRxL<5:4>) as well as to an 8-bit period register (PR2). When the TMR2 register = Duty Cycle register, the CCPx pin will be forced low. When TMR2 = PR2, TMR2 is cleared to 00h, an interrupt can be generated, and the CCPx pin (if an output) will be forced high.

NOTES:

7.0 TIMER0 MODULE

Applicable Devices

61 62 62 R62 63 R63 64 64 R64 65 65 R65 66 67 The Timer0 module has the following features:

- 8-bit timer/counter register, TMR0
 - Read and write capability
- Interrupt on overflow from FFh to 00h
- 8-bit software programmable prescaler
- Internal or external clock select
 - Edge select for external clock

Figure 7-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing bit TOCS (OPTION<5>). In timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two instruction cycles (Figure 7-2 and Figure 7-3). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting bit T0CS. In this mode, Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the source edge select bit T0SE

(OPTION<4>). Clearing bit T0SE selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 7.2.

The prescaler is mutually exclusively shared between the Timer0 module and the Watchdog Timer. The prescaler assignment is controlled in software by control bit PSA (OPTION<3>). Clearing bit PSA will assign the prescaler to the Timer0 module. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4, ..., 1:256 are selectable. Section 7.3 details the operation of the prescaler.

7.1 <u>TMR0 Interrupt</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The TMR0 interrupt is generated when the register (TMR0) overflows from FFh to 00h. This overflow sets interrupt flag bit T0IF (INTCON<2>). The interrupt can be masked by clearing enable bit T0IE (INTCON<5>). Flag bit T0IF must be cleared in software by the TImer0 interrupt service routine before re-enabling this interrupt. The TMR0 interrupt cannot wake the processor from SLEEP since the timer is shut off during SLEEP. Figure 7-4 displays the Timer0 interrupt timing.

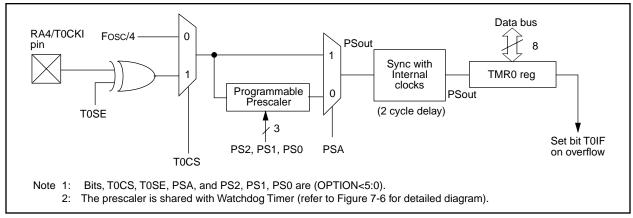


FIGURE 7-2: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALER

(Program	1	1						ا ا
Counter)	(PC-1	Y PC	X <u>PC+1</u>) <u>PC+2</u>	PC+3	X PC+4) PC+5	PC+6
nstruction Fetch		MOVWF TMR0	MOVF TMR0,W	MOVF TMR0,W	MOVF TMR0,W	MOVF TMR0,W	MOVF TMR0,W	1
	1	1	1	1	1	1	, , , , , , , , , , , , , , , , , , ,	1
TMR0	, το χ	Τ0+1 χ	Τ0+2 χ	NTO X	ΝΤΟ Χ	ΝΤΟ Χ	NT0+1 χ	NT0+2
	1	I.	. ▲	. ▲	A	. ▲	i ▲ i	A
Instruction	1	1	1	· .		1	ı ı	· ·
Executed	1	1	Write TMR0	Read TMR0	Read TMR0	Read TMR0	Read TMR0	Read TMR0

FIGURE 7-1: TIMER0 BLOCK DIAGRAM



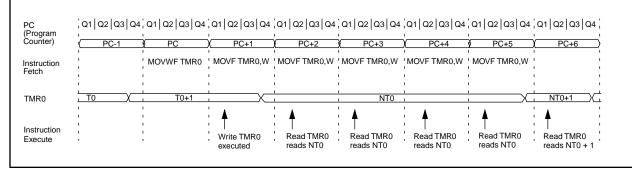
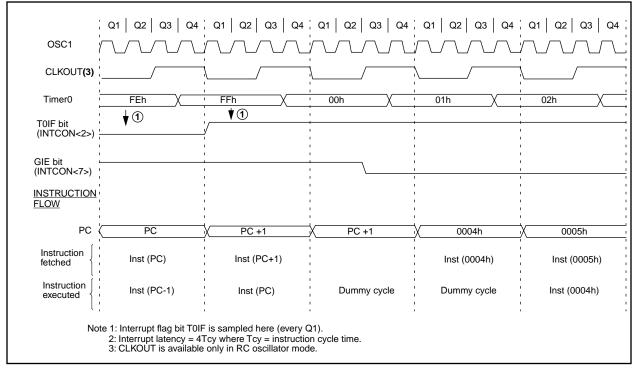


FIGURE 7-4: TMR0 INTERRUPT TIMING



7.2 Using Timer0 with External Clock

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

When an external clock input is used for Timer0, it must meet certain requirements. The requirements ensure the external clock can be synchronized with the internal phase clock (TOSC). Also, there is a delay in the actual incrementing of Timer0 after synchronization.

7.2.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of TOCKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 7-5). Therefore, it is necessary for TOCKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device. When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for TOCKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on TOCKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

7.2.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 7-5 shows the delay from the external clock edge to the timer incrementing.

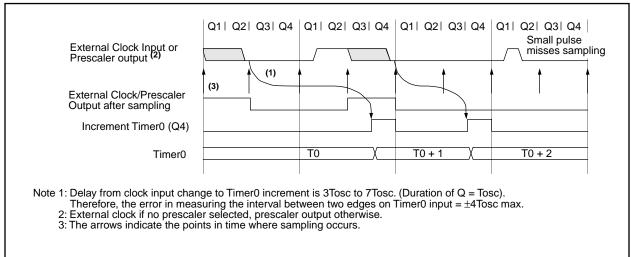


FIGURE 7-5: TIMER0 TIMING WITH EXTERNAL CLOCK

7.3 <u>Prescaler</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

An 8-bit counter is available as a prescaler for the Timer0 module or as a postscaler for the Watchdog Timer (WDT), respectively (Figure 7-6). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer, and vice-versa. The PSA and PS2:PS0 bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g. CLRF TMR0, MOVWF TMR0, BSF TMR0,bitx) will clear the prescaler count. When assigned to the Watchdog Timer, a CLRWDT instruction will clear the Watchdog Timer and the prescaler count. The prescaler is not readable or writable.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count, but will not change the prescaler assignment.

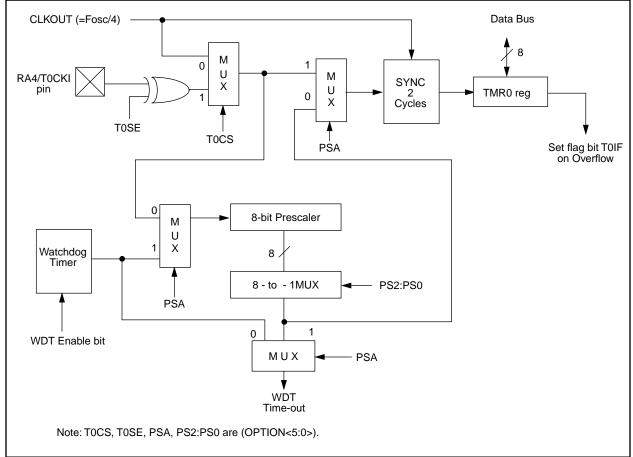


FIGURE 7-6: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER

7.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control, i.e., it can be changed "on the fly" during program execution.

Note:	To avoid an unintended device RESET, the
	following instruction sequence (shown in
	Example 7-1) must be executed when
	changing the prescaler assignment from
	Timer0 to the WDT. This precaution must
	be followed even if the WDT is disabled.

EXAMPLE 7-1: CHANGING PRESCALER (TIMER0→WDT)

	1)	BSF	STATUS, RPO	;Bank 1
Lines 2 and 3 do NOT have to	2)	MOVLW	b'xx0x0xxx'	;Select clock source and prescale value of
be included if the final desired	3)	MOVWF	OPTION_REG	;other than 1:1
prescale value is other than 1:1.	4)	BCF	STATUS, RPO	;Bank 0
If 1:1 is final desired value, then a temporary prescale value is	5)	CLRF	TMR0	;Clear TMR0 and prescaler
set in lines 2 and 3 and the final	6)	BSF	STATUS, RP1	;Bank 1
prescale value will be set in lines	7)	MOVLW	b'xxxx1xxx'	;Select WDT, do not change prescale value
10 and 11.	8)	MOVWF	OPTION_REG	;
	9)	CLRWDT		;Clears WDT and prescaler
	10)	MOVLW	b'xxxx1xxx'	;Select new prescale value and WDT
	11)	MOVWF	OPTION_REG	;
	12)	BCF	STATUS, RPO	;Bank 0

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 7-2.

EXAMPLE 7-2: CHANGING PRESCALER (WDT → TIMER0)

CLRWDT;Clear WDT and prescalerBSFSTATUS, RP0;Bank 1MOVLWb'xxxx0xxx';Select TMR0, new prescale value and clock sourceMOVWFOPTION_REG;BCFSTATUS, RP0;Bank 0

TABLE 7-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
01h, 101h	TMR0	Timer0	module's r	egister						xxxx xxxx	uuuu uuuu
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE ⁽¹⁾	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
81h, 181h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRISA	_	_	PORTA Data	Direction F	Register ⁽¹⁾				11 1111	11 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

Note 1: TRISA<5> and bit PEIE are not implemented on the PIC16C61, read as '0'.

NOTES:

8.0 TIMER1 MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer1 is a 16-bit timer/counter consisting of two 8-bit registers (TMR1H and TMR1L) which are readable and writable. Register TMR1 (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR1 Interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit TMR1IF (PIR1<0>). This interrupt can be enabled/disabled by setting/clearing the TMR1 interrupt enable bit TMR1IE (PIE1<0>).

Timer1 can operate in one of two modes:

- As a timer
- As a counter

The operating mode is determined by clock select bit, TMR1CS (T1CON<1>) (Figure 8-2).

In timer mode, Timer1 increments every instruction cycle. In counter mode, it increments on every rising edge of the external clock input.

Timer1 can be enabled/disabled by setting/clearing control bit TMR1ON (T1CON<0>).

Timer1 also has an internal "reset input". This reset can be generated by CCP1 or CCP2 (Capture/Compare/ PWM) module. See Section 10.0 for details. Figure 8-1 shows the Timer1 control register.

For the PIC16C62A/R62/63/R63/64A/R64/65A/R65/ R66/67, when the Timer1 oscillator is enabled (T1OSCEN is set), the RC1 and RC0 pins become inputs. That is, the TRISC<1:0> value is ignored.

For the PIC16C62/64/65, when the Timer1 oscillator is enabled (T1OSCEN is set), RC1 pin becomes an input, however the RC0 pin will have to be configured as an input by setting the TRISC<0> bit.

The Timer1 module also has a software programmable prescaler.

FIGURE 8-1: T1CON: TIMER1 CONTROL REGISTER (ADDRESS 10h)

U-0	U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0
bit7	T1CKPS1 T1CKPS0 T1OSCEN T1SYNC TMR1CS TMR1ON bit0 R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
bit 7-6:	Unimplemented: Read as '0'
bit 5-4:	T1CKPS1:T1CKPS0 : Timer1 Input Clock Prescale Select bits 11 = 1:8 Prescale value 10 = 1:4 Prescale value 01 = 1:2 Prescale value 00 = 1:1 Prescale value
bit 3:	T1OSCEN : Timer1 Oscillator Enable Control bit 1 = Oscillator is enabled 0 = Oscillator is shut off Note: The oscillator inverter and feedback resistor are turned off to eliminate power drain.
bit 2:	T1SYNC: Timer1 External Clock Input Synchronization Control bit
	TMR1CS = 1 1 = Do not synchronize external clock input 0 = Synchronize external clock input
	$\underline{\text{TMR1CS}} = 0$ This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.
bit 1:	TMR1CS : Timer1 Clock Source Select bit 1 = External clock from T1OSI (on the rising edge) (See pinouts for pin with T1OSI function) 0 = Internal clock (Fosc/4)
bit 0:	TMR10N: Timer1 On bit 1 = Enables Timer1 0 = Stops Timer1

8.1 <u>Timer1 Operation in Timer Mode</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer mode is selected by clearing bit TMR1CS (T1CON<1>). In this mode, the input clock to the timer is Fosc/4. The synchronize control bit $\overline{T1SYNC}$ (T1CON<2>) has no effect since the internal clock is always in sync.

8.2 <u>Timer1 Operation in Synchronized</u> <u>Counter Mode</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Counter mode is selected by setting bit TMR1CS. In this mode the timer increments on every rising edge of clock input on T1OSI when enable bit T1OSCEN is set or pin with T1CKI when bit T1OSCEN is cleared.

Note: The T1OSI function is multiplexed to different pins, depending on the device. See the pinout descriptions to see which pin has the T1OSI function.

If $\overline{\text{T1SYNC}}$ is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if an external clock is present, since the synchronization circuit is shut off. The prescaler, however, will continue to increment.

8.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in synchronized counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of TMR1 after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to appropriate electrical specification section, parameters 45, 46, and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripplecounter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to applicable electrical specification section, parameters 40, 42, 45, 46, and 47.

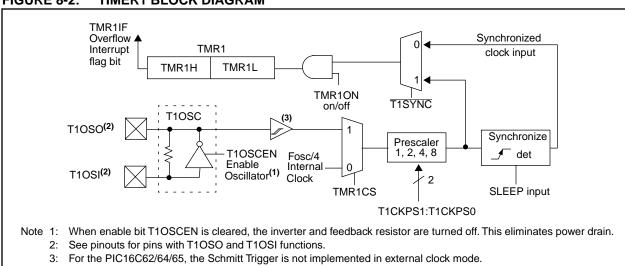


FIGURE 8-2: TIMER1 BLOCK DIAGRAM

8.3 <u>Timer1 Operation in Asynchronous</u> <u>Counter Mode</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

If control bit T1SYNC (T1CON<2>) is set, the external clock input is not synchronized. The timer continues to increment asynchronous to the internal phase clocks. The timer will continue to run during SLEEP and generate an interrupt on overflow which will wake the processor. However, special precautions in software are needed to read-from or write-to the Timer1 register pair, TMR1L and TMR1H (Section 8.3.2).

In asynchronous counter mode, Timer1 cannot be used as a time-base for capture or compare operations.

8.3.1 EXTERNAL CLOCK INPUT TIMING WITH UNSYNCHRONIZED CLOCK

If control bit $\overline{T1SYNC}$ is set, the timer will increment completely asynchronously. The input clock must meet certain minimum high time and low time requirements, as specified in timing parameters (45 - 47).

8.3.2 READING AND WRITING TMR1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L, while the timer is running from an external asynchronous clock, will ensure a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself poses certain problems since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers while the register is incrementing. This may produce an unpredictable value in the timer register.

Reading the 16-bit value requires some care. Example 8-1 is an example routine to read the 16-bit timer value. This is useful if the timer cannot be stopped.

EXAMPLE 8-1: READING A 16-BIT FREE-RUNNING TIMER

;	All Inte	errupts	are d	isabled
	MOVF	TMR1H,	W	;Read high byte
	MOVWF	TMPH		;
	MOVF	TMR1L,	W	;Read low byte
	MOVWF	TMPL		;
	MOVF	TMR1H,	W	;Read high byte
	SUBWF	TMPH,	W	;Sub 1st read
				;with 2nd read
	BTFSC	STATUS	Z	;is result = 0
	GOTO	CONTINU	JE	;Good 16-bit read
;	TMR1L may	/ have r	olled	over between the read
;	of the h	igh and	low b	ytes. Reading the high
;	and low 1	oytes no	w wil	l read a good value.
	MOVF	TMR1H,	W	;Read high byte
	MOVWF	TMPH		;
	MOVF	TMR1L,	W	;Read low byte
	MOVWF	TMPL		;
;	Re-enak	ole Inte	rrupt	(if required)
C	ONTINUE			;Continue with
	:			;your code

8.4 <u>Timer1 Oscillator</u>

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

A crystal oscillator circuit is built in-between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting control bit T1OSCEN (T1CON<3>). The oscillator is a low power oscillator rated up to 200 kHz. It will continue to run during SLEEP. It is primarily intended for a 32 kHz crystal. Table 8-1 shows the capacitor selection for the Timer1 oscillator.

The Timer1 oscillator is identical to the LP oscillator. The user must allow a software time delay to ensure proper oscillator start-up.

TABLE 8-1: CAPACITOR SELECTION FOR THE TIMER1 OSCILLATOR

Osc Type	Freq	C1	C2							
LP	32 kHz	33 pF								
	100 kHz	15 pF	15 pF							
	200 kHz	15 pF	15 pF							
These values are for design guidance only.										
Crystals Tested:										
32.768 kHz	Epson C-00 ⁻	1R32.768K-A	± 20 PPM							
100 kHz	Epson C-2 100.00 KC-P ± 20 PP									
200 kHz	STD XTL 20	\pm 20 PPM								
of o time 2: Sind cha reso	scillator but a be ce each reson racteristics, th onator/crystal	ce increases t lso increases ator/crystal ha le user should manufacturer ernal compone	the start-up as its own consult the for appropri-							

8.5 <u>Resetting Timer1 using a CCP Trigger</u> <u>Output</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

CCP2 is implemented on the PIC16C63/R63/65/65A/ R65/66/67 only.

If CCP1 or CCP2 module is configured in Compare mode to generate a "special event trigger" (CCPxM3:CCPxM0 = 1011), this signal will reset Timer1.

Note:	The	"special	event	trigger"	from	the						
	CCP1and CCP2 modules will not set inter-											
	rupt t	flag bit TM	R1IF(P	IR1<0>).								

Timer1 must be configured for either timer or synchronized counter mode to take advantage of this feature. If the Timer1 is running in asynchronous counter mode, this reset operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1 or CCP2, the write will take precedence.

In this mode of operation, the CCPRxH:CCPRxL registers pair effectively becomes the period register for the Timer1 module.

8.6 <u>Resetting of TMR1 Register Pair</u> (TMR1H:TMR1L)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The TMR1H and TMR1L registers are not reset to 00h on a POR or any other reset except by the CCP1 or CCP2 special event trigger.

The T1CON register is reset to 00h on a Power-on Reset or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescaler. In all other resets, the register is unaffected.

8.7 <u>Timer1 Prescaler</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR		Value on all other resets	
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
0Eh	TMR1L	Holding re	egister	for the Leas	st Significar	nt Byte of the	e 16-bit TN	/R1 registe	er	xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding re	Holding register for the Most Significant Byte of the 16-bit TMR1 register										uuuu
10h	T1CON	_		T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu

TABLE 8-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by the Timer1 module. Note 1: The USART is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

2: Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

3: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

9.0 TIMER2 MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer2 is an 8-bit timer with a prescaler and a postscaler. It is especially suitable as PWM time-base for PWM mode of CCP module(s). TMR2 is a readable and writable register, and is cleared on any device reset.

The input clock (FOSC/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits T2CKPS1:T2CKPS0 (T2CON<1:0>).

The Timer2 module has an 8-bit period register, PR2. Timer2 increments from 00h until it matches PR2 and then resets to 00h on the next increment cycle. PR2 is a readable and writable register. The PR2 register is initialized to FFh upon reset.

The match output of the TMR2 register goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling, inclusive) to generate a TMR2 interrupt (latched in flag bit TMR2IF (PIR1<1>)).

The Timer2 module can be shut off by clearing control bit TMR2ON (T2CON<2>) to minimize power consumption.

Figure 9-2 shows the Timer2 control register. T2CON is cleared upon reset which initializes Timer2 as shut off with the prescaler and postscaler at a 1:1 value.

9.1 <u>Timer2 Prescaler and Postscaler</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The prescaler and postscaler counters are cleared when any of the following occurs:

- a write to the TMR2 register
- · a write to the T2CON register
- any device reset (POR, BOR, MCLR Reset, or WDT Reset).

TMR2 is not cleared when T2CON is written.

9.2 Output of TMR2

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The output of TMR2 (before the postscaler) is fed to the Synchronous Serial Port module which optionally uses it to generate shift clock.

FIGURE 9-1: TIMER2 BLOCK DIAGRAM

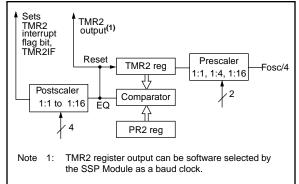


FIGURE 9-2: T2CON: TIMER2 CONTROL REGISTER (ADDRESS 12h)

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	R = Readable bit
bit7							bitO	 W = Writable bit U = Unimplemented bit, read as '0' n = Value at POR reset
bit 7:	Unimplem	ented: Rea	d as '0'					
bit 6-3:	TOUTPS3: 0000 = 1:1 0001 = 1:2 • 1111 = 1:1	postscale postscale		tput Postsca	ale Select bi	ts		
bit 2:	TMR2ON : 1 1 = Timer2 0 = Timer2	is on	bit					
bit 1-0:	T2CKPS1: 00 = 1:1 pr 01 = 1:4 pr 1x = 1:16 p	escale escale	Timer2 Clo	ck Prescale	Select bits			

TABLE 9-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER
--

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value PC BC		all c	e on other sets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
11h	TMR2	Timer2 m	odule's reg	ister						0000	0000	0000	0000
12h	T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000	0000	-000	0000
92h	PR2	Timer2 Pe	eriod registe	er						1111	1111	1111	1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer2.

 Note
 1:
 The USART is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.
 2:
 Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

3: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

10.0 CAPTURE/COMPARE/PWM (CCP) MODULE(s)

Applicable Devices

 61
 62
 62A
 R62
 63
 R63
 64
 64A
 R64
 65
 65A
 R65
 66
 67
 CCP1

 61
 62
 62A
 R62
 63
 R63
 64
 64A
 R64
 65
 65A
 R65
 66
 67
 CCP1

 61
 62
 62A
 R62
 63
 R63
 64
 64A
 R64
 65
 65A
 R65
 66
 67
 CCP2

Each CCP (Capture/Compare/PWM) module contains a 16-bit register which can operate as a 16-bit capture register, as a 16-bit compare register, or as a PWM master/slave duty cycle register. Both the CCP1 and CCP2 modules are identical in operation, with the exception of the operation of the special event trigger. Table 10-1 and Table 10-2 show the resources and interactions of the CCP modules(s). In the following sections, the operation of a CCP module is described with respect to CCP1. CCP2 operates the same as CCP1, except where noted.

CCP1 module:

Capture/Compare/PWM Register1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. All are readable and writable.

CCP2 module:

Capture/Compare/PWM Register2 (CCPR2) is comprised of two 8-bit registers: CCPR2L (low byte) and CCPR2H (high byte). The CCP2CON register controls the operation of CCP2. All are readable and writable.

For use of the CCP modules, refer to the *Embedded Control Handbook*, "Using the CCP Modules" (AN594).

TABLE 10-1: CCP MODE - TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1
Compare	Timer1
PWM	Timer2

TABLE 10-2:INTERACTION OF TWO CCP MODULES

CCPx Mode	CCPy Mode	Interaction
Capture	Capture	Same TMR1 time-base.
Capture	Compare	The compare should be configured for the special event trigger, which clears TMR1.
Compare	Compare	The compare(s) should be configured for the special event trigger, which clears TMR1.
PWM	PWM	The PWMs will have the same frequency, and update rate (TMR2 interrupt).
PWM	Capture	None
PWM	Compare	None

FIGURE 10-1: CCP1CON REGISTER (ADDRESS 17h) / CCP2CON REGISTER (ADDRESS 1Dh)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0							
	_	CCPxX	CCPxY	CCPxM3	CCPxM2	CCPxM1	CCPxM0	R = Readable bit						
bit7							bit0	W = Writable bit U = Unimplemented bit, read as '0' - n =Value at POR reset						
bit 7-6:	it 7-6: Unimplemented: Read as '0' it 5-4: CCPxX:CCPxY: PWM Least Significant bits													
bit 5-4:	<u>Captu</u> Unuse <u>Comp</u> Unuse <u>PWM</u>	i <u>re Mode</u> ed <u>are Mode</u> ed <u>Mode</u>		-		cle. The eig	ht MSbs are	found in CCPRxL.						
bit 3-0:	0000 0100 0101 0110 0111 1000 1001 1010	= Capture = Capture = Capture = Capture = Capture = Compa = Compa = Compa	Acompare a mode, ev a mode, ev a mode, ev a mode, ev a mode, ev re mode, e	very falling e very rising e very 4th risinvery 16th ris set output o clear output generate sol	resets CCP edge ng edge sing edge n match (bit on match (li ftware intern	CCPxIF is bit CCPxIF i upt on matc	is set) h (bit CCPxII	F is set, CCPx pin is unaffected) sets TMR1; CCP2 resets TMR1)						

10.1 Capture Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 register when an event occurs on pin RC2/CCP1 (Figure 10-2). An event is defined as:

- · Every falling edge
- · Every rising edge
- Every 4th rising edge
- Every 16th rising edge

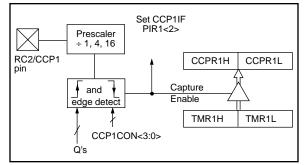
An event is selected by control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR1<2>) is set. It must be cleared in software. If another capture occurs before the value in register CCPR1 is read, the old captured value will be lost.

10.1.1 CCP PIN CONFIGURATION

In Capture mode, the RC2/CCP1 pin should be configured as an input by setting the TRISC<2> bit.

Note: If the RC2/CCP1 pin is configured as an output, a write to PORTC can cause a capture condition.

FIGURE 10-2: CAPTURE MODE OPERATION BLOCK DIAGRAM



10.1.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work consistently.

10.1.3 SOFTWARE INTERRUPT

When the Capture event is changed, a false capture interrupt may be generated. The user should clear enable bit CCP1IE (PIE1<2>) to avoid false interrupts and should clear flag bit CCP1IF following any such change in operating mode.

10.1.4 CCP PRESCALER

There are four prescaler settings, specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, therefore the first capture may be from a non-zero prescaler. Example 10-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 10-1: CHANGING BETWEEN CAPTURE PRESCALERS

CLRF	CCP1CON	;	Turn CCP module off
MOVLW	NEW_CAPT_PS	;	Load the W reg with
		;	the new prescaler
		;	mode value and CCP \ensuremath{ON}
MOVWF	CCP1CON	;	Load CCP1CON with
		;	this value

10.2 Compare Mode

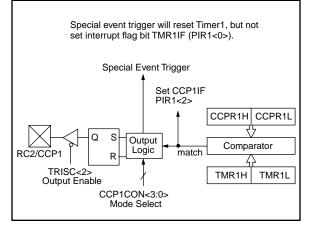
Applicable Devices													
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RC2/CCP1 pin is:

- Driven High
- Driven Low
- Remains Unchanged

The action on the pin is based on the value of control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). At the same time interrupt flag bit CCP1IF is set.

FIGURE 10-3: COMPARE MODE OPERATION BLOCK DIAGRAM



10.2.1 CCP PIN CONFIGURATION

The user must configure the RC2/CCP1 pin as an output by clearing the TRISC<2> bit.

Note:	Clearing the CCP1CON register will force
	the RC2/CCP1 compare output latch to the
	default low level. This is not the data latch.

10.2.1 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

10.2.2 SOFTWARE INTERRUPT MODE

When Generate Software Interrupt is chosen, the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

10.2.3 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated which may be used to initiate an action.

The special event trigger output of CCP1 and CCP2 resets the TMR1 register pair. This allows the CCPR1H:CCPR1L and CCPR2H:CCPR2L registers to effectively be 16-bit programmable period register(s) for Timer1.

For compatibility issues, the special event trigger output of CCP1 (<u>PIC16C72</u>) and CCP2 (all other <u>PIC16C7X</u> devices) also starts an A/D conversion.

Note: The "special event trigger" from the CCP1and CCP2 modules will not set interrupt flag bit TMR1IF (PIR1<0>).

10.3 PWM Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

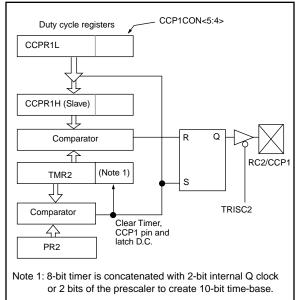
In Pulse Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note: Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 10-4 shows a simplified block diagram of the CCP module in PWM mode.

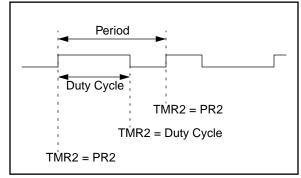
For a step by step procedure on how to set up the CCP module for PWM operation, see Section 10.3.3.

FIGURE 10-4: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 10-5) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 10-5: PWM OUTPUT



10.3.1 PWM PERIOD

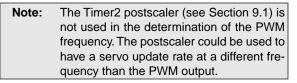
The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

PWM period = [(PR2) + 1] • 4 • TOSC • (TMR2 prescale value)

PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The PWM duty cycle is latched from CCPR1L into CCPR1H
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)



10.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available: the CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

PWM duty cycle = (CCPR1L:CCP1CON<5:4>) • Tosc • (TMR2 prescale value)

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

When the CCPR1H and 2-bit latch match TMR2 concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

Maximum PWM resolution (bits) for a given PWM frequency:

$$= \frac{\log\left(\frac{FOSC}{FPWM}\right)}{\log(2)} \quad \text{bits}$$

Note: If the PWM duty cycle value is longer than the PWM period the CCP1 pin will not be forced to the low level.

EXAMPLE 10-2: PWM PERIOD AND DUTY CYCLE CALCULATION

Desired PWM frequency is 78.125 kHz, Fosc = 20 MHz TMR2 prescale = 1

$$1/78.125 \text{ kHz} = [(PR2) + 1] \cdot 4 \cdot 1/20 \text{ MHz} \cdot 1$$

12.8 \mu s = [(PR2) + 1] \cdot 4 \cdot 50 \text{ ns} \cdot 1

PR2 = 63

Find the maximum resolution of the duty cycle that can be used with a 78.125 kHz frequency and 20 MHz oscillator:

1/78.125 kHz	$= 2^{\text{PWM RESOLUTION}} \bullet 1/20 \text{ MHz} \bullet 1$
12.8 µs	$= 2^{\text{PWM RESOLUTION}} \bullet 50 \text{ ns} \bullet 1$
256	$= 2^{\text{PWM RESOLUTION}}$
log(256)	= (PWM Resolution) • $log(2)$
8.0	= PWM Resolution

At most, an 8-bit resolution duty cycle can be obtained from a 78.125 kHz frequency and a 20 MHz oscillator, i.e., $0 \le CCPR1L:CCP1CON<5:4> \le 255$. Any value greater than 255 will result in a 100% duty cycle. In order to achieve higher resolution, the PWM frequency must be decreased. In order to achieve higher PWM frequency, the resolution must be decreased.

Table 10-3 lists example PWM frequencies and resolutions for Fosc = 20 MHz. The TMR2 prescaler and PR2 values are also shown.

10.3.3 SET-UP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- 1. Set the PWM period by writing to the PR2 register.
- Set the PWM duty cycle by writing to the CCPR1L register and CCP1CON<5:4> bits.
- Make the CCP1 pin an output by clearing the TRISC<2> bit.
- 4. Set the TMR2 prescale value and enable Timer2 by writing to T2CON.
- 5. Configure the CCP1 module for PWM operation.

TABLE 10-3: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 20 MHz

PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12 kHz	156.3 kHz	208.3 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0x3F	0x1F	0x17
Maximum Resolution (bits)	10	10	10	8	7	5.5

TABLE 10-4: REGISTERS ASSOCIATED WITH TIMER1, CAPTURE AND COMPARE

Add	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	PC	e on: DR, DR	all c	ie on other sets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
0Dh ⁽⁴⁾	PIR2	_	_	_	_	—	_	_	CCP2IF		0		0
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
8Dh ⁽⁴⁾	PIE2	_	_	—	_	_	_		CCP2IE		0		0
87h	TRISC	PORTC D	ata Direc	ction registe	er					1111	1111	1111	1111
0Eh	TMR1L	Holding re	egister for	r the Least	Significant	Byte of the	16-bit TMF	R1 register		xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding re	egister for	r the Most S	Significant I	Byte of the ?	16-bit TMR	1 register		xxxx	xxxx	uuuu	uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu
15h	CCPR1L	Capture/C	Compare/	PWM1 (LS	B)					xxxx	xxxx	uuuu	uuuu
16h	CCPR1H	Capture/C	Compare/	PWM1 (MS	SB)					xxxx	xxxx	uuuu	uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00	0000	00	0000
1Bh ⁽⁴⁾	CCPR2L	Capture/C	Capture/Compare/PWM2 (LSB)								xxxx	uuuu	uuuu
1Ch ⁽⁴⁾	CCPR2H	Capture/C	Compare/	PWM2 (MS	SB)					xxxx	xxxx	uuuu	uuuu
1Dh ⁽⁴⁾	CCP2CON	_	_	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00	0000	00	0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used in these modes.

Note 1: These bits are associated with the USART module, which is implemented on the PIC16C63/R63/65/65A/R65/66/67 only. 2: Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

3: The PIR1<6> and PIE1<6> bits are reserved, always maintain these bits clear.

5. The FIR I<0> and FIE I<0> bits are reserved, always maintain these bits clear.

4: These registers are associated with the CCP2 module, which is only implemented on the PIC16C63/R63/65/65A/R65/66/67.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh ⁽⁴⁾	PIR2	_	_	_	_	_	_	_	CCP2IF	0	0
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
8Dh ⁽⁴⁾	PIE2	_	_	_	_	_	_	_	CCP2IE	0	0
87h	TRISC	PORTC D	Data Direction	on register						1111 1111	1111 1111
11h	TMR2	Timer2 m	odule's regi	ster						0000 0000	0000 0000
92h	PR2	Timer2 m	odule's Per	iod register						1111 1111	1111 1111
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
15h	CCPR1L	Capture/0	Compare/P\	VM1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/0	Compare/P\	VM1 (MSB))					xxxx xxxx	uuuu uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
1Bh ⁽⁴⁾	CCPR2L	Capture/0	Compare/P\	VM2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch ⁽⁴⁾	CCPR2H	Capture/0	Compare/P\	WM2 (MSB))					xxxx xxxx	uuuu uuuu
1Dh ⁽⁴⁾	CCP2CON	_	—	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000

TABLE 10-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used in this mode.

Note 1: These bits are associated with the USART module, which is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

2: Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

3: The PIR1<6> and PIE1<6> bits are reserved, always maintain these bits clear.

4: These registers are associated with the CCP2 module, which is only implemented on the PIC16C63/R63/65/65A/R65/66/67.

11.0 SYNCHRONOUS SERIAL PORT (SSP) MODULE

11.1 SSP Module Overview

The Synchronous Serial Port (SSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be Serial EEPROMs, shift registers, display drivers, A/D converters, etc. The SSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C)

The SSP module in I^2C mode works the same in all PIC16C6X devices that have an SSP module. However the SSP Module in SPI mode has differences between the PIC16C66/67 and the other PIC16C6X devices.

The register definitions and operational description of SPI mode has been split into two sections because of the differences between the PIC16C66/67 and the other PIC16C6X devices. The default reset values of both the SPI modules is the same regardless of the device:

11.2 SPI Mode for PIC16C62/62A/R62/63/R63/8	54/
64A/R64/65/65A/R65	84
11.3 SPI Mode for PIC16C66/67	89
11.4 I2C [™] Overview	95
11.5 SSP I2C Operation	99

Refer to Application Note AN578, "Use of the SSP Module in the I²C Multi-Master Environment."

11.2 <u>SPI Mode for PIC16C62/62A/R62/63/</u> <u>R63/64/64A/R64/65/65A/R65</u>

This section contains register definitions and operational characteristics of the SPI module for the PIC16C62, PIC16C62A, PIC16CR62, PIC16C63, PIC16CR63, PIC16C64, PIC16CR64, PIC16CR64, PIC16C65, PIC16C65A, PIC16CR65.

FIGURE 11-1: SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS 94h)

U-0	U-0	R-0	R-0	R-0	R-0	R-0	R-0	
	—	D/Ā	Р	S	R/W	UA	BF	R = Readable bit
bit7							bitO	W = Writable bit U = Unimplemented bit, read as '0' - n =Value at POR reset
bit 7-6:	Unimpl	emented	: Read as	'0'				
bit 5:	 bit 5: D/Ā: Data/Address bit (I²C mode only) 1 = Indicates that the last byte received or transmitted was data 0 = Indicates that the last byte received or transmitted was address 							
bit 4:	1 = Indi	cates that		has been	leared when detected last			abled, SSPEN is cleared) T)
bit 3:	1 = Indi	cates that	node only. a start bit not detect	has been	cleared wher detected las	the SSP m t (this bit is	nodule is dis '0' on RESE	abled, SSPEN is cleared) T)
bit 2:	This bit	holds the o the next ad	R/W bit i	ation (I ² C n nformation stop bit, or	following the	e last addre	ess match. T	his bit is valid from the address
bit 1:	1 = Indi	cates that	the user i	t I ² C mode needs to up to be upda	odate the ad	dress in the	SSPADD re	egister
bit 0:	BF: Buf	fer Full St	atus bit					
	<u>Receive</u> (SPI and I ² C modes) 1 = Receive complete, SSPBUF is full 0 = Receive not complete, SSPBUF is empty							
	1 = Trar		ogress, S	SPBUF is f PBUF is err				

FIGURE 11-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)

Г

WCOL	SSPOV SSPEN CKP SSPM3 SSPM2 SSPM1 SSPM0 R = Readable bit								
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n =Value at POR reset								
bit 7:	<pre>WCOL: Write Collision Detect bit 1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software) 0 = No collision</pre>								
bit 6:	SSPOV: Receive Overflow Detect bit								
	In SPI mode 1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow the data in SSPSR register is lost. Overflow can only occur in slave mode. The user must read the SSP BUF, even if only transmitting data, to avoid setting overflow. In master mode the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register. 0 = No overflow								
	In I^2C mode 1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care in transmit mode. SSPOV must be cleared in software in either mode. 0 = No overflow								
bit 5:	SSPEN: Synchronous Serial Port Enable bit								
	In SPI mode 1 = Enables serial port and configures SCK, SDO, and SDI as serial port pins 0 = Disables serial port and configures these pins as I/O port pins								
	<u>In I²C mode</u> 1 = Enables the serial port and configures the SDA and SCL pins as serial port pins 0 = Disables serial port and configures these pins as I/O port pins In both modes, when enabled, these pins must be properly configured as input or output.								
bit 4:	CKP: Clock Polarity Select bit								
	In SPI mode 1 = Idle state for clock is a high level. Transmit happens on falling edge, receive on rising edge. 0 = Idle state for clock is a low level. Transmit happens on rising edge, receive on falling edge.								
	$\frac{\ln l^2 C \text{ mode}}{SCK \text{ release control}}$ $1 = \text{Enable clock}$ $0 = \text{Holds clock low (clock stretch) (Used to ensure data setup time)}$								
bit 3-0:	SSPM3:SSPM0 : Synchronous Serial Port Mode Select bits 0000 = SPI master mode, clock = Fosc/4 0001 = SPI master mode, clock = Fosc/16 0010 = SPI master mode, clock = Fosc/64 0011 = SPI master mode, clock = TMR2 output/2 $0100 = SPI$ slave mode, clock = SCK pin. \overline{SS} pin control enabled. $0101 = SPI$ slave mode, clock = SCK pin. \overline{SS} pin control disabled. \overline{SS} can be used as I/O pin. $0110 = I^2C$ slave mode, 7-bit address $0111 = I^2C$ slave mode, 10-bit address $1011 = I^2C$ firmware controlled Master Mode (slave idle) $1110 = I^2C$ slave mode, 7-bit address with start and stop bit interrupts enabled $1111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled								

11.2.1 OPERATION OF SSP MODULE IN SPI MODE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The SPI mode allows 8-bits of data to be synchronously transmitted and received simultaneously. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO)
- Serial Data In (SDI)
- Serial Clock (SCK)

Additionally a fourth pin may be used when in a slave mode of operation:

Slave Select (SS)

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits in the SSPCON register (SSPCON<5:0>). These control bits allow the following to be specified:

- Master Mode (SCK is the clock output)
- Slave Mode (SCK is the clock input)
- Clock Polarity (Output/Input data on the Rising/ Falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select Mode (Slave mode only)

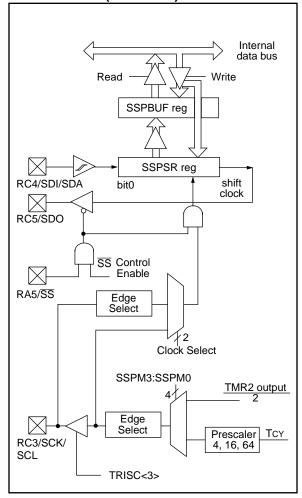
The SSP consists of a transmit/receive Shift Register (SSPSR) and a Buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the 8-bits of data have been received, that byte is moved to the SSPBUF register. Then the Buffer Full bit, BF (SSPSTAT<0>) and flag bit SSPIF are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit, WCOL (SSPCON<7>) will be set. User software must clear bit WCOL so that it can be determined if the following write(s) to the SSPBUF completed successfully. When the application software is expecting to receive valid data, the SSPBUF register should be read before the next byte of data to transfer is written to the SSPBUF register. The Buffer Full bit BF (SSPSTAT<0>) indicates when the SSPBUF register has been loaded with the received data (transmission is complete). When the SSPBUF is read, bit BF is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally the SSP Interrupt is used to determine when the transmission/reception has completed. The SSPBUF register must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 11-1 shows the loading of the SSPBUF (SSPSR) register for data transmission. The shaded instruction is only required if the received data is meaningful.

EXAMPLE 11-1: LOADING THE SSPBUF (SSPSR) REGISTER

		-	-	
	BSF	STATUS,	RP0	;Specify Bank 1
LOOP	BTFSS	SSPSTAT,	BF	;Has data been
				;received
				;(transmit
				;complete)?
	GOTO	LOOP		;No
	BCF	STATUS,	RP0	;Specify Bank 0
	MOVF	SSPBUF,	W	;W reg = contents
				;of SSPBUF
	MOVWF	RXDATA		;Save in user RAM
	MOVF	TXDATA,	W	;W reg = contents
				; of TXDATA
	MOVWF	SSPBUF		;New data to xmit

The block diagram of the SSP module, when in SPI mode (Figure 11-3), shows that the SSPSR register is not directly readable or writable, and can only be accessed from addressing the SSPBUF register. Additionally, the SSP status register (SSPSTAT) indicates the various status conditions.

FIGURE 11-3: SSP BLOCK DIAGRAM (SPI MODE)



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

To enable the serial port, SSP enable bit SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear enable bit SSPEN, re-initialize SSPCON register, and then set enable bit SSPEN. This configures the SDI, SDO, SCK, and SS pins as serial port pins. For the pins to behave as the serial port function, they must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- SDI must have TRISC<4> set
- SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- SS must have TRISA<5> set (if implemented)

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value. An example would be in master mode where you are only sending data (to a display driver), then both SDI and SS could be used as general purpose outputs by clearing their corresponding TRIS register bits.

Figure 11-4 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2) is to broadcast data by the software protocol.

In master mode the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SCK output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor" mode.

In slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched interrupt flag bit SSPIF (PIR1<3>) is set.

The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 11-5 and Figure 11-6 where the MSB is transmitted first. In master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or TCY)
- Fosc/16 (or 4 TCY)
- Fosc/64 (or 16 TCY)
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5 MHz. When in slave mode the external clock must meet the minimum high and low times.

In sleep mode, the slave can transmit and receive data and wake the device from sleep.

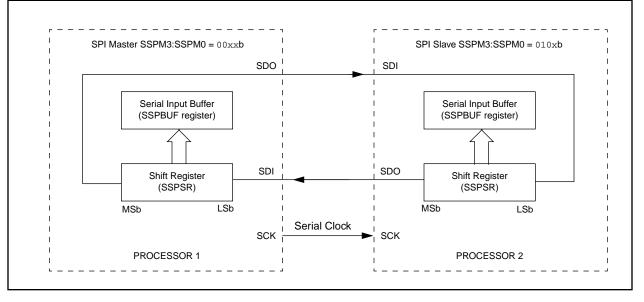


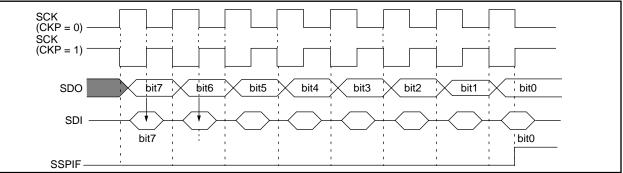
FIGURE 11-4: SPI MASTER/SLAVE CONNECTION

The \overline{SS} pin allows a synchronous slave mode. The SPI must be in slave mode (SSPCON<3:0> = 04h) and the TRISA<5> bit must be set the for synchronous slave mode to be enabled. When the \overline{SS} pin is low, transmission and reception are enabled and the SDO pin is driven. When the \overline{SS} pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. If the \overline{SS} pin is taken low without resetting SPI mode, the transmission will continue from the

point at which it was taken high. External pull-up/ pull-down resistors may be desirable, depending on the application.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.

FIGURE 11-5: SPI MODE TIMING, MASTER MODE OR SLAVE MODE W/O SS CONTROL



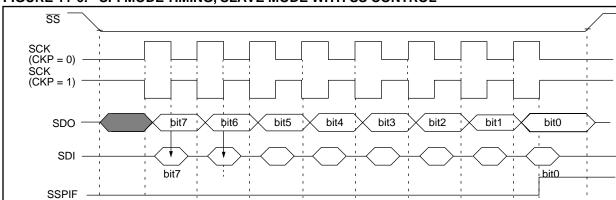


FIGURE 11-6: SPI MODE TIMING, SLAVE MODE WITH SS CONTROL



Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
13h	SSPBUF	Synchronc	ous Serial	Port Rece	ive Buffer,	/Transmit	Register			xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
85h	TRISA	_	_	PORTA Da	ta Directior	Register				11 1111	11 1111
87h	TRISC	PORTC D	ata Directi	Direction Register						1111 1111	1111 1111
94h	SSPSTAT	—	—	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by SSP module in SPI mode.

Note 1: These bits are associated with the USART which is implemented on the PIC16C63/R63/65/65A/R65 only. 2: PSPIF and PSPIE are reserved on the PIC16C62/62A/R62/63/R63, always maintain these bits clear.

3: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

11.3 SPI Mode for PIC16C66/67

This section contains register definitions and operational characterisitics of the SPI module on the PIC16C66 and PIC16C67 only.

FIGURE 11-7: SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS 94h)(PIC16C66/67)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0	
SMP	CKE	D/Ā	Р	S	R/W	UA	BF	R = Readable bit
bit7							bit0	W = Writable bit U = Unimplemented bit, read as '0' - n =Value at POR reset
bit 7:	<u>SPI Mas</u> 1 = Inpu 0 = Inpu <u>SPI Slav</u>	<u>ster Mod</u> It data sa It data sa <u>/e Mode</u>	ampled at e ampled at r	end of data niddle of d	output time ata output ti ed in slave r	me		
bit 6:	$\frac{CKP = 0}{1 = Data}$ $0 = Data$ $\frac{CKP = 1}{1 = Data}$	<u>)</u> a transm a transm I a transm	Edge Sele itted on risi itted on fall itted on fall itted on risi	ng edge o ing edge c ing edge c	if SCK if SCK	e 11-12, an	d Figure 11-	13)
bit 5:	1 = India	cates that		yte receive) ed or transm ed or transm			
bit 4:	detected 1 = India	d last, SS cates tha	SPEN is cle	eared) : has been	cleared whe			lisabled, or when the Start bit is
bit 3:	detected 1 = India	d last, SS cates tha	SPEN is cle	eared) t has been	cleared wh detected las			disabled, or when the Stop bit is
bit 2:	This bit	holds th match to d	ne R/W bit	informatic	mode only) In following op bit, or AC		dress match	n. This bit is only valid from the
bit 1:	1 = India	cates that	ress (10-bi at the user es not need	needs to u	pdate the ac	ddress in the	e SSPADD r	egister
bit 0:	BF: Buff	ier Full S	status bit					
	1 = Rec	eive com	d I ² C mode pplete, SSF complete,	BUF is ful				
		smit in p	ode only) progress, S					

Г

FIGURE 11-8: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)(PIC16C66/67)

R/W-0	R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0
WCOL	SSPOV SSPEN CKP SSPM3 SSPM2 SSPM1 SSPM0 R = Readable bit
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n =Value at POR reset
bit 7:	WCOL: Write Collision Detect bit 1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software) 0 = No collision
bit 6:	SSPOV: Receive Overflow Indicator bit
	In SPI mode 1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of over flow, the data in SSPSR is lost. Overflow can only occur in slave mode. The user must read the SSPBUF even if only transmitting data, to avoid setting overflow. In master mode the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register. 0 = No overflow
	<u>In I^2C mode</u> 1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don' care" in transmit mode. SSPOV must be cleared in software in either mode. 0 = No overflow
bit 5:	SSPEN: Synchronous Serial Port Enable bit
	In SPI mode 1 = Enables serial port and configures SCK, SDO, and SDI as serial port pins 0 = Disables serial port and configures these pins as I/O port pins
	In l^2C mode 1 = Enables the serial port and configures the SDA and SCL pins as serial port pins 0 = Disables serial port and configures these pins as I/O port pins In both modes, when enabled, these pins must be properly configured as input or output.
bit 4:	CKP : Clock Polarity Select bit In SPI mode 1 = Idle state for clock is a high level 0 = Idle state for clock is a low level In l^2C mode SCK release control 1 = Enable clock 0 = Holds clock low (clock stretch) (Used to ensure data setup time)
bit 3-0:	SSPM3:SSPM0: Synchronous Serial Port Mode Select bits 0000 = SPI master mode, clock = Fosc/4 0011 = SPI master mode, clock = Fosc/64 0011 = SPI master mode, clock = TMR2 output/2 $0100 = SPI$ slave mode, clock = SCK pin. \overline{SS} pin control enabled. $0101 = SPI$ slave mode, clock = SCK pin. \overline{SS} pin control disabled. \overline{SS} can be used as I/O pin $0110 = I^2C$ slave mode, 7-bit address $0111 = I^2C$ slave mode, 10-bit address $1011 = I^2C$ firmware controlled master mode (slave idle) $1110 = I^2C$ slave mode, 7-bit address with start and stop bit interrupts enabled $1111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled

11.3.1 SSP MODULE IN SPI MODE FOR PIC16C66/67

The SPI mode allows 8-bits of data to be synchronously transmitted and received simultaneously. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO) RC5/SDO
- Serial Data In (SDI) RC4/SDI/SDA
- Serial Clock (SCK) RC3/SCK/SCL

Additionally a fourth pin may be used when in a slave mode of operation:

Slave Select (SS) RA5/SS

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits in the SSPCON register (SSPCON<5:0>) and SSPSTAT<7:6>. These control bits allow the following to be specified:

- Master Mode (SCK is the clock output)
- Slave Mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Clock edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select Mode (Slave mode only)

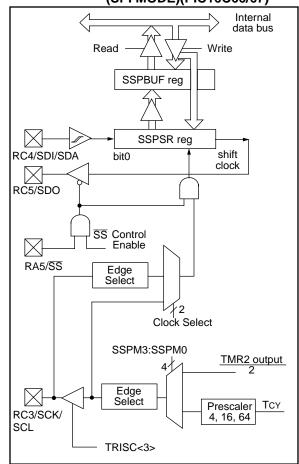
The SSP consists of a transmit/receive Shift Register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR until the received data is ready. Once the 8-bits of data have been received, that byte is moved to the SSPBUF register. Then the buffer full detect bit BF (SSPSTAT<0>) and interrupt flag bit SSPIF (PIR1<3>) are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit WCOL (SSPCON<7>) will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully. When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. Buffer full bit BF (SSPSTAT<0>) indicates when SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, bit BF is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally the SSP Interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 11-2 shows the loading of the SSPBUF (SSPSR) for data transmission. The shaded instruction is only required if the received data is meaningful.

EXAMPLE 11-2: LOADING THE SSPBUF (SSPSR) REGISTER (PIC16C66/67)

LOOP	BCF BSF BTFSS	STATUS, RP1 STATUS, RP0 SSPSTAT, BF	;Specify Bank 1 ; ;Has data been ;received ;(transmit ;complete)?
	GOTO	LOOP	;No
	BCF	STATUS, RPO	;Specify Bank 0
	MOVF	SSPBUF, W	;W reg = contents ; of SSPBUF
	MOVWF	RXDATA	;Save in user RAM
	MOVF	TXDATA, W	;W reg = contents ; of TXDATA
	MOVWF	SSPBUF	;New data to xmit

The block diagram of the SSP module, when in SPI mode (Figure 11-9), shows that the SSPSR is not directly readable or writable, and can only be accessed from addressing the SSPBUF register. Additionally, the SSP status register (SSPSTAT) indicates the various status conditions.

FIGURE 11-9: SSP BLOCK DIAGRAM (SPI MODE)(PIC16C66/67)



To enable the serial port, SSP Enable bit, SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear bit SSPEN, re-initialize the SSPCON register, and then set bit SSPEN. This configures the SDI, SDO, SCK, and SS pins as serial port pins. For the pins to behave as the serial port function, they must have their data direction bits (in the TRISC register) appropriately programmed. That is:

- SDI must have TRISC<4> set
- SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- SS must have TRISA<5> set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value. An example would be in master mode where you are only sending data (to a display driver), then both SDI and SS could be used as general purpose outputs by clearing their corresponding TRIS register bits.

Figure 11-10 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application firmware. This leads to three scenarios for data transmission:

- Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2) is to broadcast data by the firmware protocol.

In master mode the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SCK output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor" mode.

In slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched the interrupt flag bit SSPIF (PIR1<3>) is set.

The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 11-11, Figure 11-12, and Figure 11-13 where the MSB is transmitted first. In master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5 MHz. When in slave mode the external clock must meet the minimum high and low times.

In sleep mode, the slave can transmit and receive data and wake the device from sleep.

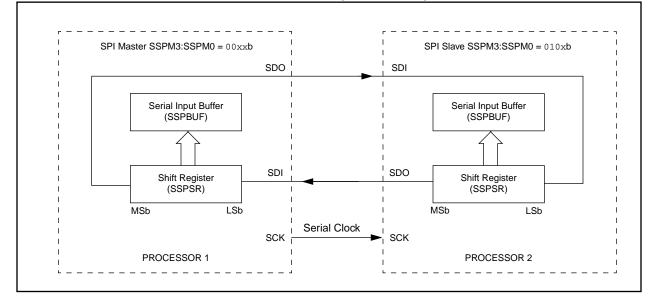


FIGURE 11-10: SPI MASTER/SLAVE CONNECTION (PIC16C66/67)

The \overline{SS} pin allows a synchronous slave mode. The SPI must be in slave mode (SSPCON<3:0> = 04h) and the TRISA<5> bit must be set for the synchronous slave mode to be enabled. When the \overline{SS} pin is low, transmission and reception are enabled and the SDO pin is driven. When the \overline{SS} pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. If the \overline{SS} pin is taken low without resetting SPI mode, the transmission will continue from the point at which it was taken high. External pull-up/ pull-down resistors may be desirable, depending on the application.

- Note: When the SPI is in Slave Mode with SS pin control enabled, (SSPCON<3:0> = 0100) the SPI module will reset if the SS pin is set to VDD.
- Note: If the SPI is used in Slave Mode with CKE = '1', then the SS pin control must be enabled.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.

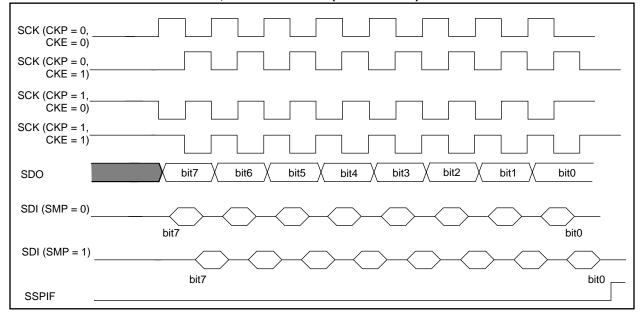
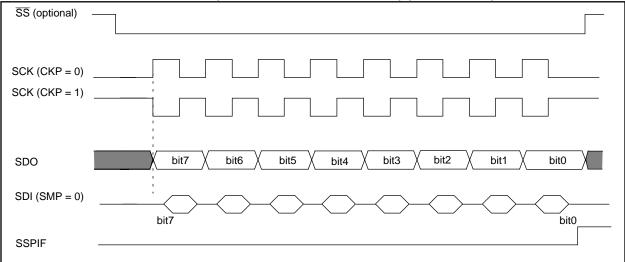


FIGURE 11-11: SPI MODE TIMING, MASTER MODE (PIC16C66/67)

FIGURE 11-12: SPI MODE TIMING (SLAVE MODE WITH CKE = 0) (PIC16C66/67)



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 11-13: SPI MODE TIMING (SLAVE MODE WITH CKE = 1) (PIC16C66/67)

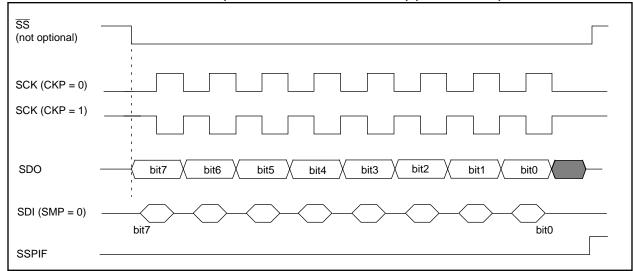


TABLE 11-2: REGISTERS ASSOCIATED WITH SPI OPERATION (PIC16C66/67)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset		Value on all other resets	
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
13h	SSPBUF	Synchron	ous Serial	Port Rec	eive Buffe	r/Transmit	Register			xxxx	xxxx	uuuu	uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000	0000	0000	0000
85h	TRISA	—	_	PORTA D	Data Direc	tion regist	er			11	1111	11	1111
87h	TRISC	PORTC D	ata Direc	rection register							1111	1111	1111
94h	SSPSTAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000	0000	0000	0000

 $\label{eq:Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by SSP module in SPI mode.$

Note 1: PSPIF and PSPIE are reserved on the PIC16C66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

11.4 $I^2 \underline{C^{TM} Overview}$

This section provides an overview of the Inter-Integrated Circuit (I^2C) bus, with Section 11.5 discussing the operation of the SSP module in I^2C mode.

The I²C bus is a two-wire serial interface developed by the Philips[®] Corporation. The original specification, or standard mode, was for data transfers of up to 100 Kbps. The enhanced specification (fast mode) is also supported. This device will communicate with both standard and fast mode devices if attached to the same bus. The clock will determine the data rate.

The l^2C interface employs a comprehensive protocol to ensure reliable transmission and reception of data. When transmitting data, one device is the "master" which initiates transfer on the bus and generates the clock signals to permit that transfer, while the other device(s) acts as the "slave." All portions of the slave protocol are implemented in the SSP module's hardware, except general call support, while portions of the master protocol need to be addressed in the PIC16CXX software. Table 11-3 defines some of the l^2C bus terminology. For additional information on the l^2C interface specification, refer to the Philips document "*The* l^2C bus and how to use it."#939839340011, which can be obtained from the Philips Corporation.

In the I²C interface protocol each device has an address. When a master wishes to initiate a data transfer, it first transmits the address of the device that it wishes to "talk" to. All devices "listen" to see if this is their address. Within this address, a bit specifies if the master wishes to read-from/write-to the slave device. The master and slave are always in opposite modes (transmitter/receiver) of operation during a data transfer. That is they can be thought of as operating in either of these two relations:

- Master-transmitter and Slave-receiver
- Slave-transmitter and Master-receiver

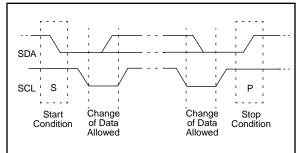
In both cases the master generates the clock signal. The output stages of the clock (SCL) and data (SDA)

lines must have an open-drain or open-collector in order to perform the wired-AND function of the bus. External pull-up resistors are used to ensure a high level when no device is pulling the line down. The number of devices that may be attached to the l^2C bus is limited only by the maximum bus loading specification of 400 pF.

11.4.1 INITIATING AND TERMINATING DATA TRANSFER

During times of no data transfer (idle time), both the clock line (SCL) and the data line (SDA) are pulled high through the external pull-up resistors. The START and STOP conditions determine the start and stop of data transmission. The START condition is defined as a high to low transition of the SDA when the SCL is high. The STOP condition is defined as a low to high transition of the SDA when the SCL is high. The START and STOP conditions. The master generates these conditions for starting and terminating data transfer. Due to the definition of the START and STOP conditions, when data is being transmitted, the SDA line can only change state when the SCL line is low.

FIGURE 11-14: START AND STOP CONDITIONS



Term	Description
Transmitter	The device that sends the data to the bus.
Receiver	The device that receives the data from the bus.
Master	The device which initiates the transfer, generates the clock and terminates the transfer.
Slave	The device addressed by a master.
Multi-master	More than one master device in a system. These masters can attempt to control the bus at the same time without corrupting the message.
Arbitration	Procedure that ensures that only one of the master devices will control the bus. This ensure that the transfer data does not get corrupted.
Synchronization	Procedure where the clock signals of two or more devices are synchronized.

TABLE 11-3:I²C BUS TERMINOLOGY

11.4.2 ADDRESSING I²C DEVICES

There are two address formats. The simplest is the 7-bit address format with a R/\overline{W} bit (Figure 11-15). The more complex is the 10-bit address with a R/\overline{W} bit (Figure 11-16). For 10-bit address format, two bytes must be transmitted with the first five bits specifying this to be a 10-bit address.

FIGURE 11-15: 7-BIT ADDRESS FORMAT

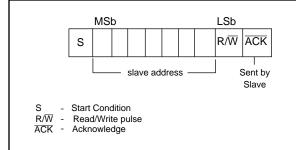
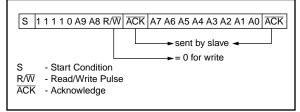


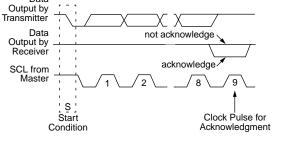
FIGURE 11-16: I²C 10-BIT ADDRESS FORMAT



11.4.3 TRANSFER ACKNOWLEDGE

All data must be transmitted per byte, with no limit to the number of bytes transmitted per data transfer. After each byte, the slave-receiver generates an acknowledge bit (\overline{ACK}) (Figure 11-17). When a slave-receiver doesn't acknowledge the slave address or received data, the master must abort the transfer. The slave must leave SDA high so that the master can generate the STOP condition (Figure 11-14).

FIGURE 11-17: SLAVE-RECEIVER ACKNOWLEDGE



If the master is receiving the data (master-receiver), it generates an acknowledge signal for each received byte of data, except for the last byte. To signal the end of data to the slave-transmitter, the master does not generate an acknowledge (not acknowledge). The slave then releases the SDA line so the master can generate the STOP condition. The master can also generate the STOP condition during the acknowledge pulse for valid termination of data transfer.

If the slave needs to delay the transmission of the next byte, holding the SCL line low will force the master into a wait state. Data transfer continues when the slave releases the SCL line. This allows the slave to move the received data or fetch the data it needs to transfer before allowing the clock to start. This wait state technique can also be implemented at the bit level, Figure 11-18. The slave will inherently stretch the clock, when it is a transmitter, but will not when it is a receiver. The slave will have to clear the SSPCON<4> bit to enable clock stretching when it is a receiver.

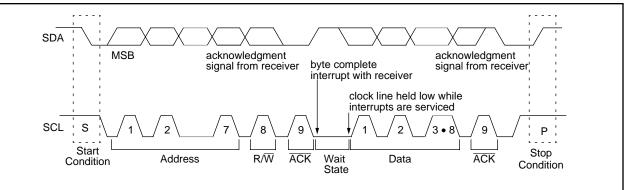


FIGURE 11-18: DATA TRANSFER WAIT STATE

Figure 11-19 and Figure 11-20 show Master-transmitter and Master-receiver data transfer sequences.

When a master does not wish to relinquish the bus (by generating a STOP condition), a repeated START condition (Sr) must be generated. This condition is identical to the start condition (SDA goes high-to-low while

SCL is high), but occurs after a data transfer acknowledge pulse (not the bus-free state). This allows a master to send "commands" to the slave and then receive the requested information or to address a different slave device. This sequence is shown in Figure 11-21.

FIGURE 11-19: MASTER-TRANSMITTER SEQUENCE

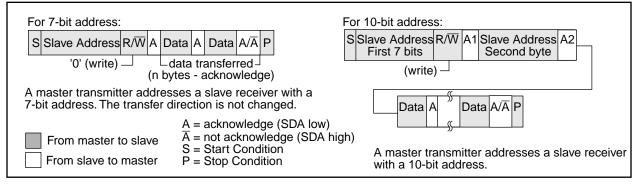


FIGURE 11-20: MASTER-RECEIVER SEQUENCE

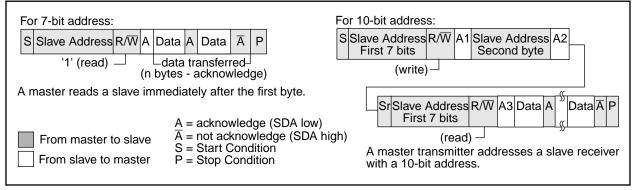
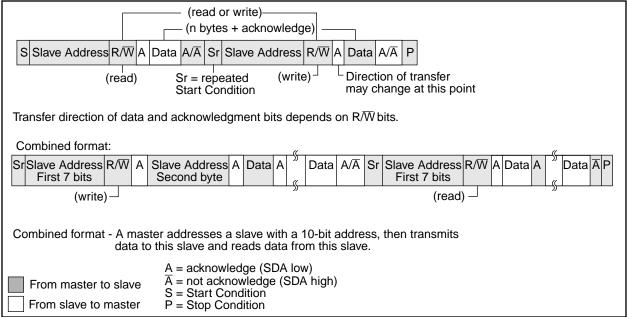


FIGURE 11-21: COMBINED FORMAT



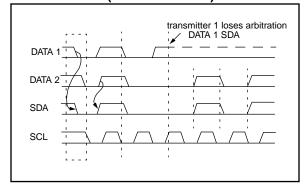
11.4.4 MULTI-MASTER

The I²C protocol allows a system to have more than one master. This is called multi-master. When two or more masters try to transfer data at the same time, arbitration and synchronization occur.

11.4.4.1 ARBITRATION

Arbitration takes place on the SDA line, while the SCL line is high. The master which transmits a high when the other master transmits a low loses arbitration (Figure 11-22), and turns off its data output stage. A master which lost arbitration can generate clock pulses until the end of the data byte where it lost arbitration. When the master devices are addressing the same device, arbitration continues into the data.

FIGURE 11-22: MULTI-MASTER ARBITRATION (TWO MASTERS)



Masters that also incorporate the slave function, and have lost arbitration must immediately switch over to slave-receiver mode. This is because the winning master-transmitter may be addressing it.

Arbitration is not allowed between:

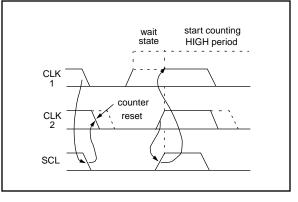
- A repeated START condition
- A STOP condition and a data bit
- A repeated START condition and a STOP condition

Care needs to be taken to ensure that these conditions do not occur.

11.2.4.2 Clock Synchronization

Clock synchronization occurs after the devices have started arbitration. This is performed using a wired-AND connection to the SCL line. A high to low transition on the SCL line causes the concerned devices to start counting off their low period. Once a device clock has gone low, it will hold the SCL line low until its SCL high state is reached. The low to high transition of this clock may not change the state of the SCL line, if another device clock is still within its low period. The SCL line is held low by the device with the longest low period. Devices with shorter low periods enter a high waitstate, until the SCL line comes high. When the SCL line comes high, all devices start counting off their high periods. The first device to complete its high period will pull the SCL line low. The SCL line high time is determined by the device with the shortest high period, Figure 11-23.

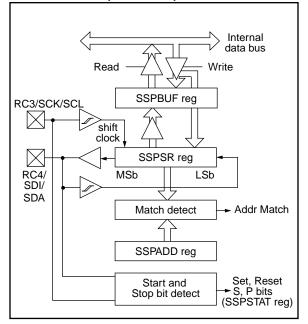
FIGURE 11-23: CLOCK SYNCHRONIZATION



11.5 <u>SSP I²C Operation</u>

The SSP module in I²C mode fully implements all slave functions, except general call support, and provides interrupts on start and stop bits in hardware to facilitate firmware implementations of the master functions. The SSP module implements the standard mode specifications as well as 7-bit and 10-bit addressing. Two pins are used for data transfer. These are the RC3/SCK/ SCL pin, which is the clock (SCL), and the RC4/SDI/ SDA pin, which is the data (SDA). The user must configure these pins as inputs or outputs through the TRISC<4:3> bits. The SSP module functions are enabled by setting SSP Enable bit SSPEN (SSP-CON<5>).

FIGURE 11-24: SSP BLOCK DIAGRAM (I²C MODE)



The SSP module has five registers for I^2C operation. These are the:

- SSP Control Register (SSPCON)
- SSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) Not directly accessible
- SSP Address Register (SSPADD)

The SSPCON register allows control of the I^2C operation. Four mode selection bits (SSPCON<3:0>) allow one of the following I^2C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address), with start and stop bit interrupts enabled
- I²C Slave mode (10-bit address), with start and stop bit interrupts enabled
- I²C Firmware controlled Master Mode, slave is idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCL and SDA pins to be open drain, provided these pins are programmed to inputs by setting the appropriate TRISC bits.

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START or STOP bit, specifies if the received byte was data or address if the next byte is the completion of 10-bit address, and if this will be a read or write data transfer. The SSPSTAT register is read only.

The SSPBUF is the register to which transfer data is written to or read from. The SSPSR register shifts the data in or out of the device. In receive operations, the SSPBUF and SSPSR create a doubled buffered receiver. This allows reception of the next byte to begin before reading the last byte of received data. When the complete byte is received, it is transferred to the SSPBUF register and flag bit SSPIF is set. If another complete byte is received before the SSPBUF register is read, a receiver overflow has occurred and bit SSPOV (SSPCON<6>) is set and the byte in the SSPSR is lost.

The SSPADD register holds the slave address. In 10-bit mode, the user first needs to write the high byte of the address (1111 0 A9 A8 0). Following the high byte address match, the low byte of the address needs to be loaded (A7:A0).

11.5.1 SLAVE MODE

In slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The SSP module will override the input state with the output data when required (slave-transmitter).

When an address is matched or the data transfer after an address match is received, the hardware automatically will generate the acknowledge (\overline{ACK}) pulse, and then load the SSPBUF register with the received value currently in the SSPSR register.

There are certain conditions that will cause the SSP module not to give this \overline{ACK} pulse. These are if either (or both):

- a) The buffer full bit BF (SSPSTAT<0>) was set before the transfer was received.
- b) The overflow bit SSPOV (SSPCON<6>) was set before the transfer was received.

In this case, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF (PIR1<3>) is set. Table 11-4 shows what happens when a data transfer byte is received, given the status of bits BF and SSPOV. The shaded cells show the condition where user software did not properly clear the overflow condition. Flag bit BF is cleared by reading the SSPBUF register while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I^2C specification as well as the requirement of the SSP module is shown in timing parameter #100 and parameter #101.

11.5.1.1 ADDRESSING

Once the SSP module has been enabled, it waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The

address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- a) The SSPSR register value is loaded into the SSPBUF register.
- b) The buffer full bit, BF is set.
- c) An ACK pulse is generated.
- d) SSP interrupt flag bit, SSPIF (PIR1<3>) is set (interrupt is generated if enabled) - on the falling edge of the ninth SCL pulse.

In 10-bit address mode, two address bytes need to be received by the slave (Figure 11-16). The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address. The sequence of events for 10-bit address is as follows, with steps 7-9 for slave-transmitter:

- 1. Receive first (high) byte of Address (bits SSPIF, BF, and bit UA (SSPSTAT<1>) are set).
- Update the SSPADD register with second (low) byte of Address (clears bit UA and releases the SCL line).
- 3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 4. Receive second (low) byte of Address (bits SSPIF, BF, and UA are set).
- 5. Update the SSPADD register with the first (high) byte of Address, if match releases SCL line, this will clear bit UA.
- 6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 7. Receive repeated START condition.
- 8. Receive first (high) byte of Address (bits SSPIF and BF are set).
- 9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

TABLE 11-4: DATA TRANSFER RECEIVED BYTE ACTIONS

	ts as Data s Received			Set bit SSPIF		
BF	SSPOV	$SSPSR \to SSPBUF$	Generate ACK Pulse	(SSP Interrupt occurs if enabled)		
0	0	Yes	Yes	Yes		
1	0	No	No	Yes		
1	1	No	No	Yes		
0	1	No	No	Yes		

11.5.1.2 RECEPTION

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no acknowledge (\overline{ACK}) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set or bit SSPOV (SSPCON<6>) is set. An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the byte.

FIGURE 11-25: I²C WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)

Receiving Address R/W=0_Receiving Data ACK Receiving Data ACK Receivin	₹ <u> </u>
SSPIF (PIR1<3>)	Bus Master terminates
BF (SSPSTAT<0>) SSPBUF register is read	transfer
SSPOV (SSPCON<6>)	
Bit SSPOV is set because the SSPBUF register is still full.	
ACK is not sent.——	

11.5.1.3 TRANSMISSION

When the R/\overline{W} bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF register. The \overline{ACK} pulse will be sent on the ninth bit, and pin RC3/SCK/SCL is held low. The transmit data must be loaded into the SSP-BUF register, which also loads the SSPSR register. Then pin RC3/SCK/SCL should be enabled by setting bit CKP (SSPCON<4>). The master must monitor the SCL pin prior to asserting another clock pulse. The slave devices may be holding off the master by stretching the clock. The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (Figure 11-26). An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF must be cleared in software, and the SSPSTAT register is used to determine the status of the byte. Flag bit SSPIF is set on the falling edge of the ninth clock pulse.

As a slave-transmitter, the \overline{ACK} pulse from the masterreceiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line was high (not \overline{ACK}), then the data transfer is complete. When the \overline{ACK} is latched by the slave, the slave logic is reset (resets SSPSTAT register) and the slave then monitors for another occurrence of the START bit. If the SDA line was low (\overline{ACK}), the transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then pin RC3/SCK/SCL should be enabled by setting bit CKP.

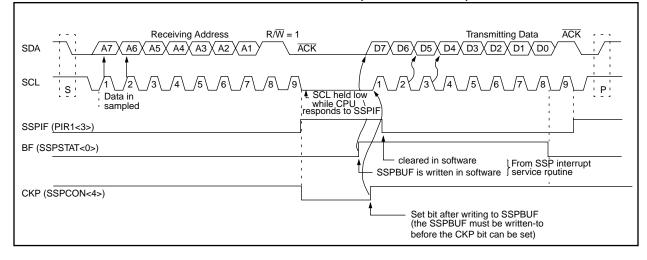


FIGURE 11-26: I²C WAVEFORMS FOR TRANSMISSION (7-BIT ADDRESS)

11.5.2 MASTER MODE

Master mode of operation is supported in firmware using interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a reset or when the SSP module is disabled. The STOP (P) and START (S) bits will toggle based on the START and STOP conditions. Control of the I²C bus may be taken when the P bit is set, or the bus is idle and both the S and P bits are clear.

In master mode the SCL and SDA lines are manipulated by clearing the corresponding TRISC<4:3> bit(s). The output level is always low, irrespective of the value(s) in PORTC<4:3>. So when transmitting data, a '1' data bit must have the TRISC<4> bit set (input) and a '0' data bit must have the TRISC<4> bit cleared (output). The same scenario is true for the SCL line with the TRISC<3> bit.

The following events will cause SSP Interrupt Flag bit, SSPIF, to be set (SSP Interrupt if enabled):

- START condition
- STOP condition
- Data transfer byte transmitted/received

Master mode of operation can be done with either the slave mode idle (SSPM3:SSPM0 = 1011) or with the slave active. When both master and slave modes are enabled, the software needs to differentiate the source(s) of the interrupt.

11.5.3 MULTI-MASTER MODE

In multi-master mode, the interrupt generation on the detection of the START and STOP conditions allows the determination of when the bus is free. The STOP (P) and START (S) bits are cleared from a reset or when the SSP module is disabled. The STOP (P) and START (S) bits will toggle based on the START and STOP conditions. Control of the I²C bus may be taken when bit P (SSPSTAT<4>) is set, or the bus is idle and both the S and P bits clear. When the bus is busy, enabling the SSP Interrupt will generate the interrupt when the STOP condition occurs.

In multi-master operation, the SDA line must be monitored to see if the signal level is the expected output level. This check only needs to be done when a high level is output. If a high level is expected and a low level is present, the device needs to release the SDA and SCL lines (set TRISC<4:3>). There are two stages where this arbitration can be lost, these are:

- Address Transfer
- Data Transfer

When the slave logic is enabled, the slave continues to receive. If arbitration was lost during the address transfer stage, communication to the device may be in progress. If addressed an ACK pulse will be generated. If arbitration was lost during the data transfer stage, the device will need to re-transfer the data at a later time.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other resets	
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u	
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000	
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000	
13h	SSPBUF	Synchrono	us Serial	Port Rece	eive Buffe	r/Transmit	t Register			xxxx xxxx	uuuu uuuu	
93h	SSPADD	Synchrono	us Serial	Port (I ² C I	mode) Ac	ldress Re	gister			0000 0000	0000 0000	
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000	
94h	SSPSTAT	SMP ⁽³⁾	CKE ⁽³⁾	D/Ā	Р	S	R/W	UA	BF	0000 0000	0000 0000	
87h	TRISC	PORTC Da	ta Directi	on registe	er					1111 1111	1111 1111	

TABLE 11-5: REGISTERS ASSOCIATED WITH I²C OPERATION

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'.

Shaded cells are not used by SSP module in SPI mode.

Note 1: PSPIF and PSPIE are reserved on the PIC16C66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

^{3:} The SMP and CKE bits are implemented on the PIC16C66/67 only. All other PIC16C6X devices have these two bits unimplemented, read as '0'.

FIGURE 11-27: OPERATION OF THE I²C MODULE IN IDLE_MODE, RCV_MODE OR XMIT_MODE

IDLE_MODE (7-bit):	
if (Addr_match)	{ Set interrupt;
	if $(R/\overline{W} = 1)$ { Send $\overline{ACK} = 0$;
	set XMIT_MODE;
	else if $(R/\overline{W} = 0)$ set RCV_MODE;
RCV_MODE:]
if ((SSPBUF=Full) OR (SSPOV	= 1))
{ Set SSPOV;	
Do not ackn	owledge;
} else { transfer SS	$PSR \rightarrow SSPBUF;$
send ACK =	
}	
Receive 8-bits in SSPSR;	
Set interrupt;	
XMIT_MODE:	
While ((SSPBUF = Empty) ANE Send byte;	(CRF=0)) Hold SCE LOW,
Set interrupt;	
if (\overline{ACK} Received = 1)	{ End of transmission;
	Go back to IDLE_MODE;
else if (ACK Received = 0) Go IDLE_MODE (10-Bit):) back to XMIT_MODE;
If (High_byte_addr_match AND	$(R/\overline{W}=0))$
	DR_MATCH = FALSE;
Set interrupt	;
	= Full) OR ((SSPOV = 1))
{	Set SSPOV; Do not acknowledge;
}	Do not acknowledge,
else {	Set UA = 1;
	Send $\overline{ACK} = 0$;
	While (SSPADD not updated) Hold SCL low;
	Clear UA = 0;
	Receive Low_addr_byte; Set interrupt;
	Set UA = 1;
	If (Low_byte_addr_match)
	{ PRIOR_ADDR_MATCH = TRUE;
	Send ACK = 0; while (SSPADD not undeted) Held SCI Jawr
	while (SSPADD not updated) Hold SCL low; Clear UA = 0;
	Set RCV_MODE;
	}
}	
}	
else if (High_byte_addr_match	AND (R/W = 1)
	DDR_MATCH)
{	send $\overline{ACK} = 0$:
t	set XMIT_MODE;
}	····· <u>···</u> ····························
, else PRIOR_ADDR_	MATCH = FALSE:
}	
,	

12.0 UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART) MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI) The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc.

The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous Master (half duplex)
- Synchronous Slave (half duplex)

Bit SPEN (RCSTA<7>) and bits TRISC<7:6> have to be set in order to configure pins RC6/TX/CK and RC7/RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter.

FIGURE 12-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER (ADDRESS 98h)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0	
CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	R = Readable bit
bit7							bit0	W = Writable bit U = Unimplemented bit,
								read as '0'
								- n =Value at POR reset
bit 7:	CSRC: Clo	ck Source	Select bit					
	Asynchron Don't care	<u>ous mode</u>						
		mode (Clo	ck generate k from exte			G)		
bit 6:	1 = Selects	Transmit Er s 9-bit trans s 8-bit trans	mission					
bit 5:	TXEN: Trar		le bit					
	1 = Transm 0 = Transm							
			verrides TXI	EN in SYN	NC mode.			
bit 4:	SYNC: US	ART Mode	Select bit					
	1 = Synchr 0 = Asynch	onous moo						
bit 3:		ented: Rea						
bit 2:	•		ite Select bi	+				
bit 2.	Asynchron			L				
	1 = High sp							
	Note:							eed mode (BRGH = 1) may
								t BRGH = 0. If you desire a ce errata for additional infor-
		•	use the PIC			port, 10101		
	0 = Low sp	eed						
	<u>Synchrono</u> Unused in							
bit 1:			Register St	atus bit				
	1 = TSR er 0 = TSR fu							
bit 0:			mit data. Ca	n be parit	ty bit.			

Г

FIGURE 12-2: RCSTA: RECEIVE STATUS AND CONTROL REGISTER (ADDRESS 18h)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R-0	R-0	R-x		
SPEN	RX9	SREN	CREN		FERR	OERR	RX9D	R	= Readable bit
bit7		I			1		bitO	W U - n x	= Writable bit = Unimplemented bit, read as '0' = Value at POR reset = unknown
bit 7:	SPEN : Ser (Configures 1 = Serial p 0 = Serial p	s RC7/RX/l	DT and RC	6/TX/CK	oins as ser	al port pins	s when bits	TRIS	C<7:6> are set)
bit 6:	RX9 : 9-bit I 1 = Selects 0 = Selects	9-bit rece	ption						
bit 5:	SREN: Sing	gle Receive	e Enable bit	t					
	Asynchrone Don't care	<u>ous mode</u>							
	$\frac{\text{Synchrono}}{1 = \text{Enable}}$ $0 = \text{Disable}$ This bit is c	s single rea s single re	ceive	is comple	ete.				
	Synchrono Unused in t		<u>slave</u>						
bit 4:	CREN: Cor	ntinuous Re	eceive Enal	ole bit					
	$\frac{\text{Asynchron}}{1 = \text{Enable}}$ $0 = \text{Disable}$	s continuo							
	Synchrono 1 = Enable 0 = Disable	s continuo	us receive u us receive	Intil enabl	e bit CREN	l is cleared	(CREN ov	erride	s SREN)
bit 3:	Unimplem	ented: Rea	ad as '0'						
bit 2:	FERR: Fran 1 = Framing 0 = No fran	g error (Ca		ed by read	ding RCRE	G register	and receive	e next	valid byte)
bit 1:	OERR : Ove 1 = Overrue 0 = No ove	n error (Ca		d by clear	ing bit CR	EN)			
bit 0:	RX9D : 9th	bit of recei	ved data (C	an be par	ity bit)				

12.1 USART Baud Rate Generator (BRG)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The BRG supports both the Asynchronous and Synchronous modes of the USART. It is a dedicated 8-bit baud rate generator. The SPBRG register controls the period of a free running 8-bit timer. In asynchronous mode bit BRGH (TXSTA<2>) also controls the baud rate. In synchronous mode bit BRGH is ignored. Table 12-1 shows the formula for computation of the baud rate for different USART modes which only apply in master mode (internal clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG register can be calculated using the formula in Table 12-1. From this, the error in baud rate can be determined.

Example 12-1 shows the calculation of the baud rate error for the following conditions:

Fosc = 16 MHz Desired Baud Rate = 9600 BRGH = 0 SYNC = 0

EXAMPLE 12-1: CALCULATING BAUD RATE ERROR

Desired Baud rate = Fosc / (64 (X + 1))

9600 = 16000000 / (64 (X + 1))

 $X = \lfloor 25.042 \rfloor = 25$

Calculated Baud Rate=16000000 / (64 (25 + 1))

Error = (<u>Calculated Baud Rate - Desired Baud Rate</u>) Desired Baud Rate

= (9615 - 9600) / 9600

= 0.16%

It may be advantageous to use the high baud rate (BRGH = 1) even for slower baud clocks. This is because the FOSC/(16(X + 1)) equation can reduce the baud rate error in some cases.

Writing a new value to the SPBRG register, causes the BRG timer to be reset (or cleared), this ensures that the BRG does not wait for a timer overflow before outputting the new baud rate.

TABLE 12-1: BAUD RATE FORMULA

SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
0	(Asynchronous) Baud Rate = Fosc/(64(X+1))	Baud Rate = Fosc/(16(X+1))
1	(Synchronous) Baud Rate = Fosc/(4(X+1))	N/A

X = value in SPBRG (0 to 255)

TABLE 12-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets	
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010	
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x	
99h	SPBRG	Baud Rat	te Genera	0000 0000	0000 0000							

Legend: x = unknown, - = unimplemented read as '0'. Shaded cells are not used by the BRG.

BAUD	FOSC = 20 MHz		SPBRG	16 MHz SPBRG			10 MHz		SPBRG	7.15909	MHz	SPBRG
RATE (K)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-
2.4	NA	-	-	NA	-	-	NA	-	-	NA	-	-
9.6	NA	-	-	NA	-	-	9.766	+1.73	255	9.622	+0.23	185
19.2	19.53	+1.73	255	19.23	+0.16	207	19.23	+0.16	129	19.24	+0.23	92
76.8	76.92	+0.16	64	76.92	+0.16	51	75.76	-1.36	32	77.82	+1.32	22
96	96.15	+0.16	51	95.24	-0.79	41	96.15	+0.16	25	94.20	-1.88	18
300	294.1	-1.96	16	307.69	+2.56	12	312.5	+4.17	7	298.3	-0.57	5
500	500	0	9	500	0	7	500	0	4	NA	-	-
HIGH	5000	-	0	4000	-	0	2500	-	0	1789.8	-	0
LOW	19.53	-	255	15.625	-	255	9.766	-	255	6.991	-	255

TABLE 12-3: BAUD RATES FOR SYNCHRONOUS MODE

	FOSC = 5.0688 MHz			4 MHz			3.579545 MHz			1 MHz			32.768 kHz		
BAUD RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-	0.303	+1.14	26
1.2	NA	-	-	NA	-	-	NA	-	-	1.202	+0.16	207	1.170	-2.48	6
2.4	NA	-	-	NA	-	-	NA	-	-	2.404	+0.16	103	NA	-	-
9.6	9.6	0	131	9.615	+0.16	103	9.622	+0.23	92	9.615	+0.16	25	NA	-	-
19.2	19.2	0	65	19.231	+0.16	51	19.04	-0.83	46	19.24	+0.16	12	NA	-	-
76.8	79.2	+3.13	15	76.923	+0.16	12	74.57	-2.90	11	83.34	+8.51	2	NA	-	-
96	97.48	+1.54	12	1000	+4.17	9	99.43	+3.57	8	NA	-	-	NA	-	-
300	316.8	+5.60	3	NA	-	-	298.3	-0.57	2	NA	-	-	NA	-	-
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
HIGH	1267	-	0	100	-	0	894.9	-	0	250	-	0	8.192	-	0
LOW	4.950	-	255	3.906	-	255	3.496	-	255	0.9766	-	255	0.032	-	255

TABLE 12-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD	FOSC = 20 MHz SPBRG			16 MHz SPBRG			10 MHz SPBRG			7.15909 I	SPBRG	
RATE (K)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	1.221	+1.73	255	1.202	+0.16	207	1.202	+0.16	129	1.203	+0.23	92
2.4	2.404	+0.16	129	2.404	+0.16	103	2.404	+0.16	64	2.380	-0.83	46
9.6	9.469	-1.36	32	9.615	+0.16	25	9.766	+1.73	15	9.322	-2.90	11
19.2	19.53	+1.73	15	19.23	+0.16	12	19.53	+1.73	7	18.64	-2.90	5
76.8	78.13	+1.73	3	83.33	+8.51	2	78.13	+1.73	1	NA	-	-
96	104.2	+8.51	2	NA	-	-	NA	-	-	NA	-	-
300	312.5	+4.17	0	NA	-	-	NA	-	-	NA	-	-
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-
HIGH	312.5	-	0	250	-	0	156.3	-	0	111.9	-	0
LOW	1.221	-	255	0.977	-	255	0.6104	-	255	0.437	-	255

	FOSC = 5.0688 MHz			4 MHz			3.579545 MHz			1 MHz			32.768 kHz		
BAUD RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	0.31	+3.13	255	0.3005	-0.17	207	0.301	+0.23	185	0.300	+0.16	51	0.256	-14.67	1
1.2	1.2	0	65	1.202	+1.67	51	1.190	-0.83	46	1.202	+0.16	12	NA	-	-
2.4	2.4	0	32	2.404	+1.67	25	2.432	+1.32	22	2.232	-6.99	6	NA	-	-
9.6	9.9	+3.13	7	NA	-	-	9.322	-2.90	5	NA	-	-	NA	-	-
19.2	19.8	+3.13	3	NA	-	-	18.64	-2.90	2	NA	-	-	NA	-	-
76.8	79.2	+3.13	0	NA	-	-	NA	-	-	NA	-	-	NA	-	-
96	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
300	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
HIGH	79.2	-	0	62.500	-	0	55.93	-	0	15.63	-	0	0.512	-	0
LOW	0.3094	-	255	3.906	-	255	0.2185	-	255	0.0610	-	255	0.0020	-	255

BAUD RATE	Fosc = 2	20 MHz %	SPBRG value	16 MHz	%	SPBRG value	10 MHz	%	SPBRG value	7.16 MH	z %	SPBRG value
(K)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)
9.6	9.615	+0.16	129	9.615	+0.16	103	9.615	+0.16	64	9.520	-0.83	46
19.2	19.230	+0.16	64	19.230	+0.16	51	18.939	-1.36	32	19.454	+1.32	22
38.4	37.878	-1.36	32	38.461	+0.16	25	39.062	+1.7	15	37.286	-2.90	11
57.6	56.818	-1.36	21	58.823	+2.12	16	56.818	-1.36	10	55.930	-2.90	7
115.2	113.636	-1.36	10	111.111	-3.55	8	125	+8.51	4	111.860	-2.90	3
250	250	0	4	250	0	3	NA	-	-	NA	-	-
625	625	0	1	NA	-	-	625	0	0	NA	-	-
1250	1250	0	0	NA	-	-	NA	-	-	NA	-	-

TABLE 12-5: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD	Fosc = 5	.068 MHz	SPBRG	4 MHz		SPBRG	3.579 Mł	łz	SPBRG	1 MHz		SPBRG	32.768	κHz	SPBRG
RATE		%	value		%	value		%	value		%	value		%	value
(K)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)
9.6	9.6	0	32	NA	-	-	9.727	+1.32	22	8.928	-6.99	6	NA	-	-
19.2	18.645	-2.94	16	1.202	+0.17	207	18.643	-2.90	11	20.833	+8.51	2	NA	-	-
38.4	39.6	+3.12	7	2.403	+0.13	103	37.286	-2.90	5	31.25	-18.61	1	NA	-	-
57.6	52.8	-8.33	5	9.615	+0.16	25	55.930	-2.90	3	62.5	+8.51	0	NA	-	-
115.2	105.6	-8.33	2	19.231	+0.16	12	111.860	-2.90	1	NA	-	-	NA	-	-
250	NA	-	-	NA	-	-	223.721	-10.51	0	NA	-	-	NA	-	-
625	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1250	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-

Note: For the PIC16C63/R63/65/65A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

12.1.1 SAMPLING

The data on the RC7/RX/DT pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX pin. If bit BRGH (TXSTA<2>) is clear (i.e., at the low baud rates), the sampling is done on the seventh, eighth and ninth falling edges of a x16 clock (Figure 12-3). If bit BRGH is set (i.e., at the high baud rates), the sampling is done on the 3 clock edges preceding the second rising edge after the first falling edge of a x4 clock (Figure 12-4 and Figure 12-5).

FIGURE 12-3: RX PIN SAMPLING SCHEME (BRGH = 0) PIC16C63/R63/65/65A/R65)

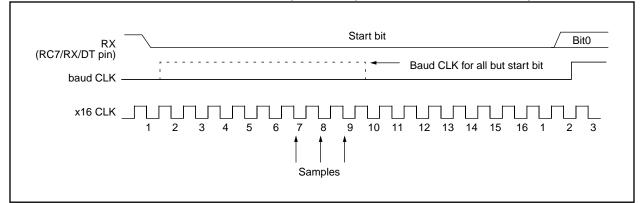
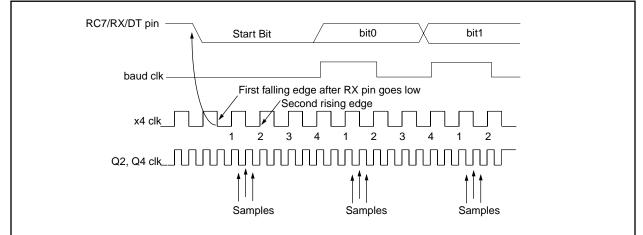
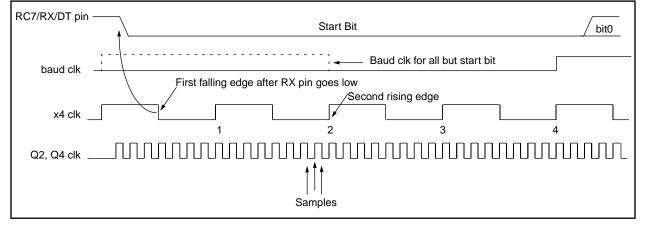
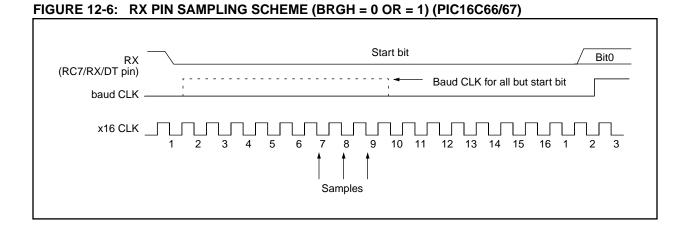


FIGURE 12-4: RX PIN SAMPLING SCHEME (BRGH = 1) (PIC16C63/R63/65/65A/R65)









12.2 USART Asynchronous Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

In this mode, the USART uses standard nonreturn-tozero (NRZ) format (one start bit, eight or nine data bits and one stop bit). The most common data format is 8-bits. An on-chip dedicated 8-bit baud rate generator can be used to derive standard baud rate frequencies from the oscillator. The USART transmits and receives the LSb first. The USART's transmitter and receiver are functionally independent but use the same data format and baud rate. The baud rate generator produces a clock either x16 or x64 of the bit shift rate, depending on bit BRGH (TXSTA<2>). Parity is not supported by the hardware, but can be implemented in software (and stored as the ninth data bit). Asynchronous mode is stopped during SLEEP.

Asynchronous mode is selected by clearing bit SYNC (TXSTA<4>).

The USART Asynchronous module consists of the following important elements:

- Baud Rate Generator
- · Sampling Circuit
- Asynchronous Transmitter
- Asynchronous Receiver

12.2.1 USART ASYNCHRONOUS TRANSMITTER

The USART transmitter block diagram is shown in Figure 12-7. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer, TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the STOP bit has been transmitted from the previous load. As soon as the STOP bit is transmitted, the TSR is loaded with new data from the TXREG (if available). Once the TXREG register transfers the data to the TSR register (occurs in one TcY) the TXREG register is empty and flag bit TXIF (PIR1<4>) is set. This interrupt is enabled/dis-

abled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set regardless of the state of enable bit TXIE and cannot be cleared in software. It will reset only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit, TRMT (TXSTA<1>) shows the status of the TSR register. Status bit TRMT is a read only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty.

	Note 1:	The TSR register is not mapped in data memory so it is not available to the user.
Note 2: Flag bit TXIF is set when enable bit TXEN is set.	Note 2:	

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data and the baud rate generator (BRG) has produced a shift clock (Figure 12-7). The transmission can also be started by first loading the TXREG register and then setting enable bit TXEN. Normally when transmission is first started, the TSR register is empty, so a transfer to the TXREG register resulting in an empty TXREG register. A back-to-back transfer is thus possible (Figure 12-9). Clearing enable bit TXEN during a transmission will cause the transmission to be aborted and will revert to hi-impedance.

In order to select 9-bit transmission, transmit bit TX9 (TXSTA<6>) should be set and the ninth bit should be written to bit TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG register can result in an immediate transfer of the data to the TSR register (if the TSR is empty). In such a case, an incorrect ninth data bit maybe loaded in the TSR register.

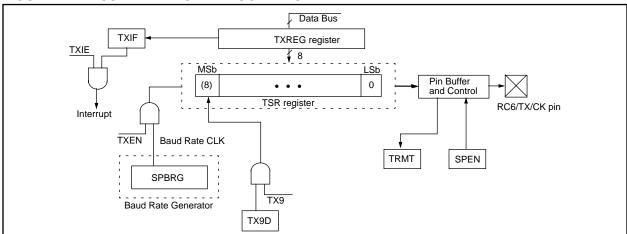


FIGURE 12-7: USART TRANSMIT BLOCK DIAGRAM

Steps to follow when setting up an Asynchronous Transmission:

- 1. Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, then set bit BRGH. (Section 12.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set transmit bit TX9.

- 5. Enable the transmission by setting bit TXEN, which will also set bit TXIF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Load data to the TXREG register (starts transmission).

FIGURE 12-8: ASYNCHRONOUS MASTER TRANSMISSION

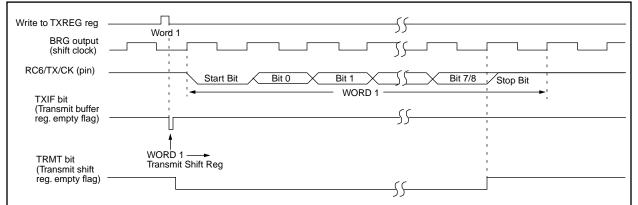


FIGURE 12-9: ASYNCHRONOUS MASTER TRANSMISSION (BACK TO BACK)

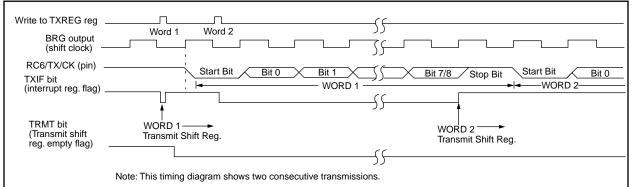


TABLE 12-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	ansmit R	egister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Registe		0000 0000	0000 0000				

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Transmission.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

12.2.2 USART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 12-10. The data comes in the RC7/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at FOSC.

Once Asynchronous mode is selected, reception is enabled by setting bit CREN (RCSTA<4>).

The heart of the receiver is the receive (serial) shift register (RSR). After sampling the STOP bit, the received data in the RSR is transferred to the RCREG register (if it is empty). If the transfer is complete, flag bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit which is cleared by the hardware. It is cleared when the RCREG register has been read and is empty. The RCREG is double buffered register, i.e., it is a two deep FIFO. It is

FIGURE 12-10: USART RECEIVE BLOCK DIAGRAM

possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte begin shifting to the RSR register. On the detection of the STOP bit of the third byte, if the RCREG is still full, then the overrun error bit, OERR (RCSTA<1>) will be set. The word in the RSR register will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun bit OERR has to be cleared in software. This is done by resetting the receive logic (CREN is cleared and then set). If bit OERR is set, transfers from the RSR register to the RCREG register are inhibited, so it is essential to clear overrun bit OERR if it is set. Framing error bit FERR (RCSTA<2>) is set if a stop bit is detected as clear. Error bit FERR and the 9th receive bit are buffered the same way as the receive data. Reading the RCREG register will load bits RX9D and FERR with new values. Therefore it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

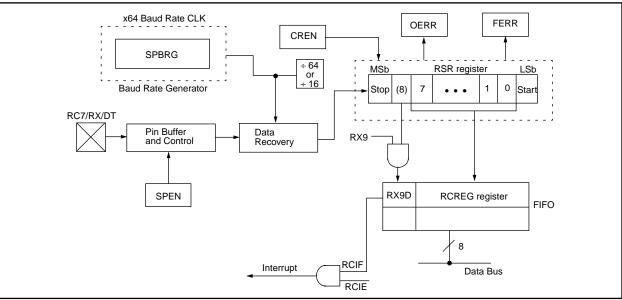
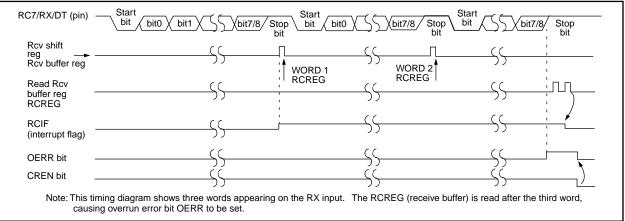


FIGURE 12-11: ASYNCHRONOUS RECEPTION



Steps to follow when setting up an Asynchronous Reception:

- 1. Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH (Section 12.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- 3. If interrupts are desired, then set enable bit RCIE.
- 4. If 9-bit reception is desired, then set bit RX9.
- 5. Enable the reception by setting enable bit CREN.

- Flag bit RCIF will be set when reception is complete, and an interrupt will be generated if enable bit RCIE was set.
- 7. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading the RCREG register.
- 9. If any error occurred, clear the error by clearing enable bit CREN.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00x
1Ah	RCREG	USART Re	eceive Re	egister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Genera	tor Registe		0000 0000	0000 0000				

TABLE 12-7: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Reception.

Note 1: PSPIE and PSPIF are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIE1<6> and PIR1<6> are reserved, always maintain these bits clear.

12.3 USART Synchronous Master Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

In Synchronous Master mode the data is transmitted in a half-duplex manner i.e., transmission and reception do not occur at the same time. When transmitting data the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTA<4>). In addition enable bit SPEN (RCSTA<7>) is set in order to configure the RC6 and RC7 I/O pins to CK (clock) and DT (data) lines respectively. The Master mode indicates that the processor transmits the master clock on the CK line. The Master mode is entered by setting bit CSRC (TXSTA<7>).

12.3.1 USART SYNCHRONOUS MASTER TRANSMISSION

The USART transmitter block diagram is shown in Figure 12-7. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer register, TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR register is loaded with new data from the TXREG register (if available). Once the TXREG register transfers the data to the TSR register (occurs in one Tcycle), the TXREG register is empty and interrupt flag bit TXIF (PIR1<4>) is set. This interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set regardless of the status of enable bit TXIE and cannot be cleared in software. It will clear only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit, TRMT (TXSTA<1>), shows the status of the TSR register. Status bit TRMT is a read only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty. The TSR register is not mapped in data memory so it is not available to the user.

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data. The first data bit will be shifted out on the next available rising edge of the clock on the CK line. Data out is stable around the falling edge of the synchronous clock (Figure 12-12). The transmission can also be started by first loading the TXREG register and then setting enable bit TXEN (Figure 12-13). This is advantageous when slow baud rates are selected, since the BRG is kept in reset when bits TXEN, CREN, and SREN are clear. Setting enable bit TXEN will start the BRG, creating a shift clock immediately. Normally when transmission is first started, the TSR register is empty, so a transfer to the TXREG register will result in an immediate transfer to TSR resulting in an empty TXREG register. Back-to-back transfers are possible.

Clearing enable bit TXEN, during a transmission, will cause the transmission to be aborted and will reset the transmitter. The DT and CK pins will revert to hi-impedance. If, during a transmission, either bit CREN or bit SREN is set the transmission is aborted and the DT pin reverts to a hi-impedance state (for a reception). The CK pin will remain an output if bit CSRC is set (internal clock). The transmitter logic however, is not reset although it is disconnected from the pins. In order to reset the transmitter, the user has to clear enable bit TXEN. If enable bit SREN is set (to interrupt an on going transmission and receive a single word), then after the single word is received, enable bit SREN will be cleared, and the serial port will revert back to transmitting since enable bit TXEN is still set. The DT line will immediately switch from hi-impedance receive mode to transmit and start driving. To avoid this, enable bit TXEN should be cleared.

In order to select 9-bit transmission, bit TX9 (TXSTA<6>) should be set and the ninth bit should be written to bit TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG register can result in an immediate transfer of the data to the TSR register (if the TSR is empty). If the TSR register was empty and the TXREG register was written before writing the "new" TX9D, the "present" value of bit TX9D is loaded.

Steps to follow when setting up a Synchronous Master Transmission:

- 1. Initialize the SPBRG register for the appropriate baud rate (Section 12.1).
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- 3. If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set bit TX9.
- 5. Enable the transmission by setting enable bit TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Start transmission by loading data to the TXREG register.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	ansmit Re	egister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Regist		0000 0000	0000 0000				

TABLE 12-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Master Transmission. Note 1: PSPIE and PSPIF are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIE1<6> and PIR1<6> are reserved, always maintain these bits clear.

FIGURE 12-12: SYNCHRONOUS TRANSMISSION

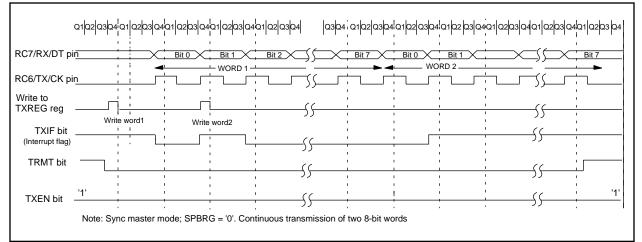
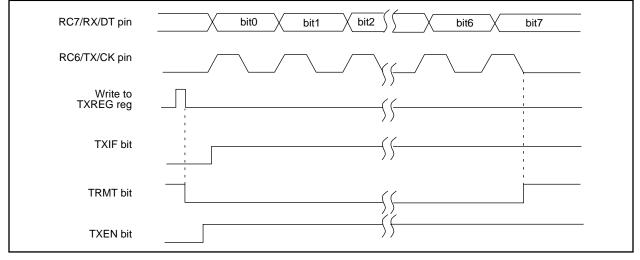


FIGURE 12-13: SYNCHRONOUS TRANSMISSION THROUGH TXEN



12.3.2 USART SYNCHRONOUS MASTER RECEPTION

Once Synchronous Mode is selected, reception is enabled by setting either enable bit SREN (RCSTA<5>) bit or enable bit CREN (RCSTA<4>). Data is sampled on the DT pin on the falling edge of the clock. If enable bit SREN is set, then only a single word is received. If enable bit CREN is set, the reception is continuous until bit CREN is cleared. If both the bits are set then bit CREN takes precedence. After clocking the last bit, the received data in the Receive Shift Register (RSR) is transferred to the RCREG register (if it is empty). When the transfer is complete, interrupt bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit which is reset by the hardware. In this case, it is reset when the RCREG register has been read and is empty. The RCREG is a double buffered register, i.e., it is a two deep FIFO. It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting into the RSR register. On the clocking of the last bit of the third byte, if the RCREG register is still full, then overrun error bit, OERR (RCSTA<1>) is set. The word in the RSR register will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun error bit OERR has to be cleared in software (by clearing bit CREN). If bit OERR is set, transfers from the RSR to the RCREG are inhibited, so it is essential to clear bit OERR if it is set. The 9th receive bit is buffered the same way as the receive data. Reading the RCREG register will load bit RX9D with a new value. Therefore it is essential for the user to read the RCSTA register before reading the RCREG register in order not to lose the old RX9D bit information.

Steps to follow when setting up Synchronous Master Reception:

- 1. Initialize the SPBRG register for the appropriate baud rate (Section 12.1).
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- 3. Ensure bits CREN and SREN are clear.
- 4. If interrupts are desired, then set enable bit RCIE.
- 5. If 9-bit reception is desired, then set bit RX9.
- If a single reception is required, set enable bit SREN. For continuous reception set enable bit CREN.
- 7. Flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 9. Read the 8-bit received data by reading the RCREG register.
- 10. If any error occurred, clear the error by clearing enable bit CREN.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	0000 0000	0000 0000				
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
1Ah	RCREG	USART Re	eceive Re	gister		0000 0000	0000 0000				
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Regis		0000 0000	0000 0000				

 TABLE 12-9:
 REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Master Reception.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

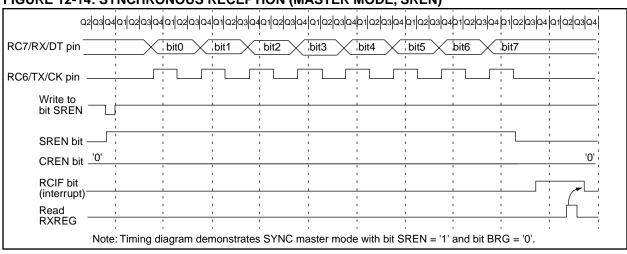


FIGURE 12-14: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

12.4 USART Synchronous Slave Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Synchronous Slave Mode differs from Master Mode in the fact that the shift clock is supplied externally at the CK pin (instead of being supplied internally in master mode). This allows the device to transfer or receive data while in SLEEP mode. Slave mode is entered by clearing bit CSRC (TXSTA<7>).

12.4.1 USART SYNCHRONOUS SLAVE TRANSMIT

The operation of the synchronous master and slave modes are identical except in the case of the SLEEP mode.

If two words are written to the TXREG and then the SLEEP instruction is executed, the following will occur:

- a) The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in TXREG register.
- c) Flag bit TXIF will not be set.
- d) When the first word has been shifted out of TSR, the TXREG register will transfer the second word to the TSR and flag bit TXIF will now be set.
- e) If enable bit TXIE is set, the interrupt will wake the chip from SLEEP and if the global interrupt is enabled, the program will branch to the interrupt vector (0004h).

Steps to follow when setting up Synchronous Slave Transmission:

- 1. Enable the synchronous slave serial port by setting bits SYNC and SPEN, and clearing bit CSRC.
- 2. Clear bits CREN and SREN.
- 3. If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set bit TX9.
- 5. Enable the transmission by setting bit TXEN.
- 6. If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- 7. Start transmission by loading data to the TXREG register.

12.4.2 USART SYNCHRONOUS SLAVE RECEPTION

The operation of the synchronous master and slave modes is identical except in the case of the SLEEP mode. Also, enable bit SREN is a don't care in slave mode.

If receive is enabled by setting bit CREN prior to the SLEEP instruction, then a word may be received during SLEEP. On completely receiving the word, the RSR register will transfer the data to the RCREG register and if enable bit RCIE is set, the interrupt generated will wake the chip from SLEEP. If the global interrupt is enabled, the program will branch to the interrupt vector (0004h).

Steps to follow when setting up a Synchronous Slave Reception:

- Enable the synchronous master serial port by setting bits SYNC and SPEN, and clearing bit CSRC.
- 2. If interrupts are desired, then set enable bit RCIE.
- 3. If 9-bit reception is desired, then set bit RX9.
- 4. To enable reception, set enable bit CREN.
- Flag bit RCIF will be set when reception is complete, and an interrupt will be generated if enable bit RCIE was set.
- 6. Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 7. Read the 8-bit received data by reading the RCREG register.
- 8. If any error occurred, clear the error by clearing enable bit CREN.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	ansmit R		0000 0000	0000 0000					
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	tor Registe		0000 0000	0000 0000				

TABLE 12-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Slave Transmission.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

TABLE 12-11: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	x000 0000	0000 -00x
1Ah	RCREG	USART Re	eceive Re		0000 0000	0000 0000					
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Regist		0000 0000	0000 0000				

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Slave Reception.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

NOTES:

13.0 SPECIAL FEATURES OF THE CPU

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

What sets a microcontroller apart from other processors are special circuits to deal with the needs of realtime applications. The PIC16CXX family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- · Oscillator selection
- Reset
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
 - Brown-out Reset (BOR)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP mode
- · Code protection
- · ID locations
- In-circuit serial programming

The PIC16CXX has a Watchdog Timer which can be shut off only through configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in reset while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

SLEEP mode is designed to offer a very low current power-down mode. The user can wake from SLEEP through external reset, Watchdog Timer Wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

13.1 Configuration Bits

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h - 3FFFh), which can be accessed only during programming.

FIGURE 13-1: CONFIGURATION WORD FOR PIC16C61

 bit13	Unimplen		-		_	_	_	CP0	PWRTE	WDTE	FOSC1	FOSC0 bit0	Register: Address	CONFIG 2007h
bit 4:	CP0 : Code 1 = Code 0 = All me	e protec protecti	ction bit on off	t	d, but ()0h - 3f	⁻ h is wr	itable						
bit 3:	PWRTE : F 1 = Power 0 = Power	-up Tim	Ier enal	bled	e bit									
bit 2:	WDTE : Wa 1 = WDT e 0 = WDT e	enabled		Enable	bit									
bit 1-0:	FOSC1:F0 11 = RC c 10 = HS c 01 = XT o 00 = LP o	scillato scillato scillato	r r r	or Seleo	ction bi	ts								

FIGURE 13-2: CONFIGURATION WORD FOR PIC16C62/64/65

bit13		_	_	_	-	_	CP1	CP0	PWRTE	WDTE	FOSC1	FOSC0 bit0	Register: Address	CONFIG 2007h
bit 13-6:	Unimpleme	nted: R	Read as	'1'									L	
bit 5-4:	CP1:CP0 : C 11 = Code p 10 = Upper 1 01 = Upper 3 00 = All mer	brotection half of p 3/4th of	on off program f prograr	memo n men	nory c	•								
bit 3:	PWRTE : Pov 1 = Power-up 0 = Power-up	p Timei	r enable	d	bit									
bit 2:	WDTE : Wate 1 = WDT ena 0 = WDT dis	abled	Γimer En	able b	bit									
bit 1-0:	FOSC1:FOS 11 = RC osc 10 = HS osc 01 = XT osc 00 = LP osc	cillator cillator cillator	scillator	Selecti	ion bit	S								

FIGURE 13-3: CONFIGURATION WORD FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

CP1	CP0	CP1	CP0	CP1	CP0	—	BODEN	CP1	CP0	PWRTE	WDTE	FOSC1	FOSC0	Register: Address	CONFIG 2007h
bit13													bit0	Address	200711
		P1:CP0				2)									
bit 5:4		= Code	•												
							ode prote								
							code pro	tected							
) = All m	-			tea									
bit 7:	U	nimplen	nented	Read	as '1'										
bit 6:	B	ODEN: E	Brown-o	out Res	et Enat	ole bit (1)								
		= Brown													
	0	= Brown	-out Re	eset dis	abled										
bit 3:	P	NRTE: F	Power-u	ıp Time	r Enabl	e bit (1)								
	1	= Power	-up Tim	ner disa	bled										
	0	= Power	-up Tim	ner ena	bled										
bit 2:	W	DTE: W	atchdog	g Timer	Enable	bit									
	1	= WDT e	enablec	ł											
	0	= WDT o	disable	b											
bit 1-0): F (DSC1:F	OSCO:	Oscillat	or Sele	ction b	its								
	11	= RC c	scillato	r											
	1() = HS c	scillato	r											
		_ = XT o		-											
	00) = LP o	scillato	r											
Note	1· F,	nahling F	Srown-a	nut Res	et auto	matica	llv enable	POW	er-un T	ïmer (P\	NRT) r4	alhrene	ss of the	value of bit P	WRTE
1010							anytime		•	· ·	,	0	55 51 110		
				•									otection s	scheme listed	d.
				•											

13.2 Oscillator Configurations

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

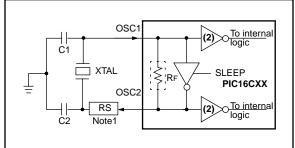
13.2.1 OSCILLATOR TYPES

The PIC16CXX can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor
- 13.2.2 CRYSTAL OSCILLATOR/CERAMIC RESONATORS

In LP, XT, or HS modes a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 13-4). The PIC16CXX oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in LP, XT, or HS modes, the device can have an external clock source to drive the OSC1/CLKIN pin (Figure 13-5).

FIGURE 13-4: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)



See Table 13-1, Table 13-3, Table 13-2 and Table 13-4 for recommended values of C1 and C2.

- Note 1: A series resistor may be required for AT strip cut crystals.
 - 2: For the PIC16C61 the buffer is on the OSC2 pin, all other devices have the buffer on the OSC1 pin.

FIGURE 13-5: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)

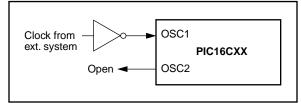


TABLE 13-1: CERAMIC RESONATORS PIC16C61

Ranges Tested:							
Mode	Freq	Freq OSC1					
ХТ	455 kHz 2.0 MHz	47 - 100 pF 15 - 68 pF	47 - 100 pF 15 - 68 pF				
	4.0 MHz	15 - 68 pF	15 - 68 pF				
HS	8.0 MHz 16.0 MHz	15 - 68 pF 10 - 47 pF	15 - 68 pF 10 - 47 pF				
	These values are for design guidance only. See notes at bottom of page.						
Resonators Used:							
455 kHz	Panasonic EFO-A455K04B ± 0.3%						
2.0 MHz	Murata Erie CSA2.00MG ± 0.5%						

2.0 MHz	Murata Erie CSA2.00MG	± 0.5%			
4.0 MHz	Murata Erie CSA4.00MG	± 0.5%			
8.0 MHz	Murata Erie CSA8.00MT	± 0.5%			
16.0 MHz Murata Erie CSA16.00MX ± 0.5%					
All resonators used did not have built-in capacitors.					

TABLE 13-2: CERAMIC RESONATORS PIC16C62/62A/R62/63/R63/64/ 64A/R64/65/65A/R65/66/67

Ranges Tested:						
Mode	Freq	OSC2				
XT	455 kHz	68 - 100 pF	68 - 100 pF			
	2.0 MHz	15 - 68 pF	15 - 68 pF			
	4.0 MHz	15 - 68 pF	15 - 68 pF			
HS	8.0 MHz	10 - 68 pF	10 - 68 pF			
	16.0 MHz	10 - 22 pF	10 - 22 pF			
	se values are f es at bottom of p	i or design guidar bage.	nce only. See			
Resonato	Resonators Used:					
455 kHz Panasonic EFO-A455K04B ± 0.3%						
2.0 MHz	Murata Erie CSA2.00MG ± 0.5%					
4.0 MHz	MHz Murata Erie CSA4.00MG ± 0.5%					
8.0 MHz	Murata Erie CSA8.00MT ± 0.5%					
16.0 MHz	Murata Erie CSA16.00MX ± 0.5%					
All reso	onators used did	d not have built-in	capacitors.			

TABLE 13-3: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR FOR PIC16C61

Mode	Freq	OSC1	OSC2		
LP	32 kHz	33 - 68 pF	33 - 68 pF		
	200 kHz	15 - 47 pF	15 - 47 pF		
ХТ	100 kHz	47 - 100 pF	47 - 100 pF		
	500 kHz	20 - 68 pF	20 - 68 pF		
	1 MHz	15 - 68 pF	15 - 68 pF		
	2 MHz	15 - 47 pF	15 - 47 pF		
	4 MHz	15 - 33 pF	15 - 33 pF		
HS	8 MHz	15 - 47 pF	15 - 47 pF		
	20 MHz	15 - 47 pF	15 - 47 pF		
These values are for design guidance only. See notes at bottom of page.					

TABLE 13-4:CAPACITOR SELECTION
FOR CRYSTAL OSCILLATOR
FOR PIC16C62/62A/R62/63/
R63/64/64A/R64/65/65A/R65/
66/67

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF
	e values are at bottom of	for design guidanc page.	e only. See
	Crys	stals Used	
32 kHz	Epson C-00	01R32.768K-A	\pm 20 PPM
200 kHz	STD XTL 2	± 20 PPM	
1 MHz	ECS ECS-	\pm 50 PPM	
4 MHz	ECS ECS-4	± 50 PPM	
8 MHz	EPSON CA	\pm 30 PPM	
20 MHz	EPSON CA	-301 20.000M-C	\pm 30 PPM

Note 1: Recommended values of C1 and C2 are identical to the ranges tested Table 13-1 and Table 13-2.

2: Higher capacitance increases the stability of oscillator but also increases the start-up time.

3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.

4: Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification.

13.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance, or one with parallel resonance.

Figure 13-6 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 k Ω resistor provides the negative feedback for stability. The 10 k Ω potentiometer biases the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 13-6: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT

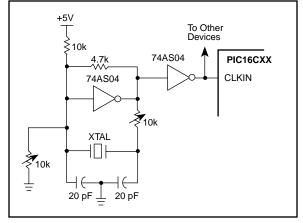
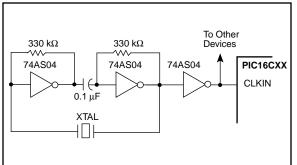


Figure 13-7 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 13-7: EXTERNAL SERIES RESONANT CRYSTAL OSCILLATOR CIRCUIT



13.2.4 RC OSCILLATOR

For timing insensitive applications the RC device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 13-8 shows how the RC combination is connected to the PIC16CXX. For Rext values below 2.2 k Ω , the oscillator operation may become unstable or stop completely. For very high Rext values (e.g. 1 M Ω), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend keeping Rext between 3 k Ω and 100 k Ω .

Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See characterization data for desired device for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See characterization data for desired device for variation of oscillator frequency due to VDD for given Rext/ Cext values as well as frequency variation due to operating temperature for given R, C, and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (see Figure 3-5 for waveform).

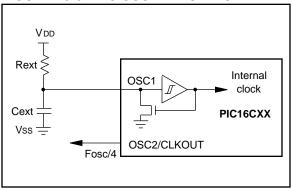


FIGURE 13-8: RC OSCILLATOR MODE

13.3 <u>Reset</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The PIC16CXX differentiates between various kinds of reset:

- Power-on Reset (POR)
- MCLR reset during normal operation
- MCLR reset during SLEEP
- WDT Reset (normal operation)
- Brown-out Reset (BOR) Not on PIC16C61/62/ 64/65

Some registers are not affected in any reset condition, their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a "reset state" on Power-on Reset (POR), on $\overline{\text{MCLR}}$ or $\overline{\text{WDT}}$ Reset, on $\overline{\text{MCLR}}$ reset during SLEEP, and on Brownout Reset (BOR). They are not affected by a WDT Wake-up, which is viewed as the resumption of normal operation.

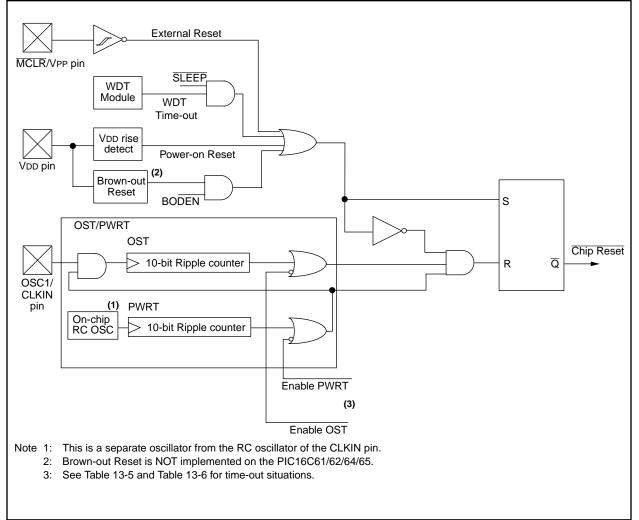
The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different reset situations as indicated in Table 13-7, Table 13-8, and Table 13-9. These bits are used in software to determine the nature of the reset. See Table 13-12 for a full description of reset states of all registers.

A simplified block diagram of the on-chip reset circuit is shown in Figure 13-9.

On the PIC16C62A/R62/63/R63/64A/R64/65A/R65/ 66/67, the $\overline{\text{MCLR}}$ reset path has a noise filter to detect and ignore small pulses. See parameter #34 for pulse width specifications.

It should be noted that a WDT Reset does not drive the $\overline{\text{MCLR}}$ pin low.

FIGURE 13-9: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



13.4 <u>Power-on Reset (POR), Power-up</u> <u>Timer (PWRT), Oscillator Start-up</u> <u>Timer (OST) and Brown-out Reset</u> (BOR)

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

13.4.1 POWER-ON RESET (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.5V - 2.1V). To take advantage of the POR, just tie the $\overline{\text{MCLR}}$ /VPP pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, ...) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met. Brown-out Reset may be used to meet the startup conditions.

For additional information, refer to Application Note AN607, "*Power-up Trouble Shooting*."

13.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms nominal time-out on power-up only, from POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as PWRT is active. The PWRT's time delay allows VDD to rise to an acceptable level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip to chip due to VDD, temperature, and process variation. See DC parameters for details.

13.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

13.4.4 BROWN-OUT RESET (BOR)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

A configuration bit, BODEN, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V (parameter D005 in Electrical Specification section) for greater than parameter #34 (see Electrical Specification section), the brown-out situation will reset the chip. A reset may not occur if VDD falls below 4.0V for less than parameter #34. The chip will remain in Brown-out Reset until VDD rises above BVDD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms. If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once VDD rises above BVDD, the Power-up Timer will execute a 72 ms time delay. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 13-10 shows typical brown-out situations.

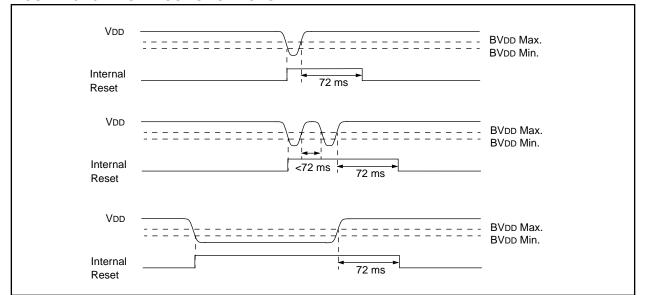


FIGURE 13-10: BROWN-OUT SITUATIONS

13.4.5 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First a PWRT time-out is invoked after the POR time delay has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode, with the PWRT disabled, there will be no time-out at all. Figure 13-11, Figure 13-12, and Figure 13-13 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if the $\overline{\text{MCLR}}/\text{VPP}$ pin is kept low long enough, the time-outs will expire. Then bringing the $\overline{\text{MCLR}}/\text{VPP}$ pin high will begin execution immediately (Figure 13-14). This is useful for testing purposes or to synchronize more than one PIC16CXX device operating in parallel.

Table 13-10 and Table 13-11 show the reset conditions for some special function registers, while Table 13-12 shows the reset conditions for all the registers.

13.4.6 POWER CONTROL/STATUS REGISTER (PCON)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Power Control/Status Register, PCON has up to two bits, depending upon the device. Bit0 is not implemented on the PIC16C62/64/65.

Bit0 is BOR (Brown-out Reset Status bit). BOR is unknown on Power-on Reset. It must then be set by the user and checked on subsequent resets to see if BOR cleared, indicating that a brown-out has occurred. The BOR status bit is a "Don't Care" and is not necessarily predictable if the Brown-out Reset circuitry is disabled (by clearing bit BODEN in the Configuration Word).

Bit1 is POR (Power-on Reset Status bit). It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

TABLE 13-5: TIME-OUT IN VARIOUS SITUATIONS, PIC16C61/62/64/65

Oscillator Configuration	Powe	Wake-up from SLEEP	
	PWRTE = 1 PWRTE = 0		
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	1024 Tosc
RC	72 ms	—	_

TABLE 13-6:TIME-OUT IN VARIOUS SITUATIONS,
PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

Oppillator Configuration	Power	·up	Duran and	Wake up from	
Oscillator Configuration	PWRTE = 0	PWRTE = 1	Brown-out	SLEEP	
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	72 ms + 1024Tosc	1024 Tosc	
RC	72 ms	—	72 ms	—	

TABLE 13-7: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C61

TO	PD	
1	1	Power-on Reset or MCLR reset during normal operation
0	1	WDT Reset
0	0	WDT Wake-up
1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

TABLE 13-8: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C62/64/65

POR	TO	PD	
0	1	1	Power-on Reset
0	0	x	Illegal, TO is set on a Power-on Reset
0	x	0	Illegal, PD is set on a Power-on Reset
1	0	1	WDT Reset
1	0	0	WDT Wake-up
1	u	u	MCLR reset during normal operation
1	1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

Legend: x = unknown, u = unchanged

TABLE 13-9:STATUS BITS AND THEIR SIGNIFICANCE FOR
PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

POR	BOR	TO	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on a Power-on Reset
0	x	x	0	Illegal, PD is set on a Power-on Reset
1	0	x	x	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR reset during normal operation
1	1	1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

Legend: x = unknown, u = unchanged

TABLE 13-10: RESET CONDITION FOR SPECIAL REGISTERS ON PIC16C61/62/64/65

	Program Counter	STATUS	PCON ⁽²⁾
Power-on Reset	000h	0001 1xxx	0-
MCLR reset during normal operation	000h	000u uuuu	u-
MCLR reset during SLEEP	000h	0001 Ouuu	u-
WDT Reset	000h	0000 luuu	u-
WDT Wake-up	PC + 1	սսս0 Օսսս	u-
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul Ouuu	u-

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

2: The PCON register is not implemented on the PIC16C61.

TABLE 13-11: RESET CONDITION FOR SPECIAL REGISTERS ON PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

	Program Counter	STATUS	PCON
Power-on Reset	000h	0001 1xxx	0x
MCLR reset during normal operation	000h	000u uuuu	uu
MCLR reset during SLEEP	000h	0001 Ouuu	uu
WDT Reset	000h	0000 luuu	uu
Brown-out Reset	000h	0001 luuu	u0
WDT Wake-up	PC + 1	uuu0 Ouuu	uu
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuul Ouuu	uu

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

TABLE 13-12: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register						Appli	cab	le De	vices	5					Power-on Reset Brown-out Reset	MCLR Reset during: – normal operation – SLEEP WDT Reset	Wake-up via interrupt or WDT Wake-up
W	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	N/A	N/A	N/A
TMR0	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000h	0000h	PC + 1(2)
STATUS	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0001 1xxx	000q quuu (3)	uuuq quuu (3)
FSR	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	x xxxx	u uuuu	u uuuu
PORTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xx xxxx	uu uuuu	uu uuuu
PORTB	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTD	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTE	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxx	uuu	uuu
PCLATH	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0 0000	0 0000	u uuuu
INTCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000x	0000 000u	uuuu uuuu (1)
PIR1	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0000	00 0000	uu uuuu (1)
	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu (1)
PIR2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0	0	u(2)
TMR1L	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1H	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0000	uu uuuu	uu uuuu
TMR2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
T2CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	-000 0000	-000 0000	-uuu uuuu
SSPBUF	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
CCPR1L	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0000	00 0000	uu uuuu
RCSTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 -00x	0000 -00x	uuuu -uuu
TXREG	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
RCREG	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
CCPR2L	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR2H	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
OPTION	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 1111	1111 1111	uuuu uuuu
TRISA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1 1111	1 1111	u uuuu
	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	11 1111	11 1111	uu uuuu
TRISB	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 1111	1111 1111	uuuu uuuu

Legend: u = unchanged, x = unknown, -= unimplemented bit read as '0', <math>q = value depends on condition. Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

3: See Table 13-10 and Table 13-11 for reset value for specific conditions.

Register		Applicable Devices											Power-on Brown- Rese	out	MCLR Reset during: – normal operation – SLEEP WDT Reset	Wake-up via interrupt or WDT Wake-up		
	64	62 62A R62 63 R63 64 64A R64 65 65A R65 66 67										DOG						
TRISC	61	62	62A	R62	63	R63	64	64A	R64	65	65A	805	60	67	1111 1	111	1111 1111	uuuu uuuu
TRISD	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 1	111	1111 1111	uuuu uuuu
TRISE	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 -	111	0000 -111	uuuu -uuu
PIE1	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0	000	00 0000	uu uuuu
	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0	000	0000 0000	uuuu uuuu
PIE2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		0	0	u
PCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		-0u	uu	uu
FCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		-0-	u-	u-
PR2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 1	111	1111 1111	1111 1111
SSPADD	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0	000	0000 0000	uuuu uuuu
SSPSTAT	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0	000	00 0000	uu uuuu
TXSTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 -	010	0000 -010	uuuu -uuu
SPBRG	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0	000	0000 0000	uuuu uuuu

TABLE 13-12: INITIALIZATION CONDITIONS FOR ALL REGISTERS (Cont.'d)

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0', q = value depends on condition.

Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

3: See Table 13-10 and Table 13-11 for reset value for specific conditions.

FIGURE 13-11: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 1

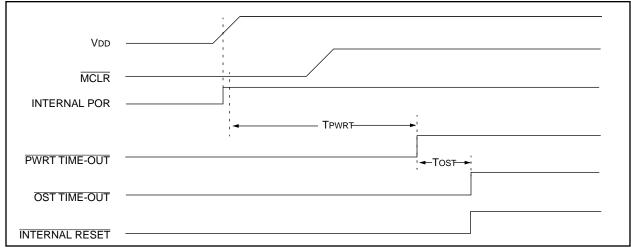


FIGURE 13-12: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2

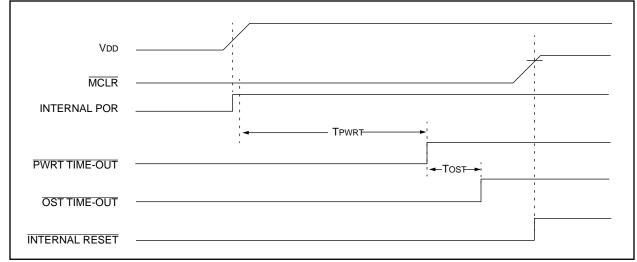


FIGURE 13-13: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD)

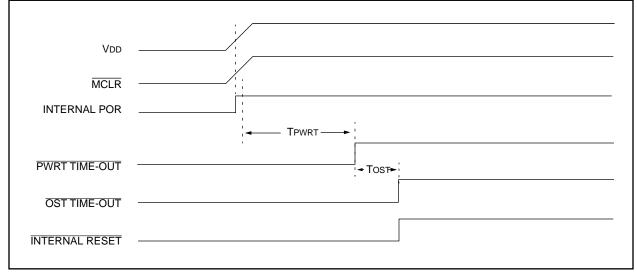
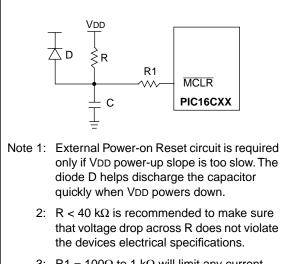
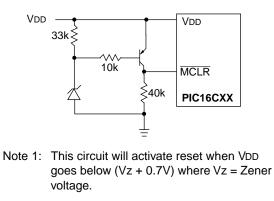


FIGURE 13-14: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



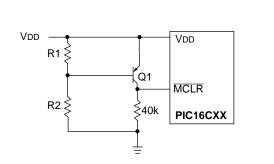
3: $R1 = 100\Omega$ to $1 k\Omega$ will limit any current flowing into \overline{MCLR} from external capacitor C in the event of \overline{MCLR}/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrostatic Overstress (EOS).

FIGURE 13-15: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



- 2: Internal brown-out detection on the PIC16C62A/R62/63/R63/64A/R64/65A/ R65/66/67 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistors.

FIGURE 13-16: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



Note 1: This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

- 2: Internal brown-out detection on the PIC16C62A/R62/63/R63/64A/R64/65A/ R65/66/67 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistors.

13.5 Interrupts

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The PIC16C6X family has up to 11 sources of interrupt. The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

Note: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or global enable bit, GIE.

Global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. When bit GIE is enabled, and an interrupt flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in the INTCON register. GIE is cleared on reset.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine as well as sets the GIE bit, which re-enable interrupts.

The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flag bits are contained in the INTCON register.

The peripheral interrupt flag bits are contained in special function registers PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers PIE1 and PIE2 and the peripheral interrupt enable bit is contained in special function register INTCON.

When an interrupt is responded to, bit GIE is cleared to disable any further interrupts, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the RB0/INT pin or RB port change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs (Figure 13-19). The latency is the same for one or two cycle instructions. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid infinite interrupt requests. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

Note: For the PIC16C61/62/64/65, if an interrupt occurs while the Global Interrupt Enable bit, GIE is being cleared, bit GIE may unintentionally be re-enabled by the user's Interrupt Service Routine (the RETFIE instruction). The events that would cause this to occur are:

- 1. An instruction clears the GIE bit while an interrupt is acknowledged
- 2. The program branches to the Interrupt vector and executes the Interrupt Service Routine.
- The Interrupt Service Routine completes with the execution of the RET-FIE instruction. This causes the GIE bit to be set (enables interrupts), and the program returns to the instruction after the one which was meant to disable interrupts.
- 4. Perform the following to ensure that interrupts are globally disabled.

LOOP	BCF II	NTCON,GIE	;Disable Global
			;Interrupt bit
	BTFSC	INTCON,GIE	;Global Interrupt
			;Disabled?
	GOTO	LOOP	;NO, try again
	:		;Yes, continue
			;with program flow
	GOTO		;Disabled? ;NO, try again ;Yes, continue

FIGURE 13-17: INTERRUPT LOGIC FOR PIC16C61

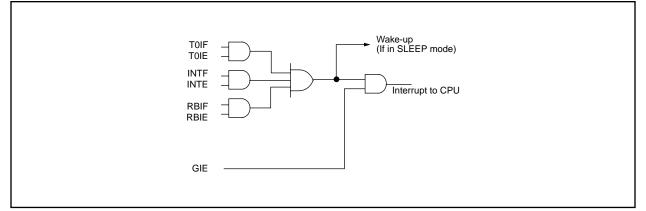
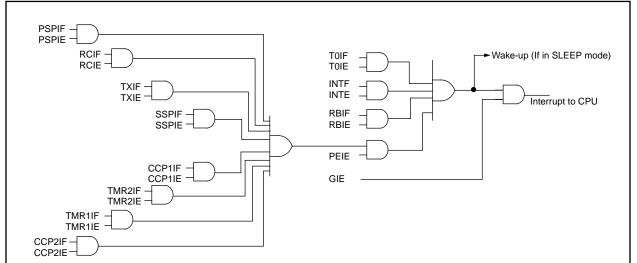


FIGURE 13-18: INTERRUPT LOGIC FOR PIC16C6X



The following table shows which devices have which interrupts.

Device	TOIF	INTF	RBIF	PSPIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	CCP2IF
PIC16C62	Yes	Yes	Yes	-	-	-	Yes	Yes	Yes	Yes	-
PIC16C62A	Yes	Yes	Yes	-	-	-	Yes	Yes	Yes	Yes	-
PIC16CR62	Yes	Yes	Yes	-	-	-	Yes	Yes	Yes	Yes	-
PIC16C63	Yes	Yes	Yes	-	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16CR63	Yes	Yes	Yes	-	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C64	Yes	Yes	Yes	Yes	-	-	Yes	Yes	Yes	Yes	-
PIC16C64A	Yes	Yes	Yes	Yes	-	-	Yes	Yes	Yes	Yes	-
PIC16C64	Yes	Yes	Yes	Yes	-	-	Yes	Yes	Yes	Yes	-
PIC16C65	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C65A	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16CR65	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C66	Yes	Yes	Yes	-	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C67	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes

13.5.1 INT INTERRUPT

External interrupt on RB0/INT pin is edge triggered: either rising if edge select bit INTEDG (OPTION<6>) is set, or falling, if bit INTEDG is clear. When a valid edge appears on the RB0/INT pin, flag bit INTF (INTCON<1>) is set. This interrupt can be disabled by clearing enable bit INTE (INTCON<4>). The INTF bit must be cleared in software in the interrupt service routine before re-enabling this interrupt. The INT interrupt can wake the processor from SLEEP, if enable bit INTE was set prior to going into SLEEP. The status of global enable bit GIE decides whether or not the processor branches to the interrupt vector following wake-up. See Section 13.8 for details on SLEEP mode.

13.5.2 TMR0 INTERRUPT

An overflow (FFh \rightarrow 00h) in the TMR0 register will set flag bit T0IF (INTCON<2>). The interrupt can be enabled/disabled by setting/clearing enable bit T0IE (INTCON<5>) (Section 7.0).

13.5.3 PORTB INTERRUPT ON CHANGE

An input change on PORTB<7:4> sets flag bit RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit RBIE (INTCON<4>) (Section 5.2).

Note: For the PIC16C61/62/64/65, if a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then flag bit RBIF may not get set.

FIGURE 13-19: INT PIN INTERRUPT TIMING

	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
OSC1					
CLKOUT (3)	4		\/		
INT pin		(1)	1	1 1	
INTF flag (INTCON<1>)			Interrupt Latency (2)	· · · ·	
GIE bit (INTCON<7>)				1 1 1	
INSTRUCTION	FLOW		- 	1 1	1 1 1 1
PC	(PC)	PC+1	PC+1	0004h	X0005h
Instruction (fetched	Inst (PC)	Inst (PC+1)		Inst (0004h)	Inst (0005h)
Instruction {	Inst (PC-1)	Inst (PC)	Dummy Cycle	Dummy Cycle	Inst (0004h)
Note 1: IN	NTE flag is sampled her				

Note 1: INTF flag is sampled here (every Q1).

- 2: Interrupt latency = 3TCY for synchronous interrupt and 3-4TCY for asynchronous interrupt.
- Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.
- 3: CLKOUT is available only in RC oscillator mode.
- 4: For minimum width spec of INT pulse, refer to AC specs.
- 5: INTF can to be set anytime during the Q4-Q1 cycles.

13.6 Context Saving During Interrupts

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt i.e., W register and STATUS register. This will have to be implemented in software.

Example 13-1 stores and restores the STATUS and W registers. Example 13-2 stores and restores the STATUS, W, and PCLATH registers (Devices with paged program memory). For all PIC16C6X devices with greater than 1K of program memory (all devices except PIC16C61), the register, W_TEMP, must be

defined in all banks and must be defined at the same offset from the bank base address (i.e., if W_TEMP is defined at 0x20 in bank 0, it must also be defined at 0xA0 in bank 1, 0x120 in bank 2, and 0x1A0 in bank 3).

The examples:

- a) Stores the W register
- b) Stores the STATUS register in bank 0
- c) Stores PCLATH
- d) Executes ISR code
- e) Restores PCLATH
- f) Restores STATUS register (and bank select bit)
- g) Restores W register

EXAMPLE 13-1: SAVING STATUS AND W REGISTERS IN RAM (PIC16C61)

MOVWF SWAPF	W_TEMP STATUS,W	;Copy W to TEMP register, could be bank one or zero ;Swap status to be saved into W
MOVWF :	STATUS_TEMP	;Save status to bank zero STATUS_TEMP register
:(ISR) :		
SWAPF	STATUS_TEMP,W	;Swap STATUS_TEMP register into W ;(sets bank to original state)
MOVWF	STATUS	;Move W into STATUS register
SWAPF	W_TEMP,F	;Swap W_TEMP
SWAPF	W_TEMP,W	;Swap W_TEMP into W

EXAMPLE 13-2: SAVING STATUS, W, AND PCLATH REGISTERS IN RAM (ALL OTHER PIC16C6X DEVICES)

MOVWF SWAPF CLRF MOVWF MOVF MOVWF CLRF BCF MOVF MOVWF	W_TEMP STATUS,W STATUS_TEMP PCLATH,W PCLATH_TEMP PCLATH STATUS, IRP FSR,W FSR_TEMP	<pre>;Copy W to TEMP register, could be bank one or zero ;Swap status to be saved into W ;bank 0, regardless of current bank, Clears IRP,RP1,RP0 ;Save status to bank zero STATUS_TEMP register ;Only required if using pages 1, 2 and/or 3 ;Save PCLATH into W ;Page zero, regardless of current page ;Return to Bank 0 ;Copy FSR to W ;Copy FSR from W to FSR_TEMP</pre>
: (ISR) : MOVF MOVWF SWAPF SWAPF SWAPF	PCLATH_TEMP, W PCLATH STATUS_TEMP,W STATUS W_TEMP,F W_TEMP,W	<pre>;Restore PCLATH ;Move W into PCLATH ;Swap STATUS_TEMP register into W ;(sets bank to original state) ;Move W into STATUS register ;Swap W_TEMP ;Swap W_TEMP into W</pre>

13.7 <u>Watchdog Timer (WDT)</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run, even if the clock on the OSC1/CLKIN and OSC2/ CLKOUT pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT time-out generates a device reset. If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation (WDT Wake-up). The WDT can be permanently disabled by clearing configuration bit WDTE (Section 13.1).

13.7.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be

FIGURE 13-20: WATCHDOG TIMER BLOCK DIAGRAM

assigned to the WDT under software control by writing to the OPTION register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition.

The $\overline{\text{TO}}$ bit in the STATUS register will be cleared upon a WDT time-out.

13.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler) it may take several seconds before a WDT time-out occurs.

Note: When a CLRWDT instruction is executed and the prescaler is assigned to the WDT, the prescaler count will be cleared, but the prescaler assignment is not changed.

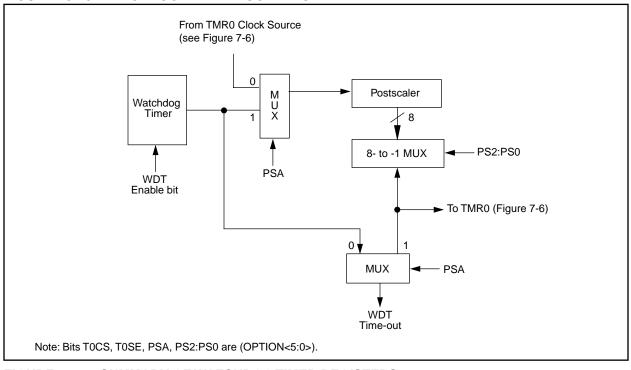


FIGURE 13-21: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
2007h	Config. bits	(1)	BODEN ⁽¹⁾	CP1	CP0	PWRTE ⁽¹⁾	WDTE	FOSC1	FOSC0
81h,181h	OPTION	RBPU	INTEDG	TOCS	T0SE	PSA	PS2	PS1	PS0

Legend: Shaded cells are not used by the Watchdog Timer.

Note 1: See Figure 13-1, Figure 13-2, and Figure 13-3 for details of these bits for the specific device.

13.8 Power-down Mode (SLEEP)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Power-down mode is entered by executing a $\ensuremath{\mathtt{SLEEP}}$ instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, status bit \overline{PD} (STATUS<3>) is cleared, status bit \overline{TO} (STATUS<4>) is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD, or VSS, ensure no external circuitry is drawing current from the I/O pin, and disable external clocks. Pull all I/O pins, that are hi-impedance inputs, high or low externally to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should be considered.

The MCLR/VPP pin must be at a logic high level (VIHMC).

13.8.1 WAKE-UP FROM SLEEP

The device can wake from SLEEP through one of the following events:

- 1. External reset input on MCLR/VPP pin.
- 2. Watchdog Timer Wake-up (if WDT was enabled).
- 3. Interrupt from RB0/INT pin, RB port change, or some peripheral interrupts.

External MCLR Reset will cause a device reset. All other events are considered a continuation of program execution and cause a "wake-up". The TO and PD bits in the STATUS register can be used to determine the cause of device reset. The PD bit, which is set on power-up is cleared when SLEEP is invoked. The TO bit is cleared if WDT time-out occurred (and caused wake-up).

The following peripheral interrupts can wake the device from SLEEP:

- 1. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 2. SSP (Start/Stop) bit detect interrupt.
- 3. SSP transmit or receive in slave mode (SPI/I²C).
- 4. CCP capture mode interrupt.
- 5. Parallel Slave Port read or write.
- 6. USART TX or RX (synchronous slave mode).

Other peripherals can not generate interrupts since during SLEEP, no on-chip Q clocks are present.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

13.8.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs before the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake up from sleep. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the \overline{PD} bit. If the \overline{PD} bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

FIGURE 13-22: WAKE-UP FROM SLEEP THROUGH INTERRUPT

Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
osc1/~_/~_/~_/				$\frac{1}{2}\sqrt{2}\sqrt{2}\sqrt{2}\sqrt{2}\sqrt{2}\sqrt{2}\sqrt{2}\sqrt{2}\sqrt{2}$		
CLKOUT(4)		Tost(2)		, ,		
INT pin	1			1 I	1	
INTF flag (INTCON<1>)	1 1 			Interrupt Latency (Note 2)		
GIE bit (INTCON<7>)		Processor in SLEEP			1 1 1	
INSTRUCTION FLOW	1			1 I 1 I		
PC X PC X	PC+1 X	PC+2	PC+2	X PC + 2	0004h	0005h
Instruction { Inst(PC) = SLEEP	Inst(PC + 1)		Inst(PC + 2)	1 1 1 1 1 1	Inst(0004h)	Inst(0005h)
Instruction { Inst(PC - 1)	SLEEP	1	Inst(PC + 1)	Dummy cycle	Dummy cycle	Inst(0004h)
Note 1: XT, HS or LP oscillator r						
2: Tost = 1024Tosc (draw 3: GIE = '1' assumed. In thi		-				
		ap, and processor jun				

If GIE = '0', execution will continue in-line.

4: CLKOUT is not available in these osc modes, but shown here for timing reference.

13.9 Program Verification/Code Protection

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note:	Microchip does not recommend code pro-
	tecting windowed devices.

13.10 ID Locations

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Four memory locations (2000h - 2003h) are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. It is recommended that only the 4 least significant bits of the ID location are used.

For ROM devices, these values are submitted along with the ROM code.

13.11 In-Circuit Serial Programming

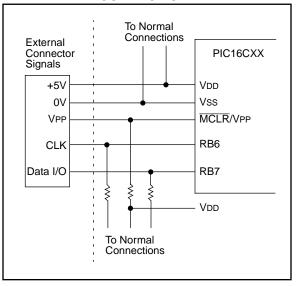
Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The PIC16CXX microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed. The device is placed into a program/verify mode by holding pins RB6 and RB7 low while raising the $\overline{\text{MCLR}}$ (VPP) pin from VIL to VIHH (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

After reset, to place the device in program/verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14-bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC16C6X/7X Programming Specifications (Literature #DS30228).

FIGURE 13-23: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION



14.0 INSTRUCTION SET SUMMARY

Each PIC16CXX instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16CXX instruction set summary in Table 14-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 14-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 14-1:OPCODE FIELD
DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with $x = 0$. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; $d = 0$: store result in W, d = 1: store result in file register f. Default is $d = 1$
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLATH	Program Counter High Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
TO	Time-out bit
PD	Power-down bit
dest	Destination either the W register or the specified register file location
[]	Options
()	Contents
\rightarrow	Assigned to
<>	Register bit field
∈	In the set of
italics	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- Byte-oriented operations
- Bit-oriented operations
- Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μ s.

Table 14-2 lists the instructions recognized by the MPASM assembler.

Figure 14-1 shows the general formats that the instructions can have.

Note: To maintain upward compatibility with future PIC16CXX products, <u>do not use</u> the OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

FIGURE 14-1: GENERAL FORMAT FOR INSTRUCTIONS

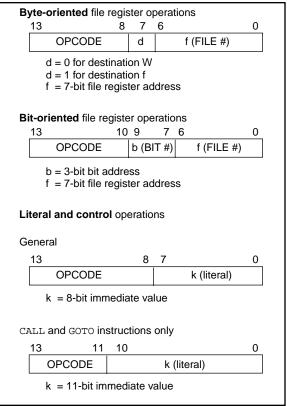


TABLE 14-2: PIC16CXX INSTRUCTION SET

Mnemonic,		Description	Cycles		14-Bit	Opcode	Ð	Status	Notes
Operands				MSb			LSb	Affected	
BYTE-ORIE		FILE REGISTER OPERATIONS		·					
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2
CLRW	-	Clear W	1	00	0001	0xxx	xxxx	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,3
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000	lfff	ffff		
NOP	-	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	С	1,2
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	С	1,2
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
BIT-ORIENT	ED FIL	E REGISTER OPERATIONS						•	•
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3
LITERAL AN		NTROL OPERATIONS							
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	-	Clear Watchdog Timer	1	00	0000	0110	0100	TO,PD	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	-	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	-	Go into standby mode	1	00	0000	0110	0011	TO,PD	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

Note 1: When an I/O register is modified as a function of itself (e.g., MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

14.1 Instruction Descriptions

Add Lite	ral and \	N	
[<i>label</i>] Al	DDLW	k	
$0 \le k \le 25$	55		
(W) + k –	→ (W)		
C, DC, Z			
11	111x	kkkk	kkkk
The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.			
1			
1			
Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process data	Write to W
ADDLW	0x15		
		Ì	
W = 0x10			
/		0x25	
	$[label] AI 0 \le k \le 25 (W) + k - C, DC, Z 11 The conten- added to the result is play 1 1 Q1 Decode ADDLW Before In After Inst$	[<i>label</i>] ADDLW $0 \le k \le 255$ (W) + k \rightarrow (W) C, DC, Z 11 111x The contents of the added to the eight b result is placed in th 1 1 Q1 Q2 Decode Read literal 'k' ADDLW 0x15 Before Instruction W = After Instruction	$0 \le k \le 255$ (W) + k \rightarrow (W) C, DC, Z 11 111x kkkk The contents of the W register added to the eight bit literal 'k' result is placed in the W regist 1 1 2 2 2 2 3 2 2 2 2 3 2 2 2 3 2 2 3 2 2 2 3 2 2 3 2 2 3 2 2 3 2 2 3 2 2 3 2 3 2 2 3 2 3 2 3 2 3 2 3 2 3 2 3 2 3 2 3 2 3 2 3 2 3 2 3 3 2 3 2 3 3 2 3 3 2 3 3 3 2 3 3 3 3 3 3 3 3 3 3 3 3 3

ANDLW	AND Lite	eral with	w	
Syntax:	[<i>label</i>] A	NDLW	k	
Operands:	$0 \le k \le 25$	55		
Operation:	(W) .AND	D. (k) \rightarrow (W)	
Status Affected:	Z			
Encoding:	11	1001	kkkk	kkkk
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal "k"	Process data	Write to W
Example	ANDLW	0x5F		
	Before In	struction W =	0xA3	
	After Inst	ruction W =	0x03	

ADDWF	Add W a	nd f			
Syntax:	[<i>label</i>] A	[label] ADDWF f,d			
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in [0,1] \end{array}$	27			
Operation:	(W) + (f)	ightarrow (desti	nation)		
Status Affected:	C, DC, Z				
Encoding:	00	0111	dfff	ffff	
Description:	Add the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Decode	Read register 'f'	Process data	Write to destination	
Example	ADDWF	FSR,	0		
	Before Instruction				
		W = FSR =	0x17 0xC2		
	After Inst	ruction			
		W =	0xD9		
		FSR =	0xC2		

ANDWF	AND W v	vith f			
Syntax:	[<i>label</i>] Al	[<i>label</i>] ANDWF f,d			
Operands:	$0 \le f \le 12$ $d \in [0,1]$	7			
Operation:	(W) .AND	D. (f) \rightarrow (c	destinatio	n)	
Status Affected:	Z				
Encoding:	00	0101	dfff	ffff	
Description:	AND the W register with register 'f'. If 'd' is 0 the result is stored in the W regis- ter. If 'd' is 1 the result is stored back in register 'f'.				
Words:	1				
Cycles:	1				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Decode	Read register 'f'	Process data	Write to destination	
Example	ANDWF	FSR,	1		
	Before Instruction				
		W = FSR =	0x17 0xC2		
	After Inst		0.02		
		W =	0x17		
		FSR =	0x02		

BCF	Bit Clear	f		
Syntax:	[<i>label</i>] BC	CF f,b		
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$			
Operation:	$0 \rightarrow (f < b;$	>)		
Status Affected:	None			
Encoding:	01	00bb	bfff	ffff
Description:	Bit 'b' in register 'f' is cleared.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'
Example	After Inst		EG = 0xC7	,
		FLAG_RE	EG = 0x47	

BTFSC	Bit Test,	Skip if Cl	ear		
Syntax:	[<i>label</i>] BT	FSC f,b			
Operands:	$0 \le f \le 12$ $0 \le b \le 7$	27			
Operation:	skip if (f<	b>) = 0			
Status Affected:	None				
Encoding:	01	10bb	bfff	ffff	
Description:	instruction If bit 'b', in instruction executed i	If bit 'b' in register 'f' is '1' then the next instruction is executed. If bit 'b', in register 'f', is '0' then the next instruction is discarded, and a NOP is executed instead, making this a 2TcY instruction.			
Words:	1				
Cycles:	1(2)				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Decode	Read register 'f'	Process data	No- Operation	
If Skip:	(2nd Cyc	le)			
	Q1	Q2	Q3	Q4	
	No- Operation	No- Operation	No- Operation	No- Operation	
Example	HERE FALSE TRUE	BTFSC GOTO • •	FLAG,1 PROCESS_	_CODE	
	Before Instruction PC = address HERE				
	After Instruction if FLAG<1> = 0, PC = address TRUE if FLAG<1>=1,				

PC = address FALSE

Syntax:	[<i>label</i>] BS	SF f,b		
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$			
Operation:	$1 \rightarrow (f < b >$	>)		
Status Affected:	None			
Encoding:	01	01bb	bfff	ffff
Description:	Bit 'b' in register 'f' is set.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'
Example	BSF	FLAG_R	EG, 7	

Bit Set f

BSF

BTFSS	Bit Test f, Skip if Set	CALL	Call Subroutine
Syntax:	[<i>label</i>] BTFSS f,b	Syntax:	[<i>label</i>] CALL k
Operands:	$0 \le f \le 127$	Operands:	$0 \le k \le 2047$
	$0 \leq b < 7$	Operation:	(PC)+ 1 \rightarrow TOS,
Operation:	skip if (f) = 1		$k \rightarrow PC < 10:0>,$
Status Affected:	None		$(PCLATH{<}4:3{>}) \rightarrow PC{<}12:11{>}$
Encoding:	01 11bb bfff ffff	Status Affected:	None
Description:	If bit 'b' in register 'f' is '0' then the next	Encoding:	10 0kkk kkkk kkkk
	instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2TCY instruction.		Call Subroutine. First, return address (PC+1) is pushed onto the stack. The eleven bit immediate address is loaded into PC bits <10:0>. The upper bits of
Words:	1		the PC are loaded from PCLATH. CALL is a two cycle instruction.
Cycles:	1(2)	Words:	1
Q Cycle Activity:	Q1 Q2 Q3 Q4	Cycles:	2
	Decode Read Process No- register 'f' data Operation	Q Cycle Activity:	Q1 Q2 Q3 Q4
If Skip:	(2nd Cycle)	1st Cycle	E Decode Read Process Write to literal 'k', data PC
·	Q1 Q2 Q3 Q4		Push PC to Stack
	No-No-No-OperationOperationOperation	2nd Cycle	No- No- No- No- Operation Operation Operation
Example	HERE BTFSC FLAG,1 FALSE GOTO PROCESS_CODE	Example	HERE CALL THERE
	TRUE •		Before Instruction PC = Address HERE
	•		After Instruction
	Before Instruction PC = address HERE After Instruction		PC = Address THERE TOS = Address HERE+1
	if FLAG<1> = 0, PC = address FALSE if FLAG<1> = 1, PC = address TRUE		
	FU = audiess IRUE		

CLRF	Clear f			
Syntax:	[<i>label</i>] C	LRF f		
Operands:	$0 \le f \le 12$	27		
Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$			
Status Affected:	Z			
Encoding:	00	0001	lfff	ffff
Description:	The contents of register 'f' are cleared and the Z bit is set.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'
Example	CLRF	FLAG	_REG	
	After Inst	FLAG_RE ruction FLAG_RE	EG =	0x5A 0x00
		Z	=	1

CLRW	Clear W			
Syntax:	[label]	CLRW		
Operands:	None			
Operation:	$\begin{array}{l} 00h \rightarrow (V \\ 1 \rightarrow Z \end{array}$	V)		
Status Affected:	Z			
Encoding:	00	0001	0xxx	xxxx
Description:	W register set.	is cleared	. Zero bit (Z) is
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	No- Operation	Process data	Write to W
Example	CLRW			
	Before In	struction		
	After Inst		0x5A	
			0x00	
		Z =	1	
CLRWDT	Clear Wa	tchdog 1	Timer	
Syntax:	[label]	CLRWD	Г	
Operands:	None			
Operation:	$00h \rightarrow W$			
	$0 \rightarrow WD$	F prescale	ər,	
	$1 \rightarrow \overline{\text{TO}}$ $1 \rightarrow \overline{\text{PD}}$			
Status Affected:	TO, PD			
Encoding:	00	0000	0110	0100
Description:	dog Timer	. It also res	esets the vertices the vertices the pro- tests the pro- test TO and	e <u>sc</u> aler
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4

Example

CLRWI	DT
Before	Instru

Decode

?
0x00
0
1
1

No-

Operation

Process

data

Clear WDT Counter

COMF	Complement f				
Syntax:	[label]	COMF	f,d		
Operands:	$0 \le f \le 12$ $d \in [0,1]$	7			
Operation:	$(\bar{f}) \rightarrow (des$	stination)		
Status Affected:	Z				
Encoding:	00	1001	dfff	ffff	
Description:	mented. If W. If 'd' is	The contents of register 'f' are comple- mented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.			
Words:	1				
Cycles:	1				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Decode	Read register 'f'	Process data	Write to destination	
Example	COMF	REG	G1,0		
	Before Instruction				
	$\begin{array}{rcl} REG1 &=& 0x13\\ After Instruction\\ REG1 &=& 0x13\\ W &=& 0xEC \end{array}$				
	Decrement f				
DECF	Decreme	ent f			
DECF Syntax:	Decreme [<i>label</i>] D				
		ECF f,d			
Syntax:	[<i>label</i>] D 0 ≤ f ≤ 12	DECF f,d	ion)		
Syntax: Operands:	[<i>label</i>] D $0 \le f \le 12$ $d \in [0,1]$	DECF f,d	ion)		
Syntax: Operands: Operation:	$[label] \square \\ 0 \le f \le 12 \\ d \in [0,1] \\ (f) - 1 \rightarrow $	DECF f,d	ion)	ffff	
Syntax: Operands: Operation: Status Affected:	$[label] D 0 \le f \le 12 d \in [0,1] (f) - 1 \rightarrow 2 Z$	DECF f,d 7 (destinat 0011 t register ored in th	dfff 'f'. If 'd' is (e W registe	0 the er. If 'd' is	
Syntax: Operands: Operation: Status Affected: Encoding:	$\begin{bmatrix} label \end{bmatrix} \square \\ 0 \le f \le 12 \\ d \in [0,1] \\ (f) - 1 \rightarrow 0 \\ Z \\ \boxed{00} \\ Decrement \\ result is st$	DECF f,d 7 (destinat 0011 t register ored in th	dfff 'f'. If 'd' is (e W registe	0 the er. If 'd' is	
Syntax: Operands: Operation: Status Affected: Encoding: Description:	$\begin{bmatrix} label \end{bmatrix} \square \\ 0 \le f \le 12 \\ d \in [0,1] \\ (f) - 1 \rightarrow 0 \\ Z \\ \boxed{00} \\ Decrement \\ result is st$	DECF f,d 7 (destinat 0011 t register ored in th	dfff 'f'. If 'd' is (e W registe	0 the er. If 'd' is	
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words:	$[label] D$ $0 \le f \le 12$ $d \in [0,1]$ $(f) - 1 \rightarrow 0$ Z 00 Decrement result is standard the result is standard t	DECF f,d 7 (destinat 0011 t register ored in th	dfff 'f'. If 'd' is (e W registe	0 the er. If 'd' is	
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles:	$[label] D$ $0 \le f \le 12$ $d \in [0,1]$ $(f) - 1 \rightarrow 0$ Z 00 Decrement result is st 1 the result 1 1 1	DECF f,d 7 (destinat 0011 t register ored in the t is stored	dfff 'f'. If 'd' is (e W registe d back in re	0 the er. If 'd' is egister 'f'.	
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles:	$[label] D$ $0 \le f \le 12$ $d \in [0,1]$ $(f) - 1 \rightarrow 0$ Z $\boxed{00}$ Decrementes the result is set 1 the result is 1 the result	Q2	dfff 'f'. If 'd' is (e W registe d back in re Q3 Process	Q4 Q4 Write to	
Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity:	$\begin{bmatrix} label \end{bmatrix} D \\ 0 \le f \le 12 \\ d \in [0,1] \\ (f) - 1 \rightarrow 0 \\ Z \\ \hline 0 0 \\ Decrement result is standard the result is stan$	Q2 Read register 'f' CNT, struction CNT Z	dfff 'f'. If 'd' is (e W registe d back in re Q3 Process data	Q4 Write to destination	

DECFSZ	Decreme	ent f, Skip	o if O	
Syntax:	[label]	DECFSZ	f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	27		
Operation:	(f) - 1 \rightarrow skip if res	(destinatio sult = 0	on);	
Status Affected:	None			
Encoding:	00	1011	dfff	ffff
Description:	The contents of register 'f' are decre- mented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 1, the next instruction, is executed. If the result is 0, then a NOP is executed instead making it a 2Tcy instruc- tion.			
Words:	1			
Cycles:	1(2)			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
If Skip:	(2nd Cyc	le)		
	Q1	Q2	Q3	Q4
	No- Operation	No- Operation	No- Operation	No- Operation
Example	HERE	DECFS GOTO JE •	Z CNT, LOOF	
	• Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0, PC = address HERE+1			

GOTO	Unconditional Branch				
Syntax:	[label]	GOTO	k		
Operands:	$0 \le k \le 20$	047			
Operation:		$k \rightarrow PC<10:0>$ PCLATH<4:3> \rightarrow PC<12:11>			
Status Affected:	None				
Encoding:	10	1kkk	kkkk	kkkk	
Description:	GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two cycle instruction.				
Words:	1				
Cycles:	2				
Q Cycle Activity:	Q1	Q2	Q3	Q4	
1st Cycle	Decode	Read literal 'k'	Process data	Write to PC	
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation	
Example GOTO THERE After Instruction PC = Address THERE				THERE	

INCF	Increme	nt f		
Syntax:	[label]	INCF f	,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	27		
Operation:	(f) + 1 \rightarrow (destination)			
Status Affected:	Z			
Encoding:	00	1010	dfff	ffff
Description:	The contermented. If the W reginst placed back	'd' is 0 the ster. If 'd'	e result is is 1 the re	placed in
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
Example	INCF	CNT,	1	
	After Inst	CNT Z	= 0xFf = 0 = 0x00 = 1	

INCFSZ	Increme	nt f, Skip	if O	
Syntax:	[label]	INCFSZ	f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	7		
Operation:	(f) + 1 \rightarrow skip if res	•	ion),	
Status Affected:	None			
Encoding:	00	1111	dfff	ffff
Description:	The contents of register 'f' are incre- mented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 1, the next instruction is executed. If the result is 0, a NOP is executed instead making it a 2Tcy instruction.			
Words:	1			
Cycles:	1(2)			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
If Skip:	(2nd Cyc	le)		
	Q1	Q2	Q3	Q4
	No- Operation	No- Operation	No- Operation	No- Operation
Example	HERE CONTIN	INCFS GOTO JE • •	Z CI LO	NT, 1 DP
	Before In PC After Inst CNT if CNT PC if CNT PC	= add ruction = CNT = 0, = add ≠ 0,	ress HERE [+ 1 ress CONT ress HERE	

IORLW	Inclusive OR Literal with W			
Syntax:	[label]	IORLW	k	
Operands:	$0 \le k \le 25$	55		
Operation:	(W) .OR. $k \rightarrow$ (W)			
Status Affected:	Z			
Encoding:	11	1000	kkkk	kkkk
Description:	The conter OR'ed with result is pla	n the eigh	t bit literal	'k'. The
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process data	Write to W
Example	IORLW	0x35		
	After Inst	W =	0x9A 0xBF 1	

IORWF	Inclusive	e OR W \	with f	
Syntax:	[label]	IORWF	f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	7		
Operation:	(W) .OR.	$(f) \rightarrow (de)$	estination)
Status Affected:	Z			
Encoding:	00	0100	dfff	ffff
Description:	Inclusive OR the W register with regis- ter 'f'. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
Example	After Inst	struction RESULT W	= 0x13 = 0x91	3
MOVF	Move f			
Syntax:	[label]	MOVF	f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	7		
Operation:	(f) \rightarrow (des	stination)	
Status Affected:	Z			
Encoding:	00	1000	dfff	ffff
Description:	The contents of register f is moved to a destination dependant upon the status of d. If $d = 0$, destination is W register. If $d = 1$, the destination is file register f itself. $d = 1$ is useful to test a file register since status flag Z is affected.			
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination

Example

MOVF

After Instruction

FSR, 0

W = value in FSR register Z = 1

abel]≤ k ≤ 2t→ (W)one11	MOVLW	/ k	
→ (W) one	55		
one			
11			
	00xx	kkkk	kkkk
gister. Th			
Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process data	Write to W
ter Inst		0	
	Q1 Decode MOVLW fter Inst	e eight bit literal ' gister. The don't c ; 0's. Q1 Q2 Decode Read literal 'k'	Process Process Q1 Q2 Q3 Decode Read literal 'k' Process data MOVLW 0x5A fter Instruction

MOVWF	Move W to f			
Syntax:	[label]	MOVW	= f	
Operands:	$0 \le f \le 12$	27		
Operation:	$(W) \to (f)$			
Status Affected:	None			
Encoding:	00	0000	lfff	ffff
Description:	Move data 'f'.	from W r	egister to i	register
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'
Example	MOVWF	OPTIC	N_REG	
	Before In			_
		OPTION W	= 0xFF = 0x4F	
	After Inst	••		-

NOP	No Operation			
Syntax:	[label]	NOP		
Operands:	None			
Operation:	No opera	ation		
Status Affected:	None			
Encoding:	00	0000	0xx0	0000
Description:	No operat	ion.		
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	No- Operation	No- Operation	No- Operation
Example	NOP			

RETFIE	Return from Interrupt			
Syntax:	[label]	RETFIE		
Operands:	None			
Operation:	$\begin{array}{l} TOS \rightarrow PC, \\ 1 \rightarrow GIE \end{array}$			
Status Affected:	None			
Encoding:	00	0000	0000	1001
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two cycle instruction.			
Words:	1			
Cycles:	2			
Q Cycle Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	No- Operation	Set the GIE bit	Pop from the Stack
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation

Example

RETFIE

After Interrupt PC = TOS GIE = 1

OPTION	Load Op	tion Reg	gister	
Syntax:	[label]	OPTION	٧	
Operands:	None			
Operation:	$(W) \to OPTION$			
Status Affected:	None			
Encoding:	00	0000	0110	0010
Description: Words: Cycles: Example	The conter loaded in t instruction patibility w Since OPT register, th it. 1	he OPTIC is suppoi ith PIC16 TION is a e user ca	DN register rted for coo C5X produ readable/v n directly a	r. This de com- ucts. vritable address
		re PIC16	rd compa CXX produ uction.	-

RETLW	Return w	ith Liter	al in W	
Syntax:	[label]	RETLW	k	
Operands:	$0 \le k \le 2\xi$	55		
Operation:	$\begin{array}{l} k \rightarrow (W); \\ TOS \rightarrow F \end{array}$	PC .		
Status Affected:	None			
Encoding:	11	01xx	kkkk	kkkk
Description:	The W reg bit literal 'k loaded from return add instruction	'. The prog m the top ress). This	gram coun of the stac	ter is k (the
Words:	1			
Cycles:	2			
Q Cycle Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	Read literal 'k'	No- Operation	Write to W, Pop from the Stack
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation
Example	CALL TABLE ADDWF PC RETLW k1 RETLW k2 RETLW kn	;offse ;W now ;W = o ;Begin ;		
	After Inst	W = ruction	0x07 value of kt	3

RETURN	Return fi	rom Sub	routine							
Syntax:	[label]	[label] RETURN								
Operands:	None									
Operation:	$\text{TOS} \to \text{F}$	УC								
Status Affected:	None									
Encoding:	00	0000	0000	1000						
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two cycle instruction.									
Words:	1									
Cycles:	2									
Q Cycle Activity:	Q1	Q2	Q3	Q4						
1st Cycle	Decode	No- Operation	No- Operation	Pop from the Stack						
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation						
Example	RETURN	•	TOS							

_

RLF	Rotate L	eft f thro	ough Car	ry
Syntax:	[label]	RLF	f,d	
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	7		
Operation:	See desc	ription b	elow	
Status Affected:	С			
Encoding:	00	1101	dfff	ffff
Description:	The conter one bit to t Flag. If 'd' i W register back in reg	the left the is 0 the re . If 'd' is 1	rough the (sult is place	Carry ced in the
			Register f	_
Words:	1		Register f	_
Words: Cycles:	- C		Register f	_
	1		Register f	_ Q4
Cycles:	1 1			Q4 Write to destination
Cycles:	1 1 Q1	Q2 Read register 'f'	Q3 Process	Write to
Cycles: Q Cycle Activity:	1 1 Q1 Decode RLF Before In	Q2 Read register 'f' REC	Q3 Process data	Write to

RRF	Rotate R	ight f th	rough C	arry				
Syntax:	[label]	RRF f,	d					
Operands:	$0 \le f \le 12$ $d \in [0,1]$	27						
Operation:	See desc	ription b	elow					
Status Affected:	С							
Encoding:	00	1100	dfff	ffff				
Description:	one bit to Flag. If 'd' W register	The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.						
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Process data	Write to destination				
Example	RRF		REG1,0					
	Before Instruction REG1 = C =							
		Before Instruction REG1 =		0 0110				

SLEEP

Syntax:	[label] SLEEP							
Operands:	None							
Operation:	$\begin{array}{l} 00h \rightarrow WDT, \\ 0 \rightarrow WDT \ prescaler, \\ 1 \rightarrow \overline{TO}, \\ 0 \rightarrow \overline{PD} \end{array}$							
Status Affected:	TO, PD							
Encoding:	00	0000	0110	0011				
Description:	The power-down status bit, \overline{PD} is cleared. Time-out status bit, \overline{TO} is set. Watchdog Timer and its pres- caler are cleared. The processor is put into SLEEP mode with the oscillator stopped. See Section 13.8 for more details.							
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	No- Operation	No- Operation	Go to Sleep				
Example:	SLEEP							

SUBLW	Subtract	W from L	iteral	
Syntax:	[label]	SUBLW	k	
Operands:	$0 \le k \le 25$	55		
Operation:	k - (W) \rightarrow	• (W)		
Status Affected:	C, DC, Z			
Encoding:	11	110x	kkkk	kkkk
Description:	ment meth	ister is subt od) from th is placed in	e eight bit	literal 'k'.
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process data	Write to W
Example 1:	SUBLW	0x02		
	Before In:	struction		
		W = C = Z =	1 ? ?	
	After Inst	ruction		
		W = C = Z =	1 1; result is 0	positive
Example 2:	Before In	struction		
		W = C = Z =	2 ? ?	
	After Inst	ruction		
		W = C = Z =	0 1; result is 1	s zero
Example 3:	Before In	struction		
		W = C = Z =	3 ? ?	
	After Inst	ruction		
		W = C = Z =	0xFF 0; result is 0	negative

SUBWF	Subtract	W from f							
Syntax:	[label]	SUBWF	f,d						
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \ [0,1] \end{array}$	7							
Operation:	(f) - (W) –	→ (destina	tion)						
Status Affected:	C, DC, Z	C, DC, Z							
Encoding:	00	0010	dfff	ffff					
Description:	Subtract (2 ister from r stored in th result is sto	egister 'f'. I e W regist	f 'd' is 0 the er. If 'd' is 1	e result is the					
Words:	1								
Cycles:	1								
Q Cycle Activity:	Q1	Q2	Q3	Q4					
	Decode	Read register 'f'	Process data	Write to destination					
Example 1:	SUBWF Before Ins	REG1,1							
	REG1	=	3						
	W	=	2						
	C Z	=	? ?						
	After Instr		•						
	REG1	=	1						
	W	=	2						
	C Z	=	1; result is 0	positive					
Example 2:	Before Ins	struction	-						
	REG1	=	2						
	W	=	2						
	C Z	=	? ?						
	After Instr	uction							
	REG1	=	0						
	W	=	2						
	C Z	=	1; result is 1	zero					
Example 3:	Before Ins	struction							
	REG1	=	1						
	W	=	2						
	C Z	=	? ?						
	After Instr	uction							
	REG1	=	0xFF						
	W	=	2 Ou recoult in	nonotive					
	C Z	=	0; result is 0	negative					

SWAPF	Swap Ni	bbles in	f						
Syntax:	[label]	[label] SWAPF f,d							
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	27							
Operation:	• • •	ightarrow (destin $ ightarrow$ (destin							
Status Affected:	None								
Encoding:	00	1110	dfff	ffff					
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in W register. If 'd' is 1 the result is placed in register 'f'.								
Words:	1								
Cycles:	1								
Q Cycle Activity:	Q1	Q2	Q3	Q4					
	Decode	Read register 'f'	Process data	Write to destination					
Example	SWAPF	REG,	0						
	Before In	struction							
		REG1	= 0x	A5					
	After Inst	ruction							
		REG1 W	= 0x = 0x						

TRIS	Load TRIS Register					
Syntax:	[<i>label</i>] TRIS f					
Operands:	$5 \le f \le 7$					
Operation:	(W) \rightarrow TRIS register f;					
Status Affected:	None					
Encoding:	00 0000 0110 0fff					
Description:	The instruction is supported for code compatibility with the PIC16C5X prod- ucts. Since TRIS registers are read- able and writable, the user can directly address them.					
Words:	1					
Cycles: Example	1					
	To maintain upward compatibility with future PIC16CXX products, do not use this instruction.					

XORLW	Exclusive OR Literal with W							
Syntax:	[<i>label</i>]	XORLV	V k					
Operands:	$0 \le k \le 2$	55						
Operation:	(W) .XO	$R.k \rightarrow (N)$	N)					
Status Affected:	Z							
Encoding:	11	1010	kkkk	kkkk				
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W regis- ter.							
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read literal 'k'	Process data	Write to W				
Example:	XORLW	0xAF						
	Before Ir	nstruction	n					
		W =	0xB5					
	After Ins	truction						
		W =	0x1A					

XORWF	Exclusiv	e OR W	with f				
Syntax:	[label]	XORWF	f,d				
Operands:	$\begin{array}{l} 0 \leq f \leq 12 \\ d \in \ [0,1] \end{array}$	7					
Operation:	(W) .XOF	$R.\left(f\right)\to(o$	destinatio	on)			
Status Affected:	Z						
Encoding:	00	0110	dfff	ffff			
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.						
Words:	1						
Cycles:	1						
Q Cycle Activity:	Q1	Q2	Q3	Q4			
	Decode	Read register 'f'	Process data	Write to destination			
Example	XORWF	REG	1				
	Before Instruction						
		REG W	= 0x = 0x	AF B5			
	After Inst	ruction					
		REG	= 0x	1 /			
		W	0/1	B5			

15.0 DEVELOPMENT SUPPORT

15.1 <u>Development Tools</u>

The PIC16/17 microcontrollers are supported with a full range of hardware and software development tools:

- PICMASTER/PICMASTER CE Real-Time In-Circuit Emulator
- ICEPIC Low-Cost PIC16C5X and PIC16CXXX In-Circuit Emulator
- PRO MATE[®] II Universal Programmer
- PICSTART[®] Plus Entry-Level Prototype Programmer
- PICDEM-1 Low-Cost Demonstration Board
- PICDEM-2 Low-Cost Demonstration Board
- PICDEM-3 Low-Cost Demonstration Board
- MPASM Assembler
- MPLAB-SIM Software Simulator
- MPLAB-C (C Compiler)
- Fuzzy logic development system (*fuzzy*TECH[®]–MP)

15.2 <u>PICMASTER: High Performance</u> <u>Universal In-Circuit Emulator with</u> <u>MPLAB IDE</u>

The PICMASTER Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for all microcontrollers in the PIC12C5XX, PIC14C000, PIC16C5X, PIC16CXXX and PIC17CXX families. PICMASTER is supplied with the MPLAB[™] Integrated Development Environment (IDE), which allows editing, "make" and download, and source debugging from a single environment.

Interchangeable target probes allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the PICMASTER allows expansion to support all new Microchip microcontrollers.

The PICMASTER Emulator System has been designed as a real-time emulation system with advanced features that are generally found on more expensive development tools. The PC compatible 386 (and higher) machine platform and Microsoft Windows[®] 3.x environment were chosen to best make these features available to you, the end user.

A CE compliant version of PICMASTER is available for European Union (EU) countries.

15.3 ICEPIC: Low-cost PIC16CXXX In-Circuit Emulator

ICEPIC is a low-cost in-circuit emulator solution for the Microchip PIC16C5X and PIC16CXXX families of 8-bit OTP microcontrollers.

ICEPIC is designed to operate on PC-compatible machines ranging from 286-AT[®] through Pentium[™] based machines under Windows 3.x environment. ICEPIC features real time, non-intrusive emulation.

15.4 PRO MATE II: Universal Programmer

The PRO MATE II Universal Programmer is a full-featured programmer capable of operating in stand-alone mode as well as PC-hosted mode.

The PRO MATE II has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for displaying error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In standalone mode the PRO MATE II can read, verify or program PIC16C5X, PIC16CXXX, PIC17CXX and PIC14000 devices. It can also set configuration and code-protect bits in this mode.

15.5 <u>PICSTART Plus Entry Level</u> <u>Development System</u>

The PICSTART programmer is an easy-to-use, lowcost prototype programmer. It connects to the PC via one of the COM (RS-232) ports. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. PICSTART Plus is not recommended for production programming.

PICSTART Plus supports all PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX and PIC17CXX devices with up to 40 pins. Larger pin count devices such as the PIC16C923 and PIC16C924 may be supported with an adapter socket.

15.6 <u>PICDEM-1 Low-Cost PIC16/17</u> <u>Demonstration Board</u>

The PICDEM-1 is a simple board which demonstrates the capabilities of several of Microchip's microcontrollers. The microcontrollers supported are: PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The users can program the sample microcontrollers provided with the PICDEM-1 board, on a PRO MATE II or PICSTART-16B programmer, and easily test firmware. The user can also connect the PICDEM-1 board to the PICMASTER emulator and download the firmware to the emulator for testing. Additional prototype area is available for the user to build some additional hardware and connect it to the microcontroller socket(s). Some of the features include an RS-232 interface, a potentiometer for simulated analog input, push-button switches and eight LEDs connected to PORTB.

15.7 <u>PICDEM-2 Low-Cost PIC16CXX</u> <u>Demonstration Board</u>

The PICDEM-2 is a simple demonstration board that supports the PIC16C62, PIC16C64, PIC16C65, PIC16C73 and PIC16C74 microcontrollers. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-2 board, on a PRO MATE II programmer or PICSTART-16C, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-2 board to test firmware. Additional prototype area has been provided to the user for adding additional hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push-button switches, a potentiometer for simulated analog input, a Serial EEPROM to demonstrate usage of the I²C bus and separate headers for connection to an LCD module and a keypad.

15.8 PICDEM-3 Low-Cost PIC16CXXX Demonstration Board

The PICDEM-3 is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with a LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM-3 board, on a PRO MATE II programmer or PICSTART Plus with an adapter socket, and easily test firmware. The PICMASTER emulator may also be used with the PICDEM-3 board to test firmware. Additional prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include an RS-232 interface, push-button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM-3 board is an LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM-3 provides an additional RS-232 interface and Windows 3.1 software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

15.9 <u>MPLAB Integrated Development</u> <u>Environment Software</u>

The MPLAB IDE Software brings an ease of software development previously unseen in the 8-bit microcontroller market. MPLAB is a windows based application which contains:

- A full featured editor
- Three operating modes
 - editor
 - emulator
 - simulator
- A project manager
- · Customizable tool bar and key mapping
- A status bar with project information
- Extensive on-line help

MPLAB allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PIC16/17 tools (automatically updates all project information)
- Debug using:
- source files
- absolute listing file
- Transfer data dynamically via DDE (soon to be replaced by OLE)
- Run up to four emulators on the same PC

The ability to use MPLAB with Microchip's simulator allows a consistent platform and the ability to easily switch from the low cost simulator to the full featured emulator with minimal retraining due to development tools.

15.10 Assembler (MPASM)

The MPASM Universal Macro Assembler is a PChosted symbolic assembler. It supports all microcontroller series including the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX, and PIC17CXX families.

MPASM offers full featured Macro capabilities, conditional assembly, and several source and listing formats. It generates various object code formats to support Microchip's development tools as well as third party programmers.

MPASM allows full symbolic debugging from PICMASTER, Microchip's Universal Emulator System.

MPASM has the following features to assist in developing software for specific use applications.

- Provides translation of Assembler source code to object code for all Microchip microcontrollers.
- Macro assembly capability.
- Produces all the files (Object, Listing, Symbol, and special) required for symbolic debug with Microchip's emulator systems.
- Supports Hex (default), Decimal and Octal source and listing formats.

MPASM provides a rich directive language to support programming of the PIC16/17. Directives are helpful in making the development of your assemble source code shorter and more maintainable.

15.11 Software Simulator (MPLAB-SIM)

The MPLAB-SIM Software Simulator allows code development in a PC host environment. It allows the user to simulate the PIC16/17 series microcontrollers on an instruction level. On any given instruction, the user may examine or modify any of the data areas or provide external stimulus to any of the pins. The input/ output radix can be set by the user and the execution can be performed in; single step, execute until break, or in a trace mode.

MPLAB-SIM fully supports symbolic debugging using MPLAB-C and MPASM. The Software Simulator offers the low cost flexibility to develop and debug code outside of the laboratory environment making it an excellent multi-project software development tool.

15.12 C Compiler (MPLAB-C)

The MPLAB-C Code Development System is a complete 'C' compiler and integrated development environment for Microchip's PIC16/17 family of micro-controllers. The compiler provides powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compiler provides symbol information that is compatible with the MPLAB IDE memory display (PICMASTER emulator software versions 1.13 and later).

15.13 <u>Fuzzy Logic Development System</u> (*fuzzy*TECH-MP)

*fuzzy*TECH-MP fuzzy logic development tool is available in two versions - a low cost introductory version, MP Explorer, for designers to gain a comprehensive working knowledge of fuzzy logic system design; and a full-featured version, *fuzzy*TECH-MP, edition for implementing more complex systems.

Both versions include Microchip's *fuzzy*LAB[™] demonstration board for hands-on experience with fuzzy logic systems implementation.

15.14 <u>MP-DriveWay™ – Application Code</u> <u>Generator</u>

MP-DriveWay is an easy-to-use Windows-based Application Code Generator. With MP-DriveWay you can visually configure all the peripherals in a PIC16/17 device and, with a click of the mouse, generate all the initialization and many functional code modules in C language. The output is fully compatible with Microchip's MPLAB-C C compiler. The code produced is highly modular and allows easy integration of your own code. MP-DriveWay is intelligent enough to maintain your code through subsequent code generation.

15.15 <u>SEEVAL[®] Evaluation and</u> <u>Programming System</u>

The SEEVAL SEEPROM Designer's Kit supports all Microchip 2-wire and 3-wire Serial EEPROMs. The kit includes everything necessary to read, write, erase or program special features of any Microchip SEEPROM product including Smart Serials[™] and secure serials. The Total Endurance[™] Disk is included to aid in trade-off analysis and reliability calculations. The total kit can significantly reduce time-to-market and result in an optimized system.

15.16 <u>TrueGauge[®] Intelligent Battery</u> <u>Management</u>

The TrueGauge development tool supports system development with the MTA11200B TrueGauge Intelligent Battery Management IC. System design verification can be accomplished before hardware prototypes are built. User interface is graphically-oriented and measured data can be saved in a file for exporting to Microsoft Excel.

15.17 <u>KEELOQ[®] Evaluation and</u> <u>Programming Tools</u>

KEELOQ evaluation and programming tools support Microchips HCS Secure Data Products. The HCS evaluation kit includes an LCD display to show changing codes, a decoder to decode transmissions, and a programming interface to program test transmitters.

TABLE 15-1: DEVELOPMENT TOOLS FROM MICROCHIP

HCS200 HCS300 HCS301										7	2					
24CXX 25CXX 93CXX							2			7		2				
PIC17C75X	Available 3Q97		7	2					7	2						
PIC17C4X	2		7	2	2	7			7	7			7			
PIC16C9XX	7		7	7	7				7	7					7	
PIC16C8X	2	7	7	7	7	7		7	7	7			7			
PIC16C7XX	2	7	7	2	7	7		7	7	7				7		
PIC16C6X	2	7	2	>	7	7		7	7	7				7		
PIC16CXXX	7	7	2	7	7	7			7	7			7			
PIC16C5X	2	7	7	7	7	7		7	7	7			7			
PIC14000	2		7	7	7				7	7						
PIC12C5XX	2	7	7	7	7				7	7						
	PICMASTER®/ PICMASTER-CE In-Circuit Emulator	In-Circuit Emulator	MPLAB™ Integrated Development Environment	MPLAB™ C Compiler	fiont fuzzyTECH®-MP Explorer/Edition Fuzzy Logic Dev. Tool	MP-DriveWay™ Applications Code Generator	Total Endurance™ Software Model	PICSTART [®] Lite Ultra Low-Cost Dev. Kit	PICSTART® Plus Low-Cost Universal Dev. Kit	PRO MATE [®] II Universal Programmer	KEELOQ [®] Programmer	SEEVAL [®] Designers Kit	ards PICDEM-1	PICDEM-2	PICDEM-3	KEELOO®

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

16.0 ELECTRICAL CHARACTERISTICS FOR PIC16C61

Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +125°C
Storage temperature	
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 pin with respect to Vss	0V to +14V
Total power dissipation (Note 1)	800 mW
Maximum current out of Vss pin	150 mA
Maximum current into VDD pin	100 mA
Input clamp current, liк (Vi < 0 or Vi > VDD)	±20 mA
Output clamp current, loк (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	20 mA
Maximum current sunk by PORTA	80 mA
Maximum current sourced by PORTA	50 mA
Maximum current sunk by PORTB	150 mA
Maximum current sourced by PORTB	100 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD-	VOH) x IOH} + Σ (VOI x IOL)

Note 2: Voltage spikes below Vss at the $\overline{\text{MCLR}}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100 Ω should be used when applying a "low" level to the $\overline{\text{MCLR}}$ pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 16-1:CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS
AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

OSC	PIC16C61-04	PIC16C61-20	PIC16LC61-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 3.3 mA max. at 5.5V IPD: 14 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 1.8 mA typ. at 5.5V IPD: 1.0 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 1.4 mA typ. at 3.0V IPD: 0.6 μA typ. at 3V Freg: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 3.3 mA max. at 5.5V IPD: 14 μA max. at 4V Freg: 4 MHz max.
ХТ	VDD: 4.0V to 6.0V IDD: 3.3 mA max. at 5.5V IPD: 14 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 1.8 mA typ. at 5.5V IPD: 1.0 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 1.4 mA typ. at 3.0V IPD: 0.6 μA typ. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 3.3 mA max. at 5.5V IPD: 14 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.0 μA typ. at 4.5V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.0 μA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.0 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 15 μA typ. at 32 kHz, 4.0V IPD: 0.6 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	 VDD: 3.0V to 6.0V IDD: 32 μA max. at 32 kHz, 3.0V IPD: 9 μA max. at 3.0V Freq: 200 kHz max. 	VDD: 3.0V to 6.0V IDD: 32 μA max. at 32 kHz, 3.0V IPD: 9 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

+

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

16.1 DC Characteristics: PIC16C61-04 (Commercial, Industrial, Extended) PIC16C61-20 (Commercial, Industrial, Extended)

		Standar	rd Opei	rating	Condi	tions (ı	unless otherwise stated)
	ACTERISTICS	Operatir	ng temp	erature	e -40)°C ≤	\leq TA \leq +125°C for extended,
DO ONAIO	ACTERIOTICO				-40)°C ≤	\leq TA \leq +85°C for industrial and
					0°0) ≤	$T_A \leq +70^{\circ}C$ for commercial
Param No.	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions
D001	Supply Voltage	Vdd	4.0	-	6.0	V	XT, RC and LP osc configuration
D001A			4.5	-	5.5	V	HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	Svdd	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2)	IDD	-	1.8	3.3	mA	Fosc = 4 MHz, VDD = 5.5V (Note 4)
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V
D020	Power-down Current	IPD	-	7	28	μΑ	VDD = 4.0V, WDT enabled, -40°C to +85°C
D021	(Note 3)		-	1.0	14	μA	VDD = $4.0V$, WDT disabled, $-0^{\circ}C$ to $+70^{\circ}C$
D021A			-	1.0	16	μA	VDD = $4.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$
D021B			-	1.0	20	μA	VDD = $4.0V$, WDT disabled, $-40^{\circ}C$ to $+125^{\circ}C$

These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD, \overline{MCLR} = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

DC Characteristics: PIC16LC61-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)											
RACTERISTICS	Operatir	ng temp	perature			$TA \le +85^{\circ}C$ for industrial and					
				0.0	; ≤	$TA \le +70^{\circ}C$ for commercial					
Characteristic	Sym	Min	Тур†	Мах	Units	Conditions					
Supply Voltage	Vdd	3.0	-	6.0	V	XT, RC, and LP osc configuration					
RAM Data Retention Volt- age (Note 1)	Vdr	-	1.5	-	V						
VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details					
VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details					
Supply Current (Note 2)	IDD	-	1.4	2.5	mA	Fosc = 4 MHz, VDD = 3.0V (Note 4)					
		-	15	32	μA	Fosc = 32 kHz, VDD = 3.0V, WDT disabled, LP osc configuration					
Power-down Current	IPD	-	5	20	μA	VDD = 3.0V, WDT enabled, -40°C to +85°C					
(Note 3)		-	0.6	9	μA	VDD = $3.0V$, WDT disabled, $0^{\circ}C$ to $+70^{\circ}C$					
		-	0.6	12	μA	VDD = $3.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$					
	Characteristic Supply Voltage RAM Data Retention Volt- age (Note 1) VDD start voltage to ensure internal Power-on Reset signal VDD rise rate to ensure nternal Power-on Reset signal Supply Current (Note 2) Power-down Current	RACTERISTICSOperatinCharacteristicSymSupply VoltageVDDSupply VoltageVDDRAM Data Retention Voltage (Note 1)VDRVDD start voltage to ensure internal Power-on Reset signalVPORVDD rise rate to ensure nternal Power-on Reset signalSVDDSupply Current (Note 2)IDDPower-down CurrentIPD	RACTERISTICSOperating tempCharacteristicSymMinSupply VoltageVDD3.0RAM Data Retention Voltage (Note 1)VDR-VDD start voltage to ensure internal Power-on Reset signalVPOR-VDD rise rate to ensure internal Power-on Reset signalSVDD0.05Supply Current (Note 2)IDD-Power-down CurrentIPD-	CharacteristicSymMinTyp†Supply VoltageVDD3.0-RAM Data Retention Voltage (Note 1)VDR-1.5VDD start voltage to ensure internal Power-on Reset signalVPOR-VSSVDD rise rate to ensure nternal Power-on Reset signalSVDD0.05-Supply Current (Note 2)IDD-1.4Power-down Current (Note 3)IPD-5	RACTERISTICSOperating temperature-40 0°CCharacteristicSymMinTyp†MaxSupply VoltageVDD3.0-6.0RAM Data Retention Voltage (Note 1)VDR-1.5-VDD start voltage to ensure internal Power-on Reset signalVPOR-VSS-VDD rise rate to ensure nternal Power-on Reset signalSVDD0.05Supply Current (Note 2)IDD-1.42.5Power-down Current (Note 3)IPD-520Note 3)-0.69-1.5-	ACTERISTICSOperating temperature $-40^{\circ}C \leq 0^{\circ}C < 0^{\circ}C \leq 0^{\circ}C \leq 0^{\circ}C < 0^{\circ}C \leq 0^{\circ}C < 0^{\circ}C \leq 0^{\circ}C < 0^{\circ}C $					

These parameters are characterized but not tested.

16.2

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

 $\overline{MCLR} = VDD$; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

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16.3 DC Characteristics: PIC16C61-04 (Commercial, Industrial, Extended) PIC16C61-20 (Commercial, Industrial, Extended) PIC16LC61-04 (Commercial, Industrial)

DC CH4	ARACTERISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C$ $\leq TA \leq +125^{\circ}C$ for extended, $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ for industrial and $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ for commercialOperating voltage VDD range as described in DC spec Section 16.1Section 16.2.								
Param No.	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions			
	Input Low Voltage									
	I/O ports	VIL								
D030 D030A	with TTL buffer		Vss Vss	-	0.15Vdd 0.8V	V V	For entire VDD range $4.5V \le VDD \le 5.5V$			
D031	with Schmitt Trigger buffer		Vss	-	0.2Vdd	V				
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2Vdd	V				
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1			
	Input High Voltage									
	I/O ports	VIH		-						
D040	with TTL buffer		2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$			
D040A			0.25Vdd + 0.8V	-	Vdd	V	For entire VDD range			
D041	with Schmitt Trigger buffer		0.85Vdd	-	Vdd	V	For entire VDD range			
D042	MCLR		0.85Vdd	-	Vdd	V				
D042A	OSC1 (XT, HS and LP)		0.7Vdd	-	Vdd	V	Note1			
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V				
D070	PORTB weak pull-up current	IPURB	50	250	† 400	μΑ	VDD = 5V, VPIN = VSS			
	Input Leakage Current (Notes 2, 3)									
D060	I/O ports	lı∟	-	-	±1	μA	Vss \leq VPIN \leq VDD, Pin at hi- impedance			
D061	MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \le VPIN \le VDD$			
D063	OSC1		-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration			
	Output Low Voltage									
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C			
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C			
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	lOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C			
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C			

The parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

DC CH4	ARACTERISTICS	Operatir	ng temper	ature	-40°C -40°C 0°C	≤ TA ≤ TA ≤ TA	as otherwise stated) $A \le +125^{\circ}C$ for extended, $A \le +85^{\circ}C$ for industrial and $A \le +70^{\circ}C$ for commercial
		Operatir Section		VDD ra	ange as c	lescribe	ed in DC spec Section 16.1 and
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	Vdd-0.7	-	-	V	ІОн = -3.0 mA, VDD = 4.5V, -40°С to +85°С
D090A			Vdd-0.7	-	-	V	ІОн = -2.5 mA, VDD = 4.5V, -40°С to +125°С
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°С to +85°С
D092A			VDD-0.7	-	-	V	ІОН = -1.0 mA, VDD = 4.5V, -40°С to +125°С
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin
	Capacitive Loading Specs on Output Pins						
D100	OSC2 pin	Cosc2			15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2 (in RC mode)	Cio			50	pF	

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The parameters are characterized but not tested.

t Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

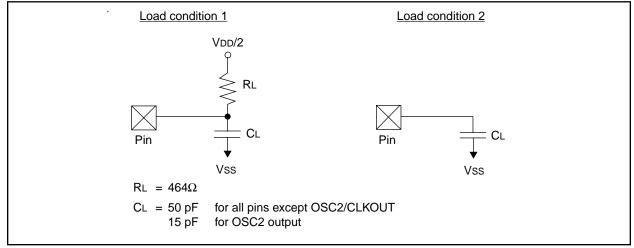
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

16.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

1. TppS2p	pS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			(
F	Frequency	Т	Time
Lowerca	ise letters (pp) and their meanings:	I	
рр	··· /		
сс	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
CS	CS	rw	\overline{RD} or \overline{WR}
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperca	se letters and their meanings:		
S			
F	Fall	P	Period
н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st (I ² C specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

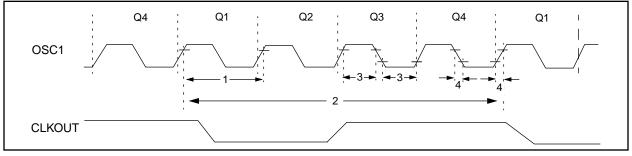
FIGURE 16-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



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16.5 <u>Timing Diagrams and Specifications</u>

FIGURE 16-2: EXTERNAL CLOCK TIMING



Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			1	_	4	MHz	HS osc mode (-04)
			1		20	MHz	HS osc mode (-20)
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			50	_	—	ns	HS osc mode (-20)
			5	_	_	μs	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	1,000	ns	HS osc mode (-04)
			50	_	1,000	ns	HS osc mode (-20)
			5	_	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	1.0	Тсү	DC	μs	TCY = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	50	_	_	ns	XT oscillator
	TosH	TosH Low Time	2.5	_		μs	LP oscillator
			10	_	—	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	25	_	_	ns	XT oscillator
	TosF	Fall Time	50	_		ns	LP oscillator
			15		_	ns	HS oscillator

 Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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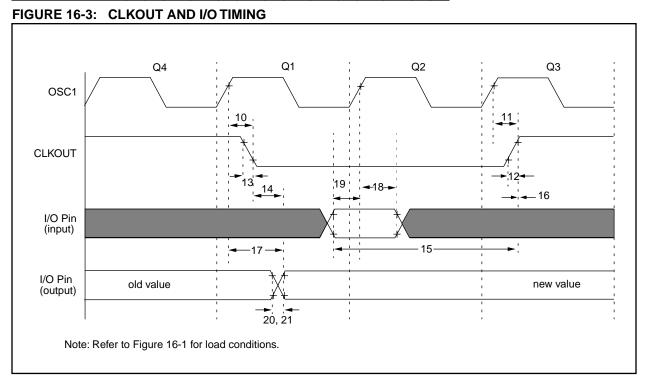


TABLE 16-3: **CLKOUT AND I/O TIMING REQUIREMENTS**

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10*	TosH2ckL	OSC1 [↑] to CLKOUT↓		—	15	30	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	15	30	ns	Note 1
12*	TckR	CLKOUT rise time		_	5	15	ns	Note 1
13*	TckF	CLKOUT fall time		_	5	15	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out va	alid	_	_	0.5TCY + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLK) TUC	0.25Tcy + 25		_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT 1		0	_	_	ns	Note 1
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Po	rt out valid	_	_	80 - 100	ns	
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Po (I/O in hold time)	rt input invalid	TBD	_	_	ns	
19*	TioV2osH	Port input valid to OSC1 time)	↑ (I/O in setup	TBD	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 61	_	10	25	ns	
			PIC16 LC 61	_	_	60	ns	
21*	TioF	Port output fall time	PIC16 C 61	_	10	25	ns	
		PIC16 LC 61		_	_	60	ns	
22††*	Tinp	RB0/INT pin high or low time		20		_	ns	
23††*	Trbp	RB7:RB4 change int hig	RB7:RB4 change int high or low time			_	ns	

These parameters are characterized but not tested.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

t Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

These parameters are asynchronous events not related to any internal clock edges. ††

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FIGURE 16-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

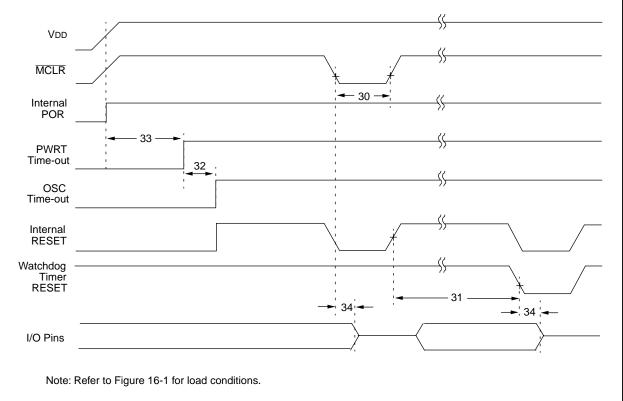


TABLE 16-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP
TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30*	TmcL	MCLR Pulse Width (low)	200	_	—	ns	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	—		TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34*	Tıoz	I/O Hi-impedance from MCLR Low			100	ns	

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

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FIGURE 16-5: TIMER0 EXTERNAL CLOCK TIMINGS

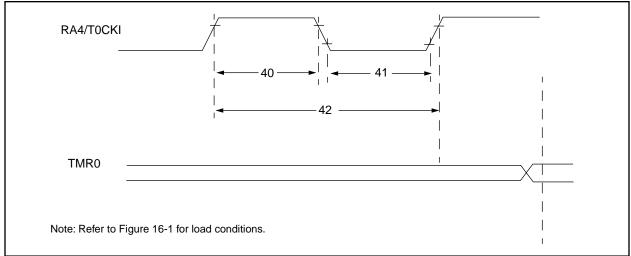


TABLE 16-5: TIMER0 EXTERNAL CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet parameter 42
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5Tcy + 20	-		ns	Must also meet
			With Prescaler	10	—	—	ns	parameter 42
42*	Tt0P	T0CKI Period	No Prescaler	Tcy + 40	—		ns	N = prescale value
			With Prescaler	Greater of: 20 ns or <u>Tcy + 40</u> N			ns	(2, 4,, 256)

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

17.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES FOR PIC16C61

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

In some graphs or tables the data presented are outside specified operating range (i.e., outside specified VDD range). This is for information only and devices are guaranteed to operate properly only within the specified range. **Note:** The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution while 'max' or 'min' represents (mean $+3\sigma$) and (mean -3σ) respectively where σ is standard deviation.

FIGURE 17-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

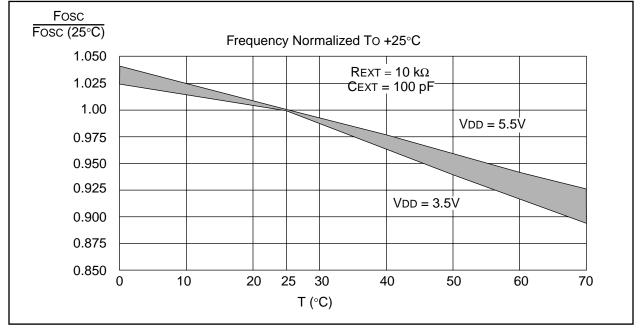
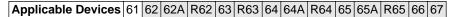
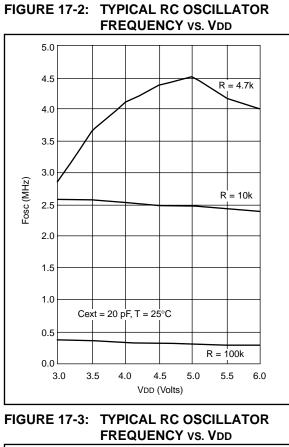


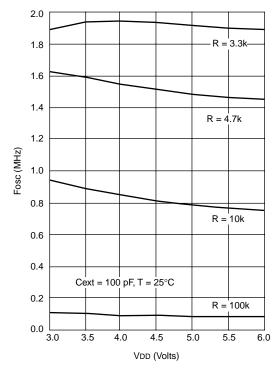
TABLE 17-1:RC OSCILLATOR FREQUENCIES

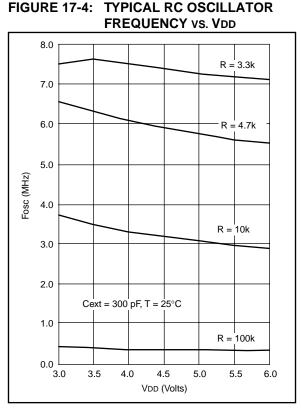
Cext	Rext	Average Fosc @ 5V, 25°C	
20 pF	4.7k	4.52 MHz	± 17.35%
	10k	2.47 MHz	± 10.10%
	100k	290.86 kHz	± 11.90%
100 pF	3.3k	1.92 MHz	± 9.43%
	4.7k	1.48 MHz	± 9.83%
	10k	788.77 kHz	± 10.92%
	100k	88.11 kHz	± 16.03%
300 pF	3.3k	726.89 kHz	± 10.97%
	4.7k	573.95 kHz	± 10.14%
	10k	307.31 kHz	± 10.43%
	100k	33.82 kHz	± 11.24%

The percentage variation indicated here is part to part variation due to normal process distribution. The variation indicated is ± 3 standard deviation from average value for VDD = 5V.

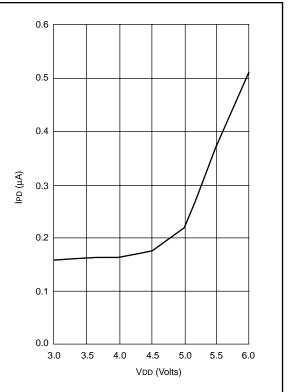




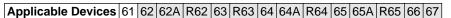


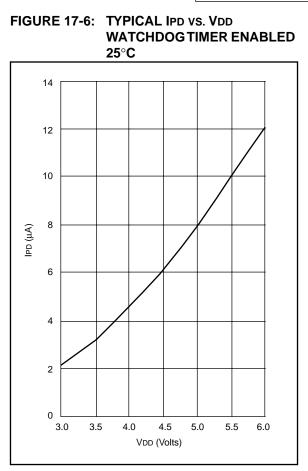


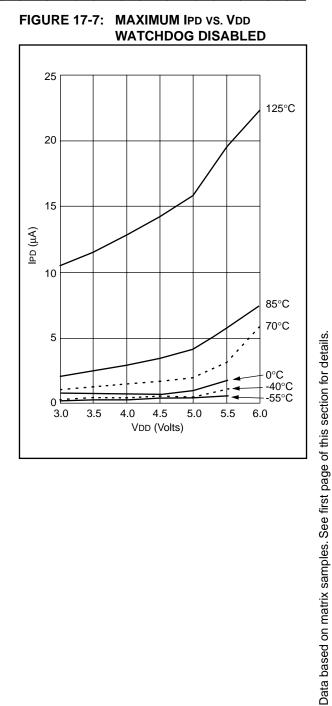




Data based on matrix samples. See first page of this section for details.



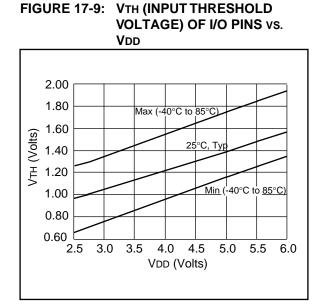




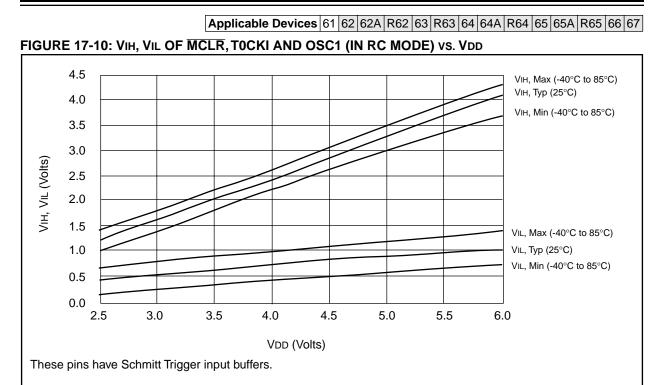
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 17-8: MAXIMUM IPD VS. VDD WATCHDOG ENABLED* 45 -55°C 40 -40°C 35 30 125°C IPD (JA) 25 20 0°C 15 70°C 85°C 10 5 0 5.5 3.0 3.5 4.0 4.5 5.0 6.0 VDD (Volts)

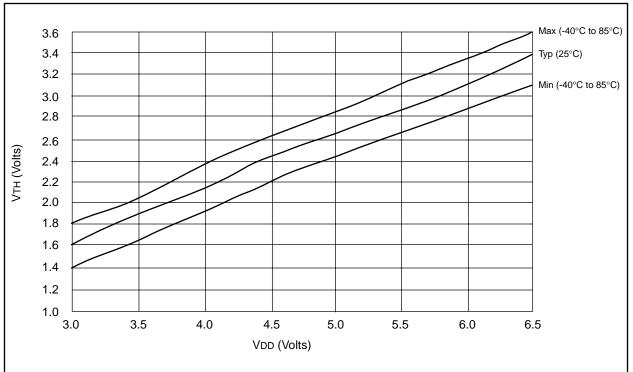
*IPD, with Watchdog Timer enabled, has two components: The leakage current which increases with higher temperature and the operating current of the Watchdog Timer logic which increases with lower temperature. At -40°C, the latter dominates explaining the apparently anomalous behavior.

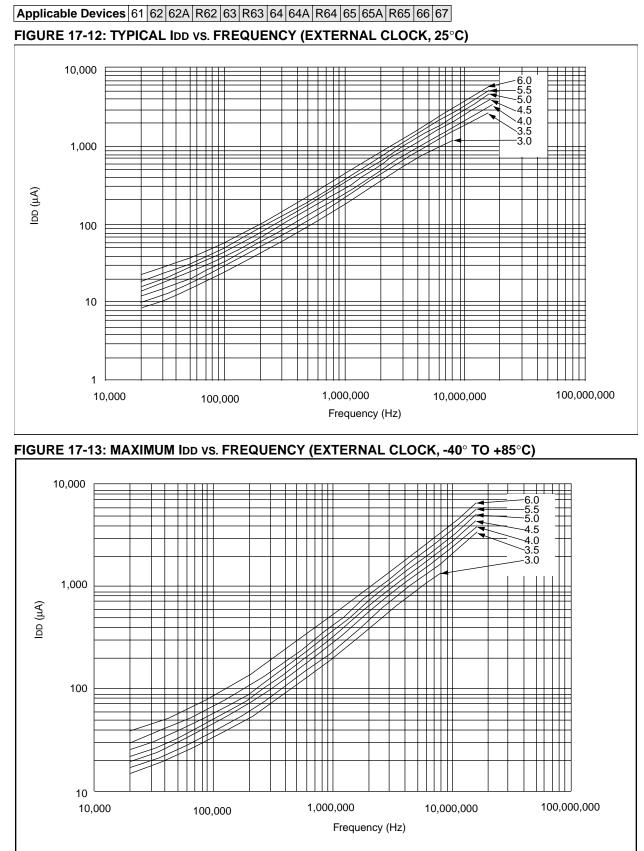


Data based on matrix samples. See first page of this section for details.









Data based on matrix samples. See first page of this section for details.

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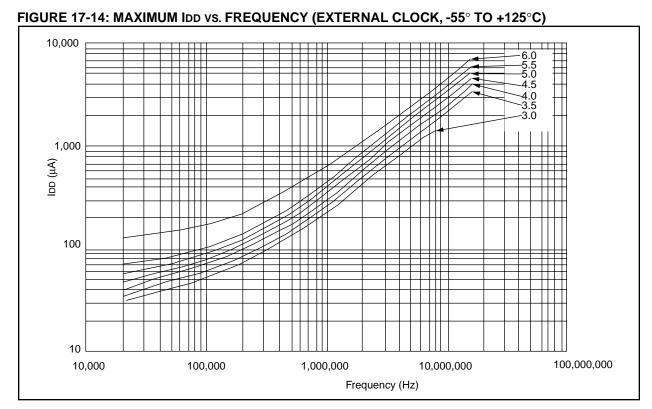


FIGURE 17-15: WDT TIMER TIME-OUT PERIOD vs. VDD

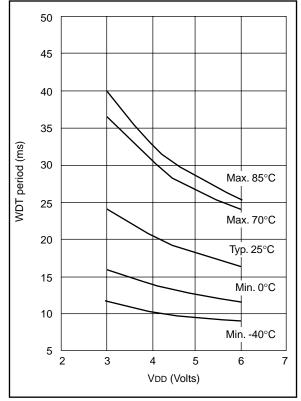
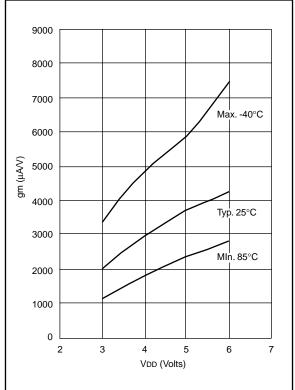
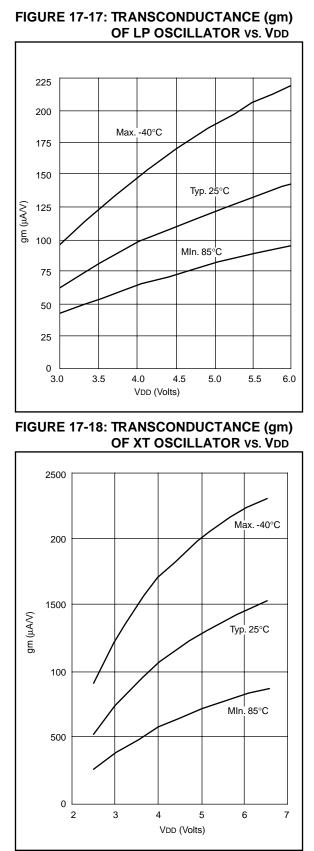


FIGURE 17-16: TRANSCONDUCTANCE (gm) OF HS OSCILLATOR vs. VDD





Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67



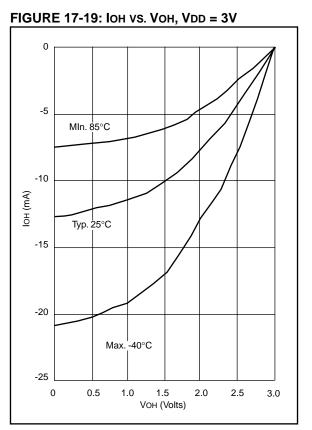
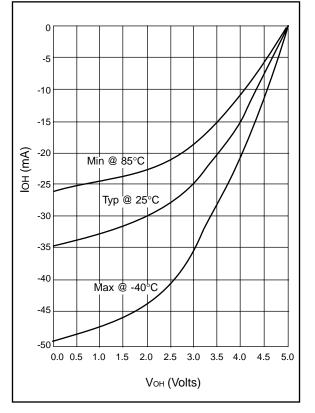
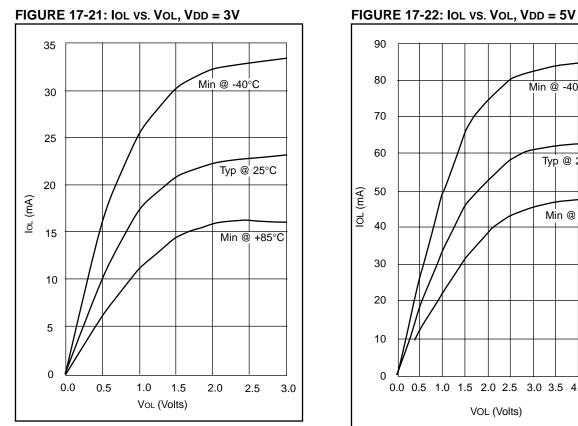


FIGURE 17-20: IOH VS. VOH, VDD = 5V



Data based on matrix samples. See first page of this section for details.



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Min @ -40°C Typ @ 25°C Min @ +85°C $0.0 \ \ 0.5 \ \ 1.0 \ \ 1.5 \ \ 2.0 \ \ 2.5 \ \ 3.0 \ \ 3.5 \ \ 4.0 \ \ 4.5 \ \ 5.0$ VOL (Volts)

TABLE 17-2: INPUT CAPACITANCE*

Typical Capacitance (pF)						
18L PDIP	18L SOIC					
5.0	4.3					
5.0	4.3					
17.0	17.0					
4.0	3.5					
4.3	3.5					
3.2	2.8					
3.2 part variation of ±25% (three stand	ard devi					

 Applicable Devices
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 NOTES:

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18.0 ELECTRICAL CHARACTERISTICS FOR PIC16C62/64

Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +85°C
Storage temperature	
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	300 mA
Maximum current into Vod pin	250 mA
Input clamp current, Iк (VI < 0 or VI > VDD)	±20 mA
Output clamp current, IOK (VO < 0 or VO > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE* (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE* (combined)	
Maximum current sunk by PORTC and PORTD* (combined)	200 mA
Maximum current sourced by PORTC and PORTD* (combined)	200 mA
* PORTD and PORTE not available on the PIC16C62.	

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD-VOH) x IOH} + \sum (VOI x IOL)

Note 2: Voltage spikes below Vss at the $\overline{\text{MCLR}}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100 Ω should be used when applying a "low" level to the $\overline{\text{MCLR}}$ pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 18-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C62-04 PIC16C64-04	PIC16C62-10 PIC16C64-10	PIC16C62-20 PIC16C64-20	PIC16LC62-04 PIC16LC64-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq:4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 μA max. at 3.0V Freq: 4 MHz max.	
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 15 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 10 MHz max.	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq:200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 13.5 μA max. at 3.0V Freq:200 kHz max.	VDD: 3.0V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD:13.5 μA max. at 3.0V Freq:200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

18.1

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DC Characteristics: PIC16C62/64-04 (Commercial, Industrial) PIC16C62/64-10 (Commercial, Industrial) PIC16C62/64-20 (Commercial, Industrial)

DC CHAR		Standaı Operatir	-	-)°C ≤	u nless otherwise stated) ≦ TA ≤ +85°C for industrial and ≦ TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions
D001 D001A	Supply Voltage	Vdd	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	Svdd	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5.0	mA	XT, RC, osc configuration Fosc = 4 MHz, VDD = 5.5V (Note 4)
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V
D020 D021 D021A	Power-down Current (Note 3, 5)	IPD	- - -	10.5 1.5 1.5	42 21 24	μΑ μΑ μΑ	$VDD = 4.0V$, WDT enabled, $-40^{\circ}C$ to $+85^{\circ}C$ $VDD = 4.0V$, WDT disabled, $-0^{\circ}C$ to $+70^{\circ}C$ $VDD = 4.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD \overline{MCLR} = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

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18.2 DC Characteristics: PIC16LC62/64-04 (Commercial, Industrial)

DC CHARACTERISTICSStandard Operating Conditions (unless otherwise stated) Operating temperature -40° C $\leq TA \leq +85^{\circ}$ C for industrial and 0° C0°C $\leq TA \leq +70^{\circ}$ C for commercial											
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions				
D001	Supply Voltage	Vdd	3.0	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)				
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V					
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details				
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details				
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 3.0V (Note 4)				
D010A			-	22.5	48	μA	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled				
D020	Power-down Current	IPD	-	7.5	30	μA	VDD = 3.0V, WDT enabled, -40°C to +85°C				
D021 D021A	(Note 3, 5)			0.9 0.9	13.5 18	μΑ μΑ	VDD = $3.0V$, WDT disabled, 0°C to +70°C VDD = $3.0V$, WDT disabled, -40°C to +85°C				

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all $\ensuremath{\mathsf{IDD}}$ measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

 $\overline{\text{MCLR}}$ = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

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18.3 DC Characteristics: PI

PIC16C62/64-04 (Commercial, Industrial) PIC16C62/64-10 (Commercial, Industrial) PIC16C62/64-20 (Commercial, Industrial) PIC16LC62/64-04 (Commercial, Industrial)

DC CHA	ARACTERISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ for industrial and $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ for commercialOperating voltage VDD range as described in DC spec Section 18.1and Section 18.2								
Param No.	Characteristic	Sym	Min	Тур †	Max	Units	Conditions			
	Input Low Voltage									
	I/O ports	VIL								
D030	with TTL buffer		Vss	-	0.15VDD		For entire VDD range			
D030A			Vss	-	0.8V		$4.5V \le VDD \le 5.5V$			
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD					
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD					
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1			
	Input High Voltage	N /··· ·								
D 040	I/O ports	VIH			\/					
D040	with TTL buffer		2.0	-	VDD		$4.5V \le VDD \le 5.5V$			
D040A			0.25VDD + 0.8V	-	Vdd	V	For entire VDD range			
D041	with Schmitt Trigger buffer		0.8Vdd	-	Vdd		For entire VDD range			
D042	MCLR		0.8VDD	-	Vdd	V				
D042A	OSC1 (XT, HS and LP)		0.7Vdd	-	Vdd	V	Note1			
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V				
D070	PORTB weak pull-up current	I PURB	50	200	400	μA	VDD = 5V, VPIN = VSS			
	Input Leakage Current (Notes 2, 3)									
D060	I/O ports	lı∟	-	-	±1	μA	$Vss \le VPIN \le VDD$, Pin at hi-impedance			
D061	MCLR, RA4/T0CKI		-	-	±5	μA	$Vss \leq VPIN \leq VDD$			
D063	OSC1		-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration			
	Output Low Voltage									
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C			
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C			
	Output High Voltage									
D090	I/O ports (Note 3)	Voн	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C			
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°С to +85°С			
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin			

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

		Standar	d Operat	ing C	ondition	s (unles	ss otherwise stated)		
		Operatir	ng temper	ature	-40°C	-40°C \leq TA \leq +85°C for industrial			
DC CHA	ARACTERISTICS				0°C	≤TA	$A \leq +70^{\circ}C$ for commercial		
	Operating voltage VDD range as described in DC spec Se						ed in DC spec Section 18.1		
		and Sec	tion 18.2						
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions		
No.				1					
	Capacitive Loading Specs on Output								
	Pins								
D100	OSC2 pin	Cosc ₂	-	-	15	pF	In XT, HS and LP modes		
							when external clock is used to		
							drive OSC1.		
D101	All I/O pins and OSC2 (in RC mode)	CIO	-	-	50	pF			
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF			

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* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

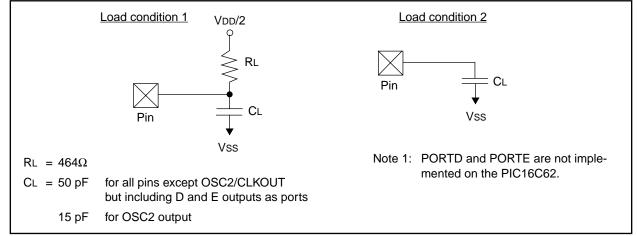
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18.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

1. TppS2p	pS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowerca	ase letters (pp) and their meanings:		
рр			
сс	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	SC	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
	ase letters and their meanings:		
S			
F	Fall	P	Period
н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st	(I ² C specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 18-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



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18.5 <u>Timing Diagrams and Specifications</u>

FIGURE 18-2: EXTERNAL CLOCK TIMING

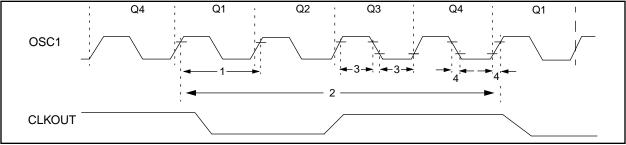


TABLE 18-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	—	4	MHz	HS osc mode (-04)
			DC	—	10	MHz	HS osc mode (-10)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	—	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	—	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	—	ns	HS osc mode (-04)
			100	_	—	ns	HS osc mode (-10)
			50	_	—	ns	HS osc mode (-20)
			5	_	—	μs	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	—	250	ns	HS osc mode (-10)
			50	—	1,000	ns	HS osc mode (-20)
			5	_	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High	100	_	—	ns	XT oscillator
	TosH	or Low Time	2.5	_		μs	LP oscillator
			15		_	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise	_	_	25	ns	XT oscillator
	TosF	or Fall Time	—	_	50	ns	LP oscillator
			_	_	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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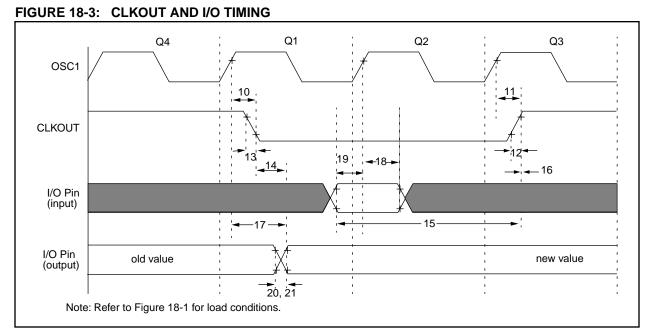


TABLE 18-3: **CLKOUT AND I/O TIMING REQUIREMENTS**

Parameters	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1 [↑] to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1 [↑] to CLKOUT [↑]	_	75	200	ns	Note 1	
12*	TckR	CLKOUT rise time	—	35	100	ns	Note 1	
13*	TckF	CLKOUT fall time	CLKOUT fall time			100	ns	Note 1
14*	TckL2ioV	CLKOUT \downarrow to Port out valid		_	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT	↑	Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT 1	0	_	_	ns	Note 1	
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port out	_	50	150	ns		
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port	PIC16 C 62/64	100	_	_	ns	
		input invalid (I/O in hold time)	PIC16 LC 62/64	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)		0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 62/64	_	10	40	ns	
			PIC16 LC 62/64	_	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 62/64	_	10	40	ns	
			PIC16 LC 62/64	—	_	80	ns	
22††*	Tinp	INT pin high or low time		Тсү	_	_	ns	
23††*	Trbp	RB7:RB4 change INT high or	low time	Тсү	_	_	ns	

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

†† These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

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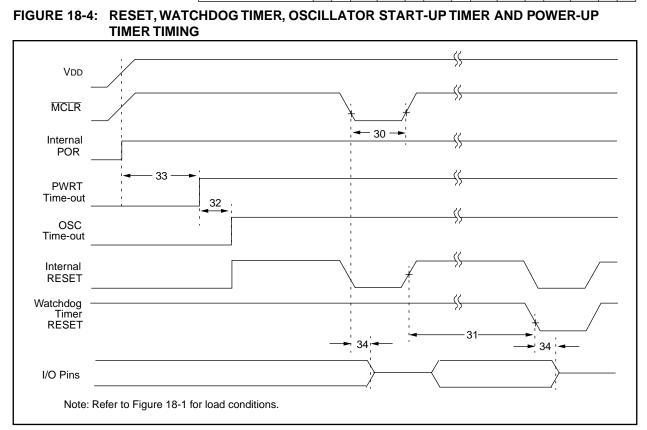


TABLE 18-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP
TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30*	TmcL	MCLR Pulse Width (low)	100	—	—	ns	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	—	—	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +85°C
34*	Tıoz	I/O Hi-impedance from MCLR Low	_	—	100	ns	

These parameters are characterized but not tested.

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FIGURE 18-5: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

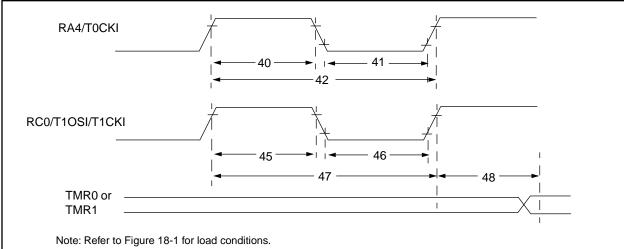


TABLE 18-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5TCY + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5TCY + 20	—	—	ns	Must also meet
				With Prescaler	10	—	—	ns	parameter 42
42*	Tt0P T0CKI Period			No Prescaler	TCY + 40	—	—	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u>	-	—	ns	N = prescale value (2, 4,, 256)
					N				
45*	Tt1H	T1CKI High Time	Synchronous, F		0.5Tcy + 20	—	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	—	—	ns	
				PIC16 LC 6X	50	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	Prescaler = 1	0.5TCY + 20	—	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	—	—	ns	
				PIC16 LC 6X	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	<u>Greater of:</u> 30 OR <u>TCY + 40</u> N	-	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	<u>Greater of:</u> 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	—	—	ns	
				PIC16 LC 6X	100	-	—	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b			DC	-	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tir	ner increment	2Tosc	—	7Tosc	_	

These parameters are characterized but not tested.

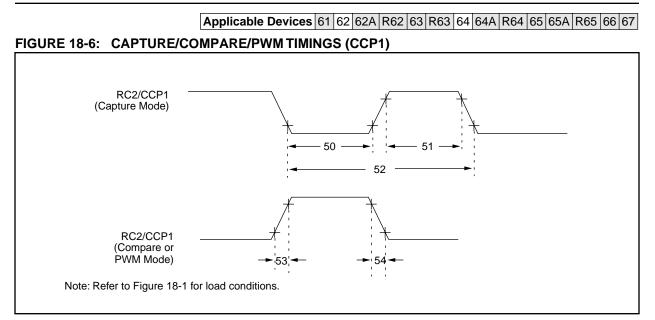


TABLE 18-6 :	CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1)
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Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions	
50*	TccL	CCP1	No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time	With Prescaler	PIC16 C 62/64	10	_	_	ns	
				PIC16 LC 62/64	20		_	ns	
51*	TccH		No Prescaler		0.5Tcy + 20		_	ns	
		input high time	With Prescaler	PIC16 C 62/64	10	_	_	ns	
				PIC16 LC 62/64	20	_	_	ns	
52*	TccP	CCP1 input period			<u>3Tcy + 40</u> N		_	ns	N = prescale value (1,4 or 16)
53	TccR	CCP1 output rise time	9	PIC16 C 62/64	_	10	25	ns	
				PIC16 LC 62/64	_	25	45	ns	
54	TccF	CCP1 output fall time		PIC16 C 62/64	_	10	25	ns	
				PIC16 LC 62/64	_	25	45	ns	

* These parameters are characterized but not tested.

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FIGURE 18-7: PARALLEL SLAVE PORT TIMING (PIC16C64)

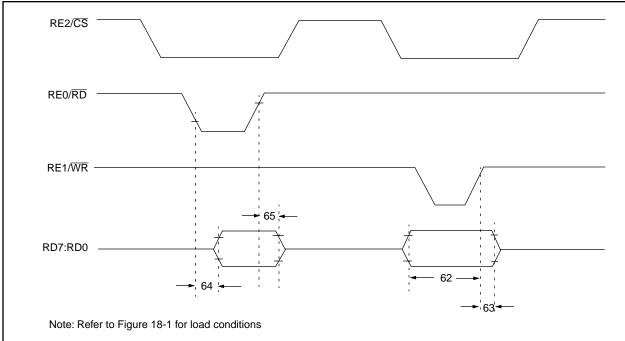


TABLE 18-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C64)

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions	
62	TdtV2wrH	Data in valid before WR↑ or CS	↑ (setup time)	20	_	_	ns	
63*	TwrH2dtl		\overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} to data–in invalid PIC16 C 64				ns	
		(hold time)	PIC16 LC 64	35	—	—	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid	—	—	80	ns		
65	TrdH2dtl	\overline{RD} or \overline{CS} to data-out invalid		10	_	30	ns	

* These parameters are characterized but not tested.

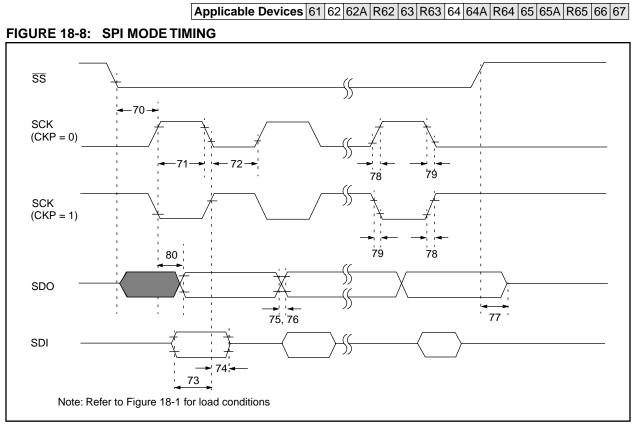
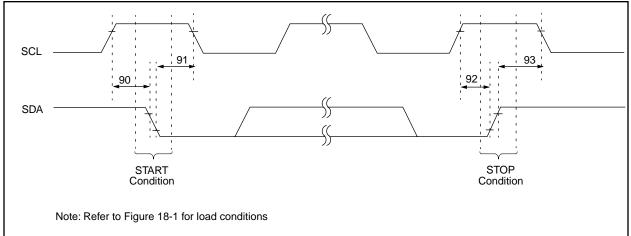


TABLE 18-8:	SPI MODE REQUIREMENTS
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Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK \downarrow or SCK \uparrow input	Тсү	—	_	ns	
71	TscH	SCK input high time (slave mode)	TCY + 20	_		ns	
72	TscL	SCK input low time (slave mode)	TCY + 20	_	_	ns	
73	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	—	_	ns	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	—	_	ns	
75	TdoR	SDO data output rise time	_	10	25	ns	
76	TdoF	SDO data output fall time	_	10	25	ns	
77	TssH2doZ	$\overline{\text{SS}}^{\uparrow}$ to SDO output hi-impedance	10	_	50	ns	
78	TscR	SCK output rise time (master mode)	_	10	25	ns	
79	TscF	SCK output fall time (master mode)	_	10	25	ns	
80	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

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FIGURE 18-9: I²C BUS START/STOP BITS TIMING



IABLE 18-9: IC BUS START/STOP BITS REQUIREMENTS	TABLE 18-9:	I ² C BUS START/STOP BITS REQUIREMENTS
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Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90	TSU:STA	START condition	100 kHz mode	4700	-	-		Only relevant for repeated START
		Setup time	400 kHz mode	600	—	-	ns	condition
91	THD:STA	START condition	100 kHz mode	4000	—	—		After this period the first clock
		Hold time	400 kHz mode	600	—	—	ns	pulse is generated
92	TSU:STO	STOP condition	100 kHz mode	4700	—	—		
		Setup time	400 kHz mode	600	—	—	ns	
93	THD:STO	STOP condition	100 kHz mode	4000	—	—		
		Hold time	400 kHz mode	600	—	—	ns	

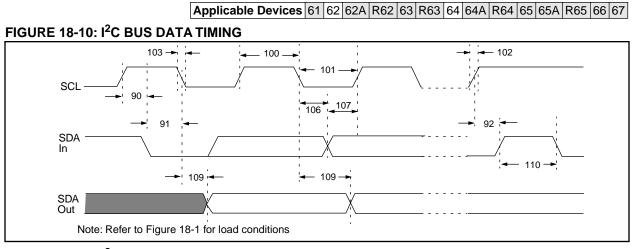


TABLE 18-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100	Тнідн	Clock high time	100 kHz mode	4.0	-	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	0.6	—	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
101	TLOW	Clock low time	100 kHz mode	4.7	—	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	1.3	—	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
102	TR	SDA and SCL rise	100 kHz mode	—	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10 to 400 pF
103	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10 to 400 pF
90	TSU:STA	START condition	100 kHz mode	4.7	—	μs	Only relevant for repeated
		setup time	400 kHz mode	0.6	—	μs	START condition
91	THD:STA	START condition hold	100 kHz mode	4.0	_	μs	After this period the first clock
		time	400 kHz mode	0.6	—	μs	pulse is generated
106	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	—	ns	
92	Tsu:sto	STOP condition setup	100 kHz mode	4.7	—	μs	
		time	400 kHz mode	0.6	—	μs	
109	ΤΑΑ	Output valid from	100 kHz mode	—	3500	ns	Note 1
		clock	400 kHz mode	—	—	ns	
110	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free
			400 kHz mode	1.3		μs	before a new transmission car start
	Cb	Bus capacitive loading		-	400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max. + tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

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NOTES:

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19.0 ELECTRICAL CHARACTERISTICS FOR PIC16C62A/R62/64A/R64

Absolute Maximum Ratings †

•	
Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	
Maximum current into VDD pin	250 mA
Input clamp current, Iк (Vi < 0 or Vi > VDD)	±20 mA
Output clamp current, loк (Vo < 0 or Vo > VDD)	<u>+</u> 20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sunk by PORTC and PORTD (combined)	200 mA
Maximum current sourced by PORTC and PORTD (combined)	200 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD-V	$/OH$) x IOH} + Σ (VOI x IOL)
Note 2: Voltage spikes below V/ss at the \overline{MCLR} pin, inducing currents greater than 80 mA	may cause latch-up. Thus

Note 2: Voltage spikes below Vss at the \overline{MCLR} pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100 Ω should be used when applying a "low" level to the \overline{MCLR} pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 19-1:CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS
AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C62A-04 PIC16CR62-04 PIC16C64A-04 PIC16CR64-04	PIC16C62A-10 PIC16CR62-10 PIC16C64A-10 PIC16CR64-10	PIC16C62A-20 PIC16CR62-20 PIC16C64A-20 PIC16CR64-20	PIC16LC62A-04 PIC16LCR62-04 PIC16LC64A-04 PIC16LCR64-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq:4 MHz max.
ХТ	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 μA max. at 3.0V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.		VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

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19.1 DC Characteristics: PIC16C62A/R62/64A/R64-04 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-10 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-20 (Commercial, Industrial, Extended)

		Standar	d Ope	rating	Condi	tions (I	unless otherwise stated)				
	RACTERISTICS	Operatir	ng temp	erature			$\leq TA \leq +125^{\circ}C$ for extended,				
		-40° C \leq TA \leq +85°C for industrial and									
		$0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial									
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions				
D001 D001A	Supply Voltage	Vdd	4.0 4.5		6.0 5.5	> >	XT, RC and LP osc configuration HS osc configuration				
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V					
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details				
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details				
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN bit in configuration word enabled				
			3.7	4.0	4.4	V	Extended Range Only				
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC, osc configuration FOSC = 4 MHz, VDD = $5.5V$ (Note 4)				
D013			-	10	20	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V				
D015*	Brown-out Reset Current (Note 6)	Δ Ibor	-	350	425	μA	BOR enabled, VDD = 5.0V				
D020	Power-down Current	IPD	-	10.5	42	μA	VDD = 4.0V, WDT enabled, -40°C to +85°C				
D021	(Note 3, 5)		-	1.5	16	μA	VDD = $4.0V$, WDT disabled, $-0^{\circ}C$ to $+70^{\circ}C$				
D021A			-	1.5	19	μA	VDD = $4.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$				
D021B			-	2.5	19	μA	VDD = $4.0V$, WDT disabled, $-40^{\circ}C$ to $+125^{\circ}C$				
D023*	Brown-out Reset Current (Note 6)	Δ Ibor	-	350	425	μA	BOR enabled, VDD = 5.0V				

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

 $\overline{MCLR} = VDD$; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

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19.2 DC Characteristics: PIC16LC62A/R62/64A/R64-04 (Commercial, Industrial)

		Standa	rd Ope	rating	Condi	tions (u	Inless otherwise stated)			
DC CHA	RACTERISTICS	Operating temperature $-40^{\circ}C \leq T_{A} \leq +85^{\circ}C$ for industrial and								
	1				0°C	≤ ≤	$TA \le +70^{\circ}C$ for commercial			
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions			
D001	Supply Voltage	Vdd	2.5	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)			
D002*	RAM Data Retention Volt- age (Note 1)	Vdr	-	1.5	-	V				
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details			
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details			
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN bit in configuration word enabled			
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 3.0V (Note 4)			
D010A			-	22.5	48	μA	LP osc configuration Fosc = 32 kHz, VDD = 3.0V, WDT disabled			
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μΑ	BOR enabled, VDD = 5.0V			
D020	Power-down Current	IPD	-	7.5	30	μA	VDD = $3.0V$, WDT enabled, $-40^{\circ}C$ to $+85^{\circ}C$			
D021	(Note 3, 5)		-	0.9	5	μA	VDD = $3.0V$, WDT disabled, $0^{\circ}C$ to $+70^{\circ}C$			
D021A			-	0.9	5	μA	VDD = 3.0V, WDT disabled, -40°C to +85°C			
D023*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, VDD = 5.0V			

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

 The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption. The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

 $\overline{MCLR} = VDD; WDT enabled/disabled as specified.$

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

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19.3 DC Characteristics: PIC16C62A/R62/64A/R64-04 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-10 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-20 (Commercial, Industrial, Extended) PIC16LC62A/R62/64A/R64-04 (Commercial, Industrial)

DC CH4		$\begin{array}{lll} \hline \textbf{Standard Operating Conditions (unless otherwise stated)} \\ Operating temperature & -40 ^{\circ}\text{C} & \leq \text{TA} \leq +125 ^{\circ}\text{C} \text{ for extended}, \\ & -40 ^{\circ}\text{C} & \leq \text{TA} \leq +85 ^{\circ}\text{C} \text{ for industrial and} \\ & 0 ^{\circ}\text{C} & \leq \text{TA} \leq +70 ^{\circ}\text{C} \text{ for commercial} \\ \hline \textbf{Operating voltage VDD range as described in DC spec Section 19.1 and} \\ \textbf{Section 19.2} \end{array}$						
Param No.	Characteristic	Sym	Min	Тур †	Max	Units	Conditions	
	Input Low Voltage							
	I/O ports	VIL						
D030	with TTL buffer		Vss	-	0.15Vdd	V	For entire VDD range	
D030A			Vss	-	0.8V	V	$4.5V \le VDD \le 5.5V$	
D031	with Schmitt Trigger buffer		Vss	-	0.2Vdd	V		
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2Vdd	V		
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1	
	Input High Voltage							
	I/O ports	VIH		-				
D040	with TTL buffer		2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$	
D040A			0.25VDD + 0.8V	-	Vdd	V	For entire VDD range	
D041	with Schmitt Trigger buffer		0.8VDD	-	Vdd	V	For entire VDD range	
D042	MCLR		0.8VDD	-	Vdd	V	Ŭ	
D042A	OSC1 (XT, HS and LP)		0.7VDD	-	Vdd	V	Note1	
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V		
D070	PORTB weak pull-up current	I PURB	50	250	400	μA	VDD = 5V, VPIN = VSS	
	Input Leakage Current (Notes 2, 3)							
D060	I/O ports	lı∟	-	-	±1	μA	Vss \leq VPIN \leq VDD, Pin at hi-impedance	
D061	MCLR, RA4/T0CKI		-	-	±5	μA	$Vss \leq VPIN \leq VDD$	
D063	OSC1		-	-	±5	μΑ	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration	
	Output Low Voltage						-	
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C	
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C	
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C	
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C	

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

Standard Operating Conditions (unless otherwise stated) -40°C Operating temperature \leq TA \leq +125°C for extended. -40°C \leq TA \leq +85°C for industrial and **DC CHARACTERISTICS** 0°C \leq TA \leq +70°C for commercial Operating voltage VDD range as described in DC spec Section 19.1 and Section 19.2 Param Characteristic Sym Min Max Units Conditions Тур No. t **Output High Voltage** I/O ports (Note 3) IOH = -3.0 mA, VDD = 4.5 V,D090 νон VDD-0.7 -V -40°C to +85°C D090A VDD-0.7 V IOH = -2.5 mA, VDD = 4.5 V,---40°C to +125°C D092 OSC2/CLKOUT (RC osc config) IOH = -1.3 mA. VDD = 4.5V. VDD-0.7 V -_ -40°C to +85°C D092A VDD-0.7 -V IOH = -1.0 mA, VDD = 4.5 V,-40°C to +125°C D150* **Open-Drain High Voltage** Vod 14 RA4 pin V --Capacitive Loading Specs on Output Pins D100 OSC2 pin Cosc₂ -15 pF In XT, HS and LP modes when external clock is used to drive OSC1. All I/O pins and OSC2 (in RC mode) CIO D101 -50 pF D102 Cb 400 pF SCL, SDA in I²C mode

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These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

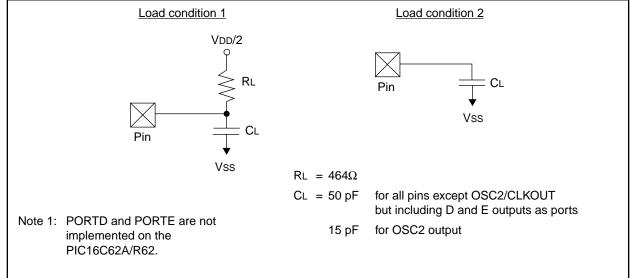
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19.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

0	, ,		-
1. TppS2p	PS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
т			
F	Frequency	Т	Time
Lowerca	se letters (pp) and their meanings:	l	
рр			
CC	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
CS	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	ss	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperca	se letters and their meanings:		
S			
F	Fall	P	Period
Н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st (I ² C specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 19-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



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19.5 <u>Timing Diagrams and Specifications</u>

FIGURE 19-2: EXTERNAL CLOCK TIMING

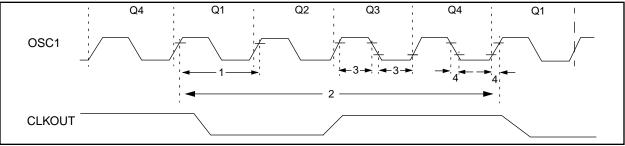


TABLE 19-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
	Fosc	External CLKIN Frequency					
		(Note 1)	DC	—	4	MHz	XT and RC osc mode
			DC	—	4	MHz	HS osc mode (-04)
			DC	—	10	MHz	HS osc mode (-10)
			DC	—	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	—	ns	XT and RC osc mode
		(Note 1)	250	_	—	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μs	LP osc mode
		Oscillator Period	250	_	—	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	100	_	—	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μs	LP oscillator
			15	—	_	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
				_	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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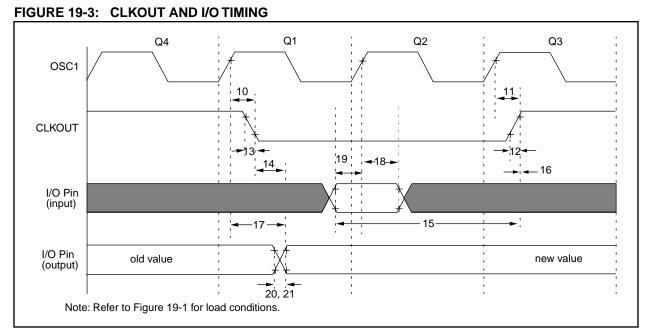


TABLE 19-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameters	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		—	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid		_	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑		0	_	_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid		_	50	150	ns	
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port input invalid (I/O in hold time)	PIC16 C 62A/ R62/64A/R64	100	_	—	ns	
			PIC16 LC 62A/ R62/64A/R64	200			ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in	setup time)	0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 62A/ R62/64A/R64	-	10	40	ns	
			PIC16 LC 62A/ R62/64A/R64	_	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 62A/ R62/64A/R64	_	10	40	ns	
				-	_	80	ns	
22††*	Tinp	RB0/INT pin high or low time		Тсү	_	—	ns	
23††*	Trbp	RB7:RB4 change int high or low	time	Тсү	_	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

tt These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

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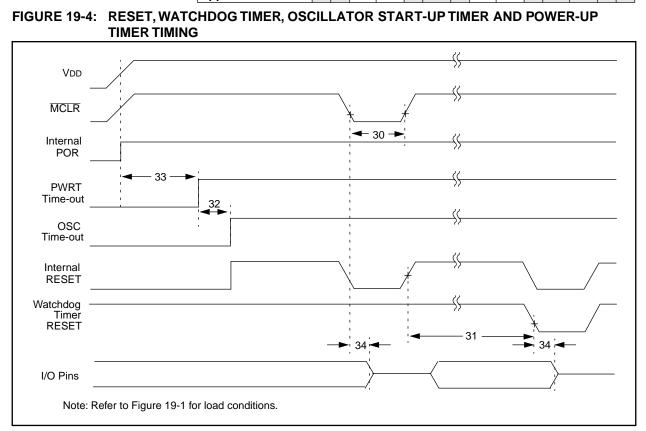


FIGURE 19-5: BROWN-OUT RESET TIMING

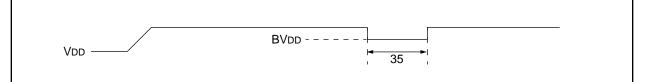


TABLE 19-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	—	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	—	1024Tosc		_	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT Reset	_	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	—	_	μs	$VDD \le BVDD$ (param. D005)

* These parameters are characterized but not tested.

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FIGURE 19-6: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

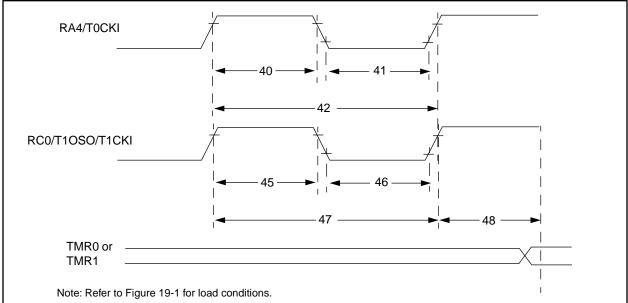


TABLE 19-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5TCY + 20	_	_	ns	Must also meet
				With Prescaler	10	-	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	T0CKI Low Pulse Width		0.5TCY + 20	—	_	ns	Must also meet
				With Prescaler	10	—	—	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	TCY + 40	—	—	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	-	—	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F	Prescaler = 1	0.5TCY + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	-	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	-	—	ns	
				PIC16 LC 6X	50	_	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	Prescaler = 1	0.5TCY + 20	-	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	—	—	ns	
				PIC16 LC 6X	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	<u>Greater of:</u> 30 OR <u>TCY + 40</u> N	-	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	<u>Greater of:</u> 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	-	_	ns	
				PIC16 LC 6X	100	-	—	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b		0	DC	-	200	kHz	
48	TCKEZtmr	1 Delay from external	clock edge to tir	ner increment	2Tosc	_	7Tosc	_	

* These parameters are characterized but not tested.

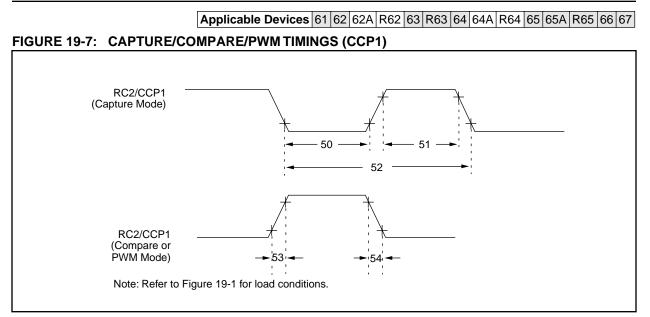


TABLE 19-6: CA	PTURE/COMPARE/PWM REQUIREMENTS (CCP1)
----------------	---------------------------------------

Parameter No.	Sym	Characteristic			Min	Тур†	Мах	Units	Conditions
50*	TccL	CCP1 input low time	No Prescaler	No Prescaler		_	_	ns	
			With Prescaler	PIC16 C 62A/R62/ 64A/R64	10	-	-	ns	
				PIC16 LC 62A/R62/ 64A/R64	20	-	_	ns	
51*	TccH	CCP1	No Prescaler		0.5Tcy + 20	-		ns	
		input high time With Prescale	PIC16 C 62A/R62/ 64A/R64	10	-	-	ns		
					PIC16 LC 62A/R62/ 64A/R64	20	-	-	ns
52*	TccP	CCP1 input period	3		<u>3Tcy + 40</u> N	-	-	ns	N = prescale valu (1,4 or 16)
53*	TccR	64A/R64		PIC16 C 62A/R62/ 64A/R64	—	10	25	ns	
				PIC16 LC 62A/R62/ 64A/R64		25	45	ns	
54*	54* TccF CCP1 output fall time		ime	PIC16 C 62A/R62/ 64A/R64	_	10	25	ns	
				PIC16 LC 62A/R62/ 64A/R64	—	25	45	ns	

These parameters are characterized but not tested.

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FIGURE 19-8: PARALLEL SLAVE PORT TIMING (PIC16C64A/R64)

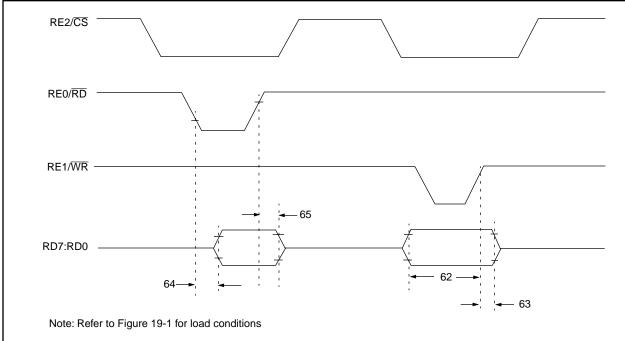


TABLE 19-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C64A/R64)

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before \overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} (setup time)		20	_	—	ns	
				25	_	_	ns	Extended Range Only
63*	TwrH2dtl	\overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} to data–in invalid (hold	PIC16 C 64A/R64	20	—	—	ns	
		time)	PIC16 LC 64A/R64	35	—	_	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid				80	ns	
				—	_	90	ns	Extended Range Only
65*	TrdH2dtl	\overline{RD}^{\uparrow} or \overline{CS}^{\uparrow} to data–out invalid		10	—	30	ns	

* These parameters are characterized but not tested.

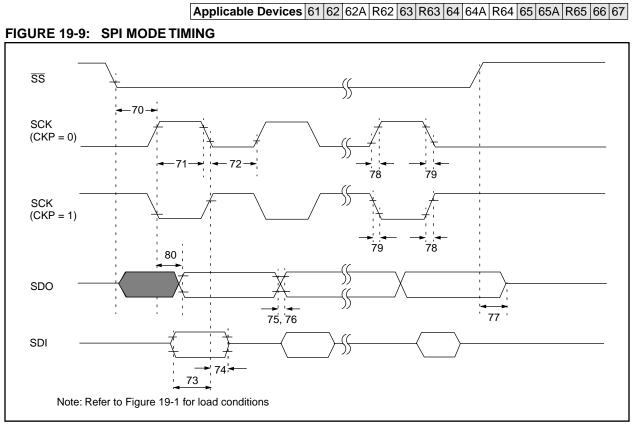


TABLE 19-8:	SPI MODE REQUIREMENTS
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Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	\overline{SS} ↓ to SCK↓ or SCK↑ input	Тсү			ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	—	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	_		ns	
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	_		ns	
75*	TdoR	SDO data output rise time		10	25	ns	
76*	TdoF	SDO data output fall time		10	25	ns	
77*	TssH2doZ	$\overline{\text{SS}}^{\uparrow}$ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)		10	25	ns	
79*	TscF	SCK output fall time (master mode)		10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

* These parameters are characterized but not tested.

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FIGURE 19-10: I²C BUS START/STOP BITS TIMING

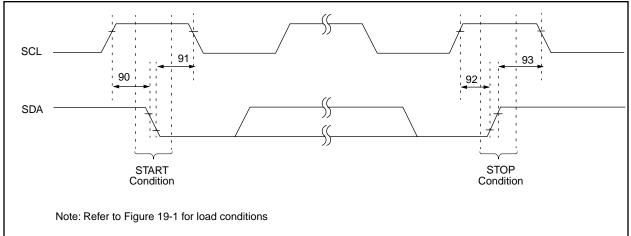


TABLE 13-3. I C DUS START/STOP DITS REQUIREMENTS	TABLE 19-9:	I ² C BUS START/STOP BITS REQUIREMENTS
--	-------------	---

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90*	TSU:STA	START condition	100 kHz mode	4700	—	—	ns	Only relevant for repeated START condition
		Setup time	400 kHz mode	600	—	—	113	
91*	THD:STA	START condition	100 kHz mode	4000	—	—	ns	After this period the first clock pulse is generated
		Hold time	400 kHz mode	600	—	—	115	
92*	Tsu:sto	STOP condition	100 kHz mode	4700	—	—	ns	
		Setup time	400 kHz mode	600	—	—	115	
93*	THD:STO	STOP condition	100 kHz mode	4000	—	—	ns	
		Hold time	400 kHz mode	600	—	—	115	

*These parameters are characterized but not tested.

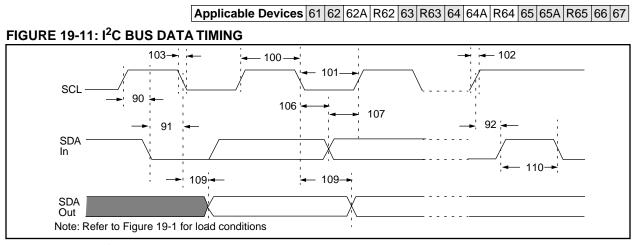


TABLE 19-10: I²C BUS DATA REQUIREMENTS

Parameter Sym No.		Characteristic	Min	Max	Units	Conditions	
100*	Тнідн	Clock high time	100 kHz mode	4.0	-	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	0.6	_	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
101*	TLOW	Clock low time	100 kHz mode	4.7	-	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	1.3	-	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
102*	Tr	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	TSU:STA	START condition	100 kHz mode	4.7	-	μs	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μs	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	—	μs	After this period the first clock
		time	400 kHz mode	0.6	—	μs	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	—	ns	
92*	TSU:STO	STOP condition setup	100 kHz mode	4.7	—	μs	
		time	400 kHz mode	0.6	—	μs	
109*	ΤΑΑ	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode		-	ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free
			400 kHz mode	1.3	_	μs	before a new transmission can start
	Cb	Bus capacitive loading		_	400	pF	

These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

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NOTES:

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20.0 ELECTRICAL CHARACTERISTICS FOR PIC16C65

Absolute Maximum Ratings †

J. J	
Ambient temperature under bias Storage temperature	55°C to +85°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	
Maximum current into VDD pin	250 mA
Input clamp current, Iik (VI < 0 or VI > VDD)	±20 mA
Output clamp current, Iok (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined)	
Maximum current sourced by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sunk by PORTC and PORTD (combined)	200 mA
Maximum current sourced by PORTC and PORTD (combined)	200 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - Σ IOH} + Σ {(VDD-	-Vон) x Iон} + Σ (Vol x Iol)
Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 m/	A. may cause latch-up. Thus.

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 20-1:CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS
AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

OSC	PIC16C65-04	PIC16C65-10	PIC16C65-20	PIC16LC65-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3V IPD: 800 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 μA max. at 4V Freq: 4 MHz max.
ХТ	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3V IPD: 800 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 15 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V
	IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.	IPD 1.0 μA typ. at 4.5V Freq: 10 MHz max.	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.		IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 105 μA max. at 32 kHz, 3.0V IPD: 800 μA max. at 3.0V Freq: 200 kHz max.	VDD: 3.0V to 6.0V IDD: 105 μA max. at 32 kHz, 3.0V IPD: 800 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

20.1

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DC Characteristics: PIC16C65-04 (Commercial, Industrial) PIC16C65-10 (Commercial, Industrial) PIC16C65-20 (Commercial, Industrial)

		Standa	rd Ope	rating		•	unless otherwise stated)		
DC CHA	RACTERISTICS	Operating temperature -40° C \leq TA \leq +85°C for industrial and							
	1	$0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial							
Param No.	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions		
D001 D001A	Supply Voltage	Vdd	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration		
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V			
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details		
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details		
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 5.5V (Note 4)		
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V		
D020 D021 D021A	Power-down Current (Note 3, 5)	IPD	- - -	10.5 1.5 1.5	800 800 800	μΑ μΑ μΑ	VDD = 4.0V, WDT enabled, -40°C to +85°C VDD = 4.0V, WDT disabled, -0°C to +70°C VDD = 4.0V, WDT disabled, -40°C to +85°C		

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD, \overline{MCLR} = VDD; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

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20.2 DC Characteristics: PIC16LC65-04 (Commercial, Industrial)

		Standar	d Ope	rating (•	inless otherwise stated)
DC CH	ARACTERISTICS	Operatir	ng temp	perature	9 -40 0°C	-	$TA \le +85^{\circ}C$ for industrial and
		•		-			$TA \leq +70^{\circ}C$ for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001	Supply Voltage	Vdd	3.0	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	105	μA	LP osc configuration Fosc = 32 kHz, VDD = $4.0V$, WDT disabled
D020	Power-down Current	IPD	-	7.5	800	μA	VDD = $3.0V$, WDT enabled, $-40^{\circ}C$ to $+85^{\circ}C$
D021	(Note 3, 5)		-	0.9	800	μA	VDD = $3.0V$, WDT disabled, $0^{\circ}C$ to $+70^{\circ}C$
D021A			-	0.9	800	μA	VDD = $3.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

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20.3 DC Characteristics: PIC16C65-04 (Commercial, Industrial) PIC16C65-10 (Commercial, Industrial) PIC16C65-20 (Commercial, Industrial) PIC16LC65-04 (Commercial, Industrial)

DC CHA	RACTERISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ for industrial and $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ for commercialOperating voltage VDD range as described in DC spec Section 20.1Section 20.2								
Param No.	Characteristic	Sym	Min	Тур †	Max	Units	Conditions			
	Input Low Voltage									
	I/O ports	VIL								
D030	with TTL buffer		Vss	-	0.15Vdd	V	For entire VDD range			
D030A			Vss	-	0.8V	V	$4.5V \le VDD \le 5.5V$			
D031	with Schmitt Trigger buffer		Vss	-	0.2Vdd	V				
D032	MCLR, OSC1(in RC mode)		Vss	-	0.2Vdd	V				
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1			
	Input High Voltage									
	I/O ports	VIH		-						
D040	with TTL buffer		2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$			
D040A			0.25VDD + 0.8V	-	Vdd	V	For entire VDD range			
D041	with Schmitt Trigger buffer		0.8Vdd	-	Vdd		For entire VDD range			
D042	MCLR		0.8Vdd	-	Vdd	V				
D042A	OSC1 (XT, HS and LP)		0.7 VDD	-	Vdd	V	Note1			
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V				
D070	PORTB weak pull-up current	IPURB	50	250	400	μA	VDD = 5V, VPIN = VSS			
	Input Leakage Current (Notes 2, 3)									
D060	I/O ports	lı∟	-	-	±1	μA	Vss \leq VPIN \leq VDD, Pin at hi- impedance			
D061	MCLR, RA4/T0CKI		-	-	±5	μA	$Vss \leq VPIN \leq VDD$			
D063	OSC1		-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS, and LP osc configuration			
	Output Low Voltage									
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C			
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C			
	Output High Voltage									
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°С to +85°С			
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C			
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin			

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

3: Negative current is defined as current sourced by the pin.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

DC CHA	RACTERISTICS	Standar Operatir	r d Operati ng tempera	ng C ature	onditions -40°C 0°C	s (unle : ; ≤ T ≤ T	ss otherwise stated) $A \le +85^{\circ}C$ for industrial and $A \le +70^{\circ}C$ for commercial	
Operating voltage VDD range as described in DC spec Section 2 Section 20.2								
Param	Characteristic Sym Min Typ Max Units Conditions							
No.				†				
	Capacitive Loading Specs on Output Pins							
D100	OSC2 pin	Cosc2	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.	
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF		
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF		
* T	hese parameters are characterized by	it not to	stad					

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These parameters are characterized but not tested.

t Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

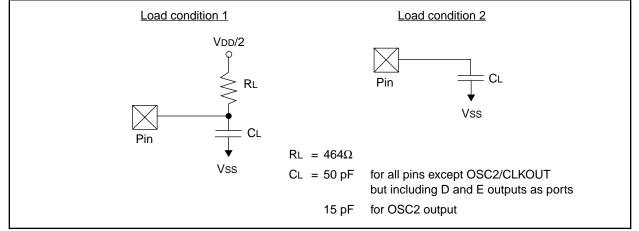
 Applicable Devices
 61
 62
 62A
 R62
 63
 R63
 64
 64A
 R64
 65
 65A
 R65
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 67

20.4 Timing Parameter Symbology

The timing parameter symbols have been created following one of the following formats:

01	, ,	0	0
1. TppS2pp	oS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
т			
F	Frequency	Т	Time
Lowerca	se letters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
CS	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	ss	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperca	se letters and their meanings:		
S			
F	Fall	P	Period
Н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st (I ² C specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		





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20.5 Timing Diagrams and Specifications

FIGURE 20-2: EXTERNAL CLOCK TIMING

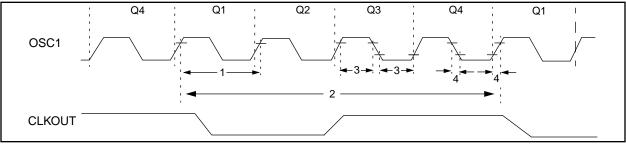


TABLE 20-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	—	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	—	ns	HS osc mode (-20)
			5	_	—	μs	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	_	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	50	_	—	ns	XT oscillator
	TosH	Low Time	2.5	_	—	μs	LP oscillator
			15	_	—	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
				_	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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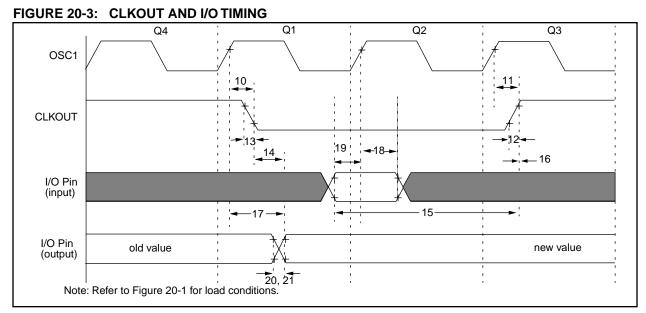


TABLE 20-3: **CLKOUT AND I/O TIMING REQUIREMENTS**

Parameter No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
10*	TosH2ckL	OSC1 [↑] to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑	_	75	200	ns	Note 1	
12*	TckR	CLKOUT rise time	CLKOUT rise time			100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT \downarrow to Port out valid		_		0.5TCY + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		0.25Tcy + 25		_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT 1	ort in hold after CLKOUT ↑			_	ns	Note 1
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port out	OSC1↑ (Q1 cycle) to Port out valid		50	150	ns	
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port	PIC16 C 65	100	_		ns	
		input invalid (I/O in hold time)	PIC16 LC 65	200	_		ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O	in setup time)	0	_		ns	
20*	TioR	Port output rise time	PIC16 C 65	_	10	25	ns	
			PIC16 LC 65	_	_	60	ns	
21*	TioF	Port output fall time	PIC16 C 65	_	10	25	ns	
			PIC16 LC 65	_		60	ns	
22††*	Tinp	RB0/INT pin high or low time		Тсү	_	—	ns	
23††*	Trbp	RB7:RB4 change int high or lo	B7:RB4 change int high or low time			_	ns	

These parameters are characterized but not tested. t

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

t These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

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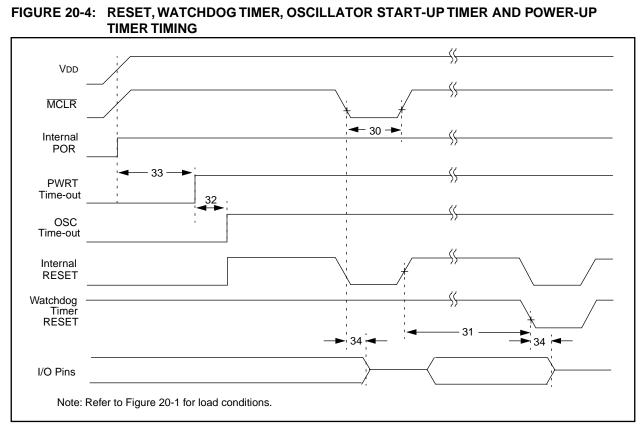


TABLE 20-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP
TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30*	TmcL	MCLR Pulse Width (low)	100	_	—	ns	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	—	—	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period or WDT reset	28	72	132	ms	VDD = 5V, -40°C to +85°C
34	Tıoz	I/O Hi-impedance from MCLR Low	—	_	100	ns	

These parameters are characterized but not tested.

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FIGURE 20-5: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

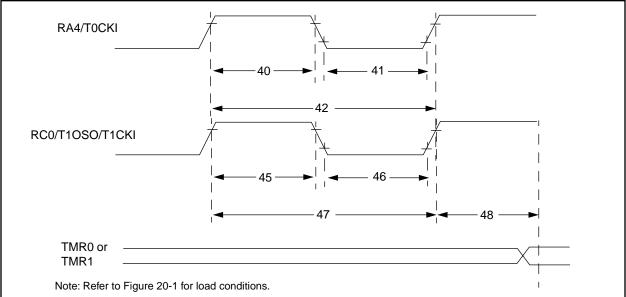


TABLE 20-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	-	—	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	-	—	ns	Must also meet
				With Prescaler	10	-	—	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	—	—	ns	
		V		With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	-	—	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F	Prescaler = 1	0.5Tcy + 20	-	_	ns	Must also meet
		U U	Synchronous,	PIC16 C 6X	15	-	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	-	—	ns	
				PIC16 LC 6X	50	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F		0.5TCY + 20	-	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	_	ns	
			Asynchronous	PIC16 C 6X	30	—	—	ns	
				PIC16 LC 6X	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	<u>Greater of:</u> 30 OR <u>TCY + 40</u> N	-	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	<u>Greater of:</u> 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	-	—	ns	
				PIC16 LC 6X	100	—	—	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b		0	DC	-	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tir	ner increment	2Tosc	—	7Tosc	—	

* These parameters are characterized but not tested.

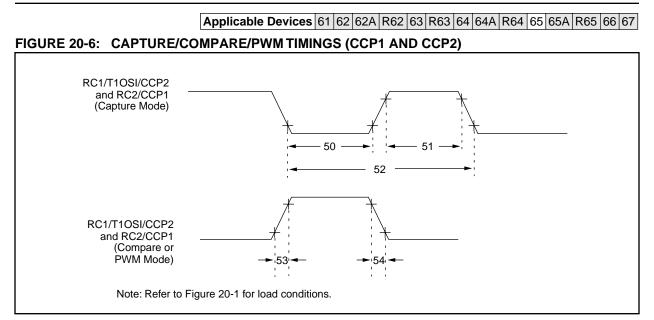


TABLE 20-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic	aracteristic		Min	Тур†	Мах	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	—	_	ns	
		input low time	With Prescaler	PIC16 C 65	10	—		ns	
				PIC16 LC 65	20	—		ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	—		ns	
		input high time	With Prescaler	PIC16 C 65	10	—		ns	
				PIC16 LC 65	20	—		ns	
52*	TccP	CCP1 and CCP2 ir	nput period		<u>3Tcy + 40</u> N	-	1	ns	N = prescale value (1,4, or 16)
53	TccR	CCP1 and CCP2 c	output rise time	PIC16 C 65	_	10	25	ns	
				PIC16 LC 65	—	25	45	ns	
54	TccF	CCP1 and CCP2 c	P1 and CCP2 output fall time		—	10	25	ns	
				PIC16 LC 65	_	25	45	ns	

* These parameters are characterized but not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 20-7: PARALLEL SLAVE PORT TIMING

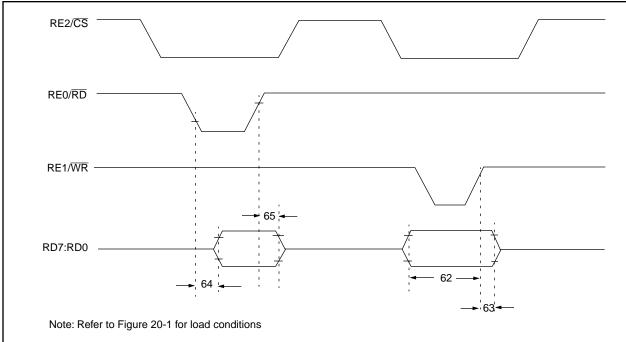


TABLE 20-7:PARALLEL SLAVE PORT REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before \overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} (setup time)		20	_	_	ns	
63*	TwrH2dtl	\overline{WR} or \overline{CS} to data–in invalid (hold	PIC16 C 65	20	_	_	ns	
		time)	PIC16 LC 65	35		_	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid		—	_	80	ns	
65	TrdH2dtl	\overline{RD} or \overline{CS} to data-out invalid		10	_	30	ns	

* These parameters are characterized but not tested.

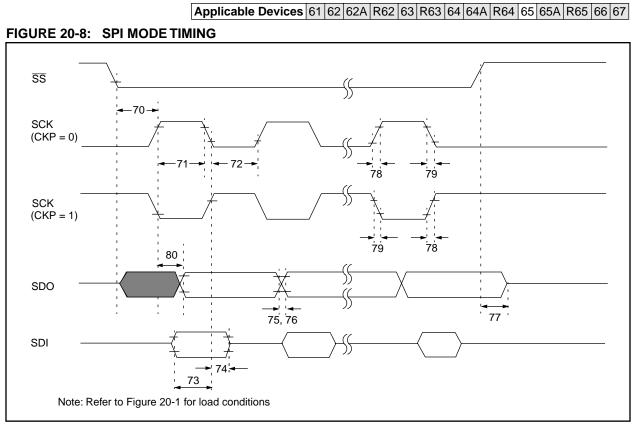


TABLE 20-8:	SPI MODE REQUIREMENTS
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Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK \downarrow or SCK \uparrow input	Тсү	—	_	ns	
71	TscH	SCK input high time (slave mode)	TCY + 20	_		ns	
72	TscL	SCK input low time (slave mode)	TCY + 20	_	_	ns	
73	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	—	_	ns	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	—	_	ns	
75	TdoR	SDO data output rise time	_	10	25	ns	
76	TdoF	SDO data output fall time	_	10	25	ns	
77	TssH2doZ	$\overline{\text{SS}}^{\uparrow}$ to SDO output hi-impedance	10	_	50	ns	
78	TscR	SCK output rise time (master mode)	_	10	25	ns	
79	TscF	SCK output fall time (master mode)	_	10	25	ns	
80	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

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FIGURE 20-9: I²C BUS START/STOP BITS TIMING

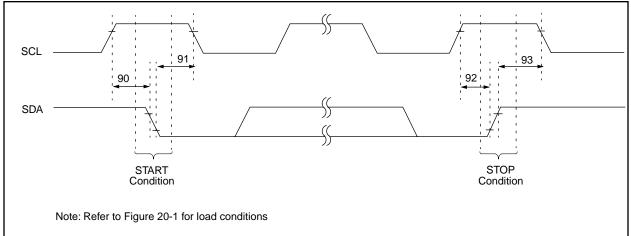
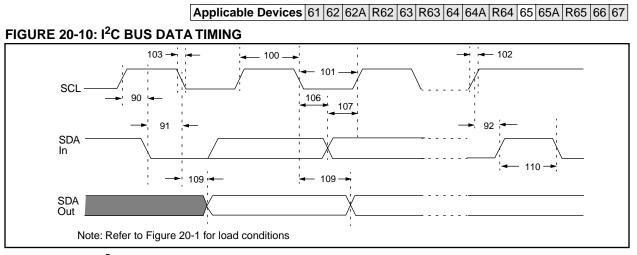


TABLE 20-9: IC BUS START/STUP BITS REQUIREMENTS	TABLE 20-9:	I ² C BUS START/STOP BITS REQUIREMENTS
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Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90	TSU:STA	START condition	100 kHz mode	4700	—	-	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	—	—	115	condition
91	THD:STA	START condition	100 kHz mode	4000	—	—	ns	After this period the first clock
		Hold time	400 kHz mode	600	—	—	115	pulse is generated
92	TSU:STO	STOP condition	100 kHz mode	4700	—	—	ns	
		Setup time	400 kHz mode	600	—	—	115	
93	THD:STO	STOP condition	100 kHz mode	4000	—	—	ns	
		Hold time	400 kHz mode	600	—	—	115	



Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions	
100	Thigh	Clock high time	100 kHz mode	4.0	-	μs	Device must operate at a mir imum of 1.5 MHz	
			400 kHz mode	0.6	-	μs	Devce must operate at a mini- mum of 10 MHz	
			SSP Module	1.5TCY	-			
101	TLOW	Clock low time	100 kHz mode	4.7	-	μs	Device must operate at a min- imum of 1.5 MHz	
			400 kHz mode	1.3	-	μs	Device must operate at a min- imum of 10 MHz	
			SSP Module	1.5TCY	-			
102	Tr	SDA and SCL rise	100 kHz mode	_	1000	ns		
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF	
103	TF	SDA and SCL fall time	100 kHz mode	—	300	ns		
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF	
90	TSU:STA	START condition	100 kHz mode	4.7	-	μs	Only relevant for repeated	
		setup time	400 kHz mode	0.6	-	μs	START condition	
91	THD:STA	START condition hold	100 kHz mode	4.0	-	μs	After this period the first clock	
		time	400 kHz mode	0.6	-	μs	pulse is generated	
106	THD:DAT	Data input hold time	100 kHz mode	0	-	ns		
			400 kHz mode	0	0.9	μs		
107	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2	
			400 kHz mode	100	—	ns		
92	TSU:STO	STOP condition setup	100 kHz mode	4.7	-	μs		
		time	400 kHz mode	0.6	-	μs		
109	ΤΑΑ	Output valid from	100 kHz mode	—	3500	ns	Note 1	
		clock	400 kHz mode	—	—	ns		
110	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free	
			400 kHz mode	1.3	_	μs	before a new transmission can start	
	Cb	Bus capacitive loading		-	400	pF		

TABLE 20-10: I²C BUS DATA REQUIREMENTS

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

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FIGURE 20-11: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

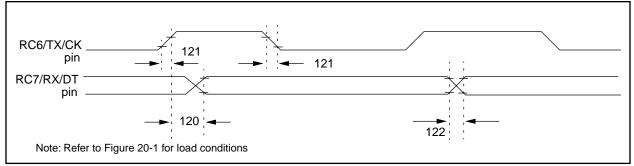


TABLE 20-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
120	TckH2dtV	<u></u>		_	—	80	ns	
		Clock high to data out valid	PIC16 LC 65	—	—	100	ns	
121 Tckrf Clock out rise time and fall time		PIC16 C 65	—	—	45	ns		
	(Master Mode)		PIC16 LC 65	—	—	50	ns	
122	122 Tdtrf Data out rise time and fall time		PIC16 C 65	—	—	45	ns	
			PIC16 LC 65	—	—	50	ns	

†: Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-12: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

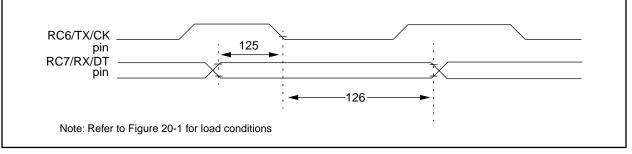


TABLE 20-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
125	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK \downarrow (DT setup time)	15	_	_	ns	
126	TckL2dtl	Data hold after CK \downarrow (DT hold time)	15	_		ns	

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21.0 ELECTRICAL CHARACTERISTICS FOR PIC16C63/65A

Absolute Maximum Ratings (†)

Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	
Maximum current into Vod pin	250 mA
Input clamp current, Iк (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loк (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sunk by PORTC and PORTD (Note 3) (combined)	200 mA
Maximum current sourced by PORTC and PORTD (Note 3) (combined)	200 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD-V	OH) x IOH} + Σ (VOI x IOL)

Note 2: Voltage spikes below Vss at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP pin rather than pulling this pin directly to Vss.

Note 3: PORTD and PORTE not available on the PIC16C63.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 21-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C63-04 PIC16C65A-04	PIC16C63-10 PIC16C65A-10	PIC16C63-20 PIC16C65A-20	PIC16LC63-04 PIC16LC65A-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
ХТ	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V
	IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.	IPD 1.5 μA typ. at 4.5V Freq: 10 MHz max.	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.		IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

21.1

*

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DC Characteristics: PIC16C63/65A-04 (Commercial, Industrial, Extended) PIC16C63/65A-10 (Commercial, Industrial, Extended) PIC16C63/65A-20 (Commercial, Industrial, Extended)

		Standa	d Ope	rating	Condi	tions (unless otherwise stated)
DC CH/	ARACTERISTICS	Operatir	ng temp	erature			≤ TA ≤ +125°C for extended, ≤ TA ≤ +85°C for industrial and
					-40 0°0		$\leq TA \leq +85$ C for industrial and $\leq TA \leq +70$ °C for commercial
Param No.	Characteristic	Sym	Min	Тур†		Units	
D001 D001A	Supply Voltage	Vdd	4.0 4.5		6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled
			3.7	4.0	4.4	V	Extended Range Only
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC, osc config Fosc = 4 MHz, VDD = 5.5V (Note 4)
D013			-	10	20	mA	HS osc config Fosc = 20 MHz, VDD = 5.5V
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA	BOR enabled, VDD = 5.0V
D020 D021 D021A D021B	Power-down Current (Note 3, 5)	IPD	- - -	10.5 1.5 1.5 2.5	42 16 19 19	μΑ μΑ μΑ μΑ	VDD = 4.0V, WDT enabled, -40°C to +85°C VDD = 4.0V, WDT disabled, -0°C to +70°C VDD = 4.0V, WDT disabled, -40°C to +85°C VDD = 4.0V, WDT disabled, -40°C to +125°C
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA	BOR enabled, VDD = 5.0V

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

 $\overline{\text{MCLR}}$ = VDD; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

DC CHA		Standaı Operatir	-	-		°C ≤	Inless otherwise stated) TA \leq +85°C for industrial and TA \leq +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001	Supply Voltage	Vdd	2.5	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	Svdd	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μA	LP osc configuration Fosc = 32 kHz, VDD = 3.0V, WDT disabled
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, $VDD = 5.0V$
D020	Power-down Current	IPD	-	7.5	30	μA	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021	(Note 3, 5)		-	0.9	5	μA	VDD = $3.0V$, WDT disabled, $0^{\circ}C$ to $+70^{\circ}C$
D021A			-	0.9	5	μA	VDD = $3.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$
D023*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, VDD = 5.0V

21.2 DC Characteristics: PIC16LC63/65A-04 (Commercial, Industrial)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

 \overline{MCLR} = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

21.3 DC Characteristics: PIC16C63/65A-04 (Commercial, Industrial, Extended) PIC16C63/65A-10 (Commercial, Industrial, Extended) PIC16C63/65A-20 (Commercial, Industrial, Extended) PIC16LC63/65A-04 (Commercial, Industrial)

			rd Operat				ss otherwise stated) $A \le +125^{\circ}C$ for extended,			
		Operation	ig temper	ature	-40°C		$A \le +85^{\circ}C$ for industrial and			
DC CHA	RACTERISTICS				-40 C 0°C		$A \le +70^{\circ}C$ for commercial			
		Onerati	na voltane	Voo						
		Operating voltage VDD range as described in DC spec Section 21.1 and Section 21.2								
Param	Characteristic	Sym	Min	Тур	Мах	Units	Conditions			
No.		• • • • •		†	mux	•				
	Input Low Voltage									
	I/O ports	VIL								
D030	with TTL buffer		Vss	-	0.15Vdd	V	For entire VDD range			
D030A			Vss	-	0.8V	V	$4.5V \leq VDD \leq 5.5V$			
D031	with Schmitt Trigger buffer		Vss	-	0.2Vdd	V				
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2Vdd	V				
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1			
	Input High Voltage									
	I/O ports	Viн		-						
D040	with TTL buffer		2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$			
D040A			0.25VDD	-	Vdd	V	For entire VDD range			
			+ 0.8V				Ŭ			
D041	with Schmitt Trigger buffer		0.8VDD	-	Vdd	V	For entire VDD range			
D042	MCLR		0.8Vdd	-	Vdd	V				
D042A	OSC1 (XT, HS and LP)		0.7Vdd	-	Vdd	V	Note1			
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V				
D070	PORTB weak pull-up current	I PURB	50	250	400	μA	VDD = 5V, VPIN = VSS			
	Input Leakage Current (Notes 2, 3)									
D060	I/O ports	lı∟	-	-	±1	μA	Vss \leq VPIN \leq VDD, Pin at hi- impedance			
D061	MCLR, RA4/T0CKI		-	-	±5	μA	$Vss \leq VPIN \leq VDD$			
D063	OSC1		-	-	±5	μΑ	Vss \leq VPIN \leq VDD, XT, HS and			
						•	LP osc configuration			
	Output Low Voltage						-			
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V,			
							-40°C to +85°C			
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C			
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	lOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C			
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5 V, -40°C to +125°C			

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

 The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

	Applicable	Devices	5 01 02 0	וןאש	102 03 11	03 04	04A K04 05 05A K05 00 07
			-	-			ss otherwise stated) $A \le +125^{\circ}C$ for extended,
		Operation	ng temper	ature			$A \le +85^{\circ}C$ for industrial and
DC CHA	DC CHARACTERISTICS				0°C		$A \le +70^{\circ}C$ for commercial
		Operatir Section	• •	Vdd	range as	describ	ed in DC spec Section 21.1 and
Param No.	Characteristic	Sym	Min	Тур †	Max	Units	Conditions
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	Vdd-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C
D090A			Vdd-0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5V, -40°C to +125°C
D092	OSC2/CLKOUT (RC osc config)		Vdd-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°С to +85°С
D092A			Vdd-0.7	-	-	V	IOH = -1.0 mA, VDD = 4.5V, -40°С to +125°С
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin
	Capacitive Loading Specs on Output Pins						
D100	OSC2 pin	COSC2	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF	
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF	

 Applicable Devices
 61
 62
 62A
 R62
 63
 R63
 64
 64A
 R64
 65
 65A
 R65
 66
 67

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

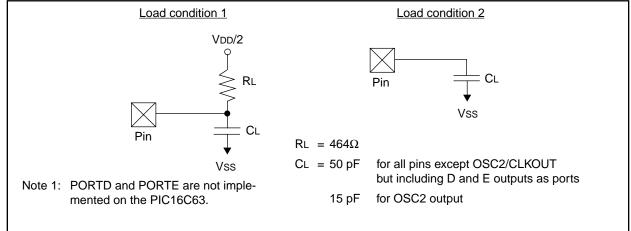
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

21.4 Timing Parameter Symbology

The timing parameter symbols have been created following one of the following formats:

0	, ,	0	
1. TppS2p	ppS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowerca	ase letters (pp) and their meanings:		
рр			
сс	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	\overline{RD} or \overline{WR}
di	SDI	sc	SCK
do	SDO	ss	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperca	ase letters and their meanings:		
S			
F	Fall	P	Period
Н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Tcc:st	(I ² C specifications only)	·	
CC	· · · ·		
HD	Hold	SU	Setup
ST			-
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 21-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



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21.5 <u>Timing Diagrams and Specifications</u>

FIGURE 21-2: EXTERNAL CLOCK TIMING

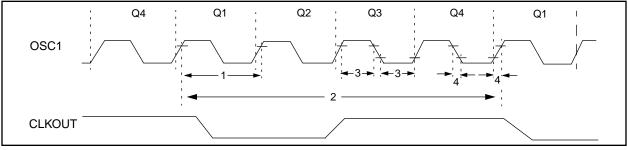


TABLE 21-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	—	4	MHz	HS osc mode (-04)
			DC	—	10	MHz	HS osc mode (-10)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency	DC		4	MHz	RC osc mode
		(Note 1)	0.1	—	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	—	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	—	ns	XT and RC osc mode
		(Note 1)	250	—	—	ns	HS osc mode (-04)
			100	—	—	ns	HS osc mode (-10)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
		Oscillator Period	250		—	ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			100	—	250	ns	HS osc mode (-10)
			50	—	250	ns	HS osc mode (-20)
			5	_	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3*	TosL,	External Clock in (OSC1) High or	100	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μs	LP oscillator
			15			ns	HS oscillator
4*	TosR,	External Clock in (OSC1) Rise or	_		25	ns	XT oscillator
	TosF	Fall Time	—	_	50	ns	LP oscillator
					15	ns	HS oscillator

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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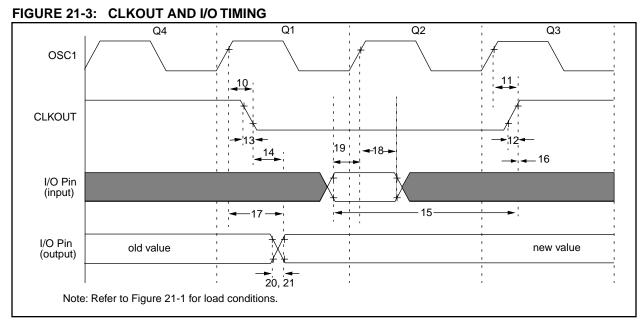


TABLE 21-3: **CLKOUT AND I/O TIMING REQUIREMENTS**

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10*	TosH2ckL	OSC1 [↑] to CLKOUT↓	OSC1 [↑] to CLKOUT↓			200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time	CLKOUT rise time			100	ns	Note 1
13*	TckF	CLKOUT fall time	—	35	100	ns	Note 1	
14*	TckL2ioV	CLKOUT \downarrow to Port out valid		—	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑		0	_	_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid		—	50	150	ns	
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port input PIC16 C 63/65A		100	_	_	ns	
		invalid (I/O in hold time)	PIC16 LC 63/65A	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in	setup time)	0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 63/65A	—	10	40	ns	
			PIC16 LC 63/65A	—	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 63/65A	—	10	40	ns	
			PIC16 LC 63/65A	—	_	80	ns	
22††*	Tinp	INT pin high or low time	in high or low time		—	—	ns	
23††*	Trbp	RB7:RB4 change INT high or low	v time	Тсү	_	—	ns	

These parameters are characterized but not tested.

t Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

these parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67



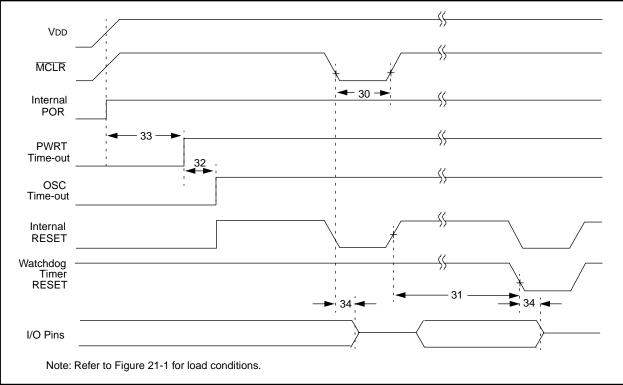


FIGURE 21-5: BROWN-OUT RESET TIMING

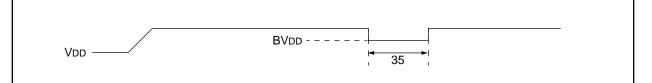


TABLE 21-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	—	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc		-	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	_	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	—	_	μs	$VDD \le BVDD (D005)$

These parameters are characterized but not tested.

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FIGURE 21-6: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

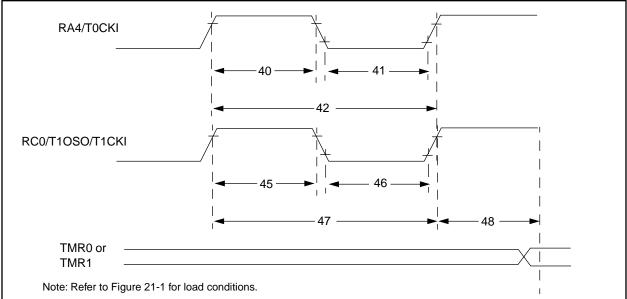


TABLE 21-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	-	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	- 1	—	ns	Must also meet
				With Prescaler	10	-	—	ns	parameter 42
42*	Tt0P	T0CKI Period	T0CKI Period		Tcy + 40	-	—	ns	
				With Prescaler	Greater of:	-	—	ns	N = prescale value
					20 or <u>Tcy + 40</u>				(2, 4,, 256)
					N				
45*	Tt1H	T1CKI High Time	Synchronous, F		0.5TCY + 20	-	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	<u> </u>	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	_	ns	
			Asynchronous	PIC16 C 6X	30	-	—	ns	
				PIC16 LC 6X	50	-	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	rescaler = 1	0.5TCY + 20	-	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	—	—	ns	
				PIC16 LC 6X	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	<u>Greater of:</u> 30 or <u>Tcy + 40</u> N	—	—	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	<u>Greater of:</u> 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	-	—	ns	
				PIC16 LC 6X	100	-	—	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b			DC	-	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tir	ner increment	2Tosc	- 1	7Tosc	_	

* These parameters are characterized but not tested.

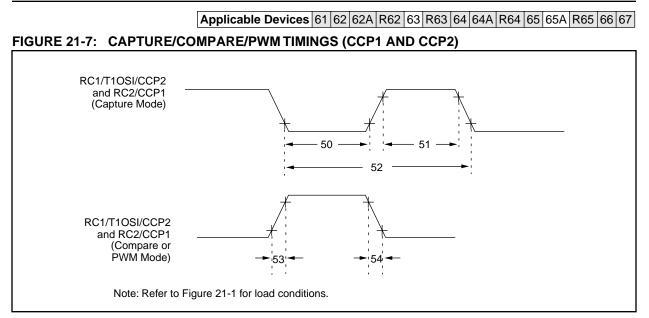


TABLE 21-6:CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL				0.5Tcy + 20	-	_	ns	
		input low time	With Prescaler	PIC16 C 63/65A	10	-	_	ns	
				PIC16 LC 63/65A	20	-	—	ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	-	_	ns	
	input high time		With Prescaler	/ith Prescaler PIC16 C 63/65A		-	_	ns	
				PIC16 LC 63/65A	20	-	—	ns	
52*	TccP	CCP1 and CCP2 ir	CCP1 and CCP2 input period		<u>3Tcy + 40</u> N	-	—	ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 and CCP2 o	utput rise time	PIC16 C 63/65A	_	10	25	ns	
					_	25	45	ns	
54*	TccF	CCP1 and CCP2 o	CP1 and CCP2 output fall time PIC160		_	10	25	ns	
				PIC16 LC 63/65A	_	25	45	ns	

* These parameters are characterized but not tested.

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FIGURE 21-8: PARALLEL SLAVE PORT TIMING (PIC16C65A)

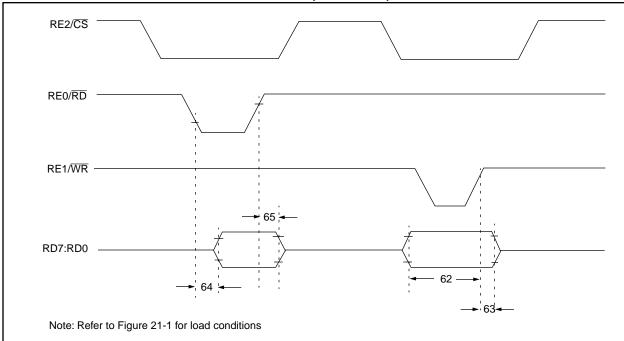


TABLE 21-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C65A)

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before \overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} (setup time)		20	_	-	ns	
				25	_	-	ns	Extended Range Only
63*	TwrH2dtl	\overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} to data–in invalid (hold	PIC16 C 65A	20	—	_	ns	
		time)	PIC16 LC 65A	35	_	_	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid	1	- 1	_	80	ns	
				-	_	90	ns	Extended Range Only
65*	TrdH2dtl	\overline{RD} for \overline{CS} to data-out invalid		10	_	30	ns	

* These parameters are characterized but not tested.

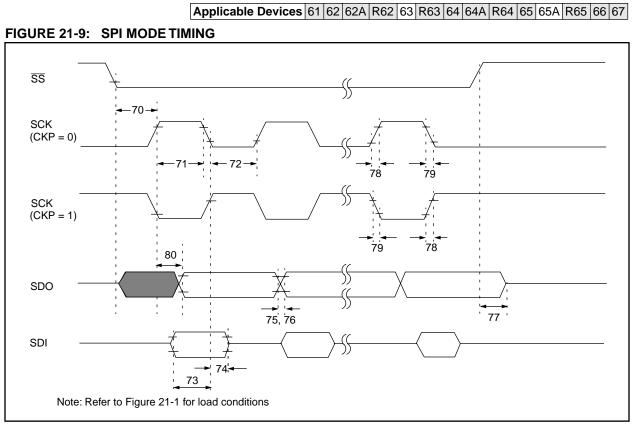


TABLE 21-8:	SPI MODE REQUIREMENTS
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Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK \downarrow or SCK \uparrow input	Тсү		—	ns	
71*	TscH	SCK input high time (slave mode)	TCY + 20	—	—	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	_		ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50		—	ns	
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	_	_	ns	
75*	TdoR	SDO data output rise time	—	10	25	ns	
76*	TdoF	SDO data output fall time	_	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)	—	10	25	ns	
79*	TscF	SCK output fall time (master mode)	_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	—		50	ns	

* These parameters are characterized but not tested.

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FIGURE 21-10: I²C BUS START/STOP BITS TIMING

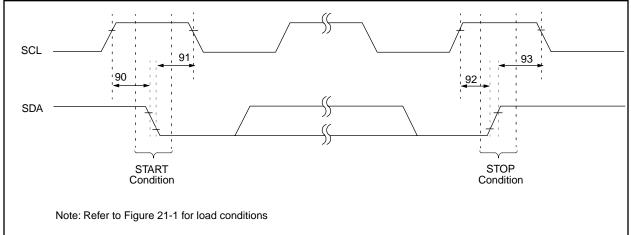
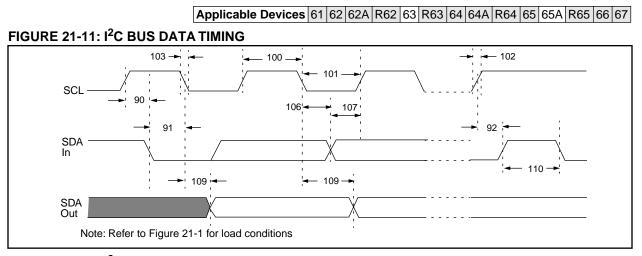


	TABLE 21-9:	I ² C BUS START/STOP BITS REQUIREMENTS
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Parameter No.	Sym	Characteristic		Min	Тур	Мах	Units	Conditions
90*	TSU:STA	START condition	100 kHz mode	4700	—	—	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	—	—	115	condition
91*	THD:STA	START condition	100 kHz mode	4000	—	—	ns	After this period the first clock
		Hold time	400 kHz mode	600	—	—	115	pulse is generated
92*	Tsu:sto	STOP condition	100 kHz mode	4700	—	—		
		Setup time	400 kHz mode	600	—	—	ns	
93	THD:STO	STOP condition	100 kHz mode	4000	—	—		
		Hold time	400 kHz mode	600	_	—	ns	

These parameters are characterized but not tested.



Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	Thigh	Clock high time	100 kHz mode	4.0	_	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	0.6	_	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
102*	TR	SDA and SCL rise	100 kHz mode	—	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	Tf	SDA and SCL fall time	100 kHz mode		300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	TSU:STA	START condition	100 kHz mode	4.7	—	μs	Only relevant for repeated
		setup time	400 kHz mode	0.6	—	μs	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	—	μs	After this period the first clock
		time	400 kHz mode	0.6	—	μs	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	_	ns	
92*	TSU:STO	STOP condition setup	100 kHz mode	4.7	_	μs	
		time	400 kHz mode	0.6	—	μs	
109*	ΤΑΑ	Output valid from	100 kHz mode	—	3500	ns	Note 1
		clock	400 kHz mode	-	_	ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free
			400 kHz mode	1.3	—	μs	before a new transmission car start
	Cb	Bus capacitive loading		—	400	pF	

TABLE 21-10: I²C BUS DATA REQUIREMENTS

* These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

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FIGURE 21-12: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

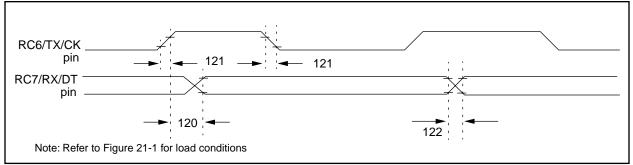


TABLE 21-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic			Тур†	Мах	Units	Conditions
120*	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 C 63/65A	_	—	80	ns	
		Clock high to data out valid	PIC16 LC 63/65A	—	—	100	ns	
121*	Tckrf	Clock out rise time and fall time	PIC16 C 63/65A	—	—	45	ns	
		(Master Mode)	PIC16 LC 63/65A	—	—	50	ns	
122*	Tdtrf	Data out rise time and fall time	PIC16 C 63/65A	—	—	45	ns	
			PIC16 LC 63/65A	_	—	50	ns	

* These parameters are characterized but not tested.

†: Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 21-13: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

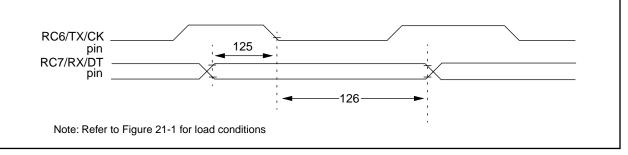


TABLE 21-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
125*	TdtV2ckL	$\frac{\text{SYNC RCV (MASTER \& SLAVE)}}{\text{Data setup before CK} \downarrow (\text{DT setup time})}$	15		_	ns	
126*	TckL2dtl	Data hold after CK \downarrow (DT hold time)	15	_	_	ns	

* These parameters are characterized but not tested.

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22.0 ELECTRICAL CHARACTERISTICS FOR PIC16CR63/R65

Absolute Maximum Ratings (†)

5	
Ambient temperature under bias Storage temperature	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	
Voltage on VDD with respect to Vss	-0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	
Maximum current into VDD pin	
Input clamp current, lik (VI < 0 or VI > VDD)	+20 mA
Output clamp current, loк (Vo < 0 or Vo > VDD)	±20 mA
Output clamp current, Iok (Vo < 0 or Vo > VDD) Maximum output current sunk by any I/O pin Maximum output current sourced by any I/O pin.	
Maximum output outront oourood by any 1/0 pin	
Maximum current sunk by PORTA, PORTB, and PORTF (Note 3) (combined).	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined)	
Maximum current sunk by PORTC and PORTD (Note 3) (combined)	
Maximum current sourced by PORTC and PORTD (Note 3) (combined)	
Note 1. Power dissipation is calculated as follows: Pdis - Von without - NION +	$\frac{1}{2}$

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {HDD - ∑IOH} + ∑{(VDD-VOH) x IOH} + ∑(VOI x IOL)
 Note 2: Voltage spikes below Vss at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP pin rather than pulling this pin directly to Vss.

Note 3: PORTD and PORTE not available on the P(C16CR63.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 22-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

		$ \rightarrow \rightarrow$			
osc	PIC16CR63-04 PIC16CR65-04	PIC16CR63-10 PIC16CR65-10	PIC16CR63-20 PIC16CR65-20	PIC16LCR63-04 PIC16LCR65-04	JW Devices
RC	VDD: 4.0V to 5.5V IDD: 5 mA max_at 5.5V IPD: 16 μA max_at 4V Freq: 4 MHz max	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IRD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 5.5V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 5.5V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
ХТ	VDD: 4.0V to 5.5V IDP: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.	20D: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 5.5V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 5.5V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V
	IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.	IPD 1.5 μA typ. at 4.5V Freq: 10 MHz max.	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.		IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 5.5V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 5.5V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	VDD: 3.0V to 5.5V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

22.1

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

DC Characteristics: PIC16CR63/R65-04 (Commercial, Industrial) PIC16CR63/R65-10 (Commercial, Industrial) PIC16CR63/R65-20 (Commercial, Industrial)

DC CH		Standard Operating Conditions (unless otherwise stated)Operating temperature -40° C $\leq TA \leq +85^{\circ}$ C for industrial and 0° C $\leq TA \leq +70^{\circ}$ C for commercial								
Param No.			Min	Тур†	Max	Units	Conditions			
D001 D001A	Supply Voltage	Vdd	4.0 4.5	-	5.5 5.5	V V	XT, RC and LP osc configuration HS osc configuration			
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V				
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details			
D004*	VDD rise rate to ensure internal Power-on Reset signal	Svdd	0.05	-	-	V/ms	See section on Power-on Reset for details			
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled			
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA~	XT, RC, osc config Fosc = 4 MHz, VDD = 5:5V (Note 4)			
D013			-	10	20	MA	HS osc config Fosc = 20 MHz, VDD = $5.5V$			
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, VDD = 5.0V			
D020 D021 D021A	Power-down Current (Note 3, 5)		-	10.5 1.5 1.5	42 16 19	μΑ μΑ μΑ	$VDD = 4.0V$, WDT enabled, $-40^{\circ}C$ to $+85^{\circ}C$ $VDD = 4.0V$, WDT disabled, $-0^{\circ}C$ to $+70^{\circ}C$ $VDD = 4.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$			
D023*	Brown-out Reset Current (Note 6)			\$50	425	μA	BOR enabled, VDD = 5.0V			

These parameters are characterized but not tested.

+ Data in "Typ" column is at 6V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the Jimit to which VoD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $OSC1 \neq external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,$

 $MCLR \neq VDD$; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

22.2 DC Characteristics: PIC16LCR63/R65-04 (Commercial, Industrial)

DC CHA	Standard Operating Conditions (unless otherwise stated)DC CHARACTERISTICSOperating temperature $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ for industrial and									
		$0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial								
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions			
D001	Supply Voltage	Vdd	3.0	-	5.5	V	LP, XT, RC osc configuration (DC - 4 MHz)			
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	\square			
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details			
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power on Reset for details			
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled			
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT RC ose configuration Fosc = 4 MHz, VpD = 3.0V (Note 4)			
D010A			-	22.5	48	μΑ	LP osc configuration Fosc = 32 kHz, VDD = 3.0V, WDT disabled			
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350 <	425	Ay	BOR enabled, VDD = 5.0V			
D020 D021 D021A	Power-down Current (Note 3, 5)	IPD		7.5 0.9 0.9	30 5 5	μА μА μА	$V_{DD} = 3.0V$, WDT enabled, -40°C to +85°C VDD = 3.0V, WDT disabled, 0°C to +70°C VDD = 3.0V, WDT disabled, -40°C to +85°C			
D023*	Brown-out Reset Current (Note 6)	AIBOR	- \	350	425	μΑ	BOR enabled, VDD = 5.0V			

These parameters are characterized but not tested.

+ Data in "Typ" column is at 50, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

- 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all Ipp measurements in active operation mode are:
 - OSC/1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,
 - $\overline{MCLR} = V \overline{D}; WDT enabled/disabled as specified.$
- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4. For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5. Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

22.3 DC Characteristics: PIC16CR63/R65-04 (Commercial, Industrial) PIC16CR63/R65-10 (Commercial, Industrial) PIC16CR63/R65-20 (Commercial, Industrial) PIC16LCR63/R65-04 (Commercial, Industrial)

			r d Operat ng temper		e -40°C	; S ≤ T	ss otherwise stated) A ≤ +85°C for industrial and			
DC CHA	RACTERISTICS	$0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial								
		Operating voltage VDD range as described in DC spec Section 22.1 a								
Damana	Oh and a tania tia		Section 22.2							
Param No.	Characteristic	Sym	Min	Тур †	Max	Units	Conditions			
	Input Low Voltage			-						
	I/O ports	VIL								
D030	with TTL buffer	VIL	Vss	-	0.15VDD	V	For entire VDD range			
D030A			VSS	-	0.10VDD	v	4.5V ≤ VD0 ≤ 5,5V			
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	v				
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD	χ				
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	1 V	Note1			
	Input High Voltage				<u>^</u>		$\langle \rangle$			
	I/O ports	VIH		-	$ \langle \setminus$	$ \rangle$				
D040	with TTL buffer		2.0	-	VDD	\sqrt{v}	$4.5V \leq VDD \leq 5.5V$			
D040A			0.25VDD	_ <	VDD	N 4	For entire VDD range			
			+ 0.8V	\wedge	$\backslash \backslash $	\vdash	, i i i i i i i i i i i i i i i i i i i			
				$\langle \rangle$	$\langle \ / \ /$					
D041	with Schmitt Trigger buffer		0.8VDD	- \	VDDV	V	For entire VDD range			
D042	MCLR		9.8VDp	<u> </u>	VDD	V				
D042A	OSC1 (XT, HS and LP)		0.7VQD	<u> </u> -	V DD	V	Note1			
D043	OSC1 (in RC mode)		0.9VDQ	<u> </u>	Vdd	V				
D070	PORTB weak pull-up current	PURB	50	250	400	μΑ	VDD = 5V, VPIN = VSS			
	Input Leakage Current (Notes 2, 3)	$ \setminus \rangle$	$\langle \rangle$							
D060	I/O ports		- Ť	-	±1	μA	$Vss \le VPIN \le VDD$, Pin at hi- impedance			
D061	MCLR, RA4/T0CKI		-	-	±5	μA	$Vss \le VPIN \le VDD$			
D063	OSC1	\mathbb{M}	-	-	±5	μA	$Vss \leq VPIN \leq VDD, XT, HS and$			
		\checkmark					LP osc configuration			
	Output Low Voltage									
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5 V,			
B 6 6 6						.,	-40°C to +85°C			
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	loL = 1.6 mA, VDD = 4.5V, -40°C to +85°C			
	Output High Voltage									
D090 <	1/Q ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°С to +85°С			
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V,			
DIEG							-40°C to +85°C			
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin			

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

 The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

	[Applicable	Devices	61 62 6	62A F	R62 63 R	63 64	64A R64 6	5 65A R6	5 66 67
DC CHA	RACTERISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature $-40^{\circ}C$ $\leq TA \leq +85^{\circ}C$ for industrial at $0^{\circ}C$ $0^{\circ}C$ $\leq TA \leq +70^{\circ}C$ for commercialOperating voltage VDD range as described in DC spec Section 22 Section 22.2							cial	
Param No.	Characteristic	;	Sym	Min	Тур †	Мах	Units	C	Conditions	1
D100	Capacitive Loading Spe put Pins OSC2 pin All I/O pins and OSC2 (in		Cosc2	-	-	15	pF	In XT, HS a external clo OSC1.		
D101 D102	SCL, SDA in I^2 C mode	KC mode)	Cb	-	-	400	pF pF			\rangle

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

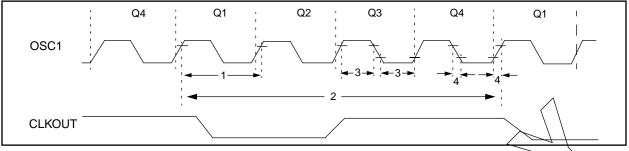
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

22.4 **Timing Parameter Symbology** The timing parameter symbols have been created following one of the following formats: 1. TppS2ppS (I²C specifications only) 3. TCC:ST 2. TppS (I²C specifications only) 4. Ts т F т Frequency Time Lowercase letters (pp) and their meanings: рр сс CCP1 osc OSC1 CLKOUT RD ck rd CS RD or WR cs rw SDI SCK di sc SS do SDO SS Data in **T0CKI** dt t0 I/O port T1CKI io t1 MCLR WR mc wr Uppercase letters and their meanings: S F Fall Ρ Period Н High R Rise Valid Т Invalid (Hi-impedance) V L Low Hi-impedance I²C only High AA output access High BUF Bus free Łòw Low Tcc:st (I²C specifications only) СС HD SU Hold Setup ST DAT DATA input hold STO STOP condition STA START condition FIGURE 22-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS Load condition 1 Load condition 2 Vdd/2 CL RL Pin Vss CL Pin $RL = 464\Omega$ $CL = 50 \, pF$ for all pins except OSC2/CLKOUT Vss but including D and E outputs as ports Note 1: PORTD and PORTE are not imple-15 pF for OSC2 output mented on the PIC16CR63.

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22.5 **Timing Diagrams and Specifications**

FIGURE 22-2: EXTERNAL CLOCK TIMING



EXTERNAL CLOCK TIMING REQUIREMENTS TABLE 22-2:

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	/MHz_	HS osc mode (-04)
			DC	_	10	MAZ	HS osc mode (-10)
			DC	_	20	MHZ/	HS esc mode (-20)
			DC	_	200		LP osc mode
		Oscillator Frequency	DC		4	MHZ	RC osc mode
		(Note 1)	0.1		4	Miųz ′	XT osc mode
			4	$ $ \wedge \rangle	20	MHz	HS osc mode
			5		200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	$\backslash - \backslash$		ns	XT and RC osc mode
		(Note 1)	250	$\langle \mathcal{F} \rangle$	\searrow	ns	HS osc mode (-04)
			1,00/	$\left \left \left -\right\rangle\right $	-	ns	HS osc mode (-10)
			50		-	ns	HS osc mode (-20)
			5	<u> </u>	—	μs	LP osc mode
		Oscillator Period	250	≥ —	—	ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			100	—	250	ns	HS osc mode (-10)
			50	—	250	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
2	TCY	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3*	TosL,	External Clock in (OSC1) High or	100	—	-	ns	XT oscillator
	TosH	LowTime	2.5	—	-	μs	LP oscillator
		$\bigvee \longrightarrow$	15			ns	HS oscillator
4*	TosR, TosF	External Clock in (OSC1) Rise or	-	—	25	ns	XT oscillator
		Fall Time	_	—	50	ns	LP oscillator
*	\bigvee		—	—	15	ns	HS oscillator

These parameters are characterized but not tested.

Data n "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested. t

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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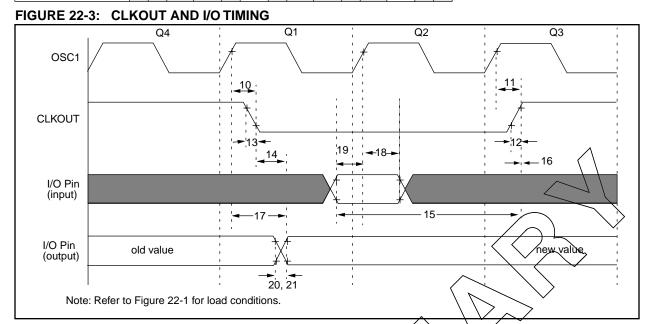


TABLE 22-3: CLKOUT AND I/O TIMING REQUIREMENTS

						∖ ∕		
Param No.	Sym	Characteristic	<	Min	Tŷpt	✓ Max	Units	Conditions
NO.			\longrightarrow	$\langle \rangle \rangle$	\searrow			
10*	TosH2ckL	OSC1 [↑] to CLKOUT↓		$\langle + \rangle$	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑			75	200	ns	Note 1
12*	TckR	CLKOUT rise time	$\sim V $	\searrow	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		<u> </u>	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT \downarrow to Port out valid		—	—	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT	///	Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT 1	$\overline{\langle } \rangle$	0	—	_	ns	Note 1
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port out val	id 🔪	—	50	150	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to Port input	P10,16CR63/R65	100	—	_	ns	
		invalid (I/O in hold time)	PIC16LCR63/R65	200	—	_	ns	
19*	TioV2osH	Port input valid to OSC1 (I/Q in	setup time)	0	_	—	ns	
20*	TioR	Port output rise time	PIC16CR63/R65	—	10	40	ns	
		\square	PIC16LCR63/R65	—	—	80	ns	
21*	TioF /	Port output fall time	PIC16CR63/R65	—	10	40	ns	
		$\langle \rangle$	PIC16LCR63/R65	—	_	80	ns	
22††*	Tinp	INT pin high or low time		Тсү	_	—	ns	
23††*	Trbp	RB7:RB3 change INT high or low	time	Тсү	_	—	ns	

Nese parameters are characterized but not tested.

+ Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

tt These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

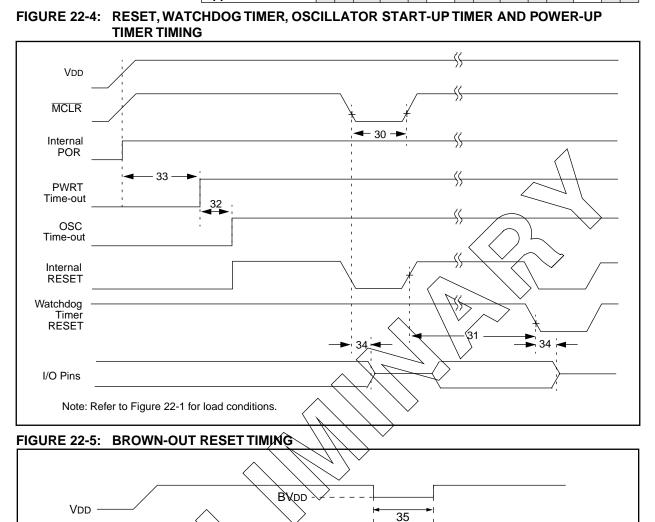


TABLE 22-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	Track	MCLR Pulse Width (low)	2	—	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	—	1024 Tosc	_	-	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	_	—	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	_	_	μs	$VDD \le BVDD$ (D005)

These parameters are characterized but not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 22-6: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

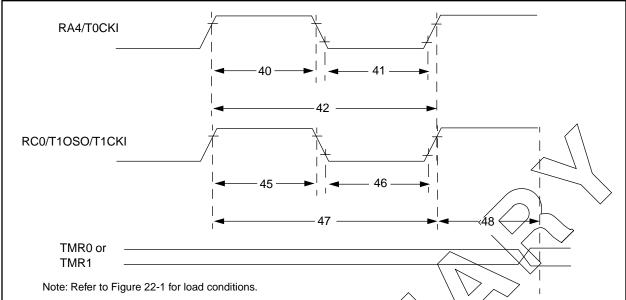


TABLE 22-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENT\$

Param No.	Sym	Characteristic			Min	Typt	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5TCY+20	-	_	ns	Must also meet
				With Prescaler		-	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5TCY + 20	-	—	ns	Must also meet
				With Prescaler	10	-	—	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	7CY + 40	—	—	ns	
			\langle	With Prescaler	Greater of: 20 or <u>Tcy + 40</u>	-	—	ns	N = prescale value (2, 4,, 256)
			\ \	$\langle \setminus \rangle$	N				(2, 4,, 200)
45*	Tt1H	T1CKI High Time	Synchronous, P		0.5TCY + 20	-	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC 16LC6X	25	-	_	ns	
			Asynchronous	PIC16 C 6X	30	-	—	ns	
				PIC16 LC 6X	50	-	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, P	Prescaler = 1	0.5TCY + 20	-	—	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	—	—	ns	parameter 47
		$(\land \land)$	Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
		$\land \checkmark \land \checkmark$	Asynchronous	PIC16 C 6X	30	—	—	ns	
		$ \setminus \langle $		PIC16 LC 6X	50	-	—	ns	
47*	THP	T1CKK input period	Synchronous	PIC16 C 6X	<u>Greater of:</u> 30 OR <u>TCY + 40</u> N	-	_	ns	N = prescale value (1, 2, 4, 8)
		>		PIC16 LC 6X	<u>Greater of:</u> 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	-	—	ns	
				PIC16 LC 6X	100	-	—	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b		0	DC	-	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tin	ner increment	2Tosc	1	7Tosc	_	

These parameters are characterized but not tested.

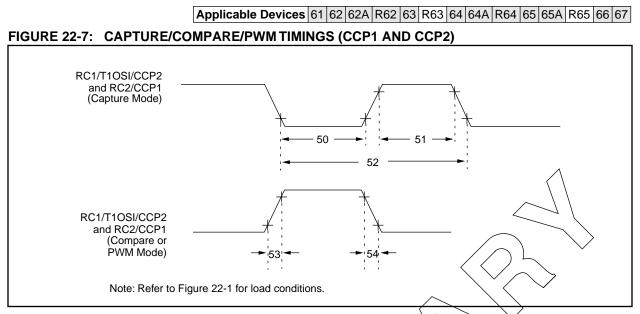


TABLE 22-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CGP2)

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcx + 20			ns	
		input low time	With Prescaler	PIC16CR63/R65	10	-	_	ns	-
				PIC16LCR63/R65	20	-		ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	-		ns	
		input high time	With Prescaler	PIC16CR03/R65	10	-	_	ns	
				PIG16LCR63/R65	20	—	-	ns	
52*	TccP	CCP1 and CCP2 ir	nput period	\square	<u>3Tcy + 40</u> N	-	_	ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 and CCP2 o	utput rise time	PIC16 ČR 63/R65	_	10	25	ns	
			$\langle \rangle$	PIC16LCR63/R65	_	25	45	ns	
54*	TccF	CCP1 and CCP2 o	utput fall time	PIC16 CR 63/R65	—	10	25	ns	
			\rightarrow	PIC16 LCR 63/R65	_	25	45	ns	

* These parameters are characterized but not tested.

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FIGURE 22-8: PARALLEL SLAVE PORT TIMING (PIC16CR65)

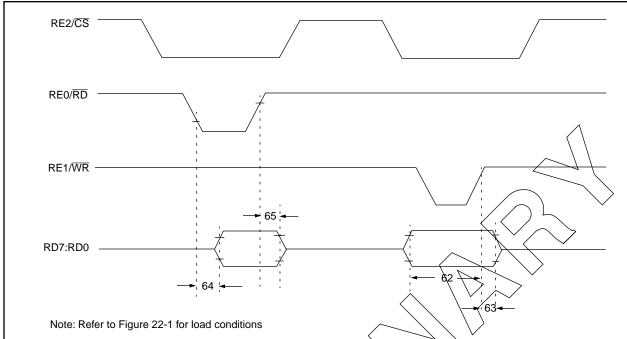
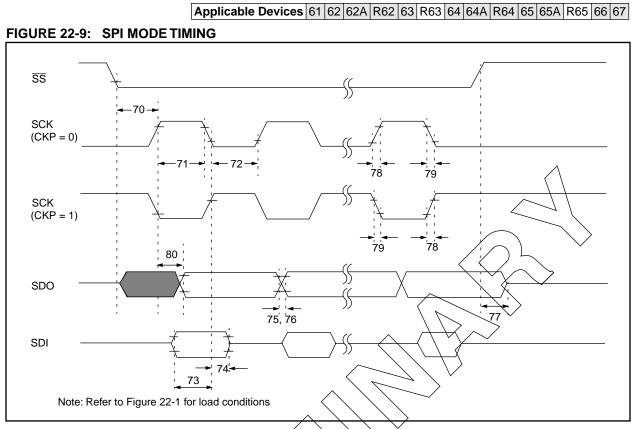


TABLE 22-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16CR65)

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before WR1 or CS1 (setup time)	20	_	_	ns	
63*	TwrH2dtl	WR1 or CS1 to data-in invalid (hold PIC16CR65	20	—	_	ns	
		time) PIC16LCR65	35	—	_	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid	_	—	80	ns	
65*	TrdH2dtl	\overline{RD} or \overline{CS} to data-out invalid	10	_	30	ns	

*

These parameters are characterized but not tested. Data in "Typ" column is at 5%, 25° C unless otherwise stated. These parameters are for design guidance only and are not t tested.



Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Тсү	—		ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK	50	—		ns	
74*	TscH2diL, TscL 2 diL	Hold time of SDI data input to SCK	50	_		ns	
75*	TdoR	SDO data output rise time	_	10	25	ns	
76* <	TeloF	SDO data output fall time	_	10	25	ns	
77*	TęsHzdoZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)	_	10	25	ns	
79*	TscF	SCK output fall time (master mode)	_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	—	50	ns	

* These parameters are characterized but not tested.

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FIGURE 22-10: I²C BUS START/STOP BITS TIMING

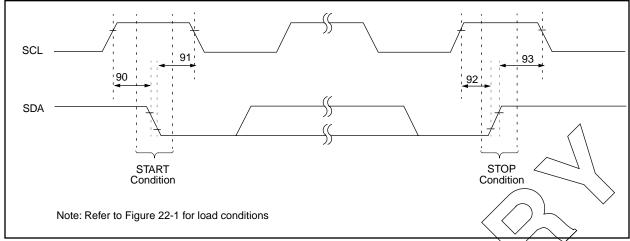


TABLE 22-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90*	TSU:STA	START condition	100 kHz mode	4700	—		ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	\wedge	_		condition
91*	THD:STA	START condition	100 kHz mode	4000	$\overline{\langle}$	\mathbb{V}		After this period the first clock
		Hold time	400 kHz mode	600		$\overline{\mathcal{A}}$	ns	pulse is generated
92*	TSU:STO	STOP condition	100 kHz mode	4700	\neq	\neq		
		Setup time	400 kHz mode	600	$\langle - \rangle$		ns	
93	THD:STO	STOP condition	100 kHz mode	4000		\geq	20	
		Hold time	400 kHz mode	600	\mathbf{F}	—	ns	

* These parameters are characterized but not tested

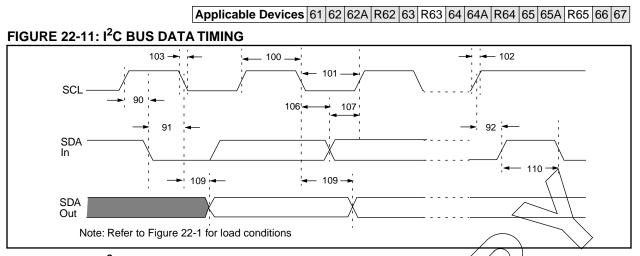


TABLE 22-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	Тнідн	Clock high time	100 kHz mode	4.0	- / '	μs	Device must operate at a min- inpum of 1.5 MHz
			400 kHz mode	0.6		us	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5Tex	$\overline{\backslash}$	∇	
101*	TLOW	Clock low time	100 kHz mode	4.7		μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	1.3	>-	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
102*	Tr	SDA and SCL rise	100 kHz mode		1000	ns	
		time	400 kHZ mode	20 ≠ 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	—	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	TSU:STA	START condition	100 kHz mode	4.7	—	μs	Only relevant for repeated
		setup time	400 kHz mode	0.6	—	μs	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	—	μs	After this period the first clock
			400 kHz mode	0.6	—	μs	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
	($\land \land \lor / $	400 kHz mode	0	0.9	μs	-
107*	TSU.DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	—	ns	
92*	TSU:STO	STOP condition setup	100 kHz mode	4.7	_	μs	
	$\sum \sum$	time	400 kHz mode	0.6	_	μs	
109*	TAA \	Output valid from	100 kHz mode		3500	ns	Note 1
		člock	400 kHz mode		_	ns	
110*		Bus free time	100 kHz mode	4.7	_	μs	Time the bus must be free
	\searrow		400 kHz mode	1.3		μs	before a new transmission can start
	Cb	Bus capacitive loading		_	400	pF	

* These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

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FIGURE 22-12: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

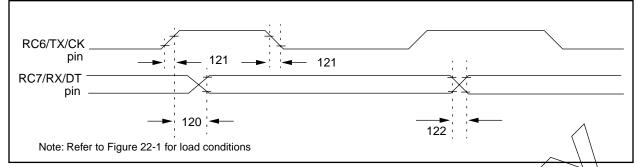


TABLE 22-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
120*	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 CR 63/R65	-	—	80	ns	\geq
		Clock high to data out valid	PIC16LCR63/R65	—	$\overline{\langle}$	100	ns	
121*	Tckrf	Clock out rise time and fall time	PIC16 CR 63/R65	— '	K	45	ns	
		(Master Mode)	PIC16LCR63/R65		$\overline{)}$	50	ns	
122*	Tdtrf	Data out rise time and fall time	PIC16CR63/R65	$\langle \mathcal{A} \rangle$	- /	45	ns	
			PIC16LCR63/R65	$\left(\mathcal{F} \right)$	$\langle - \rangle$	50	ns	

* These parameters are characterized but not tested.

+: Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are tor design guidance only and are not tested.

FIGURE 22-13: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

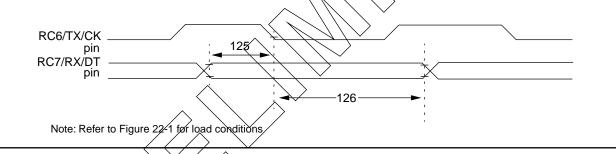


TABLE 22-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
125*	TdtV2ckL /	SYNC RCV (MASTER & SLAVE)					
	$\frown \land \land$	Data setup before CK \downarrow (DT setup time)	15	—	—	ns	
126*	TckL2dtl	Data hold after CK \downarrow (DT hold time)	15	—	—	ns	

* These parameters are characterized but not tested.

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23.0 ELECTRICAL CHARACTERISTICS FOR PIC16C66/67

Absolute Maximum Ratings (†)

Ambient temperature under bias	55°C to +125°C
Storage temperature	
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	300 mA
Maximum current into Vod pin	250 mA
Input clamp current, Iik (VI < 0 or VI > VDD)	±20 mA
Output clamp current, IOK (VO < 0 or VO > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sunk by PORTC and PORTD (Note 3) (combined)	200 mA
Maximum current sourced by PORTC and PORTD (Note 3) (combined)	200 mA
Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD-VC	DH) X IOH} + Σ (VOI X IOL)

Note 2: Voltage spikes below Vss at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP pin rather than pulling this pin directly to Vss.

Note 3: PORTD and PORTE not available on the PIC16C66.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 23-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C66-04 PIC16C67-04	PIC16C66-10 PIC16C67-10	PIC16C66-20 PIC16C67-20	PIC16LC66-04 PIC16LC67-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
ХТ	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V
	IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.	IPD 1.5 μA typ. at 4.5V Freq: 10 MHz max.	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.		IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

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23.1 DC Characteristics: PIC16C66/67-04 (Commercial, Industrial, Extended) PIC16C66/67-10 (Commercial, Industrial, Extended) PIC16C66/67-20 (Commercial, Industrial, Extended)

DC CH		Standar Operatir	-	-	e -40	.≥ 0°C ≥ 0°C	unless otherwise stated) $\leq TA \leq +125^{\circ}C$ for extended, $\leq TA \leq +85^{\circ}C$ for industrial and $\leq TA \leq +70^{\circ}C$ for commercial
Param No.	Characteristic	Sym	Min	Тур†	Мах	Units	Conditions
D001 D001A	Supply Voltage	Vdd	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	Svdd	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled
			3.7	4.0	4.4	V	Extended Range Only
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC, osc config Fosc = 4 MHz, VDD = 5.5V (Note 4)
D013			-	10	20	mA	HS osc config Fosc = 20 MHz, VDD = 5.5V
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, $VDD = 5.0V$
D020 D021 D021A D021B	Power-down Current (Note 3, 5)	IPD	- - -	10.5 1.5 1.5 2.5	42 16 19 19	μΑ μΑ μΑ μΑ	$VDD = 4.0V, WDT enabled, -40^{\circ}C \text{ to } +85^{\circ}C$ $VDD = 4.0V, WDT \text{ disabled}, -0^{\circ}C \text{ to } +70^{\circ}C$ $VDD = 4.0V, WDT \text{ disabled}, -40^{\circ}C \text{ to } +85^{\circ}C$ $VDD = 4.0V, WDT \text{ disabled}, -40^{\circ}C \text{ to } +125^{\circ}C$
D023*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, VDD = 5.0V

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

- $\overline{\text{MCLR}}$ = VDD; WDT enabled/disabled as specified.
- 3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

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DC CHA	RACTERISTICS	Standa Operatir	•	-		°C ≤	Inless otherwise stated) TA \leq +85°C for industrial and TA \leq +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max	_	Conditions
D001	Supply Voltage	Vdd	2.5	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	Vdr	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	Bvdd	3.7	4.0	4.3	V	BODEN configuration bit is enabled
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μA	LP osc configuration Fosc = 32 kHz, VDD = 3.0V, WDT disabled
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, VDD = 5.0V
D020	Power-down Current	IPD	-	7.5	30	μA	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021	(Note 3, 5)		-	0.9	5	μA	VDD = $3.0V$, WDT disabled, $0^{\circ}C$ to $+70^{\circ}C$
D021A			-	0.9	5	μA	VDD = $3.0V$, WDT disabled, $-40^{\circ}C$ to $+85^{\circ}C$
D023*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μA	BOR enabled, VDD = 5.0V

23.2 DC Characteristics: PIC16LC66/67-04 (Commercial, Industrial)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

 \overline{MCLR} = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VbD and Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.

6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

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23.3 DC Characteristics: PIC16C66/67-04 (Commercial, Industrial, Extended) PIC16C66/67-10 (Commercial, Industrial, Extended) PIC16C66/67-20 (Commercial, Industrial, Extended) PIC16LC66/67-04 (Commercial, Industrial)

		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}C \leq TA \leq +125^{\circ}C$ for extended,							
		operation	ig temper	aturt	-40°		$A \leq +85^{\circ}C$ for industrial and		
DC CHA	RACTERISTICS				0°C		$T_A \leq +70^{\circ}C$ for commercial		
		Operati	ng voltage	VDD	range as		ed in DC spec Section 23.1 and		
		Section			0				
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions		
No.				†					
	Input Low Voltage								
	I/O ports	VIL							
D030	with TTL buffer		Vss	-	0.15Vdd	V	For entire VDD range		
D030A			Vss	-	0.8V	V	$4.5V \le VDD \le 5.5V$		
D031	with Schmitt Trigger buffer		Vss	-	0.2Vdd	V			
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2Vdd	V			
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3Vdd	V	Note1		
	Input High Voltage								
	I/O ports	VIH		-					
D040	with TTL buffer		2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$		
D040A			0.25VDD	-	Vdd	V	For entire VDD range		
			+ 0.8V				_		
D041	with Schmitt Trigger buffer		0.8VDD	-	Vdd	V	For entire VDD range		
D042	MCLR		0.8Vdd	-	Vdd	V			
D042A	OSC1 (XT, HS and LP)		0.7Vdd	-	Vdd	V	Note1		
D043	OSC1 (in RC mode)		0.9Vdd	-	Vdd	V			
D070	PORTB weak pull-up current	IPURB	50	250	400	μΑ	VDD = 5V, VPIN = VSS		
	Input Leakage Current (Notes 2, 3)								
D060	I/O ports	lı∟	-	-	±1	μA	Vss \leq VPIN \leq VDD, Pin at hi- impedance		
D061	MCLR, RA4/T0CKI		-	-	±5	μA	$Vss \le VPIN \le VDD$		
D063	OSC1		-	-	±5	μA	Vss \leq VPIN \leq VDD, XT, HS and LP osc configuration		
	Output Low Voltage								
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C		
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C		
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	lOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C		
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C		

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

 The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

	Approvation	Derice		02/1			047 104 03 037 103 00 07	
DC CHA	ARACTERISTICS	Standard Operating Conditions (unless otherwise stated)Operating temperature -40° C \leq TA \leq +125°C for extended, -40° C \leq TA \leq +85°C for industrial and 0° C \leq TA \leq +70°C for commercialOperating voltage VDD range as described in DC spec Section 23.1 arSection 23.2						
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions	
No.				†				
	Output High Voltage							
D090	I/O ports (Note 3)	Vон	Vdd-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C	
D090A			Vdd-0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5V, -40°С to +125°С	
D092	OSC2/CLKOUT (RC osc config)		Vdd-0.7	-	-	V	Юн = -1.3 mA, VDD = 4.5V, -40°С to +85°С	
D092A			Vdd-0.7	-	-	V	IOH = -1.0 mA, VDD = 4.5V, -40°С to +125°С	
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin	
	Capacitive Loading Specs on Out- put Pins					_		
D100	OSC2 pin	Cosc ₂	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.	
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF		
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF		

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* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

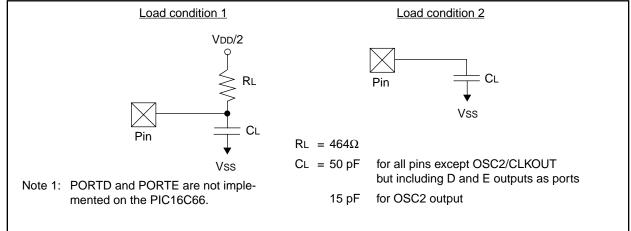
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

23.4 Timing Parameter Symbology

The timing parameter symbols have been created following one of the following formats:

0	, ,	0	
1. TppS2p	ppS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowerca	ase letters (pp) and their meanings:	I	
рр			
сс	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperca	ase letters and their meanings:		
S			
F	Fall	P	Period
Н	High	R	Rise
1	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
Тсс:ѕт	(I ² C specifications only)	ł	
CC	· · · · · · · · · · · · · · · · · · ·		
HD	Hold	SU	Setup
ST			•
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 23-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



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23.5 <u>Timing Diagrams and Specifications</u>

FIGURE 23-2: EXTERNAL CLOCK TIMING

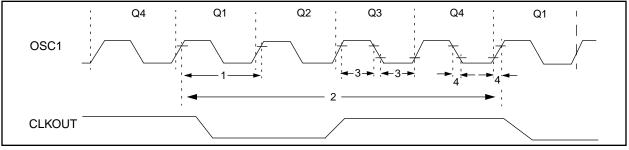


TABLE 23-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
	Fosc	External CLKIN Frequency	DC	—	4	MHz	XT and RC osc mode
		(Note 1)	DC	—	4	MHz	HS osc mode (-04)
			DC	—	10	MHz	HS osc mode (-10)
			DC	—	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency	DC	—	4	MHz	RC osc mode
		(Note 1)	0.1	—	4	MHz	XT osc mode
			4	—	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	—	—	ns	XT and RC osc mode
		(Note 1)	250	—	—	ns	HS osc mode (-04)
			100	—	—	ns	HS osc mode (-10)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
		Oscillator Period	250	—	—	ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			250	—	250	ns	HS osc mode (-04)
			100	—	250	ns	HS osc mode (-10)
			50	—	250	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	Тсү	DC	ns	Tcy = 4/Fosc
3*	TosL,	External Clock in (OSC1) High or	100	_	_	ns	XT oscillator
	TosH	Low Time	2.5	—	—	μs	LP oscillator
			15	—		ns	HS oscillator
4*	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	—	50	ns	LP oscillator
				<u> </u>	15	ns	HS oscillator

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

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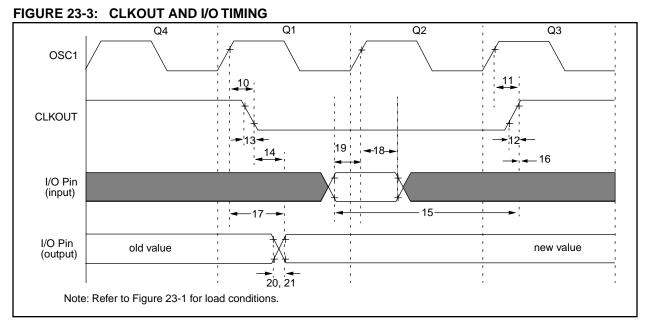


TABLE 23-3: **CLKOUT AND I/O TIMING REQUIREMENTS**

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		—	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		—	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT \downarrow to Port out valid		—	_	0.5TCY + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑	Tosc + 200	_	_	ns	Note 1	
16*	TckH2iol	Port in hold after CLKOUT 1	0	_	_	ns	Note 1	
17*	TosH2ioV	OSC1 [↑] (Q1 cycle) to Port out val	lid	—	50	150	ns	
18*	TosH2iol	OSC1 [↑] (Q2 cycle) to Port input	PIC16 C 66/67	100		_	ns	
		invalid (I/O in hold time)	PIC16 LC 66/67	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in	setup time)	0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 66/67	_	10	40	ns	
			PIC16 LC 66/67	—	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 66/67	—	10	40	ns	
			PIC16 LC 66/67			80	ns	
22††*	Tinp	INT pin high or low time		Тсү	_	—	ns	
23††*	Trbp	RB7:RB4 change INT high or low	v time	Тсү	_	_	ns	

These parameters are characterized but not tested.

t Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

these parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

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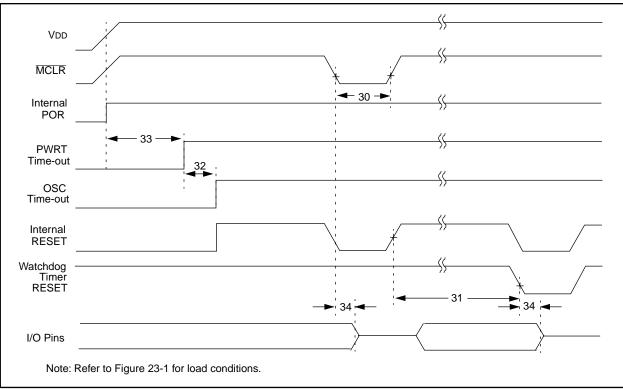


FIGURE 23-5: BROWN-OUT RESET TIMING

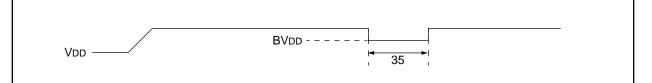


TABLE 23-4:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	—	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc		-	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	_	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	—	_	μs	$VDD \le BVDD (D005)$

These parameters are characterized but not tested.

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FIGURE 23-6: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

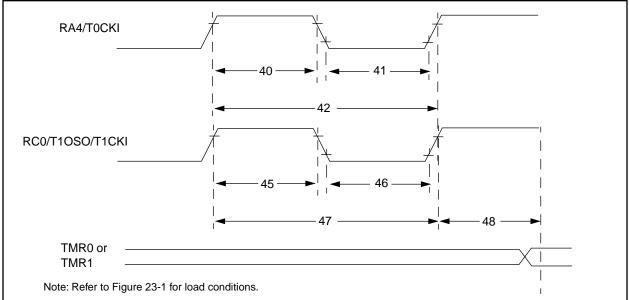


TABLE 23-5: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	-	_	ns	Must also meet
		_		With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5TCY + 20	-	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	-	—	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	-	—	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F	Prescaler = 1	0.5Tcy + 20	_	_	ns	Must also meet
.5			Synchronous,	PIC16C6X	15	-	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16LC6X	25	-	—	ns	-
			Asynchronous	PIC16 C 6X	30	-	—	ns	
			-	PIC16 LC 6X	50	-	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	Prescaler = 1	0.5TCY + 20	-	—	ns	Must also meet
		Synchronous,		PIC16 C 6X	15	—	—	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	-	—	ns	
			Asynchronous	PIC16 C 6X	30	—	—	ns	
				PIC16 LC 6X	50	—	—	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	<u>Greater of:</u> 30 OR <u>TCY + 40</u> N	-	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	<u>Greater of:</u> 50 OR <u>TCY + 40</u> N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	-	—	ns	
				PIC16 LC 6X	100	-	—	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b		0	DC	-	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tir	ner increment	2Tosc	_	7Tosc	—	

* These parameters are characterized but not tested.

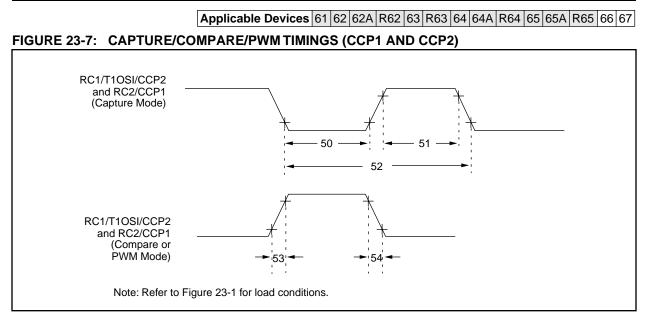


TABLE 23-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	-	_	ns	
		input low time With Presca		PIC16 C 66/67	10	-	-	ns	
				PIC16 LC 66/67	20	-		ns	
51*	51* TccH CCP1 and CCP2 No Pres		No Prescaler	•	0.5Tcy + 20	-		ns	
	input high time	With Prescaler	PIC16 C 66/67	10	-	-	ns		
				PIC16LC66/67	20	-		ns	
52*	TccP	CCP1 and CCP2 ir	nput period		<u>3Tcy + 40</u> N	-		ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 and CCP2 c	output rise time	PIC16 C 66/67	—	10	25	ns	
				PIC16 LC 66/67	_	25	45	ns	
54*	TccF	CCP1 and CCP2 c	output fall time	PIC16 C 66/67	_	10	25	ns	
				PIC16LC66/67	_	25	45	ns	

* These parameters are characterized but not tested.

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FIGURE 23-8: PARALLEL SLAVE PORT TIMING (PIC16C67)

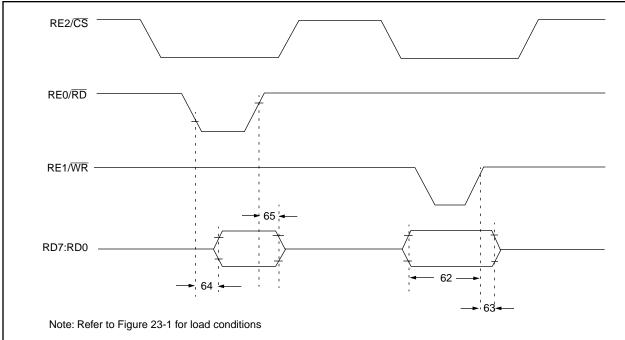
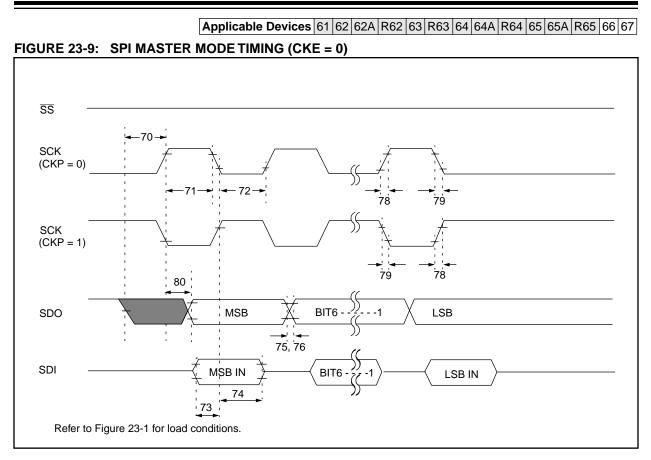


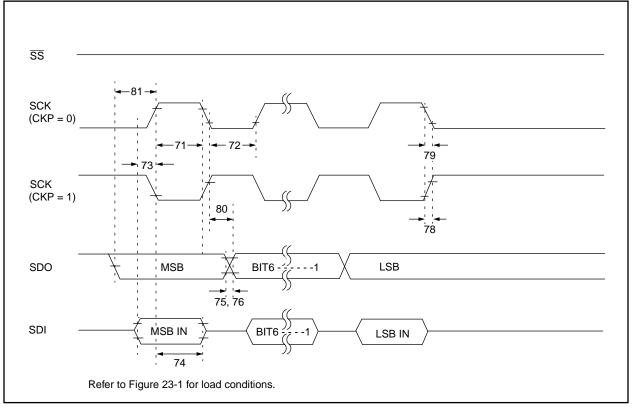
TABLE 23-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C67)

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before \overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} (setup time)		20	_	-	ns	
				25	_	-	ns	Extended Range Only
63*	TwrH2dtl	\overline{WR}^{\uparrow} or \overline{CS}^{\uparrow} to data–in invalid (hold	PIC16 C 67	20	—	_	ns	
		time)	PIC16 LC 67	35	_	_	ns	
64	TrdL2dtV	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid	$\overline{RD}\downarrow$ and $\overline{CS}\downarrow$ to data–out valid		_	80	ns	
				-	_	90	ns	Extended Range Only
65*	TrdH2dtl	\overline{RD} or \overline{CS} to data-out invalid		10	_	30	ns	

* These parameters are characterized but not tested.







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FIGURE 23-11: SPI SLAVE MODE TIMING (CKE = 0)

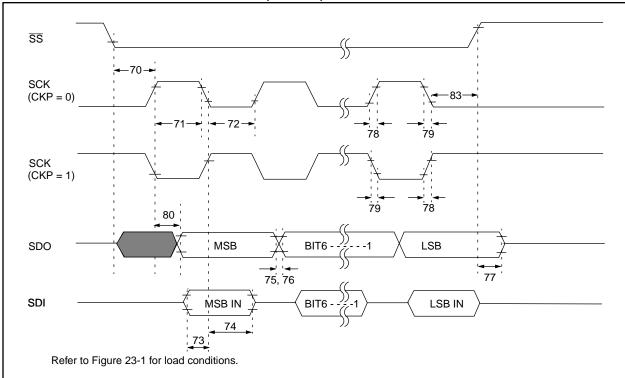
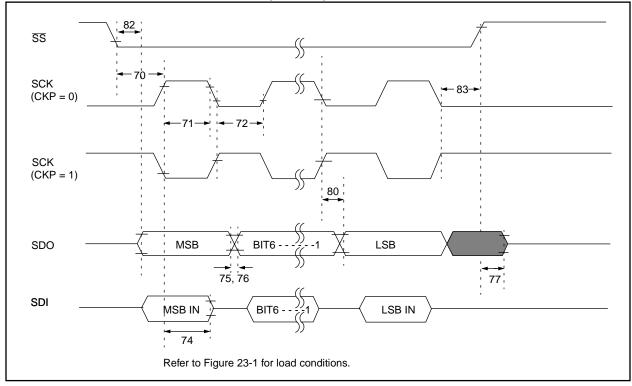


FIGURE 23-12: SPI SLAVE MODE TIMING (CKE = 1)



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Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK \downarrow or SCK \uparrow input	Тсү	—	_	ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	100	—	—	ns	
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	100	_	—	ns	
75*	TdoR	SDO data output rise time	—	10	25	ns	
76*	TdoF	SDO data output fall time	_	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)	_	10	25	ns	
79*	TscF	SCK output fall time (master mode)	_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	—	—	50	ns	
81*	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge	Тсү	_	_	ns	
82*	TssL2doV	SDO data output valid after $\overline{SS}\downarrow$ edge	—	—	50	ns	
83*	TscH2ssH, TscL2ssH	SS ↑ after SCK edge	1.5Tcy + 40	—	_	ns	

TABLE 23-8: SPI MODE REQUIREMENTS

* These parameters are characterized but not tested.

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FIGURE 23-13: I²C BUS START/STOP BITS TIMING

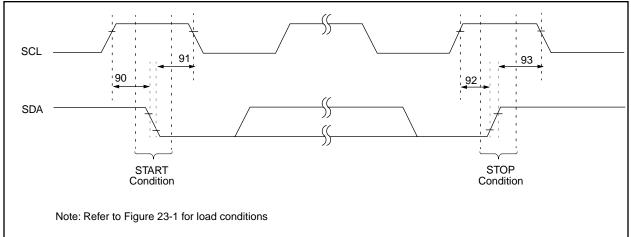
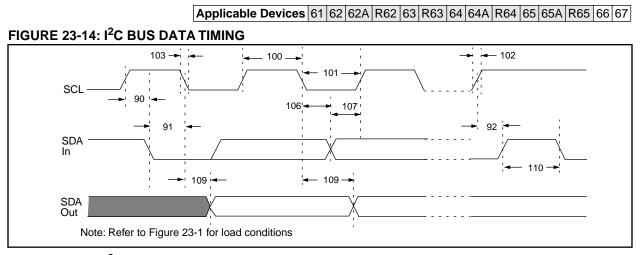


TABLE 23-9: I ² C BUS START/STOP BITS REQUIREMENT
--

Parameter No.	Sym	Characteristic		Min	Тур	Мах	Units	Conditions
90*	TSU:STA	START condition	100 kHz mode	4700	—	—	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	—	—	115	condition
91*	THD:STA	START condition	100 kHz mode	4000	—	—	ns	After this period the first clock
		Hold time	400 kHz mode	600	—	—	115	pulse is generated
92*	Tsu:sto	STOP condition	100 kHz mode	4700	—	—		
		Setup time	400 kHz mode	600	—	—	ns	
93	THD:STO	STOP condition	100 kHz mode	4000	—	—		
		Hold time	400 kHz mode	600	—	—	ns	

These parameters are characterized but not tested.



Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	Thigh	Clock high time	100 kHz mode	4.0	_	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	0.6	_	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μs	Device must operate at a min- imum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a min- imum of 10 MHz
			SSP Module	1.5TCY	—		
102*	Tr	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	Tf	SDA and SCL fall time	100 kHz mode		300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	TSU:STA	START condition	100 kHz mode	4.7	—	μs	Only relevant for repeated
		setup time	400 kHz mode	0.6	—	μs	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	—	μs	After this period the first clock
		time	400 kHz mode	0.6	—	μs	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	Note 2
			400 kHz mode	100	—	ns	
92*	TSU:STO	STOP condition setup	100 kHz mode	4.7	_	μs	
		time	400 kHz mode	0.6	—	μs	
109*	ΤΑΑ	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode	—		ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free
			400 kHz mode	1.3	—	μs	before a new transmission car start
	Cb	Bus capacitive loading		—	400	pF	

TABLE 23-10: I²C BUS DATA REQUIREMENTS

* These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

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FIGURE 23-15: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

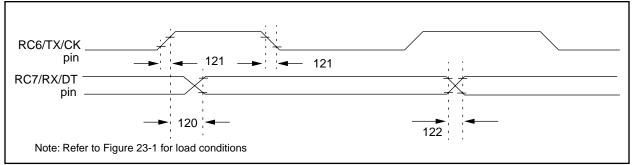


TABLE 23-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Мах	Units	Conditions
120*	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 C 66/67	—	—	80	ns	
		Clock high to data out valid	PIC16 LC 66/67	_	—	100	ns	
121*	Tckrf	Clock out rise time and fall time	PIC16 C 66/67	—	—	45	ns	
		(Master Mode)	PIC16 LC 66/67	_	—	50	ns	
122*	Tdtrf	Data out rise time and fall time	PIC16 C 66/67	_	—	45	ns	
			PIC16LC66/67		—	50	ns	

* These parameters are characterized but not tested.

†: Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 23-16: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

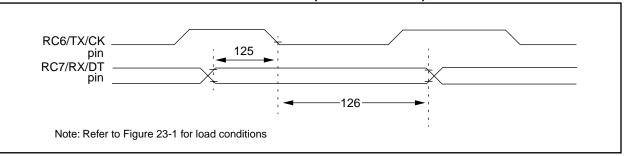


TABLE 23-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
125*	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK \downarrow (DT setup time)	15	_	_	ns	
126*	TckL2dtl	Data hold after CK \downarrow (DT hold time)	15	—	_	ns	

* These parameters are characterized but not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

24.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES FOR: PIC16C62, PIC16C62A, PIC16CR62, PIC16C63, PIC16C64, PIC16C64A, PIC16CR64, PIC16C65A, PIC16C66, PIC16C67

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

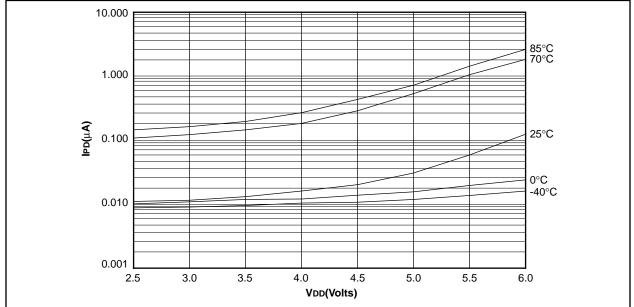
In some graphs or tables the data presented are outside specified operating range (i.e., outside specified VDD range). This is for information only and devices are guaranteed to operate properly only within the specified range.

Note: The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution at, 25°C, while 'max' or 'min' represents (mean + 3σ) and (mean - 3σ) respectively where σ is standard deviation.



35 30 25 20 IPD(nA) 15 10 5 0 2.5 3.0 3.5 4.0 4.5 5.0 6.0 5.5 VDD(Volts)





Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

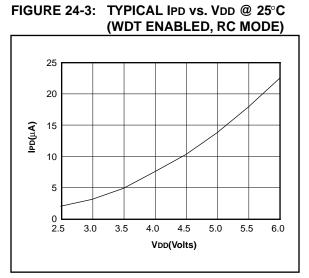
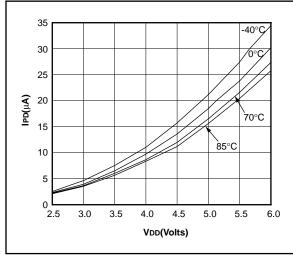


FIGURE 24-4: MAXIMUM IPD vs. VDD (WDT ENABLED, RC MODE)





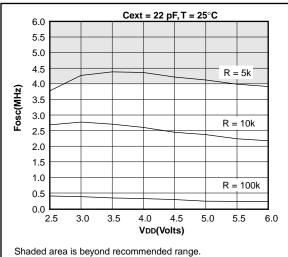


FIGURE 24-6: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

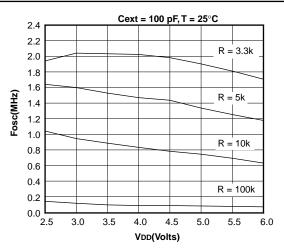
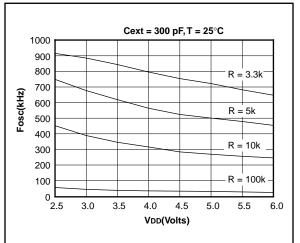


FIGURE 24-7: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 24-8: TYPICAL IPD vs. VDD BROWN-OUT DETECT ENABLED (RC

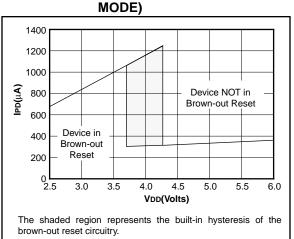
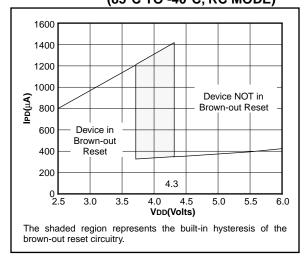
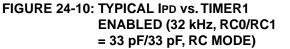


FIGURE 24-9: MAXIMUM IPD vs. VDD BROWN-OUT DETECT ENABLED (85°C TO -40°C, RC MODE)





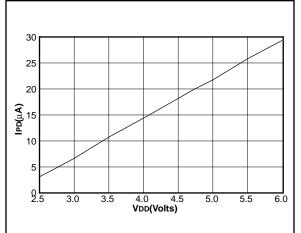
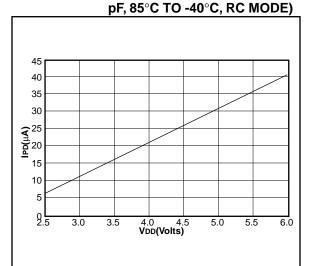


FIGURE 24-11: MAXIMUM IPD vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33



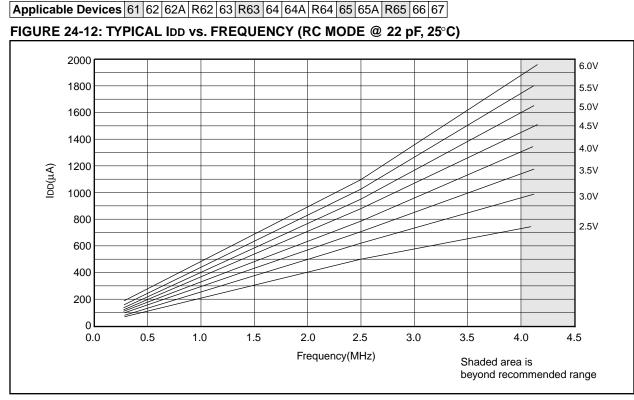
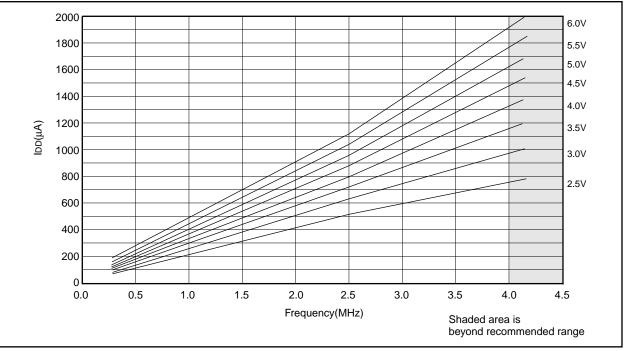


FIGURE 24-13: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 22 pF, -40°C TO 85°C)



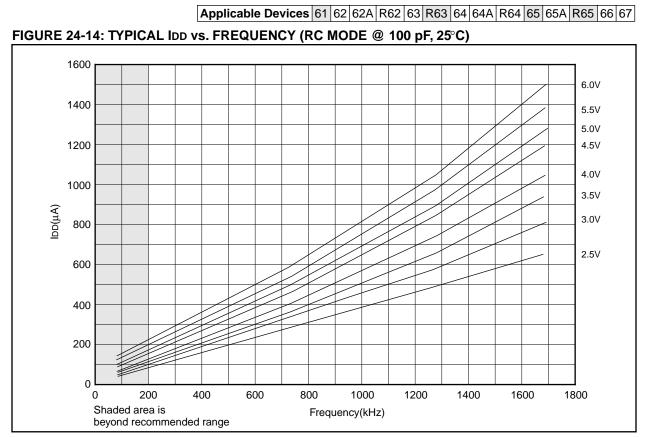
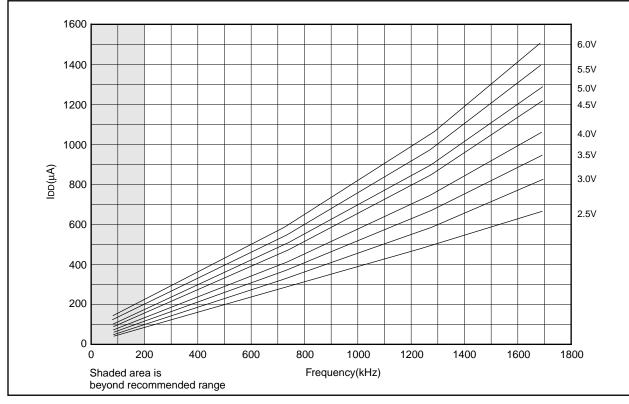


FIGURE 24-15: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 100 pF, -40°C TO 85°C)



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

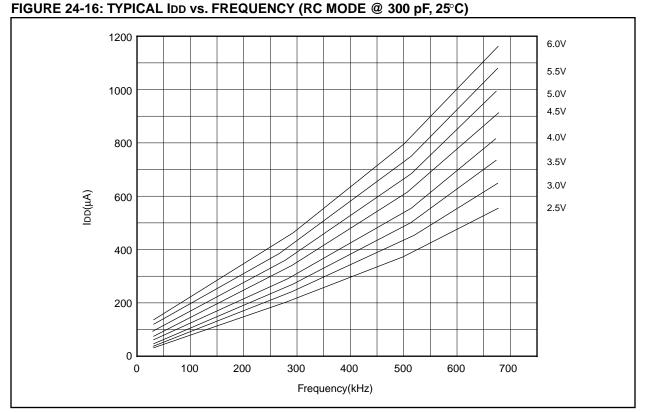
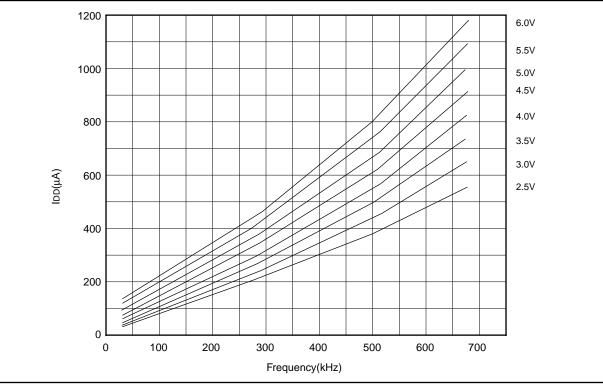


FIGURE 24-17: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 300 pF, -40°C TO 85°C)



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

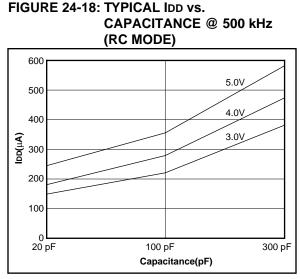


TABLE 24-1:RC OSCILLATORFREQUENCIES

Cext	Rext	Average				
Cexi	Rexi	Fosc @ 5V, 25°C				
22 pF	5k	4.12 MHz	± 1.4%			
	10k	2.35 MHz	± 1.4%			
	100k	268 kHz	± 1.1%			
100 pF	3.3k	1.80 MHz	± 1.0%			
	5k	1.27 MHz	± 1.0%			
	10k	688 kHz	± 1.2%			
	100k	77.2 kHz	± 1.0%			
300 pF	3.3k	707 kHz	± 1.4%			
	5k	501 kHz	± 1.2%			
	10k	269 kHz	± 1.6%			
	100k	28.3 kHz	± 1.1%			

The percentage variation indicated here is part to part variation due to normal process distribution. The variation indicated is ± 3 standard deviation from average value for VDD = 5V.

FIGURE 24-19: TRANSCONDUCTANCE(gm) OF HS OSCILLATOR vs. VDD

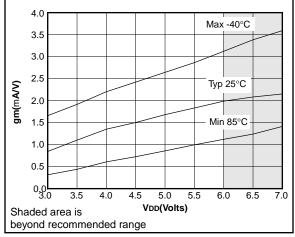


FIGURE 24-20: TRANSCONDUCTANCE(gm) OF LP OSCILLATOR vs. VDD

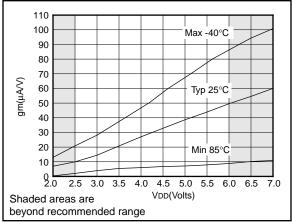
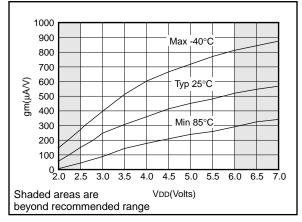
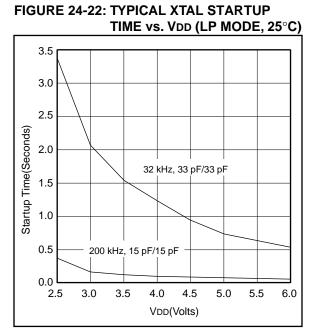
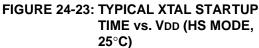


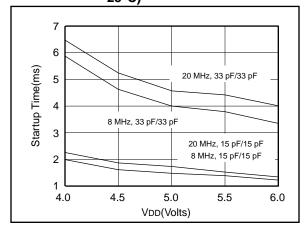
FIGURE 24-21: TRANSCONDUCTANCE(gm) OF XT OSCILLATOR vs. VDD

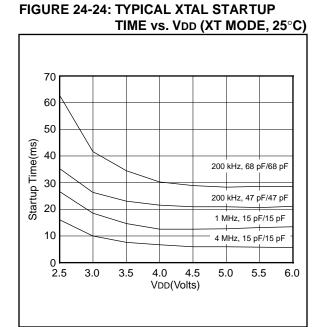


Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67



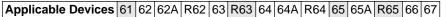






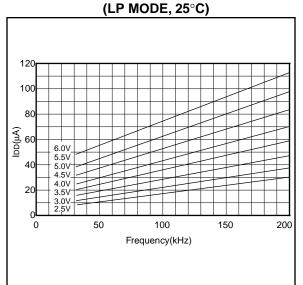


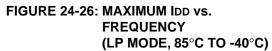
Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2		
LP	32 kHz 33 pF		33 pF		
	200 kHz	15 pF	15 pF		
ХТ	200 kHz	47-68 pF	47-68 pF		
	1 MHz	15 pF	15 pF		
	4 MHz	15 pF	15 pF		
HS	4 MHz	15 pF	15 pF		
	8 MHz	15-33 pF	15-33 pF		
	20 MHz	15-33 pF	15-33 pF		
Crystals Used	-				
32 kHz	Epson C-00)1R32.768K-A	± 20 PPM		
200 kHz	STD XTL 2	± 20 PPM			
1 MHz	ECS ECS-1	± 50 PPM			
4 MHz	ECS ECS-4	± 50 PPM			
8 MHz	EPSON CA	± 30 PPM			
20 MHz	EPSON CA	-301 20.000M-C	± 30 PPM		

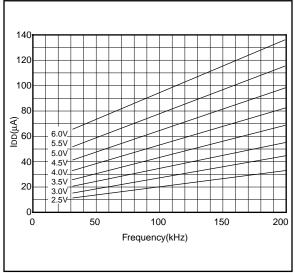












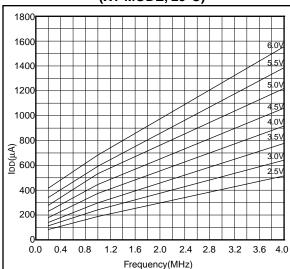
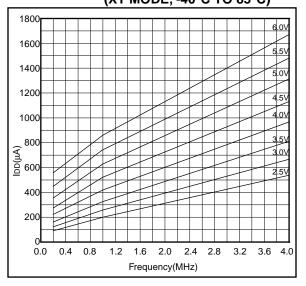
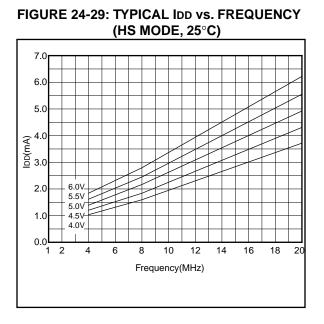
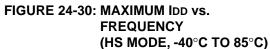


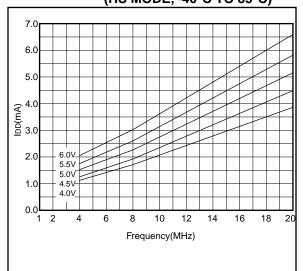
FIGURE 24-28: MAXIMUM IDD vs. FREQUENCY (XT MODE, -40°C TO 85°C)



Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67



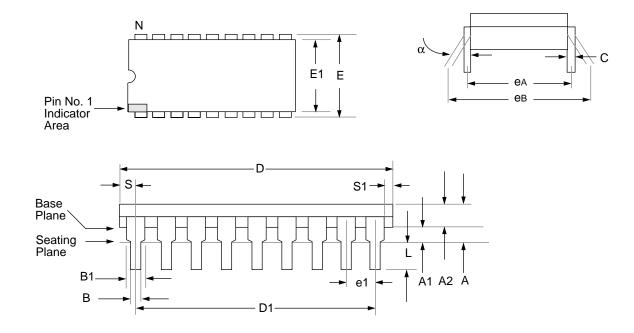




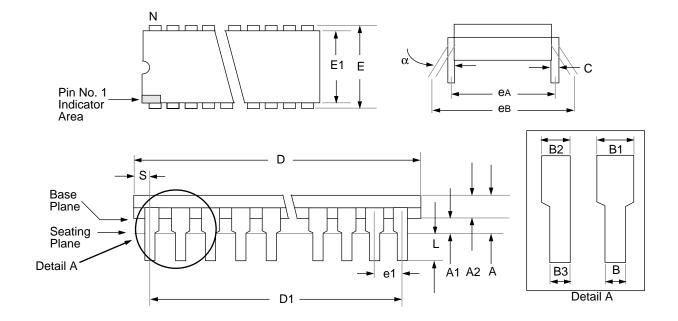
Data based on matrix samples. See first page of this section for details.

25.0 PACKAGING INFORMATION

25.1 <u>18-Lead Plastic Dual In-line (300 mil) (P)</u>



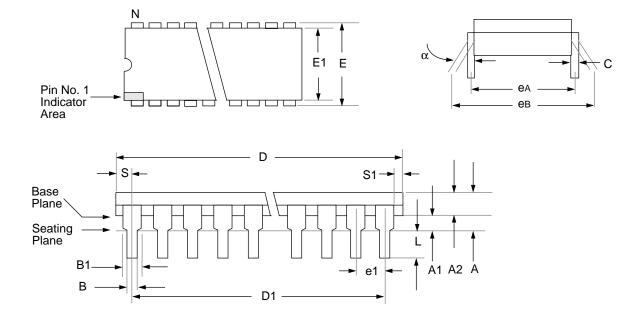
	Package Group: Plastic Dual In-Line (PLA)								
		Millimeters			Inches				
Symbol	Min	Max	Notes	Min	Max	Notes			
α	0°	10°		0°	10°				
А	_	4.064		_	0.160				
A1	0.381	_		0.015	_				
A2	3.048	3.810		0.120	0.150				
В	0.355	0.559		0.014	0.022				
B1	1.524	1.524	Reference	0.060	0.060	Reference			
С	0.203	0.381	Typical	0.008	0.015	Typical			
D	22.479	23.495		0.885	0.925				
D1	20.320	20.320	Reference	0.800	0.800	Reference			
E	7.620	8.255		0.300	0.325				
E1	6.096	7.112		0.240	0.280				
e1	2.489	2.591	Typical	0.098	0.102	Typical			
eA	7.620	7.620	Reference	0.300	0.300	Reference			
eB	7.874	9.906		0.310	0.390				
L	3.048	3.556		0.120	0.140				
N	18	18		18	18				
S	0.889	_		0.035	_				
S1	0.127	_		0.005	_				



25.2 28-Lead Plastic Dual In-line (300 mil) (SP)

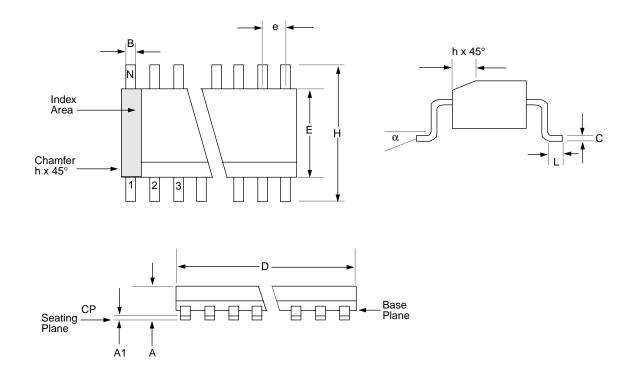
		Package Gro	oup: Plastic Dual	In-Line (PLA)			
		Millimeters			Inches		
Symbol	Min	Мах	Notes	Min	Max	Notes	
α	0°	10°		0°	10°		
A	3.632	4.572		0.143	0.180		
A1	0.381	_		0.015	_		
A2	3.175	3.556		0.125	0.140		
В	0.406	0.559		0.016	0.022		
B1	1.016	1.651	Typical	0.040	0.065	Typical	
B2	0.762	1.016	4 places	0.030	0.040	4 places	
B3	0.203	0.508	4 places	0.008	0.020	4 places	
С	0.203	0.331	Typical	0.008	0.013	Typical	
D	34.163	35.179		1.385	1.395		
D1	33.020	33.020	Reference	1.300	1.300	Reference	
E	7.874	8.382		0.310	0.330		
E1	7.112	7.493		0.280	0.295		
e1	2.540	2.540	Typical	0.100	0.100	Typical	
eA	7.874	7.874	Reference	0.310	0.310	Reference	
eB	8.128	9.652		0.320	0.380		
L	3.175	3.683		0.125	0.145		
Ν	28	28		28	28		
S	0.584	1.220		0.023	0.048		

25.3 <u>40-Lead Plastic Dual In-line (600 mil) (P)</u>

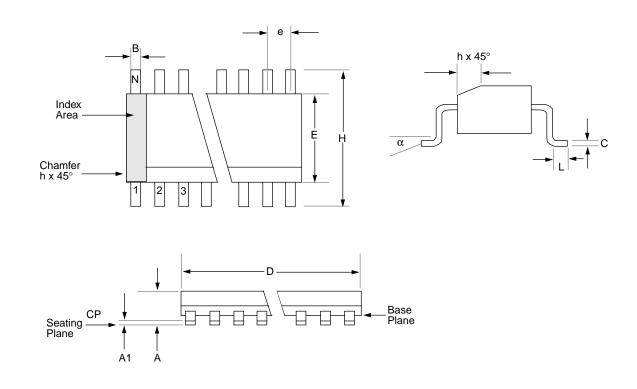


		Package Gro	up: Plastic Dual	In-Line (PLA)			
		Millimeters			Inches		
Symbol	Min	Max	Notes	Min	Max	Notes	
α	0°	10°		0°	10°		
А	_	5.080		_	0.200		
A1	0.381	_		0.015	_		
A2	3.175	4.064		0.125	0.160		
В	0.355	0.559		0.014	0.022		
B1	1.270	1.778	Typical	0.050	0.070	Typical	
С	0.203	0.381	Typical	0.008	0.015	Typical	
D	51.181	52.197		2.015	2.055		
D1	48.260	48.260	Reference	1.900	1.900	Reference	
E	15.240	15.875		0.600	0.625		
E1	13.462	13.970		0.530	0.550		
e1	2.489	2.591	Typical	0.098	0.102	Typical	
eA	15.240	15.240	Reference	0.600	0.600	Reference	
eB	15.240	17.272		0.600	0.680		
L	2.921	3.683		0.115	0.145		
N	40	40		40	40		
S	1.270	_		0.050	_		
S1	0.508	_		0.020	_		

25.4 <u>18-Lead Plastic Surface Mount (SOIC - Wide, 300 mil Body) (SO)</u>

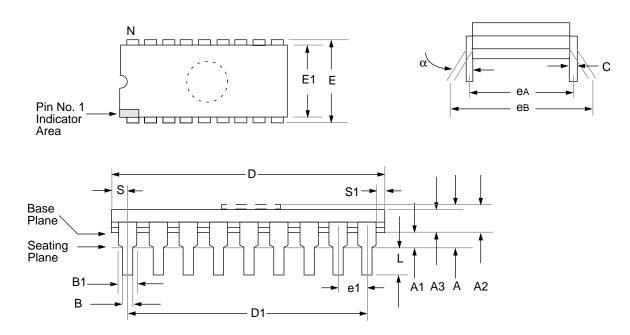


	Package Group: Plastic SOIC (SO)									
		Millimeters			Inches					
Symbol	Min	Мах	Notes	Min	Мах	Notes				
α	0°	8°		0°	8°					
А	2.362	2.642		0.093	0.104					
A1	0.101	0.300		0.004	0.012					
В	0.355	0.483		0.014	0.019					
С	0.241	0.318		0.009	0.013					
D	11.353	11.735		0.447	0.462					
E	7.416	7.595		0.292	0.299					
е	1.270	1.270	Reference	0.050	0.050	Reference				
Н	10.007	10.643		0.394	0.419					
h	0.381	0.762		0.015	0.030					
L	0.406	1.143		0.016	0.045					
Ν	18	18		18	18					
CP	_	0.102		_	0.004					



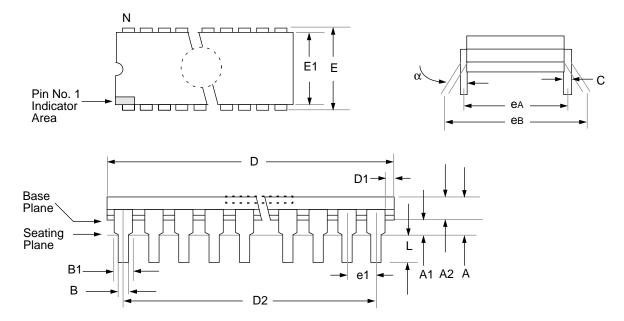
25.5 28-Lead Plastic Surface Mount (SOIC - Wide, 300 mil Body) (SO)

	Package Group: Plastic SOIC (SO)									
		Millimeters			Inches					
Symbol	Min	Max	Notes	Min	Max	Notes				
α	0°	8 °		0°	8 °					
А	2.362	2.642		0.093	0.104					
A1	0.101	0.300		0.004	0.012					
В	0.355	0.483		0.014	0.019					
С	0.241	0.318		0.009	0.013					
D	17.703	18.085		0.697	0.712					
E	7.416	7.595		0.292	0.299					
е	1.270	1.270	Typical	0.050	0.050	Typical				
Н	10.007	10.643		0.394	0.419					
h	0.381	0.762		0.015	0.030					
L	0.406	1.143		0.016	0.045					
N	28	28		28	28					
CP	_	0.102		_	0.004					



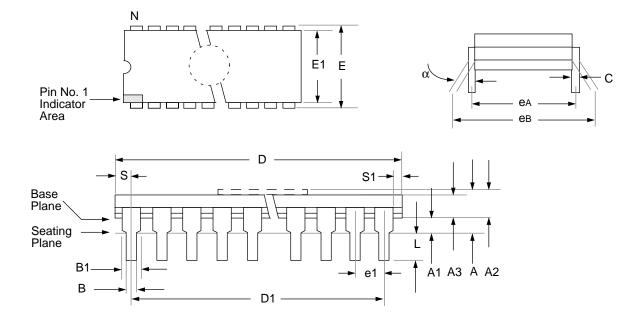
25.6 18-Lead Ceramic CERDIP Dual In-line with Window (300 mil) (JW)

	Pa	ckage Group: (Ceramic CERDIP	Dual In-Line (C	DP)	
		Millimeters		Inches		
Symbol	Min	Мах	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
А	_	5.080			0.200	
A1	0.381	1.778		0.015	0.070	
A2	3.810	4.699		0.150	0.185	
A3	3.810	4.445		0.150	0.175	
В	0.355	0.585		0.014	0.023	
B1	1.270	1.651	Typical	0.050	0.065	Typical
С	0.203	0.381	Typical	0.008	0.015	Typical
D	22.352	23.622		0.880	0.930	
D1	20.320	20.320	Reference	0.800	0.800	Reference
E	7.620	8.382		0.300	0.330	
E1	5.588	7.874		0.220	0.310	
e1	2.540	2.540	Reference	0.100	0.100	Reference
eA	7.366	8.128	Typical	0.290	0.320	Typical
eB	7.620	10.160		0.300	0.400	
L	3.175	3.810		0.125	0.150	
Ν	18	18		18	18	
S	0.508	1.397		0.020	0.055	
S1	0.381	1.270		0.015	0.050	



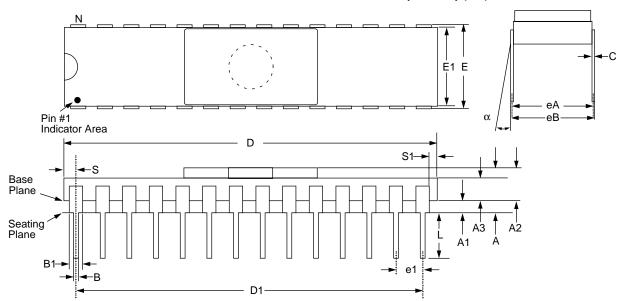
25.7 28-Lead Ceramic CERDIP Dual In-line with Window (300 mil)) (JW)

	Pa	ckage Group: (Ceramic CERDIP	Dual In-Line (C	DP)		
		Millimeters			Inches		
Symbol	Min	Max	Notes	Min	Max	Notes	
α	0°	10°		0°	10°		
А	3.30	5.84		.130	0.230		
A1	0.38	_		0.015			
A2	2.92	4.95		0.115	0.195		
В	0.35	0.58		0.014	0.023		
B1	1.14	1.78	Typical	0.045	0.070	Typical	
С	0.20	0.38	Typical	0.008	0.015	Typical	
D	34.54	37.72		1.360	1.485		
D2	32.97	33.07	Reference	1.298	1.302	Reference	
E	7.62	8.25		0.300	0.325		
E1	6.10	7.87		0.240	0.310		
е	2.54	2.54	Typical	0.100	0.100	Typical	
eA	7.62	7.62	Reference	0.300	0.300	Reference	
eB	—	11.43			0.450		
L	2.92	5.08		0.115	0.200		
Ν	28	28		28	28		
D1	0.13	_		0.005	—		



25.8 40-Lead Ceramic CERDIP Dual In-line with Window (600 mil) (JW)

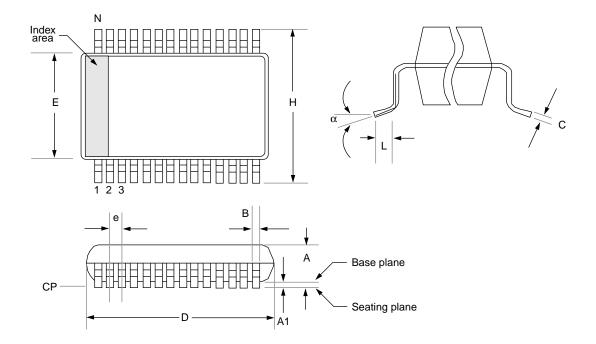
	Pa	ckage Group: (Ceramic CERDIP	Dual In-Line (C	DP)	
		Millimeters		Inches		
Symbol	Min	Мах	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
А	4.318	5.715		0.170	0.225	
A1	0.381	1.778		0.015	0.070	
A2	3.810	4.699		0.150	0.185	
A3	3.810	4.445		0.150	0.175	
В	0.355	0.585		0.014	0.023	
B1	1.270	1.651	Typical	0.050	0.065	Typical
С	0.203	0.381	Typical	0.008	0.015	Typical
D	51.435	52.705		2.025	2.075	
D1	48.260	48.260	Reference	1.900	1.900	Reference
E	15.240	15.875		0.600	0.625	
E1	12.954	15.240		0.510	0.600	
e1	2.540	2.540	Reference	0.100	0.100	Reference
eA	14.986	16.002	Typical	0.590	0.630	Typical
eB	15.240	18.034		0.600	0.710	
L	3.175	3.810		0.125	0.150	
N	40	40		40	40	
S	1.016	2.286		0.040	0.090	
S1	0.381	1.778		0.015	0.070	



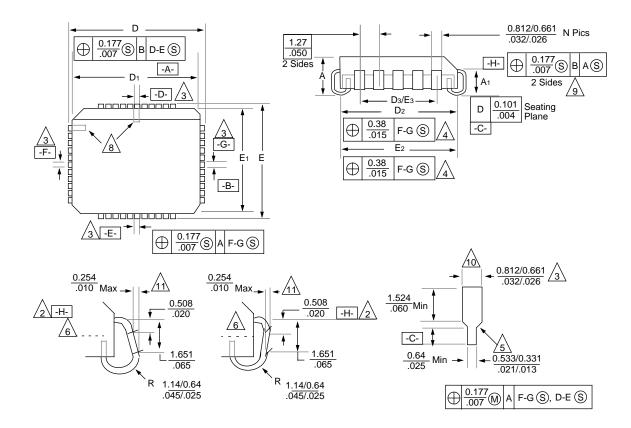
25.9 28-Lead Ceramic Side Brazed Dual In-Line with Window (300 mil) (JW)

	Package Group: Ceramic Side Brazed Dual In-Line (CER)								
O maked		Millimeters			Inches				
Symbol	Min	Max	Notes	Min	Max	Notes			
α	0°	10°		0 °	10°				
А	3.937	5.030		0.155	0.198				
A1	1.016	1.524		0.040	0.060				
A2	2.921	3.506		0.115	0.138				
A3	1.930	2.388		0.076	0.094				
В	0.406	0.508		0.016	0.020				
B1	1.219	1.321	Typical	0.048	0.052				
С	0.228	0.305	Typical	0.009	0.012				
D	35.204	35.916		1.386	1.414				
D1	32.893	33.147	Reference	1.295	1.305				
E	7.620	8.128		0.300	0.320				
E1	7.366	7.620		0.290	0.300				
e1	2.413	2.667	Typical	0.095	0.105				
eA	7.366	7.874	Reference	0.290	0.310				
eB	7.594	8.179		0.299	0.322				
L	3.302	4.064		0.130	0.160				
Ν	28	28		28	28				
S	1.143	1.397		0.045	0.055				
S1	0.533	0.737		0.021	0.029				





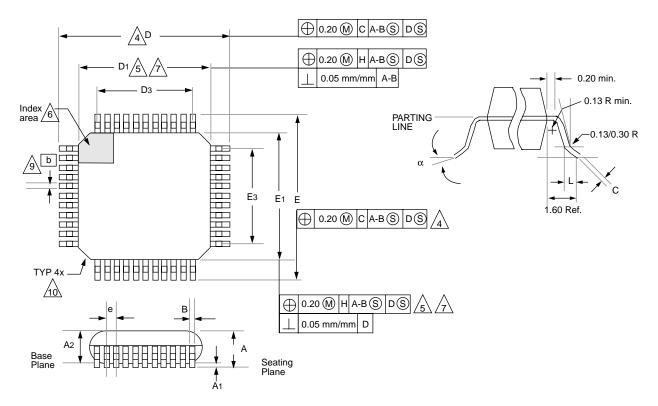
	Package Group: Plastic SSOP									
		Millimeters			Inches					
Symbol	Min	Max	Notes	Min	Max	Notes				
α	0°	8°		0°	8°					
А	1.730	1.990		0.068	0.078					
A1	0.050	0.210		0.002	0.008					
В	0.250	0.380		0.010	0.015					
С	0.130	0.220		0.005	0.009					
D	10.070	10.330		0.396	0.407					
E	5.200	5.380		0.205	0.212					
е	0.650	0.650	Reference	0.026	0.026	Reference				
Н	7.650	7.900		0.301	0.311					
L	0.550	0.950		0.022	0.037					
N	28	28		28	28					
CP	-	0.102		-	0.004					



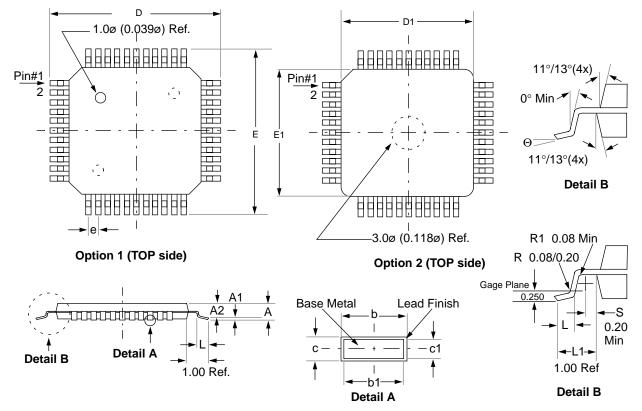
25.11 44-Lead Plastic Leaded Chip Carrier (Square) (PLCC)

	Package Group: Plastic Leaded Chip Carrier (PLCC)								
		Millimeters			Inches				
Symbol	Min	Max	Notes	Min	Max	Notes			
А	4.191	4.572		0.165	0.180				
A1	2.413	2.921		0.095	0.115				
D	17.399	17.653		0.685	0.695				
D1	16.510	16.663		0.650	0.656				
D2	15.494	16.002		0.610	0.630				
D3	12.700	12.700	Reference	0.500	0.500	Reference			
E	17.399	17.653		0.685	0.695				
E1	16.510	16.663		0.650	0.656				
E2	15.494	16.002		0.610	0.630				
E3	12.700	12.700	Reference	0.500	0.500	Reference			
Ν	44	44		44	44				
CP	_	0.102		_	0.004				
LT	0.203	0.381		0.008	0.015				

25.12 44-Lead Plastic Surface Mount (MQFP 10x10 mm Body 1.6/0.15 mm Lead Form) (PQ)



	Package Group: Plastic MQFP									
		Millimeters			Inches					
Symbol	Min	Мах	Notes	Min	Мах	Notes				
α	0°	7 °		0°	7 °					
А	2.000	2.350		0.078	0.093					
A1	0.050	0.250		0.002	0.010					
A2	1.950	2.100		0.768	0.083					
b	0.300	0.450	Typical	0.011	0.018	Typical				
С	0.150	0.180		0.006	0.007					
D	12.950	13.450		0.510	0.530					
D1	9.900	10.100		0.390	0.398					
D3	8.000	8.000	Reference	0.315	0.315	Reference				
E	12.950	13.450		0.510	0.530					
E1	9.900	10.100		0.390	0.398					
E3	8.000	8.000	Reference	0.315	0.315	Reference				
е	0.800	0.800		0.031	0.032					
L	0.730	1.030		0.028	0.041					
N	44	44		44	44					
CP	0.102	_		0.004	_					



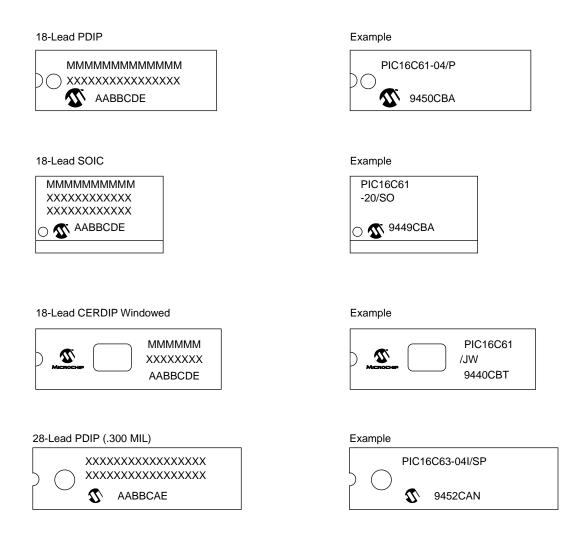
25.13 44-Lead Plastic Surface Mount (TQFP 10x10 mm Body 1.0/0.10 mm Lead Form) (TQ)

Package Group: Plastic TQFP							
	Millimeters			Inches			
Symbol	Min	Мах	Notes	Min	Max	Notes	
А	1.00	1.20		0.039	0.047		
A1	0.05	0.15		0.002	0.006		
A2	0.95	1.05		0.037	0.041		
D	11.75	12.25		0.463	0.482		
D1	9.90	10.10		0.390	0.398		
E	11.75	12.25		0.463	0.482		
E1	9.90	10.10		0.390	0.398		
L	0.45	0.75		0.018	0.030		
е	0.80	BSC		0.031	BSC		
b	0.30	0.45		0.012	0.018		
b1	0.30	0.40		0.012	0.016		
С	0.09	0.20		0.004	0.008		
c1	0.09	0.16		0.004	0.006		
N	44	44		44	44		
Θ	0°	7 °		0°	7 °		

Note 1: Dimensions D1 and E1 do not include mold protrusion. Allowable mold protrusion is 0.25m/m (0.010") per side. D1 and E1 dimensions including mold mismatch.

- Dimension "b" does not include Dambar protrusion, allowable Dambar protrusion shall be 0.08m/m (0.003")max.
- 3: This outline conforms to JEDEC MS-026.

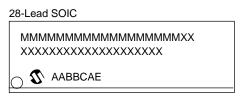
25.14 Package Marking Information



Legend:	MMM	Microchip part number information	
	XXX	Customer specific information*	
	AA	Year code (last 2 digits of calender year)	
	BB	Week code (week of January 1 is week '01')	
	С	Facility code of the plant at which wafer is manufactured. C = Chandler, Arizona, U.S.A. S = Tempe, Arizona, U.S.A.	
	D ₁	Mask revision number for microcontroller	
	D ₂	Mask revision number for EEPROM	
	E	Assembly code of the plant or country of origin in which part was assembled.	
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.		be carried over to the next line thus limiting the number of	

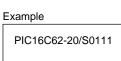
* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

Package Marking Information (Cont'd)



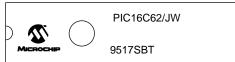
XXXXXXXXXXXXXXXX XXXXXXXXXXXXXXXX

AABBCDE



🕥 9515SBA \bigcirc

Example



28-Lead Side Brazed Skinny Windowed

28-Lead CERDIP Skinny Windowed

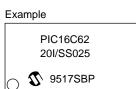




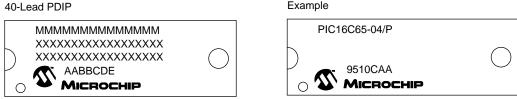


28-Lead SSOP





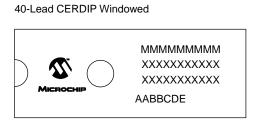
Example



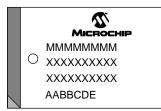
Legend:	MMM	Microchip part number information
	XXX	Customer specific information*
	AA	Year code (last 2 digits of calender year)
	BB	Week code (week of January 1 is week '01')
	С	Facility code of the plant at which wafer is manufactured. C = Chandler, Arizona, U.S.A. S = Tempe, Arizona, U.S.A.
	D ₁ E	Mask revision number for microcontroller Assembly code of the plant or country of origin in which part was assembled.
Note:	line, it will b	t the full Microchip part number cannot be marked on one be carried over to the next line thus limiting the number of naracters for customer specific information.

Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

Package Marking Information (Cont'd)



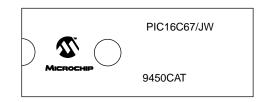
44-Lead PLCC



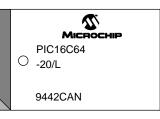
44-Lead MQFP



Example



Example



Example



Example



₫ 🔊	∞
MMMMMMM XXXXXXXXX XXXXXXXXX	PIC16C64A -10/TQ
⊖ AABBCDE	

Legend:	MMM	Microchip part number information
	XXX	Customer specific information*
	AA	Year code (last 2 digits of calender year)
	BB	Week code (week of January 1 is week '01')
	С	Facility code of the plant at which wafer is manufactured. C = Chandler, Arizona, U.S.A. S = Tempe, Arizona, U.S.A.
	D ₁ E	Mask revision number for microcontroller Assembly code of the plant or country of origin in which part was assembled.
Note:	line, it will b	t the full Microchip part number cannot be marked on one be carried over to the next line thus limiting the number of naracters for customer specific information.

* Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

APPENDIX A: MODIFICATIONS

The following are the list of modifications over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14-bits. This allows larger page sizes both in program memory (2K now as opposed to 512 before) and register file (128 bytes now versus 32 bytes before).
- 2. A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from STATUS register.
- 3. Data memory paging is redefined slightly. STA-TUS register is modified.
- Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.
 Two instructions TRIS and OPTION are being phased out although they are kept for compati-bility with PIC16C5X.
- 5. OPTION and TRIS registers are made addressable.
- 6. Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to 8 deep.
- 8. Reset vector is changed to 0000h.
- Reset of all registers is revisited. Five different reset (and wake-up) types are recognized. Registers are reset differently.
- 10. Wake-up from SLEEP through interrupt is added.
- 11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT), are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt on change feature.
- 13. Timer0 pin is also a port pin (RA4/T0CKI) now.
- 14. FSR is made a full 8-bit register.
- 15. "In-circuit programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, Vss, VPP, RB6 (clock) and RB7 (data in/out).
- 16. Power Control register (PCON) is added with a Power-on Reset status bit (POR).(Not on the PIC16C61).
- Brown-out Reset has been added to the following devices: PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/

67.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16CXX, the user should take the following steps:

- 1. Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
- 2. Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- 3. Eliminate any data memory page switching. Redefine data variables to reallocate them.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change reset vector to 0000h.

APPENDIX C: WHAT'S NEW

Added PIC16CR63 and PIC16CR65 devices.

Added PIC16C66 and PIC16C67 devices. The PIC16C66/67 devices have 368 bytes of data memory distributed in 4 banks and 8K of program memory in 4 pages. These two devices have an enhanced SPI that supports both clock phase and polarity. The USART has been enhanced.

When upgrading to the PIC16C66/67 please note that the upper 16 bytes of data memory in banks 1,2, and 3 are mapped into bank 0. This may require relocation of data memory usage in the user application code.

Q-cycles for instruction execution were added to Section 14.0 Instruction Set Summary.

APPENDIX D: WHAT'S CHANGED

Minor changes, spelling and grammatical changes.

Divided SPI section into SPI for the PIC16C66/67 (Section 11.3) and SPI for all other devices (Section 11.2).

Added the following note for the USART. This applies to all devices except the PIC16C66 and PIC16C67.

For the PIC16C63/R63/65/65A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

APPENDIX E: PIC16/17 MICROCONTROLLERS

E.1 PIC12CXXX Family of Devices

		PIC12C508	PIC12C509	PIC12C671	PIC12C672
Clock	Maximum Frequency of Operation (MHz)	4	4	4	4
Momony	EPROM Program Memory	512 x 12	1024 x 12	1024 x 14	2048 x 14
Memory	Data Memory (bytes)	25	41	128	128
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
Feripherais	A/D Converter (8-bit) Channels	—	—	4	4
	Wake-up from SLEEP on pin change	Yes	Yes	Yes	Yes
	I/O Pins	5	5	5	5
	Input Pins	1	1	1	1
Features	Internal Pull-ups	Yes	Yes	Yes	Yes
	Voltage Range (Volts)	2.5-5.5	2.5-5.5	2.5-5.5	2.5-5.5
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Number of Instructions	33	33	35	35
	Packages	8-pin DIP, SOIC	8-pin DIP, SOIC	8-pin DIP, SOIC	8-pin DIP, SOIC

All PIC12C5XX devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC12C5XX devices use serial programming with data pin GP1 and clock pin GP0.

E.2 PIC14C000 Family of Devices

		PIC14C000
Clock	Maximum Frequency of Operation (MHz)	20
	EPROM Program Memory (x14 words)	4К
Memory	Data Memory (bytes)	192
Memory	Timer Module(s)	TMR0 ADTMR
Peripherals	Serial Port(s) (SPI/I ² C, USART)	I ² C with SMBus Support
	Slope A/D Converter Channels	8 External; 6 Internal
	Interrupt Sources	11
	I/O Pins	22
	Voltage Range (Volts)	2.7-6.0
Features	In-Circuit Serial Programming	Yes
	Additional On-chip Features	Internal 4MHz Oscillator, Bandgap Reference, Temperature Sensor, Calibration Factors, Low Voltage Detector, SLEEP, HIBERNATE, Comparators with Programmable References (2)
	Packages	28-pin DIP (.300 mil), SOIC, SSOP

E.3 PIC16C15X Family of Devices

		PIC16C154	PIC16CR154	PIC16C156	PIC16CR156	PIC16C158	PIC16CR158
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x12 words)	512	—	1K	—	2К	—
Memory	ROM Program Memory (x12 words)	—	512	_	1K	—	2К
	RAM Data Memory (bytes)	25	25	25	25	73	73
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0
	I/O Pins	12	12	12	12	12	12
	Voltage Range (Volts)	3.0-5.5	2.5-5.5	3.0-5.5	2.5-5.5	3.0-5.5	2.5-5.5
Features	Number of Instructions	33	33	33	33	33	33
	Packages	18-pin DIP, SOIC; 20-pin SSOP					

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

E.4 PIC16C5X Family of Devices

		PIC16C52	PIC16C54	PIC16C54A	PIC16CR54A	PIC16C55	PIC16C56
Clock	Maximum Frequency of Operation (MHz)	4	20	20	20	20	20
	EPROM Program Memory (x12 words)	384	512	512	—	512	1K
Memory	ROM Program Memory (x12 words)	-	-	—	512	_	—
	RAM Data Memory (bytes)	25	25	25	25	24	25
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0
	I/O Pins	12	12	12	12	20	12
	Voltage Range (Volts)	2.5-6.25	2.5-6.25	2.0-6.25	2.0-6.25	2.5-6.25	2.5-6.25
Features	Number of Instructions	33	33	33	33	33	33
	Packages	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin DIP, SOIC, SSOP	18-pin DIP, SOIC; 20-pin SSOP

		PIC16C57	PIC16CR57B	PIC16C58A	PIC16CR58A
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20
	EPROM Program Memory (x12 words)	2К		2К	
Memory	ROM Program Memory (x12 words)	—	2K	—	2K
	RAM Data Memory (bytes)	72	72	73	73
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
	I/O Pins	20	20	12	12
	Voltage Range (Volts)	2.5-6.25	2.5-6.25	2.0-6.25	2.5-6.25
Features	Number of Instructions	33	33	33	33
	Packages	28-pin DIP, SOIC, SSOP	28-pin DIP, SOIC, SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer (except PIC16C52), selectable code protect and high I/O current capability.

E.5 PIC16C55X Family of Devices

		PIC16C554	PIC16C556 ⁽¹⁾	PIC16C558
Clock	Maximum Frequency of Operation (MHz)	20	20	20
Memory	EPROM Program Memory (x14 words)	512	1K	2K
wemory	Data Memory (bytes)	80	80	128
	Timer Module(s)	TMR0	TMR0	TMR0
Peripherals	Comparators(s)	—	—	—
	Internal Reference Voltage	—	—	—
	Interrupt Sources	3	3	3
	I/O Pins	13	13	13
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0
Features	Brown-out Reset	—	—	—
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C5XX Family devices use serial programming with clock pin RB6 and data pin RB7. Note 1: Please contact your local Microchip sales office for availability of these devices.

E.6 PIC16C62X and PIC16C64X Family of Devices

		PIC16C620	PIC16C621	PIC16C622	PIC16C642	PIC16C662
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20
Memory	EPROM Program Memory (x14 words)	512	1K	2К	4K	4K
	Data Memory (bytes)	80	80	128	176	176
	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0
Peripherals	Comparators(s)	2	2	2	2	2
	Internal Reference Voltage	Yes	Yes	Yes	Yes	Yes
	Interrupt Sources	4	4	4	4	5
	I/O Pins	13	13	13	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	3.0-6.0	3.0-6.0
	Brown-out Reset	Yes	Yes	Yes	Yes	Yes
Features	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin PDIP, SOIC, Windowed CDIP	40-pin PDIP, Windowed CDIP; 44-pin PLCC, MQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high

I/O current capability. All PIC16C62X and PIC16C64X Family devices use serial programming with clock pin RB6 and data pin RB7.

E.7 PIC16C7XX Family of Devces

		PIC16C710	PIC16C71	PIC16C711	PIC16C715	PIC16C72	PIC16CR72 ⁽¹⁾
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x14 words)	512	1K	1K	2К	2К	—
Memory	ROM Program Memory (14K words)	—	—	_	_	_	2К
	Data Memory (bytes)	36	36	68	128	128	128
	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/ PWM Module(s)		_			1	1
	Serial Port(s) (SPI/I ² C, USART)	—	_	_	_	SPI/I ² C	SPI/I ² C
	Parallel Slave Port	_	—	—	—	—	—
	A/D Converter (8-bit) Channels	4	4	4	4	5	5
	Interrupt Sources	4	4	4	4	8	8
	I/O Pins	13	13	13	13	22	22
	Voltage Range (Volts)	3.0-6.0	3.0-6.0	3.0-6.0	3.0-5.5	2.5-6.0	3.0-5.5
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	_	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP

		PIC16C73A	PIC16C74A	PIC16C76	PIC16C77
Clock	Maximum Frequency of Oper- ation (MHz)	20	20	20	20
Memory	EPROM Program Memory (x14 words)	4K	4K	8K	8K
	Data Memory (bytes)	192	192	368	368
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Mod- ule(s)	2	2	2	2
	Serial Port(s) (SPI/I ² C, US- ART)	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	—	Yes	—	Yes
	A/D Converter (8-bit) Channels	5	8	5	8
	Interrupt Sources	11	12	11	12
	I/O Pins	22	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	Yes	Yes	Yes
	Packages	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C7XX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip sales office for availability of these devices.

		PIC16F83	PIC16CR83	PIC16F84	PIC16CR84
Clock	Maximum Frequency of Operation (MHz)	10	10	10	10
	Flash Program Memory	512	—	1K	—
	EEPROM Program Memory	—	—	—	—
Memory	ROM Program Memory	—	512	—	1K
	Data Memory (bytes)	36	36	68	68
	Data EEPROM (bytes)	64	64	64	64
Peripher- als	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
	Interrupt Sources	4	4	4	4
	I/O Pins	13	13	13	13
Features	Voltage Range (Volts)	2.0-6.0	2.0-6.0	2.0-6.0	2.0-6.0
	Packages	18-pin DIP, SOIC	18-pin DIP, SOIC	18-pin DIP, SOIC	18-pin DIP, SOIC

E.8 PIC16C8X Family of Devices

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C8X Family devices use serial programming with clock pin RB6 and data pin RB7.

E.9 PIC16C9XX Family Of Devices

		PIC16C923	PIC16C924
Clock	Maximum Frequency of Operation (MHz)	8	8
M	EPROM Program Memory	4K	4K
Memory	Data Memory (bytes)	176	176
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
	Capture/Compare/PWM Module(s)	1	1
Peripherals	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C	SPI/I ² C
	Parallel Slave Port	—	—
	A/D Converter (8-bit) Channels	—	5
	LCD Module	4 Com, 32 Seg	4 Com, 32 Seg
	Interrupt Sources	8	9
	I/O Pins	25	25
	Input Pins	27	27
	Voltage Range (Volts)	3.0-6.0	3.0-6.0
Features	In-Circuit Serial Programming	Yes	Yes
	Brown-out Reset	—	—
	Packages	64-pin SDIP ⁽¹⁾ , TQFP; 68-pin PLCC, Die	64-pin SDIP ⁽¹⁾ , TQFP; 68-pin PLCC, Die

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C9XX Family devices use serial programming with clock pin RB6 and data pin RB7.

E.10 PIC17CXXX Family of Devices

		PIC17C42A	PIC17CR42	PIC17C43	PIC17CR43	PIC17C44
Clock	Maximum Frequency of Operation (MHz)	33	33	33	33	33
	EPROM Program Memory (words)	2K	—	4K	—	8K
Memory	ROM Program Memory (words)	—	2К	—	4K	—
	RAM Data Memory (bytes)	232	232	454	454	454
Peripherals	Timer Module(s)	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3
	Captures/PWM Module(s)	2	2	2	2	2
	Serial Port(s) (USART)	Yes	Yes	Yes	Yes	Yes
	Hardware Multiply	Yes	Yes	Yes	Yes	Yes
	External Interrupts	Yes	Yes	Yes	Yes	Yes
	Interrupt Sources	11	11	11	11	11
	I/O Pins	33	33	33	33	33
Features	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	Number of Instructions	58	58	58	58	58
	Packages	40-pin DIP; 44-pin PLCC, MQFP, TQFP				

		PIC17C752	PIC17C756
Clock	Maximum Frequency of Operation (MHz)	33	33
	EPROM Program Memory (words)	8K	16K
Memory	ROM Program Memory (words)	_	—
	RAM Data Memory (bytes)	454	902
Peripherals	Timer Module(s)	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3
	Captures/PWM Module(s)	4/3	4/3
	Serial Port(s) (USART)	2	2
	Hardware Multiply	Yes	Yes
	External Interrupts	Yes	Yes
	Interrupt Sources	18	18
	I/O Pins	50	50
Features	Voltage Range (Volts)	3.0-6.0	3.0-6.0
	Number of Instructions	58	58
	Packages	64-pin DIP; 68-pin LCC, 68-pin TQFP	64-pin DIP; 68-pin LCC, 68-pin TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

PIN COMPATIBILITY

Devices that have the same package type and VDD, VSS and MCLR pin locations are said to be pin compatible. This allows these different devices to operate in the same socket. Compatible devices may only requires minor software modification to allow proper operation in the application socket (ex., PIC16C56 and PIC16C61 devices). Not all devices in the same package size are pin compatible; for example, the PIC16C62 is compatible with the PIC16C63, but not the PIC16C55.

Pin compatibility does not mean that the devices offer the same features. As an example, the PIC16C54 is pin compatible with the PIC16C71, but does not have an A/D converter, weak pull-ups on PORTB, or interrupts.

Pin Compatible Devices	Package
PIC12C508, PIC12C509, PIC12C671, PIC12C672	8-pin
PIC16C154, PIC16CR154, PIC16C156, PIC16CR156, PIC16C158, PIC16CR158, PIC16C52, PIC16C54, PIC16C54A, PIC16C54A, PIC16C56, PIC16C58A, PIC16CR58A, PIC16C61, PIC16C554, PIC16C556, PIC16C558 PIC16C620, PIC16C621, PIC16C622 PIC16C641, PIC16C642, PIC16C661, PIC16C662 PIC16C710, PIC16C71, PIC16C711, PIC16C715 PIC16F83, PIC16CR83, PIC16F84A, PIC16CR84	18-pin, 20-pin
PIC16C55, PIC16C57, PIC16CR57B	28-pin
PIC16CR62, PIC16C62A, PIC16C63, PIC16CR63, PIC16C66, PIC16C72, PIC16C73A, PIC16C76	28-pin
PIC16CR64, PIC16C64A, PIC16C65A, PIC16CR65, PIC16C67, PIC16C74A, PIC16C77	40-pin
PIC17CR42, PIC17C42A, PIC17C43, PIC17CR43, PIC17C44	40-pin
PIC16C923, PIC16C924	64/68-pin
PIC17C756, PIC17C752	64/68-pin

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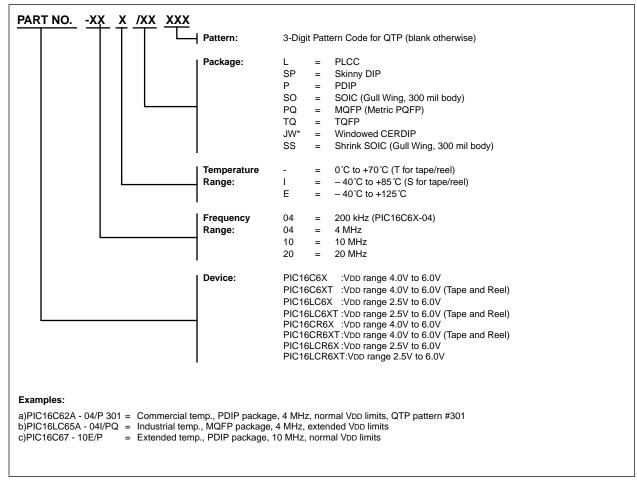
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